

VMIVME-DR11W-A

VMEbus-TO-DR11W INTERFACE

INSTRUCTION MANUAL

DOCUMENT NO. 500-000121-000 E

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IMPORTANT NOTICE

CABLE REQUIREMENTS:

The VMIVME-DR11W-A requires that the following cabling guidelines be followed for proper operation and data integrity:

1. Flat-cable with an overall shield or ground plane (or superior cable) must be used. Mass-terminated standard flat-cable **will** cause data errors.
2. The cable shield must be grounded at both ends of the cable if a shielded cable is used. The cable grounds should have low impedance at high frequencies.
3. Macrolink interfaces for the Concurrent/Perkin-Elmer require a pinout reversal on the cables. When ordering specify macrolink cables.

DR11W COMPATIBILITY:

The VMIVME-DR11W-A is pinout compatible with DR11-W and DRV11-B type devices, with the exception of Function 1 now being a defined bit on the VMIVME-DR11W-A Board. It is **not** pinout compatible with DR11-B type devices and damage may result if it is cabled directly to a DR11-B type device.

Bit 6 (LONGWORD) of the Address Modifier Register (AMR) must be maintained to the proper state to assure proper operation of the associated 8-, 16-, or 32-bit transfers. Refer to Section 4.4.4.



RECORD OF REVISIONS

REVISION LETTER	DATE	PAGES INVOLVED	CHANGE NUMBER	
A	03/21/91	Release per ECO	91-0051	
B	10/07/91	Change per ECO	91-0228	
C	02/10/92	Change per ECO	92-0022	
D	02/22/93	Cover, pages iii, vi, viii, Sections 2, and 6, and Appendix A	92-0328	
E	12/08/93	Correct Table 4.5-1	93-0913	
VME MICROSYSTEMS INT'L CORP. 12090 South Memorial Parkway • Huntsville, AL 35803-3308 • (205) 880-0444		DOC. NO. 500-000121-000	REV LTR E	PAGE NO. iii

VMIC SAFETY SUMMARY

THE FOLLOWING GENERAL SAFETY PRECAUTIONS MUST BE OBSERVED DURING ALL PHASES OF THE OPERATION, SERVICE, AND REPAIR OF THIS PRODUCT. FAILURE TO COMPLY WITH THESE PRECAUTIONS OR WITH SPECIFIC WARNINGS ELSEWHERE IN THIS MANUAL VIOLATES SAFETY STANDARDS OF DESIGN, MANUFACTURE, AND INTENDED USE OF THIS PRODUCT. VME MICROSYSTEMS INTERNATIONAL CORPORATION ASSUMES NO LIABILITY FOR THE CUSTOMER'S FAILURE TO COMPLY WITH THESE REQUIREMENTS.

GROUND THE SYSTEM

To minimize shock hazard, the chassis and system cabinet must be connected to an electrical ground. A three-conductor AC power cable should be used. The power cable must either be plugged into an approved three-contact electrical outlet or used with a three-contact to two-contact adapter with the grounding wire (green) firmly connected to an electrical ground (safety ground) at the power outlet.

DO NOT OPERATE IN AN EXPLOSIVE ATMOSPHERE

Do not operate the system in the presence of flammable gases or fumes. Operation of any electrical system in such an environment constitutes a definite safety hazard.

KEEP AWAY FROM LIVE CIRCUITS

Operating personnel must not remove product covers. Component replacement and internal adjustments must be made by qualified maintenance personnel. Do not replace components with power cable connected. Under certain conditions, dangerous voltages may exist even with the power cable removed. To avoid injuries, always disconnect power and discharge circuits before touching them.

DO NOT SERVICE OR ADJUST ALONE

Do not attempt internal service or adjustment unless another person, capable of rendering first aid and resuscitation, is present.

DO NOT SUBSTITUTE PARTS OR MODIFY SYSTEM

Because of the danger of introducing additional hazards, do not install substitute parts or perform any unauthorized modification to the product. Return the product to VME Microsystems International Corporation for service and repair to ensure that safety features are maintained.

DANGEROUS PROCEDURE WARNINGS

Warnings, such as the example below, precede only potentially dangerous procedures throughout this manual. Instructions contained in the warnings must be followed.

WARNING

DANGEROUS VOLTAGES, CAPABLE OF CAUSING DEATH, ARE PRESENT IN THIS SYSTEM. USE EXTREME CAUTION WHEN HANDLING, TESTING, AND ADJUSTING.

SAFETY SYMBOLS

GENERAL DEFINITIONS OF SAFETY SYMBOLS USED IN THIS MANUAL



Instruction manual symbol: the product is marked with this symbol when it is necessary for the user to refer to the instruction manual in order to protect against damage to the system.



Indicates dangerous voltage (terminals fed from the interior by voltage exceeding 1000 volts are so marked).



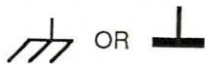
OR



Protective conductor terminal. For protection against electrical shock in case of a fault. Used with field wiring terminals to indicate the terminal which must be connected to ground before operating equipment.



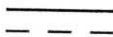
Low-noise or noiseless, clean ground (earth) terminal. Used for a signal common, as well as providing protection against electrical shock in case of a fault. Before operating the equipment, terminal marked with this symbol must be connected to ground in the manner described in the installation (operation) manual.



Frame or chassis terminal. A connection to the frame (chassis) of the equipment which normally includes all exposed metal structures.



Alternating current (power line).



Direct current (power line).



Alternating or direct current (power line).

WARNING

The WARNING sign denotes a hazard. It calls attention to a procedure, a practice, a condition, or the like, which, if not correctly performed or adhered to, could result in injury or death to personnel.



The CAUTION sign denotes a hazard. It calls attention to an operating a procedure, a practice, a condition, or the like, which, if not correctly performed or adhered to, could result in damage to or destruction of part or all of the system.

NOTE:

The NOTE sign denotes important information. It calls attention to a procedure, a practice, a condition or the like, which is essential to highlight.

VMIVME-DR11W-A VMEbus-TO-DR11W INTERFACE

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SECTION 1

INTRODUCTION

1.1 INTRODUCTION

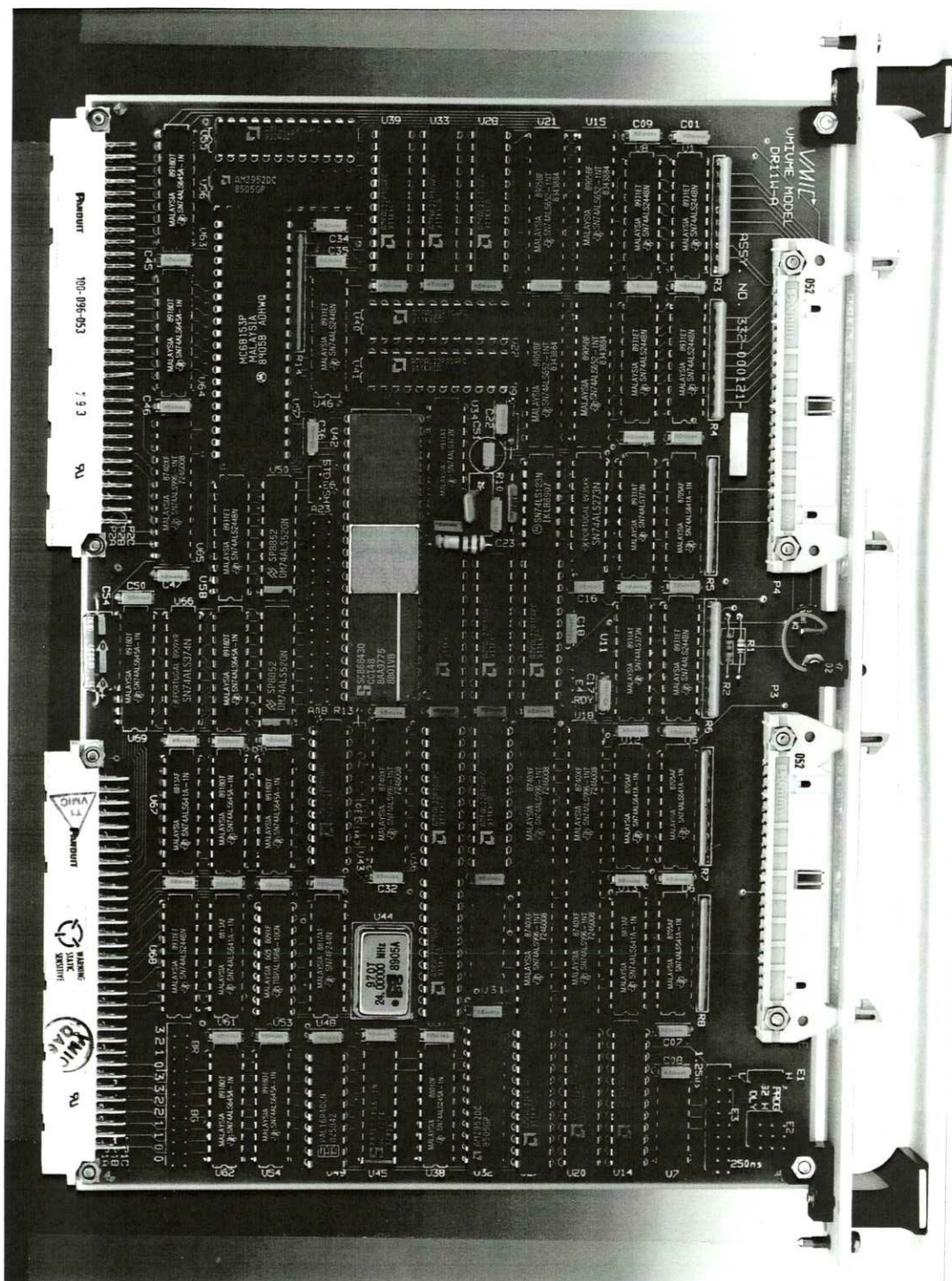
The VMIVME-DR11W-A is a high performance VMEbus 32-bit Direct Memory Access (DMA) interface that forms a 16-bit parallel interface between the VMEbus and Digital Equipment Corporation (DEC) DR11-W and DRV11-WA type devices, and with the DR11W CPU links. A photograph of the VMIVME-DR11W-A printed circuit assembly is shown in Figure 1.1-1. VMIVME-DR11W-A features are as follows:

- a. DR11W and DRV11-WA compatible I/O connection
- b. 32-bit DMA data transfers
- c. 32-bit addressing
- d. VMEbus (IEEE P1014) compatible
- e. Software-selectable byte and word swapping
- f. Watchdog timers prevent transfer lockout on VMEbus and cables
- g. Front panel Fail LED
- h. Supports off-line Built-in-Test plus single board loopback testing (with test cable)
- i. Meets VMEbus Spec. C.1 - compatible address pipelining
- j. Fully programmable operation (includes selection of 16- or 32-bit transfer, burst mode, etc.)
- k. Fully programmable interrupt vectors and levels
- l. Programmable VMEbus address modifiers
- m. Jumper-selectable VME standard short I/O address space for on-board registers
- n. Software compatible with VMIC's DR11W and DR11W-485 boards
- o. Two VMIVME-DR11W-As form a VMEbus-to-VMEbus link

1.2 FUNCTIONAL DESCRIPTION

The VMIVME-DR11W-A provides a high performance, 16-bit DMA Link between the VMEbus and DEC DR11-W compatible devices. The VMIVME-DR11W-A interfaces may also be connected back-to-back to form a VMEbus-to-VMEbus DMA Link (see Figures 1.2-1 and 1.2-2).

The VMIVME-DR11W-A incorporates a SCB68430 DMA controller device to perform its DMA transfers, a MC68153 Bus Interrupter Module (BIM) to implement a VMEbus interrupter (for the attention and DMA completion interrupts), and it also contains logic to allow the VMIVME-DR11W-A to generate an attention interrupt to the external device.



MDR11W-A/F1.1-1

Figure 1.1-1. Printed Circuit Assembly Photograph

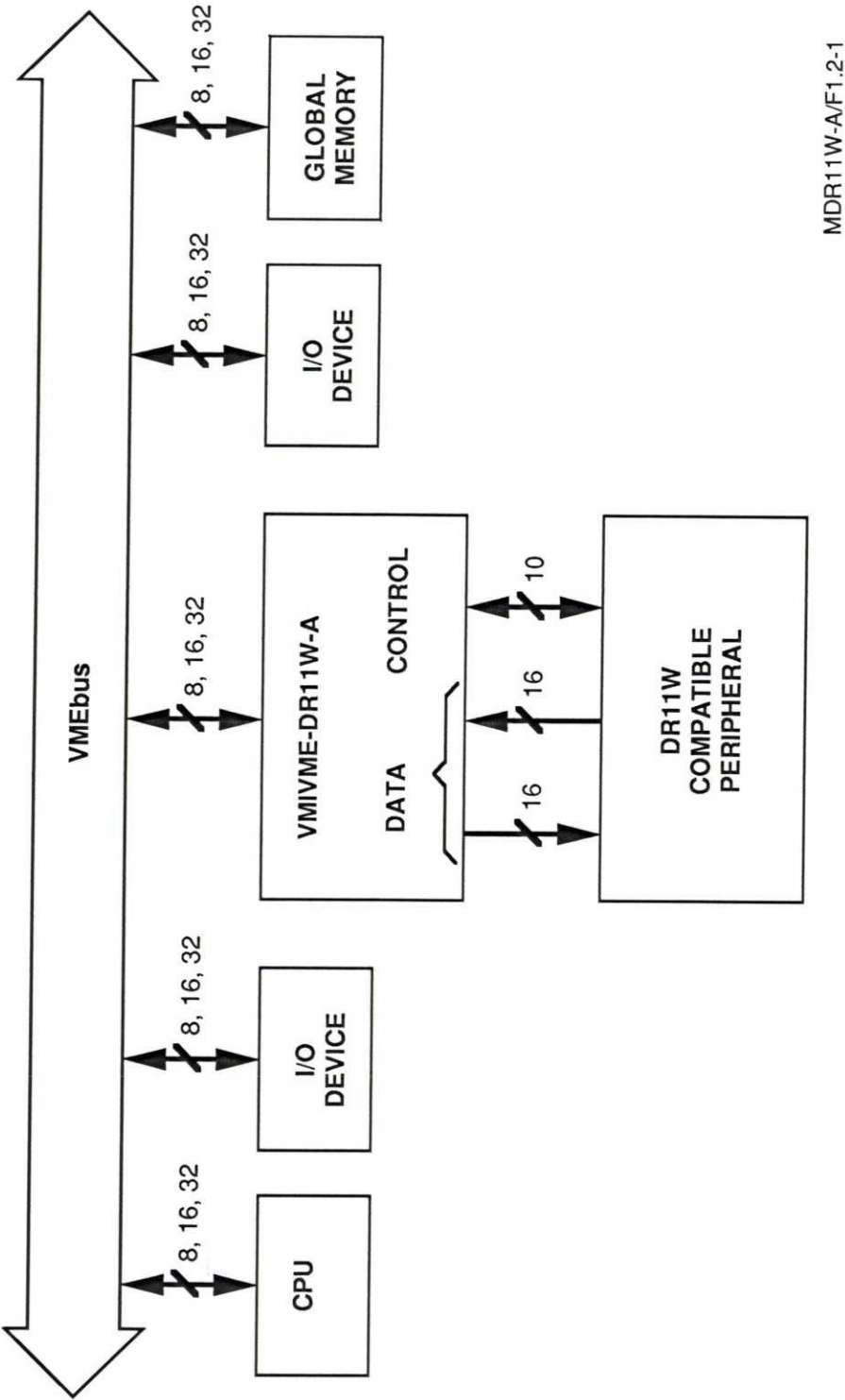
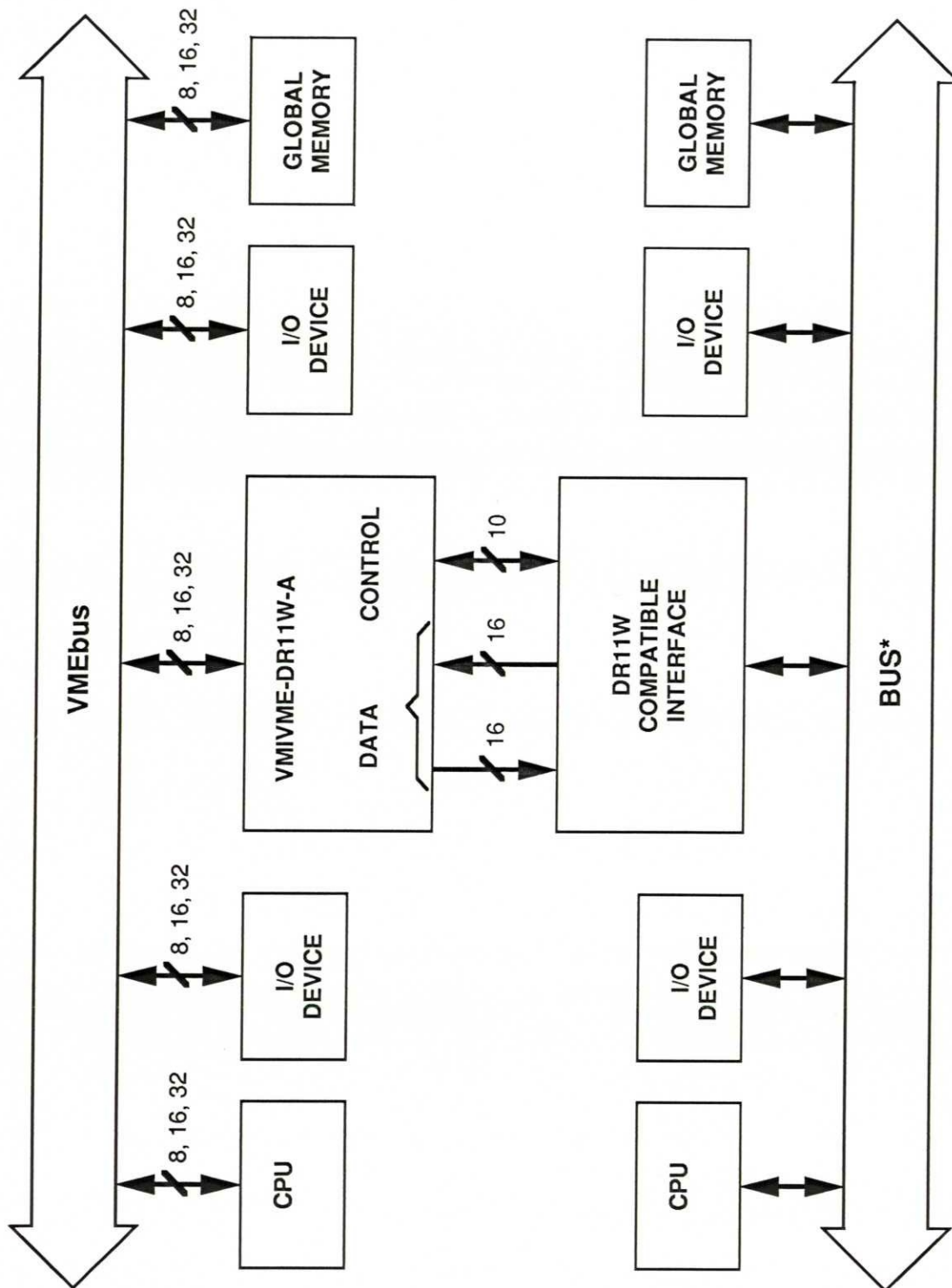


Figure 1.2-1. VMIVME-DR11W-A Connection-to-User Device



*DEC, Concurrent, Data General, Harris Night Hawk, Prime, IBM PC/AT, Masscomp, Sun Workstations, or other VMEbus based machines.

MDR11W-A/F1.2-2

Figure 1.2-2. VMIVME-DR11W-A CPU-to-CPU Link

1.3 COMPATIBILITY

VMIVME-DR11W compatibility interfaces for the computers listed in Table 1.3-1 are available from the companies indicated for each computer.

Table 1.3-1. VMIVME-DR11W-A Compatible Host Computer Interface Sources

COMPUTER	COMPANY	PHONE NUMBER
DEC VAX, PDP-11 LSI-11	Digital Equipment Corp.	1-800-DIGITAL Continental Blvd. Merrimack, NH 03054
CONCURRENT/ PERKIN-ELMER	Macrolink**	(714) 634-8080
HARRIS H60-H100	Harris	(404) 256-4000
ENCORE CONCEPT 32 Series*	Encore	(305) 587-2900
IBM PC/AT	Omnicom Graphics***	(713) 464-2990 Houston, TX

*Not directly VMIVME-DR11W compatible - requires simple modification of MPC1 Model 8020 IOP interface board (contact Encore for VMIVME-DR11W modification kit). VMIC has a 32-bit Encore HSD-to-VMEbus interface.

**Macrolink interfaces require a cable pinout reversal. When ordering cables specify the macrolink cables.

***Requires Omnicomp interprocessor link driver with soft start.

MDR11W-A/T1.3-1

NOTICE

THE INFORMATION IN TABLE 1.3-1 IS OFFERED AS A HELPFUL SUGGESTION. IT IS INTENDED AS A GUIDE. VMIC DOES NOT GUARANTEE FAVORABLE RESULTS NOR DOES IT ASSUME ANY LIABILITY IN CONNECTION WITH ITS USE. NO STATEMENT OR RECOMMENDATION IS INTENDED BY VMIC FOR THE USE OF THESE PRODUCTS. BEFORE USING THE PRODUCTS LISTED, THE USER SHALL DETERMINE THE SUITABILITY OF THE PRODUCT(S) FOR HIS INTENDED USE, AND THE USER ASSUMES ALL RISK AND LIABILITY IN CONNECTION WITH THEIR USE.

1.4 REFERENCE MATERIAL LIST

The reader should refer to "The VMEbus Specification" for a detailed explanation of VMEbus. "The VMEbus Specification is available from the following source:

VITA
VMEbus International Trade Association
10229 N. Scottsdale Road
Scottsdale, AZ 85253
(602) 951-8866

Additional information concerning the DR11W protocol is contained in the "DR11-W Direct Memory Interface Module (No. EK-DR11W-UG-002)". This document is available from the following source:

Digital Equipment Corporation
146 Main St.
Maynard, MA 01754-2751
(617) 897-5111

Specific information concerning the SCB68430 may be obtained from the following source:

Signetics Corporation
811 E. Arques Ave.
P.O. Box 3409
Sunnyvale, CA 94088-3409
(408) 991-2000

A detailed specification is provided in Appendix B.

SECTION 2
PHYSICAL DESCRIPTION AND SPECIFICATIONS
REFER TO 800-000121-000 SPECIFICATION

SECTION 3

THEORY OF OPERATION

3.1 BLOCK DIAGRAMS

As shown in the functional block diagram (see Figure 3.1-1) and in the interconnection diagrams (Figures 3.1-2 and 3.1-3) the VMIVME-DR11W-A interface provides for the exchange of program controlled interrupts and status as well as two 16-bit data buses with handshake signals. The function of these interface signals are described in Section 3.4. The handshake sequencing of the signals are depicted in Figures 3.1-4, 3.1-5, and 3.1-6 for the 32-bit transfer mode, and in Figures 3.1-7, 3.1-8, and 3.1-9 for the 16-bit transfer mode.

Although the VMIVME-DR11W-A interface was developed for interconnection to DR11-W compatible devices, it also performs DMA transfers in conjunction with the DRV-11WA interface (see Figure 3.1-3).

3.2 OPERATIONAL OVERVIEW

The VMIVME-DR11W-A has two modes of operation, INTERPROCESSOR LINK MODE (back-to-back configuration), and EXTERNAL DEVICE MODE. In the INTERPROCESSOR LINK MODE, the VMIVME-DR11W-A communicates with another DR11-W compatible computer interface. In the EXTERNAL DEVICE MODE, the VMIVME-DR11W-A communicates with a user's device such as a disk drive system, tape drive, etc.

To operate in either mode, a transfer protocol (see Section 3.3) must be established. Once this is determined, the VMIVME-DR11W-A may be programmed as detailed in Section 4.1. One difference in the operation of this device versus other DR11-W implementations is that the bus transfer type (word/byte and direction) is determined before the start of any data transfers and not on a cycle-by-cycle basis.

When two DR11W compatible boards are connected back-to-back the two cables are crossed over so that one board drives a control signal and the other board receives it. Thus, there is no need for a "master/slave mode".

3.3 TRANSFER PROTOCOL

In order for DMA transfers to take place the DMA interfaces must be set up at both ends of the link. Therefore, if a CPU on one bus wants to transfer data, a

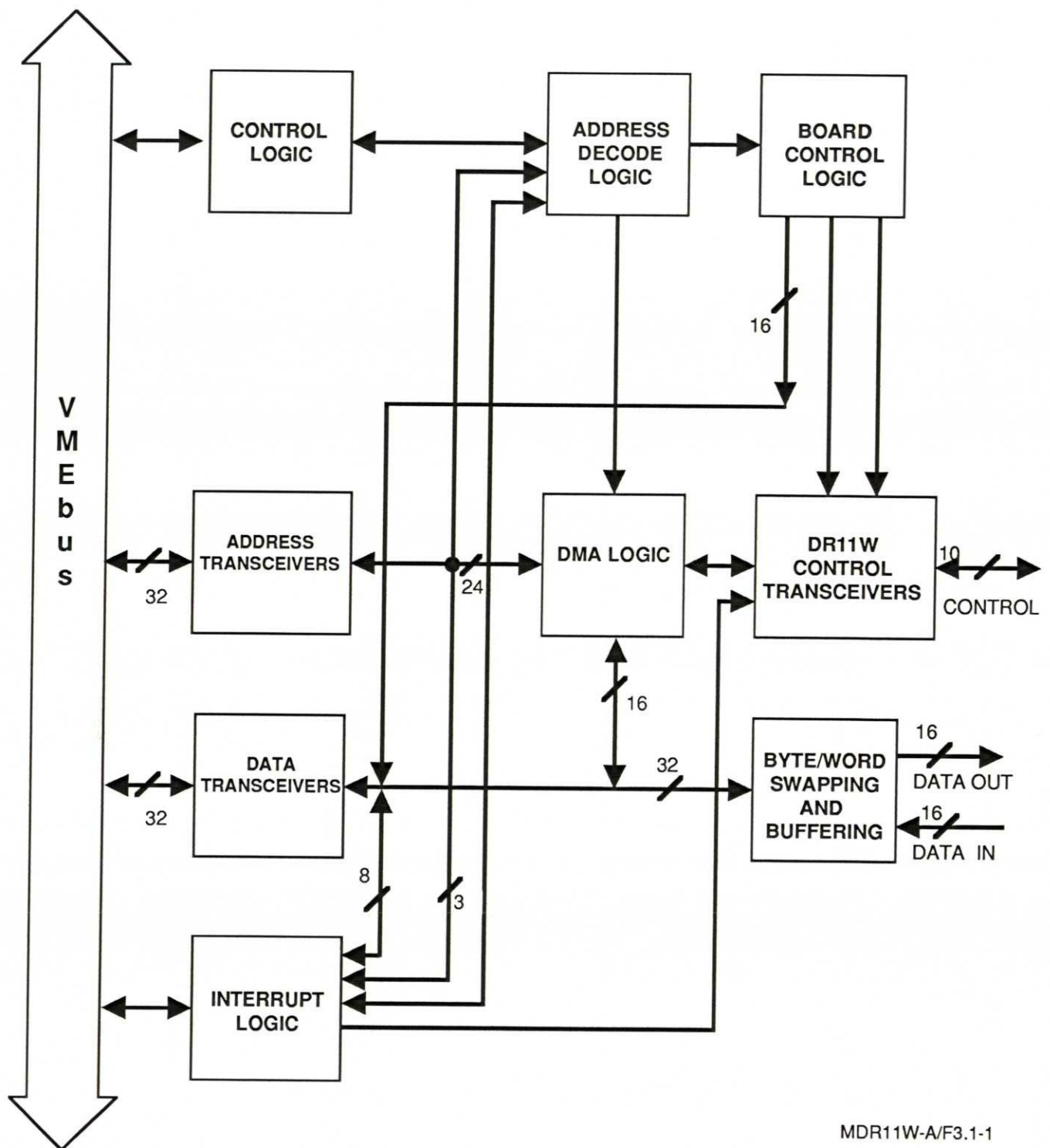
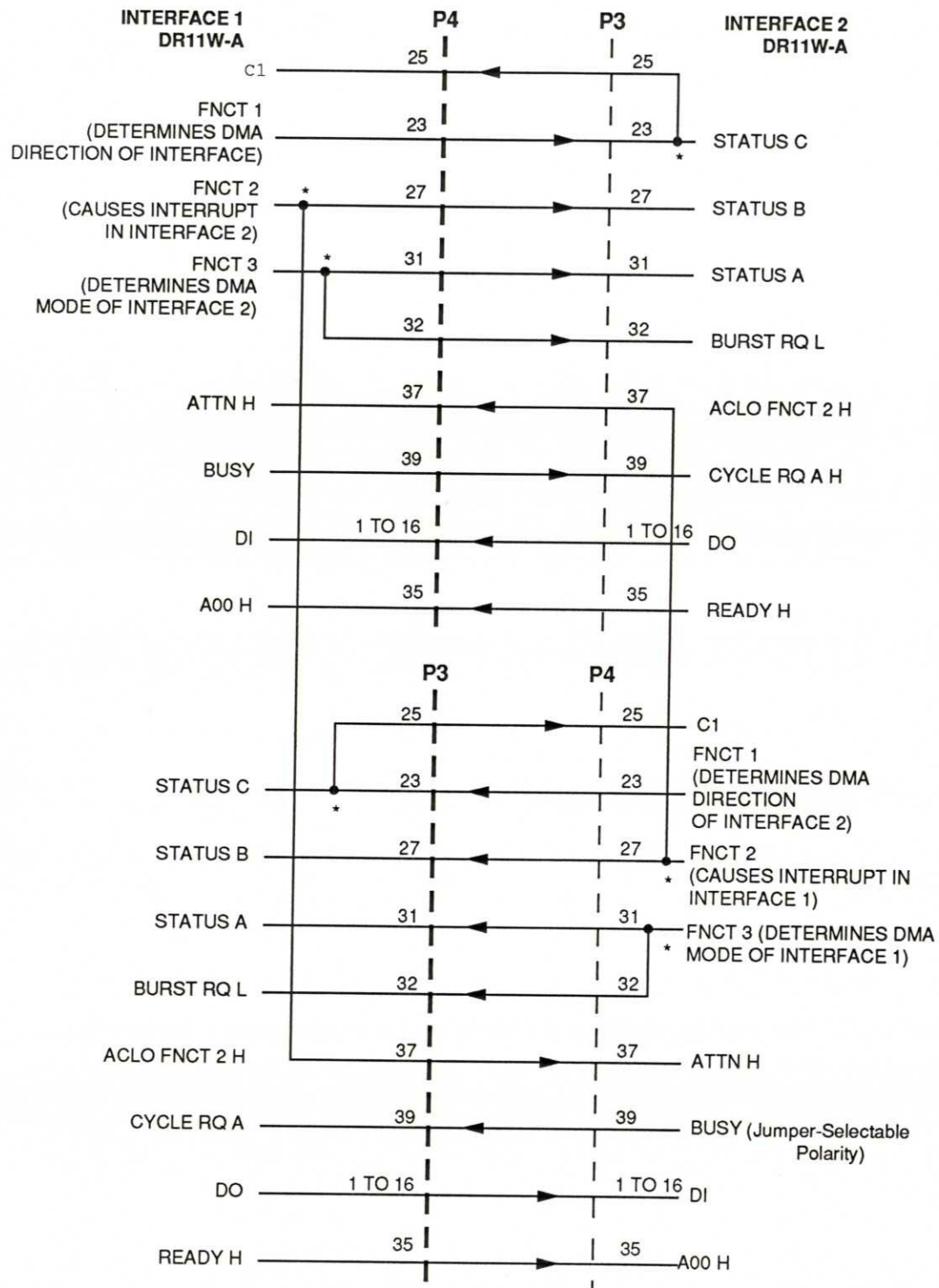


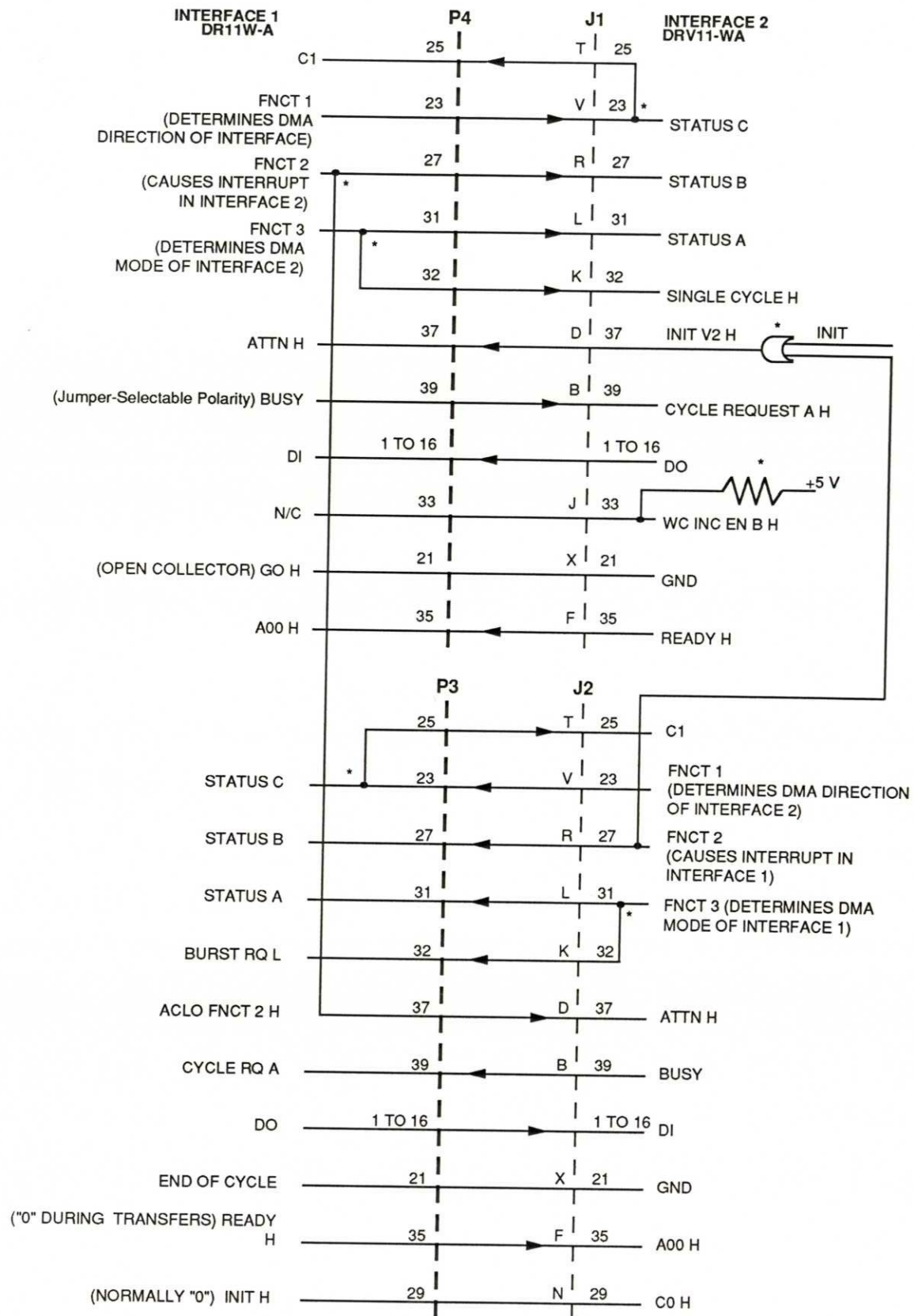
Figure 3.1-1. VMIVME-DR11W-A Functional Block Diagram



*Connection is hardwired on PC board.

MDR11W-A/F3.1-2

Figure 3.1-2. Interface Interconnection for Two VMIVME-DR11W-As in Back-to-Back Configuration



*All components and connections shown are included in the standard products.

MDR11W-A/F3.1-3

Figure 3.1-3. Interface Connection to a DRV11-WA

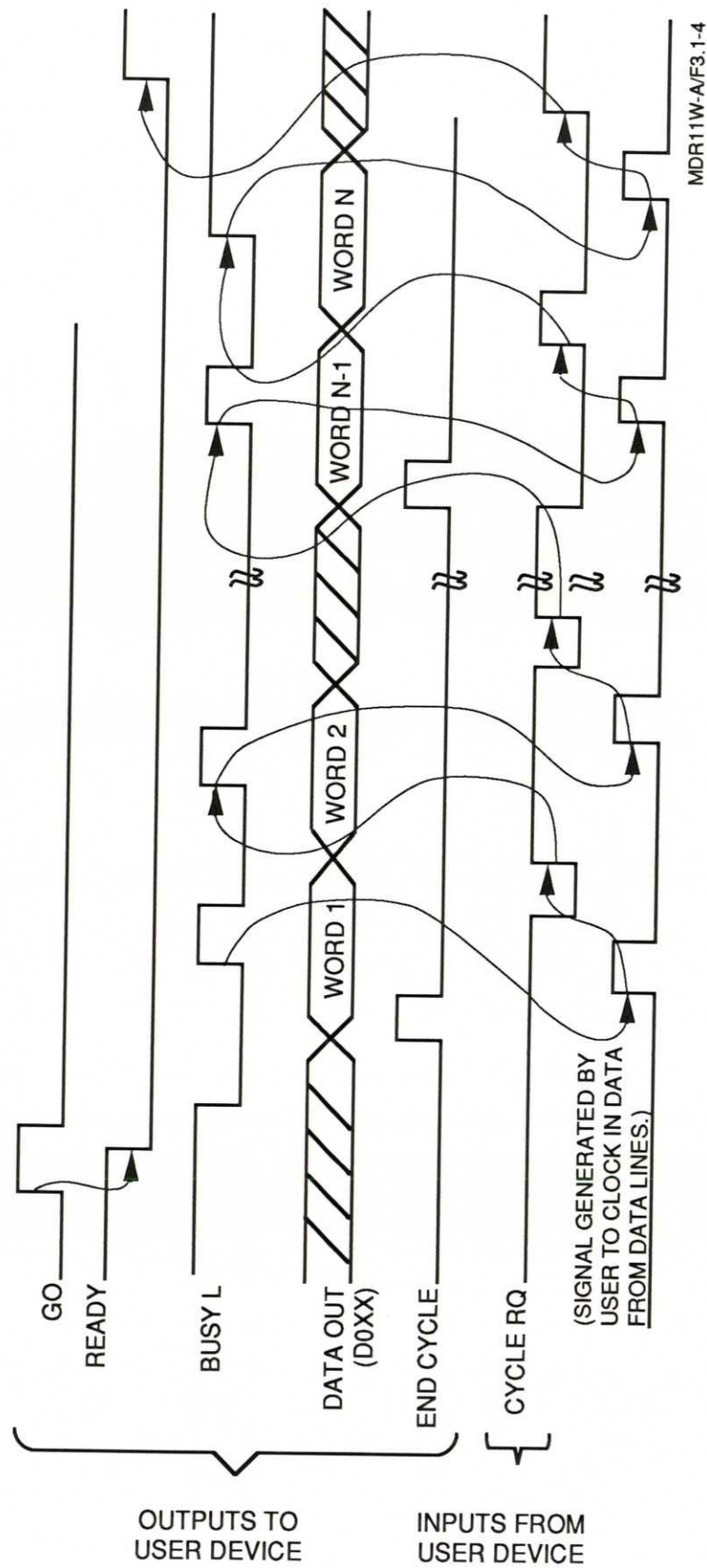


Figure 3.1-4. Timing/Handshake Sequencing 32-Bit Data Transfers from the VMIVME-DR11W-A to the User Device

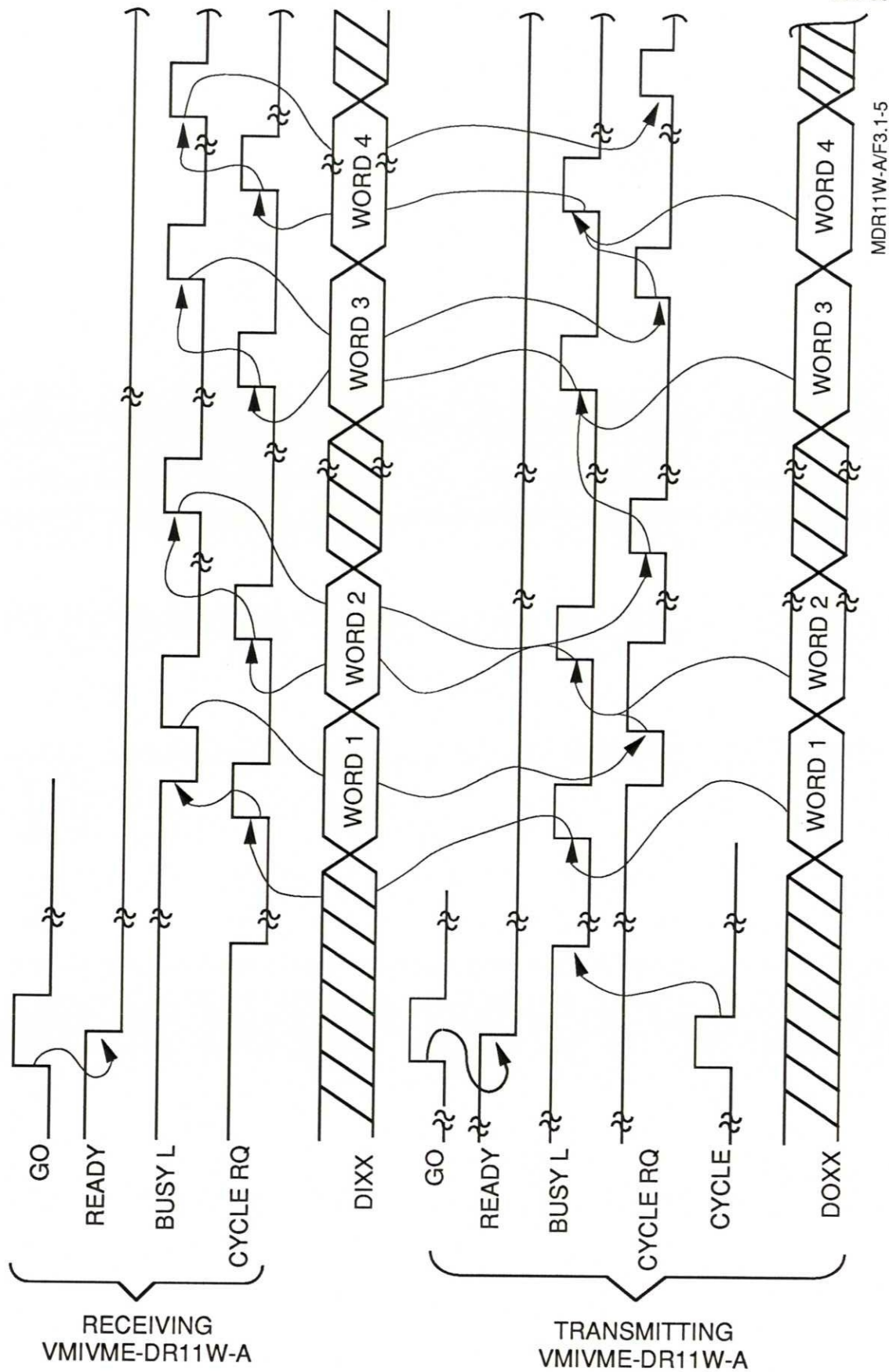


Figure 3.1-5. Back-to-Back 32-Bit DMA Transfers Configuration (Interprocessor Mode)

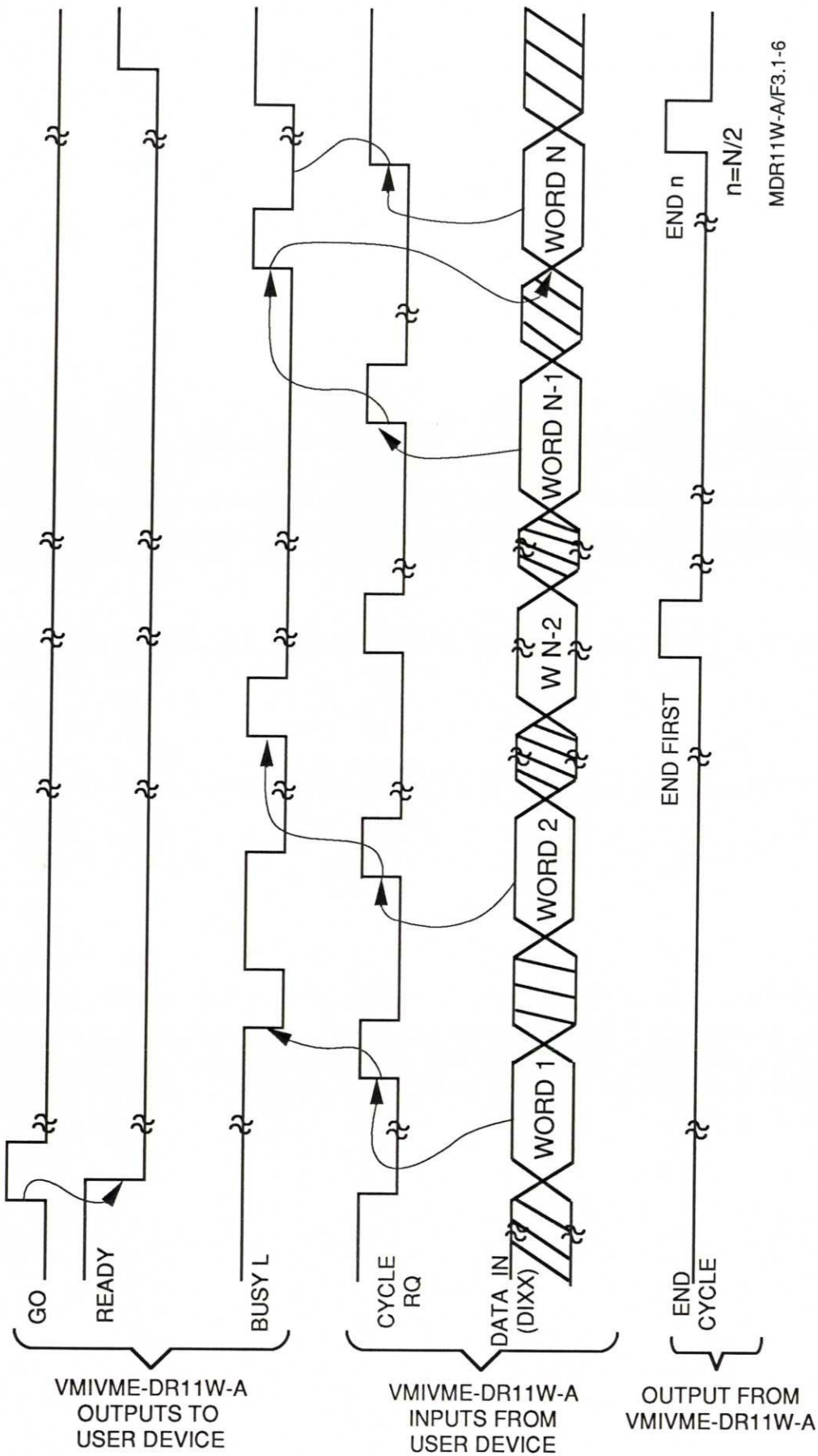


Figure 3.1-6. Diagram for 32-Bit Data Transfers from the User Device to the VMIVME-DR11W-A

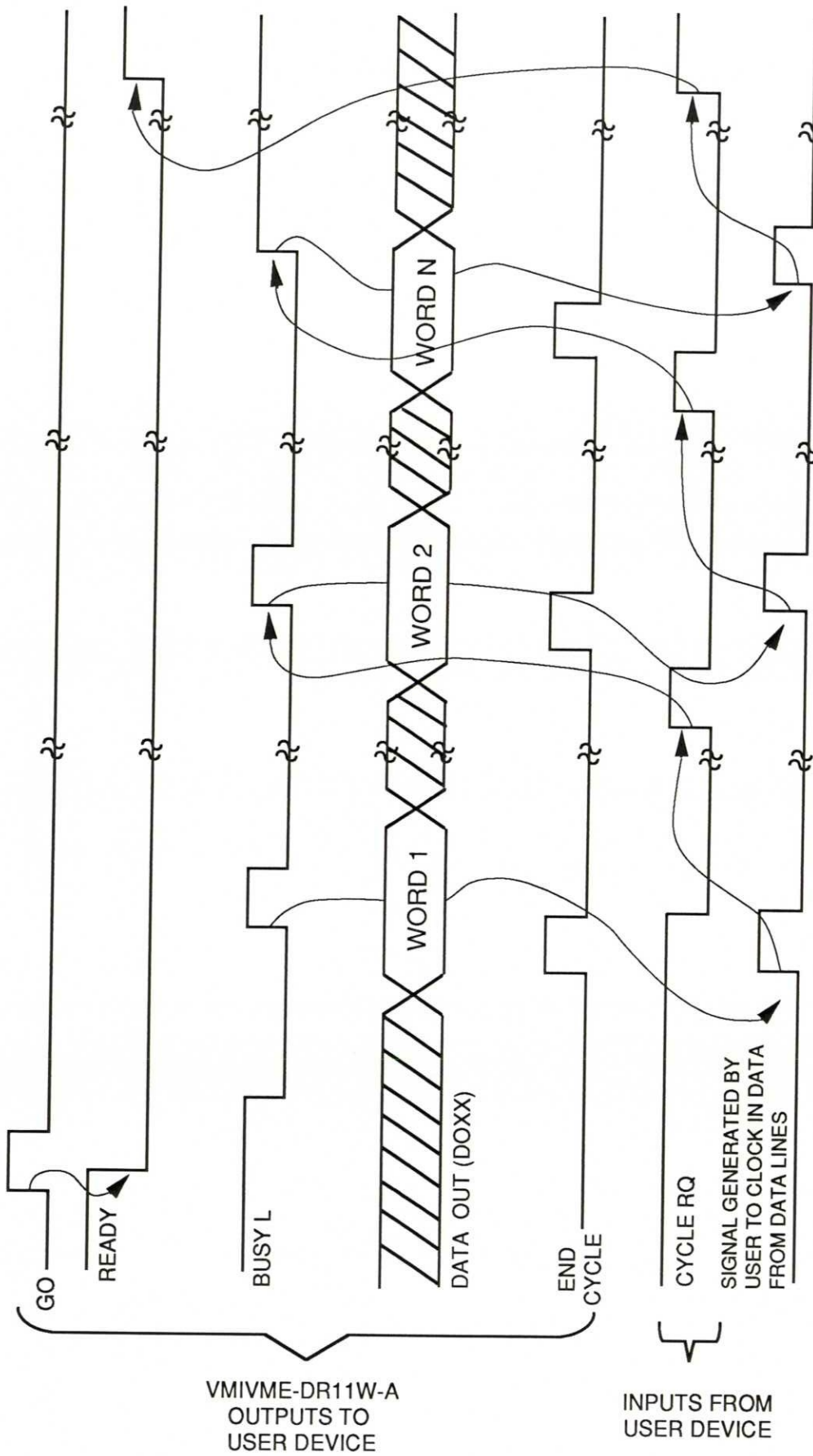
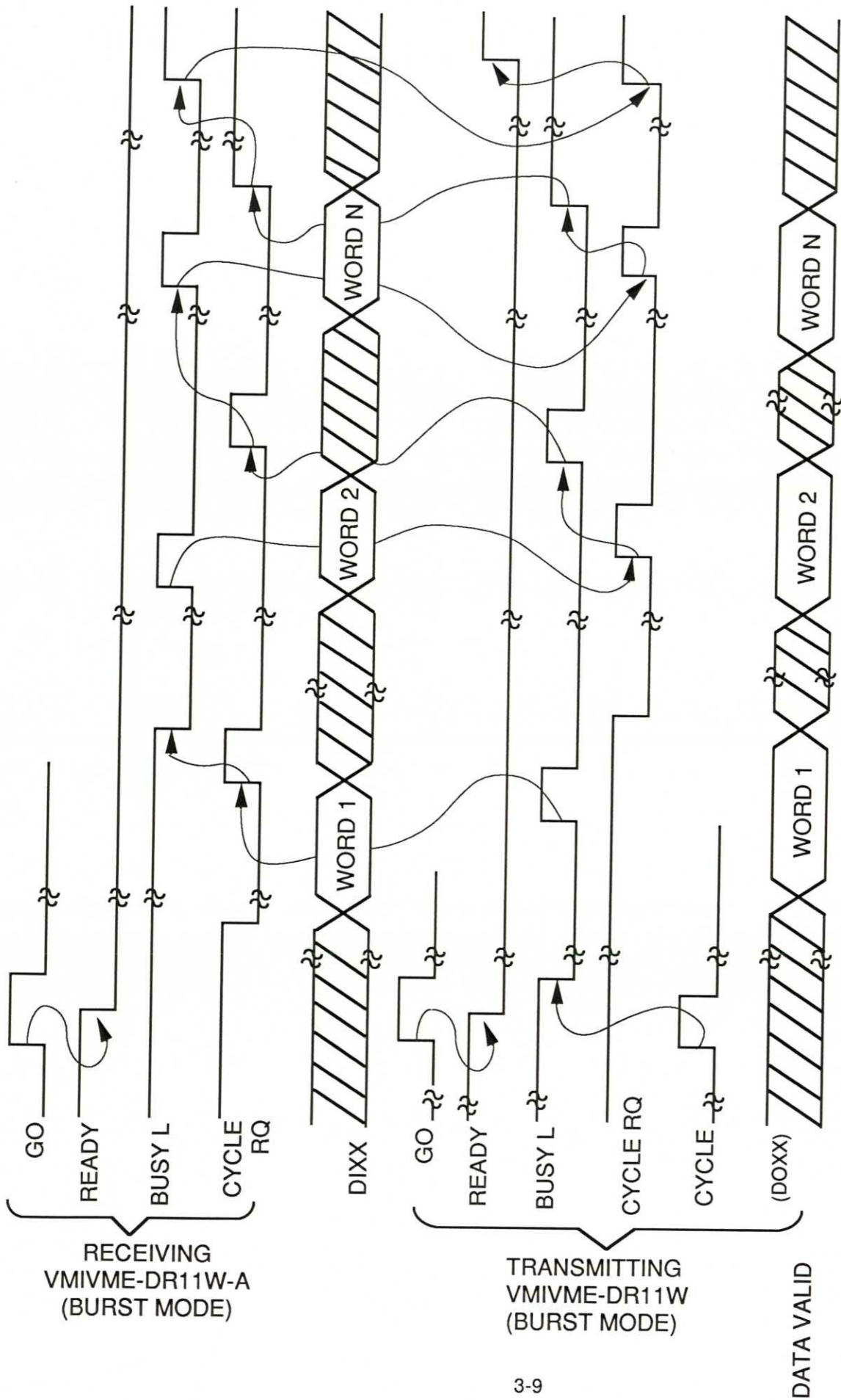


Figure 3.1-7. Timing/Handshake Sequencing 16-Bit Data Transfers from the VMIVME-DR11W-A to the User Device



MDR11W-A/F3.1-8

Figure 3.1-8. Back-to-Back 16-Bit DMA Transfer Configuration (Interprocessor Mode)

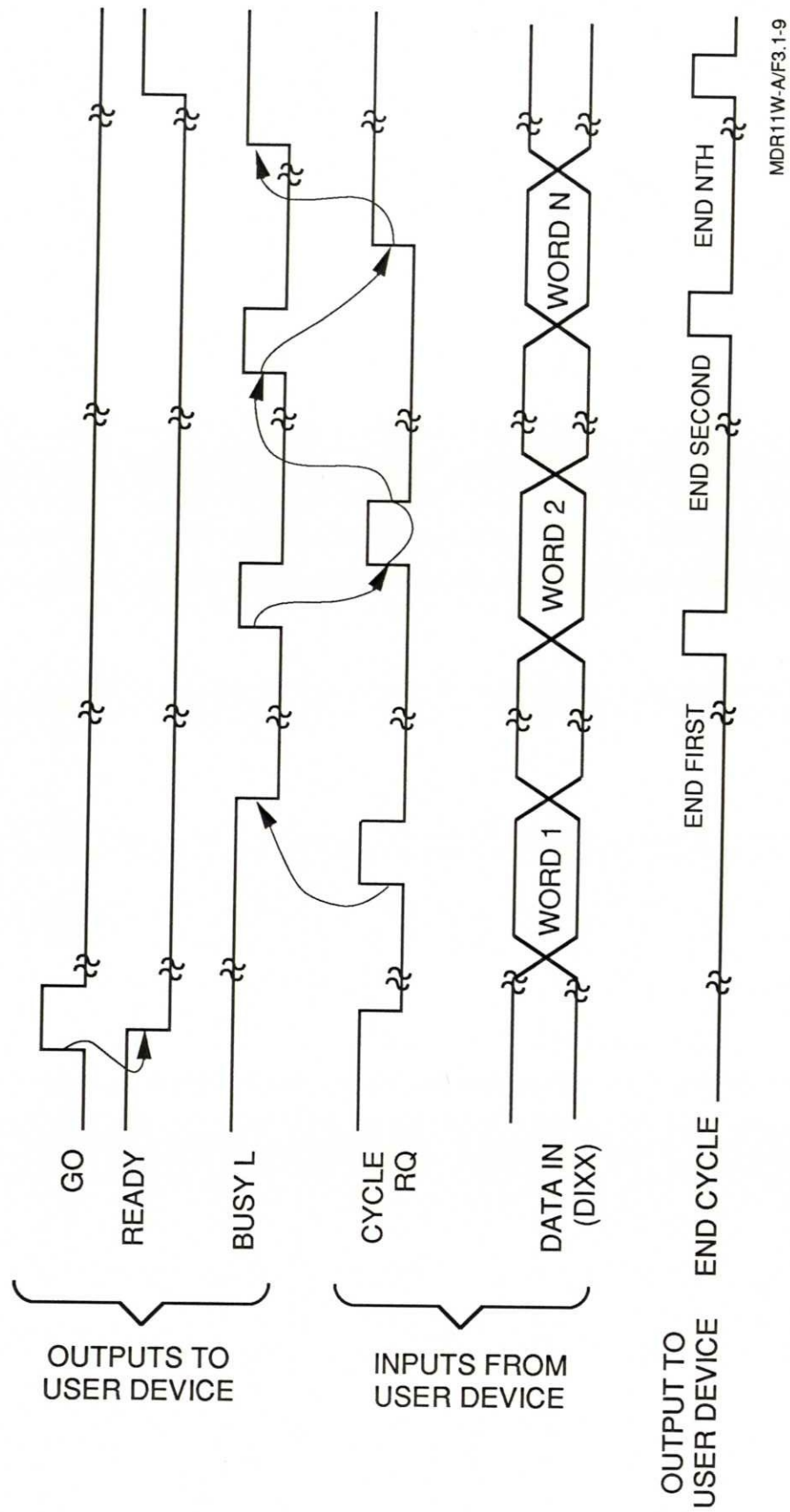


Figure 3.1-9. Diagram for 16-Bit Data Transfers from the User Device to the VMIVME-DR11W-A

second CPU on the second bus must set up the DMA interface on that second bus to the selected memory address, word count, and direction of transfer.

The sequence of operations necessary for two CPUs on two separate buses to control data transfers is referred to as the transfer protocol. There are several types of protocols that may be used with the VMIVME-DR11W-A.

One protocol type consists of the following sequences:

- a. The CPU in bus one interrupts the CPU on the other bus via the "ATTENTION" interrupt.
- b. Both DMA interfaces are set up to transfer a control data block. The control data block contains information required by the second system to set up the other VMIVME-DR11W-A (such as transfer counts, transfer direction, etc.).
- c. The control data block is then used to set up the DMA interface in the second bus. This protocol preselects the size and direction of transfer of the control block.
- d. Transfer of data then occurs after both boards have set "GO," both boards have sensed that "OTHER BOARDS READY" from the A00H cable signal (see Section 5.3.5) is at the proper level, and a "BUSY" cable signal is generated by one of the two boards (request cycle).

A second protocol type consists of using predetermined transfer block sizes and sequences.

A third protocol type consists of sending the DMA set-up data via a serial communication link.

3.4 DATA TRANSFER DESCRIPTION

When the VMIVME-DR11W-A transfers individual data words to or from an external device, it becomes the VMEbus master and transfers the data via DMA transfers to or from memory. It asserts the VMEbus address, control lines, address modifier, and sends or receives data. The data transfers are controlled by a SCB68430 DMA interface chip. Handshake signals to/from the SCB68430 are converted to/from DR11W compatible handshake signals.

3.5 VME-TO-VME LINK

Two VMIVME-DR11W-A boards may be connected back-to-back to create a DMA link between two VMEbus chassis assemblies. In this configuration, the two boards are connected so their data buses and control signals are cross coupled which allows them to transfer data back and forth under handshake control. The cross coupling is shown in Figure 3.1-2.

3.6 USER INTERFACE SIGNAL FUNCTION DESCRIPTION

The following paragraphs describe the standard DR11W signals used by the VMIVME-DR11W-A.

DO00 TO DO15 - DATA OUTPUT BUS. The data is positive true and is transmitted by bus transceivers. Each line is terminated by a 180/390 Ω network.

CYCLE REQUEST A - CYCLE REQUEST B. These two inputs are used to request a DMA cycle from the user's device. These two signals are "ORed" together.

END CYCLE. This signal indicates the end of a DMA cycle to the user's device.

STATUS A - STATUS BIT A. This bit is a user-defined status bit from the user's device to the VMIVME-DR11W-A. In the back-to-back configuration, this bit indicates that single cycle transfers should be performed when it is asserted.

STATUS B - STATUS BIT B. This bit is a user-defined status bit from the user's device to the VMIVME-DR11W-A. In the back-to-back configuration, STATUS B indicates the state of the ATTN interrupt bit.

STATUS C - STATUS BIT C. This signal is a user-defined status bit from the user's device to the VMIVME-DR11W-A. In the back-to-back configuration, STATUS C indicates the direction of the DMA transfer.

INIT - INITIALIZE. This signal is output from the VMIVME-DR11W-A to indicate a power ON reset or other reset has occurred.

BURST RQ - BURST REQUEST. This signal is an input to the VMIVME-DR11W-A and when asserted, indicates that burst transfers should be performed. This bit is negative true.

READY. This output signal indicates that the board is ready and does not have transfers in progress. This signal is de-asserted by GO.

ACLO FNCT 2 - AC LOW OR FUNCTION2. This bit is the same as Function 2 on the VMIVME-DR11W-A.

DI00 TO DI15 - DATA INPUT BUS. The data is positive true and is received by bus transceivers. Each line is terminated by a 180/390 Ω network.

GO. This bit is output by the VMIVME-DR11W-A to indicate the start of a DMA transfer block.

FNCT 1 - FUNCTION 1. Board Control Register (BCR) bit 05 (defined) is output by the VMIVME-DR11W-A. In the back-to-back configuration this bit controls the DMA direction of the VMIVME-DR11W-A and drives C1.

FNCT 2 - FUNCTION 2. Board Control Register (BCR) bit 06 (user-defined) is output from the VMIVME-DR11W-A. In the back-to-back configuration, this bit drives STATUS B (and ATTN) on the other board.

FNCT 3 - FUNCTION 3. Board Control Register (BCR) bit 07 (user-defined) is output from the VMIVME-DR11W-A. In the back-to-back configuration, this bit drives STATUS A.

C1 - CONTROL 1. This signal is an input to the VMIVME-DR11W-A and controls the direction of DMA transfer. In the back-to-back configuration, it is driven by FNCT 1. A logic "one" on C1 causes the VMIVME-DR11W-A to receive data while a logic "zero" causes it to transmit.

ATTN - ATTENTION. This signal is an input to the VMIVME-DR11W-A. It indicates that the user's device has issued attention interrupt request and causes an interrupt to the VMEbus system on the rising edge.

BUSY. This signal is an output from the VMIVME-DR11W-A and indicates that a VMEbus cycle is in progress. The polarity of this signal is jumper-selectable (Busy H or Busy L). In the BACK-TO-BACK MODE, Busy L must be selected since it is connected to the cycle request on the other DR11W board.

SECTION 4

PROGRAMMING

4.1 PROGRAMMING OVERVIEW

The VMIVME-DR11W-A has three register groups that must be programmed for proper operation. These register groups are associated with the SCB68430 DMA controller module, the MC68153 Bus Interrupter Module (BIM), and the on-board Control Registers. The on-board Control Registers are provided to allow the user the capability of programming the address modifiers, to allow control of the DMA controller and the BIM, to allow interface with the on-board error detection logic, to implement the VMIVME-DR11W-A on-board master control functions, and to communicate with the external VMIVME-DR11W-A compatible device.

The register address map showing the register names and addresses is shown in Table 4.1-1. The register formats are described in Sections 4.2, 4.3, and 4.4, where the Individual Register bit assignments are detailed.

4.2 PROGRAMMING THE SCB68430 DMAI

Programming the SCB68430 DMAI requires interface with most of the 14 on-chip registers that are described in this section. Table 4.2-1 details the DMAI register formats for the DMAI register bit descriptions that follow. Refer to the SCB68430 DMAI data sheet contained in Appendix B for additional detailed operation and programming information for the DMAI.

4.2.1 Channel Status Register/Channel Error Register

The Channel Status Register (CSR) and Channel Error Register (CER) are used together to determine status and error conditions related to the DMA controller.

4.2.1.1 CSR Bit Definitions

BIT 15 - CHANNEL OPERATION COMPLETE*. This bit will be set when the DMA operation is complete. If interrupts are enabled, an interrupt will be generated at this time.

*NOTICE

IF SET, CSR BIT 15 AND CSR BIT 12 MUST BE CLEARED BEFORE ANOTHER DMA OPERATION CAN BE STARTED. THESE BITS MAY BE CLEARED BY WRITING A "ONE" TO EACH BIT THAT IS SET. THE FOLLOWING 68000 INSTRUCTION WILL ACCOMPLISH THIS WITHOUT TESTING EACH OF THE BITS. THE OTHER BITS IN THE CSR ARE UNAFFECTED BY A WRITE.

MOVE. B CSR,CSR

Table 4.1-1. VMIVME-DR11W-A Register Address Map

HEX ADDRESS	ACRONYM	REGISTER NAME	PHYSICAL LOCATION
00	CSR	Channel Status Register	SCB68430 DMAI, U42, Sheet 3
01	CER	Channel Error Register	SCB68430 DMAI, U42, Sheet 3
04	DCR	Device Control Register	SCB68430 DMAI, U42, Sheet 3
05	OCR	Operation Control Register	SCB68430 DMAI, U42, Sheet 3
06	SCR*	Sequence Control Register	SCB68430 DMAI, U42, Sheet 3
07	CCR	Channel Control Register	SCB68430 DMAI, U42, Sheet 3
0A	MTCH	Memory Transfer Count High	SCB68430 DMAI, U42, Sheet 3
0B	MTCL	Memory Transfer Count Low	SCB68430 DMAI, U42, Sheet 3
0C	MACH*	Memory Address Count High	SCB68430 DMAI, U42, Sheet 3
0D	MACMH	Memory Address Count Mid-High	SCB68430 DMAI, U42, Sheet 3
0E	MACML	Memory Address Count Mid-Low	SCB68430 DMAI, U42, Sheet 3
0F	MACL	Memory Address Count Low	SCB68430 DMAI, U42, Sheet 3
25	DIVR	DMA Interrupt Vector Register	SCB68430 DMAI, U42, Sheet 3
27	IVR***	Interrupt Vector Register	SCB68430 DMAI, U42, Sheet 3
2D	CPR*	Channel Priority Register	SCB68430 DMAI, U42, Sheet 3
41	CR0**	Channel Register 0	MC68153 BIM, U57, Sheet 12
43	EICR (CR1)	Error Interrupt Control Register	MC68153 BIM, U57, Sheet 12
45	AICR (CR2)	Attention Interrupt Control Register	MC68153 BIM, U57, Sheet 12
47	DICR (CR3)	DMA Interrupt Control Register	MC68153 BIM, U57, Sheet 12
49	VR0**	Vector Register 0	MC68153 BIM, U57, Sheet 12
4B	EIVR (VR1)	Error Interrupt Vector Register	MC68153 BIM, U57, Sheet 12
4D	AIVR (VR2)	Attention Interrupt Vector Register	MC68153 BIM, U57, Sheet 12
4F	VR3**	Vector Register 3	MC68153 BIM, U57, Sheet 12
60	BCRH	Board Control Register High	U11, Sheet 25
61	BCRL	Board Control Register Low	U10 & U17, Sheet 25
62	IODRH	I/O Data Register High (16-Bit)	U18, Sheet 26, & U16, Sheet 28
63	IODRL	I/O Data Register Low (16-Bit)	U19, Sheet 26, & U15, Sheet 28
64	EMAR	Extended Memory Address Register	U65, Sheet 11
65	AMR	Address Modifier Register	U43, Sheet 11
66	MCR	Master Control Register	U32 & U56, Sheet 24
69	BSR	Board Status Register	U34, Sheet 24
6A	SCRQ	Set Cycle Request Command	U24, Sheet 10
6B			
6C	LDIDR	Load Input Data Register	U41, Sheet 21
6D			
70	ODR	Output Data Register (32-Bit)	U18, U19, Sheet 26 & U25, U26, Sheet 27
78	IDR	Input Data Register (32-Bit)	U21, U22, Sheet 29
7A			U15, U16, Sheet 28

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*Included for software compatibility.

**Register is not used.

***The IVR has two addresses for software compatibility (see SCB68430 Spec Sheet).

Table 4.2-1. DMA Interface (SCB68430) Register Bit Formats

CHANNEL STATUS REGISTER (\$\$XX00)** (\$XXXX00)*** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
CSR	CHANNEL OPERATION COMPLETE	NOT USED	NORMAL DEVICE TERMINATE	ERROR	CHANNEL ACTIVE	NOT USED	NOT USED	READY INPUT STATE
	0=NO 1=YES	(0)	(1)	0=NO 1=YES	0=NO 1=YES	(0)	(0)	0=0 V 1=3.5 V*

*Initialized to logic "one" at power-up. **Short I/O Address. ***Standard Address.

CHANNEL ERROR REGISTER (\$XX01)* (\$XXXX01)** (READ)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
CER	NOT USED	NOT USED	NOT USED	ERROR CODE				
	(0)	(0)	(0)	0000=NO ERROR 01001=BUS ERROR 10001=SOFTWARE ABORT				

*Short I/O Address. **Standard Address.

DEVICE CONTROL REGISTER (\$XX04)** (\$XXXX04)*** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
DCR	EXTERNAL REQUEST MODE	NOT USED	NOT USED	NOT USED	DATA SIZE	NOT USED	NOT USED	NOT USED
	0=BURST 1=CYCLE STEAL	(0)	(1)	(1)	*	(0)	(0)	(0)

*Should be programmed as a "zero" if the operand size (see Operation Control Register (OCR), bits 4 and 5) is BYTE, otherwise should be programmed as a "one". **Short I/O Address. ***Standard Address.

OPERATION CONTROL REGISTER (\$XX05)** (\$XXXX05)*** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
OCR	DIRECTION	NOT USED	OPERAND SIZE		NOT USED	NOT USED	NOT USED	NOT USED
	0=MEM TO DEV 1=DEV TO MEM		00=BYTE 01=WORD 10=LONGWORD* 11=32-BIT WORD		(0)	(0)	(1)	(0)

*Not applicable to the VMIVME-DR11W-A. **Short I/O Address. ***Standard Address.

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Table 4.2-1. DMA Interface (SCB68430) Register Bit Formats (Continued)

SEQUENCE CONTROL REGISTER (\$XX06)** (\$XXXX06)*** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
SCR*	NOT USED*							
	(0)	(0)	(0)	(0)	(0)	(0)	(0)	(0)

*Dummy register. **Short I/O Address. ***Standard Address.

CHANNEL CONTROL REGISTER (\$XX07)* (\$XXXX07)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
CCR	START	NOT USED	NOT USED	SOFTWARE ABORT	INTERRUPT ENABLE	NOT USED	NOT USED	NOT USED
	0=NO 1=YES	(0)	(0)	0=NO 1=YES	0=NO 1=YES	(0)	(0)	(0)

*Short I/O Address. **Standard Address.

MEMORY TRANSFER COUNT HIGH (\$XX0A)* (\$XXXX0A)** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
MTCH	MEMORY TRANSFER COUNT MSB							
	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8

*Short I/O Address. **Standard Address.

MEMORY TRANSFER COUNT LOW (\$XX0B)* (\$XXXX0B)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
MTCL	MEMORY TRANSFER COUNT LSB							
	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0

*Short I/O Address. **Standard Address.

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Table 4.2-1. DMA Interface (SCB68430) Register Bit Formats (Continued)

MEMORY ADDRESS COUNTER HIGH (\$XX0C)** (\$XXXX0C)*** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
MACH	NOT USED*							
	(0)	(0)	(0)	(0)	(0)	(0)	(0)	(0)

*Dummy register. **Short I/O Address. ***Standard Address.

MEMORY ADDRESS COUNTER MID-HIGH (\$XX0D)* (\$XXXX0D)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
MACMH	MEMORY ADDRESS COUNTER							
	BIT 23	BIT 22	BIT 21	BIT 20	BIT 19	BIT 18	BIT 17	BIT 16

*Short I/O Address. **Standard Address.

MEMORY ADDRESS COUNTER MID-LOW (\$XX0E)* (\$XXXX0E)** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
MACML	MEMORY ADDRESS COUNTER							
	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8

*Short I/O Address. **Standard Address.

MEMORY ADDRESS COUNTER LOW (\$XX0F)* (\$XXXX0F)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
MACL	MEMORY ADDRESS COUNTER							
	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0

*Short I/O Address. **Standard Address.

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Table 4.2-1. DMA Interface (SCB68430) Register Bit Formats (Concluded)

DMA INTERRUPT VECTOR REGISTER (\$XX25, \$XX27)** (\$XXXX25, \$XXXX27)*** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
DIVR	DONE INTERRUPT VECTOR							
	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0 *

*This bit is automatically set if an error occurred. This register is mapped to two locations to provide compatibility with other controllers. **Short I/O Address. ***Standard Address.

CHANNEL PRIORITY REGISTER (\$XX2D)** (\$XXXX2D)*** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
CPR	NOT USED*							
	(0)	(0)	(0)	(0)	(0)	(0)	(0)	(0)

*Dummy register. **Short I/O Address. ***Standard Address.

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BIT 14, BIT 13 - NOT USED.

BIT 12 - ERROR (See Notice). This bit will be set if the DMA operation was terminated due to an error condition.

BIT 11 - CHANNEL ACTIVE. This bit indicates that a DMA operation is in progress. It is automatically cleared upon termination of the operation.

BITS 10, 9 - NOT USED.

BIT 8 - READY INPUT. This bit indicates the state of the RDY input signal. A logic "zero" indicates an asserted RDY input signifying that data is ready.

4.2.1.2 CER Bit Definitions

BITS 7, 6, 5 - NOT USED.

BITS 4, 3, 2, 1, 0 - ERROR CODE. These five bits indicate the error type when an error occurs. This register is cleared when the error bit (CSR BIT 12) is cleared.

ERROR CODE	FUNCTION
00000	No Error
01001	Bus Error
10001	Software Abort

4.2.2 Device Control Register (DCR)/Operation Control Register (OCR)

These two registers control the data direction, data size, and request mode of the DMA transfers.

4.2.2.1 DCR Bit Definitions

BIT 15 - EXTERNAL REQUEST MODE. This bit is set to perform single cycle transfers and is cleared to perform burst transfers.

BITS 14, 13, 12 - NOT USED.

NOTICE

IF SET, CSR BIT 15 AND CSR BIT 12 MUST BE CLEARED BEFORE ANOTHER DMA OPERATION CAN BE STARTED. THESE BITS MAY BE CLEARED BY WRITING A "ONE" TO EACH BIT THAT IS SET. THE FOLLOWING 68000 INSTRUCTION WILL ACCOMPLISH THIS WITHOUT TESTING EACH OF THE BITS. *THE OTHER BITS IN THE CSR ARE UNAFFECTED BY A WRITE.*

MOVE. B CSR,CSR

BIT 11 - DATA SIZE. This bit is read and written as the Logical "OR" of bits 4 and 5 in the Operation Control Register (OCR).

BITS 10, 9, 8 - NOT USED.

4.2.2.2 OCR Bit Definitions

BIT 7 - DIRECTION. This bit contains the DMA transfer direction.

- 0 = Read from Memory
 Write to External Device
- 1 = Write to Memory
 Read from External Device

BIT 6 - NOT USED.

BITS 5, 4 - OPERAND SIZE. These bits control the operand size.

BIT 5	BIT 4	OPERAND SIZE
0	0	BYTE
0	1	WORD
1	0	DUAL 16-BIT*
1	1	LONGWORD (32-BIT PER TRANSFER)

*The VMIVME-DR11W-A does not support dual 16-bit operations.

BITS 3, 2, 1, 0 - NOT USED.

4.2.3 Sequence Control Register (SCR)

The SCR is a dummy register provided for compatibility with other DMA controllers.

BITS 15 THROUGH 8 - NOT USED (Dummy Register).

4.2.4 Channel Control Register (CCR)

BIT 7 - START. This bit causes the DMA controller to start its operation. This bit must be set before the GO bit is set in the Board Control Register (BCR).

BITS 6, 5 - NOT USED.

BIT 4 - SOFTWARE ABORT. This bit allows current DMA operation to be aborted under software control. It sets the error bit in the CSR and the error code in the CER. The software abort bit must be cleared in order to clear the error bit in the CSR and the error code in the CER (refer to the following Software Abort Procedure).

Software Abort Procedure:

To abort an in-process DMA, perform the following steps:

STEP 1: Set bit 4 of the Channel Control Register (CCR, \$0007) to a logic "one". Maintain bits 3 and 7 according to the desired control state.

STEP 2: Read the Channel Status Register (CSR, \$0000) until bit 15 (operation complete) and bit 12 (error) are both equal to a logic "one", indicating a DMA complete with error.

STEP 3: Read the Channel Error Register to obtain the error condition for the DMA complete with error. Reset the software abort bit (bit 4), (CCR, \$0007) to "zero".

NOTE:

THE CHANNEL ERROR REGISTER MUST BE READ WHILE THE ABORT BIT (BIT 4, CCR, \$0007) IS ACTIVE (SET) OR THE CHANNEL ERROR REGISTER WILL INDICATE THE DEFAULT ERROR STATUS (BUS ERROR).

STEP 4: Perform normal DMA termination processing clean-up, resetting all of the CSR status bits to logic "zero" (CSR bit reset requires writing a logic "one" to each bit which is set to a logic "one".)

NOTE:

USE OF BURST MODE PRECLUDES THE USE OF SOFTWARE ABORT, SINCE THE BUS WILL BE RETAINED BY THE DR11W UNTIL THE DMA IS COMPLETED ONCE IT HAS BEEN INITIATED.

BIT 3 - INTERRUPT ENABLE. This bit enables the DMA interrupt request when a DMA operation is completed.

BITS 2, 1, 0 - NOT USED.

4.2.5 Memory Transfer Count (MTC) Registers

The two MTC registers, Memory Transfer Count High (MTCH) and Memory Transfer Count Low (MTCL), hold the number of desired transfers for the current operation. The transfer count can be set to FFFF (64 Ktransfers-1). The

"DONE" (Last TRANSFER Flag) signal is used to terminate the transfers in this case. However, setting the transfer counter to FFFF does cause an extra memory cycle to be requested beyond the actual word count (only if a read from memory). This should not be a problem unless it happens to be at the end of memory, in which case a bus error trap will be generated.

4.2.6 Memory Address Counter (MAC) Registers

The four MAC registers, Memory Address Count High (MACH), Memory Address Count Mid-High (MACMH), Memory Address Count Mid-Low (MACML), and Memory Address Count Low (MACL), hold the memory address for the DMA operation. The MACH Register is a dummy register and is provided for compatibility with other DMA set controllers. The other three implemented registers provide a 24-bit memory address for the DMA transfers. These registers should be loaded with the starting memory address before an operation is started. These registers are incremented during operation and may be read while an operation is in progress.

4.2.7 DMA Interrupt Vector Register (DIVR)

This register is used to store the interrupt vector used for the DMA complete (done) interrupt. This register is resident inside the SCB68430. It is mapped to two locations to provide compatibility with other DMA controllers. Note: Bit 0 is automatically set when an error occurs, and cannot be written. Thus, a DMA interrupt vector for normal conditions must be even and the error vector is automatically the next highest odd vector. Note that although the SCB68430 supplies the interrupt vector, the MC68153 provides the interrupt handshake; therefore, the MC68153 must be programmed to handle the external vector from the SCB68430 (i.e., bit 5 of the SCB68153's DMA Interrupt Control Register (DICR) must be set to a logic "one").

4.2.8 Channel Priority Register (CPR)

This register is a dummy register provided for compatibility with other DMA controllers.

4.3 PROGRAMMING THE MC68153 BIM

The MC68153 contains eight read/write registers. These registers include four Interrupt Control Registers (ICRs) that govern BIM operation and four Interrupt Vector Registers (IVRs) in which vector data are stored for use during an interrupt cycle. Each interrupt source is assigned a Control Register (CR0 to CR3) and a Vector Register (VR0 to VR3). The BIM Control Register assignments for the VMIVME-DR11W-A are as follows:

BIM CR CONTROL REGISTER ASSIGNMENT

0	Not Used
1	Error Interrupt Control Register (EICR)
2	Attention Interrupt Control Register (AICR)
3	DMA Interrupt Control Register (DICR)

The BIM Vector Register assignments are as follows. The register that would normally be assigned to be the DMA Interrupt Vector Register, VR3, is not used since the Interrupt Vector for the DMA complete (done) interrupt is supplied by the SCB68430 DMAI's DMA Interrupt Vector Register as described in Section 4.2.

BIM VR VECTOR REGISTER ASSIGNMENT

0	Not Used
1	Error Interrupt Vector Register (EIVR)
2	Attention Interrupt Vector Register (AIVR)
3	Not used

The register formats for these BIM CRs and VRs are detailed in Table 4.3-1, and the register bit descriptions are in the following paragraphs. Refer to the MC68153 data sheet contained in Appendix B for additional detailed operation and programming information for the BIM.

4.3.1 Error Interrupt Control Register (EICR) **Attention Interrupt Control Register (AICR)** **DMA Interrupt Control Register (DICR)**

Each of the registers controls an interrupt source. The three registers are identical and are each divided into six fields as follows:

BITS 7 AND 6 - FLAG CONTROL - Not Used

BIT 5 - VECTOR LOCATION. This bit should be cleared so that the MC68153 may use its internal vector register for an interrupt acknowledge and set to use an external interrupt vector. For the VMIVME-DR11W-A, this bit should be cleared in all control registers except for the DMA Interrupt Control Register (DICR); it should be set in the DICR because an external vector is generated by the SCB68430 DMA Controller Vector Register (DIVR).

Table 4.3-1. Bus Interrupt Module (MC68153) Register Bit Formats

ERROR INTERRUPT CONTROL REGISTER (\$XX43)* (\$XXXX43)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
EICR	FLAG BIT	FLAG BIT AUTO CLEAR	VECTOR 0=INT 1=EXT	INTERRUPT ENABLE	INTERRUPT AUTO CLEAR	IRQ LEVEL 2	IRQ LEVEL 1	IRQ LEVEL 0

*Short I/O Address. **Standard Address.

ATTENTION INTERRUPT CONTROL REGISTER (\$XX45)* (\$XXXX45)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
AICR	FLAG BIT	FLAG BIT AUTO CLEAR	VECTOR 0=INT 1=EXT	INTERRUPT ENABLE	INTERRUPT AUTO CLEAR	IRQ LEVEL 2	IRQ LEVEL 1	IRQ LEVEL 0

*Short I/O Address. **Standard Address.

DMA INTERRUPT CONTROL REGISTER (\$XX47)* (\$XXXX47)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
DICR	FLAG BIT	FLAG BIT AUTO CLEAR	VECTOR 0=INT 1=EXT	INTERRUPT ENABLE	INTERRUPT AUTO CLEAR	IRQ LEVEL 2	IRQ LEVEL 1	IRQ LEVEL 0

*Short I/O Address. **Standard Address.

ERROR INTERRUPT VECTOR REGISTER (\$XX4B)* (\$XXXX4B)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
EIVR	INTERRUPT VECTOR							
	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0

*Short I/O Address. **Standard Address.

ATTENTION INTERRUPT VECTOR REGISTER (\$XX4D)* (\$XXXX4D)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
AIVR	ATTENTION INTERRUPT VECTOR							
	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0

*Short I/O Address. **Standard Address.

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BIT 4 - INTERRUPT ENABLE. This bit should be set to enable the corresponding interrupt.

BIT 3 - INTERRUPT AUTO CLEAR. This bit automatically clears the interrupt enable bit and the interrupt request output whenever the interrupt is acknowledged. It must be set in all control registers to provide VMEbus compatible timing; therefore, the interrupt enable bit is to be set after each interrupt.

BITS 2, 1, 0 - IRQ LEVEL BITS. These bits determine the interrupt level at which an interrupt request is made.

<u>LEVEL</u>	<u>BIT 2</u>	<u>BIT 1</u>	<u>BIT 0</u>
7	1	1	1
6	1	1	0
5	1	0	1
4	1	0	0
3	0	1	1
2	0	1	0
1	0	0	1
DISABLED	0	0	0

4.3.2 Error Interrupt Vector Register (EIVR) Attention Interrupt Vector Register (AIVR)

These registers have identical formats, and should be programmed to contain the vectors used for the associated interrupts. Any 8-bit integer may be used as determined by the system vector address configuration.

BITS 7 TO 0 - VECTOR ADDRESS BITS. These bits determine the 8-bit vector address for each associated interrupt.

4.4 PROGRAMMING THE ON-BOARD REGISTERS

There are eight additional sets of on-board registers listed in Table 4.1-1. Also included in the table are two special commands that support BIT (Built-in-Test) functions. The VMIVME-DR11W-A "on-board" register group consists of the Board Control Register (BCR), the VMIVME-DR11W compatible 16-bit I/O Data Register, the Extended Memory Address Register (EMAR), the Address Modifier Register (AMR), the Master Control Register (MCR), the Board Status Register (BSR), the 32-bit Output Data Register (ODR), and the 32-bit Input Data Register (IDR). The two special commands are the Load Input Data Register (LDIDR) and the Set Cycle Request (SCRQ) commands. Table 4.4-1 defines the On-Board Register bit formats for each of these registers. The On-Board Register set and the two special commands are further described in the following paragraphs.

Table 4.4-1. On-Board Register Bit Formats

BOARD CONTROL REGISTER (\$XX60)* (\$XXXX60)** (READ/WRITE)

BOARD CONTROL REGISTER HI (\$XX60)* (\$XXXX60)**

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
BCRH	STATUS C READ ONLY	STATUS B READ ONLY	STATUS A READ ONLY	BURST REQUEST READ ONLY	C1 READ ONLY	ATTN READ ONLY	CLR GO BIT WRITE ONLY	MASTER RESET WRITE ONLY

BOARD CONTROL REGISTER LO (\$XX61)* (\$XXXX61)** - COMMAND***

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
BCRL	FNCT 3	FNCT 2	FNCT 1	RESERVE	LED CONTROL 0 = ON 1 = OFF	ENABLE ATTN INTERRUPT	CYCLE	GO

***Do not use a read-modify-write instruction (e.g., bit clear) when writing to the Board Control Register.

DR11W-A 16-BIT INPUT/OUTPUT DATA REGISTER (\$XX62)* (\$XXXX62)**
(WORD READ/WRITE) WITH NO BYTE-SWAP SET***

I/O DATA REGISTER HI (\$XX62)* (\$XXXX62)**

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
IODRH	I/O DATA							
	D15	D14	D13	D12	D11	D10	D9	D8

I/O DATA REGISTER LO (\$XX63)* (\$XXXX63)**

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
IODRL	I/O DATA							
	D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/1

*Short I/O Address

**Standard I/O Address

***Bit 6 (LONGWORD) of the AMR must be maintained to a logic "one" during 16-bit transfers utilizing the IODR.

Table 4.4-1. On-Board Register Bit Formats (Continued)

DR11W-A 16-BIT INPUT/OUTPUT DATA REGISTER (\$XX62)* (\$XXXX62)** AS READ WITH BYTE-SWAP SET***

I/O DATA REGISTER HI (\$XX62)* (\$XXXX62)**

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
IODRH	I/O DATA							
	D7	D6	D5	D4	D3	D2	D1	D0

I/O DATA REGISTER LO (\$XX63)* (\$XXXX63)**

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
IODRL	I/O DATA							
	D15	D14	D13	D12	D11	D10	D9	D8

EXTENDED MEMORY ADDRESS REGISTER (\$XX64)* (\$XXXX64)** (READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
EMAR	EXTENDED MEMORY ADDRESS (VMEbus A31 THROUGH A24 DURING DMA TRANSFERS)							
	BIT 31	BIT 30	BIT 29	BIT 28	BIT 27	BIT 26	BIT 25	BIT 24

ADDRESS MODIFIER REGISTER (\$XX65)* (\$XXXX65)** (READ/WRITE)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
AMR	NOT USED	LONGWORD	ADDRESS MODIFIER					
		***	AM5	AM4	AM3	AM2	AM1	AM0

MDR11W-A/T4.4-1/2

*Short I/O Address

**Standard I/O Address

***Bit 6 (LONGWORD) of the AMR must be maintained to a logic "one" during 16-bit transfers utilizing the IODR.

Table 4.4-1. On-Board Register Bit Formats (Continued)

MASTER CONTROL REGISTER HI (\$XX66)* (\$XXXX66)** (WORD READ/WRITE)

	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
MCRH	NOT USED	ENABLE PROGRM SET CYC REQ	NOT USED	NOT USED	NOT USED	NOT USED	ENABLE ERROR IRQ	ENABLE WDT

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
MCRL	ENABLE PROG LD IN DTA REG	DISABLE CLK & RD INPUT REG	SET TEST MODE IN	SET TEST MODE OUT	SET INPUT WORD SWAP	SET INPUT BYTE SWAP	SET OUTPUT WORD SWAP	SET OUTPUT BYTE SWAP

BOARD STATUS REGISTER (\$XX69)* (\$XXXX69)** (BYTE READ)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
BSR	0	0	0	OTHER SIDE RDY FOR XFER	SET OUT CYCLE REQ	INPUT DATA READY	BUS T.O. ERR	WDT T.O. ERR

SET CYCLE REQUEST (DUMMY REGISTER) (\$XX6A)* (\$XXXX6A)** (WRITE ONLY)

	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
SCRQ	X	X	X	X	X	X	X	X

*Short I/O Address

**Standard I/O Address

MDR11W-A/T4.4-1/3

Table 4.4-1. On-Board Register Bit Formats (Continued)

LOAD INPUT DATA REGISTER (\$XX6C)* (\$XXXX6C)** (WRITE ONLY)

WORD WRITE

LDIDR							
BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
INPUT DATA REGISTER							
D15	D14	D13	D12	D11	D10	D9	D8
BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
INPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/4

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

LOAD INPUT DATA REGISTER (\$XX6C)* (\$XXXX6C)** (WRITE ONLY) WITH WORD-SWAP NOT SET

FIRST LONGWORD WRITE LOADS IDR BITS 31 TO 16 WITH DATA BITS D31 TO D16

LDIDR	BIT 31 BIT 30 BIT 29 BIT 28 BIT 27 BIT 26 BIT 25 BIT 24							
	INPUT DATA REGISTER							
	D31	D30	D29	D28	D27	D26	D25	D24

BIT 23 BIT 22 BIT 21 BIT 20 BIT 19 BIT 18 BIT 17 BIT 16							
INPUT DATA REGISTER							
D23	D22	D21	D20	D19	D18	D17	D16

SECOND LONGWORD WRITE LOADS IDR BITS 15 TO 0 WITH DATA BITS D15 TO D0

LDIDR	BIT 15 BIT 14 BIT 13 BIT 12 BIT 11 BIT 10 BIT 9 BIT 8							
	INPUT DATA REGISTER							
	D15	D14	D13	D12	D11	D10	D9	D8

BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0							
INPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/5

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

LOAD INPUT DATA REGISTER (\$XX6C)* (\$XXXX6C)** (WRITE ONLY) WITH WORD-SWAP SET

FIRST LONGWORD WRITE LOADS IDR BITS 15 TO 0 WITH DATA BITS D31 TO D16

LDIDR	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
	INPUT DATA REGISTER							
	D31	D30	D29	D28	D27	D26	D25	D24

BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
INPUT DATA REGISTER							
D23	D22	D21	D20	D19	D18	D17	D16

SECOND LONGWORD WRITE LOADS IDR BITS 31 TO 16 WITH DATA BITS D15 TO D0

LDIDR	BIT 31	BIT 30	BIT 29	BIT 28	BIT 27	BIT 26	BIT 25	BIT 24
	INPUT DATA REGISTER							
	D15	D14	D13	D12	D11	D10	D9	D8

BIT 23	BIT 22	BIT 21	BIT 20	BIT 19	BIT 18	BIT 17	BIT 16
INPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/6

*Short I/O Address
 **Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

DR11W-A 32-BIT OUTPUT DATA REGISTER (\$XX70)* (\$XXXX70)**

LONGWORD ONLY (WRITE)

ODR	BIT 31	BIT 30	BIT 29	BIT 28	BIT 27	BIT 26	BIT 25	BIT 24
	OUTPUT DATA							
	D31	D30	D29	D28	D27	D26	D25	D24

BIT 23	BIT 22	BIT 21	BIT 20	BIT 19	BIT 18	BIT 17	BIT 16
OUTPUT DATA							
D23	D22	D21	D20	D19	D18	D17	D16

BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
OUTPUT DATA							
D15	D14	D13	D12	D11	D10	D9	D8

BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
OUTPUT DATA							
D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/7

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

32-BIT OUTPUT DATA REGISTER (\$XX70)* (\$XXXX70)** WITH NO WORD-SWAP SET, NO BYTE-SWAP SET

FIRST WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D31	D30	D29	D28	D27	D26	D25	D24

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D23	D22	D21	D20	D19	D18	D17	D16

SECOND WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D15	D14	D13	D12	D11	D10	D9	D8

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/8

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

32-BIT OUTPUT DATA REGISTER (\$XX70)* (\$XXXX70)** WITH NO WORD-SWAP SET, NO BYTE-SWAP SET

FIRST WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D15	D14	D13	D12	D11	D10	D9	D8

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

SECOND WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D31	D30	D29	D28	D27	D26	D25	D24

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D23	D22	D21	D20	D19	D18	D17	D16

MDR11W-A/T4.4-1/9

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

32-BIT OUTPUT DATA REGISTER (\$XX70)* (\$XXXX70)** WITH NO WORD-SWAP SET,
BYTE-SWAP SET

FIRST WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D23	D22	D21	D20	D19	D18	D17	D16

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D31	D30	D29	D28	D27	D26	D25	D24

SECOND WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D15	D14	D13	D12	D11	D10	D9	D8

MDR11W-A/T4.4-1/10

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

32-BIT OUTPUT DATA REGISTER (\$XX70)* (\$XXXX70)** WITH WORD-SWAP SET,
BYTE-SWAP SET

FIRST WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D7	D6	D5	D4	D3	D2	D1	D0

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D15	D14	D13	D12	D11	D10	D9	D8

SECOND WORD OUTPUT TO CABLE

DO 15	DO 14	DO 13	DO 12	DO 11	DO 10	DO 9	DO 8
FROM OUTPUT DATA REGISTER							
D23	D22	D21	D20	D19	D18	D17	D16

DO 7	DO 6	DO 5	DO 4	DO 3	DO 2	DO 1	DO 0
FROM OUTPUT DATA REGISTER							
D31	D30	D29	D28	D27	D26	D25	D24

MDR11W-A/T4.4-1/11

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

DR11W-A 32-BIT INPUT DATA REGISTER (\$XX78)* (\$XXXX78)**

NO WORD-SWAP SET, NO BYTE-SWAP SET (LONGWORD READ ONLY)

		BIT 31	BIT 30	BIT 29	BIT 28	BIT 27	BIT 26	BIT 25	BIT 24
IDR	INPUT DATA WORD 1 (READ ONLY)								
	D15	D14	D13	D12	D11	D10	D9	D8	
		BIT 23	BIT 22	BIT 21	BIT 20	BIT 19	BIT 18	BIT 17	BIT 16
	INPUT DATA WORD 1 (READ ONLY)								
	D7	D6	D5	D4	D3	D2	D1	D0	
		BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
	INPUT DATA WORD 2 (READ ONLY)								
	D15	D14	D13	D12	D11	D10	D9	D8	
		BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
	INPUT DATA WORD 2 (READ ONLY)								
	D7	D6	D5	D4	D3	D2	D1	D0	

MDR11W-A/T4.4-1/12

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

DR11W-A 32-BIT INPUT DATA REGISTER (\$XX78)* (\$XXXX78)**

WORD-SWAP SET, BYTE-SWAP SET (LONGWORD READ ONLY)

IDR	BIT 31	BIT 30	BIT 29	BIT 28	BIT 27	BIT 26	BIT 25	BIT 24
	INPUT DATA WORD 2 (READ ONLY)							
	D15	D14	D13	D12	D11	D10	D9	D8

BIT 23	BIT 22	BIT 21	BIT 20	BIT 19	BIT 18	BIT 17	BIT 16
INPUT DATA WORD 2 (READ ONLY)							
D7	D6	D5	D4	D3	D2	D1	D0

BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
INPUT DATA WORD 1 (READ ONLY)							
D15	D14	D13	D12	D11	D10	D9	D8

BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
INPUT DATA WORD 1 (READ ONLY)							
D7	D6	D5	D4	D3	D2	D1	D0

MDR11W-A/T4.4-1/13

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Continued)

DR11W-A 32-BIT INPUT DATA REGISTER (\$XX78)* (\$XXXX78)**

NO WORD-SWAP SET, BYTE-SWAP SET (LONGWORD READ ONLY)

IDR	BIT 31	BIT 30	BIT 29	BIT 28	BIT 27	BIT 26	BIT 25	BIT 24
	INPUT DATA WORD 1 (READ ONLY)							
	D7	D6	D5	D4	D3	D2	D1	D0
	BIT 23	BIT 22	BIT 21	BIT 20	BIT 19	BIT 18	BIT 17	BIT 16
	INPUT DATA WORD 1 (READ ONLY)							
	D15	D14	D13	D12	D11	D10	D9	D8
	BIT 15	BIT 14	BIT 13	BIT 12	BIT 11	BIT 10	BIT 9	BIT 8
	INPUT DATA WORD 2 (READ ONLY)							
	D7	D6	D5	D4	D3	D2	D1	D0
	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
	INPUT DATA WORD 2 (READ ONLY)							
	D15	D14	D13	D12	D11	D10	D9	D8

MDR11W-A/T4.4-1/14

*Short I/O Address

**Standard I/O Address

Table 4.4-1. On-Board Register Bit Formats (Concluded)

DR11W-A 32-BIT INPUT DATA REGISTER (\$XX78)* (\$XXXX78)**

WORD-SWAP SET, BYTE-SWAP SET (LONGWORD READ ONLY)

IDR	BIT 31 BIT 30 BIT 29 BIT 28 BIT 27 BIT 26 BIT 25 BIT 24							
	INPUT DATA WORD 2 (READ ONLY)							
	D7	D6	D5	D4	D3	D2	D1	D0

BIT 23 BIT 22 BIT 21 BIT 20 BIT 19 BIT 18 BIT 17 BIT 16							
INPUT DATA WORD 2 (READ ONLY)							
D15	D14	D13	D12	D11	D10	D9	D8

BIT 15 BIT 14 BIT 13 BIT 12 BIT 11 BIT 10 BIT 9 BIT 8							
INPUT DATA WORD 1 (READ ONLY)							
D7	D6	D5	D4	D3	D2	D1	D0

BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0							
INPUT DATA WORD 1 (READ ONLY)							
D15	D14	D13	D12	D11	D10	D9	D8

MDR11W-A/T4.4-1/15

*Short I/O Address

**Standard I/O Address

4.4.1 Board Control Register (BCR)

The BCR is a 16-bit Status and Control Register that is used to communicate with the external DR11W compatible device via the interface status and control signals over the interface cable. While the upper eight bits of the BCR, BCRH, are not affected, all eight of the lower BCR bits, BCRL, are reset to logic "zero" by the Master Reset Command.

4.4.1.1 BCRH (BCR High) Bit Descriptions

BIT 15 - STATUS C. This bit is user-defined. It indicates the state of the FNCT 1 bit of the other DR11W device in BACK-TO-BACK MODE.

STATUS C	OTHER DR11W
0	Transmitter
1	Receiver

BIT 14 - STATUS B. This bit is user-defined. It indicates the state of the other DR11WA's FNCT 2 bit in BACK-TO-BACK MODE.

BIT 13 - STATUS A. This bit is user-defined. It indicates the state of the other DR11W's FNCT 3 bit in BACK-TO-BACK MODE.

STATUS A	OTHER DR11W
0	Burst Transfers
1	Normal (Single Cycle) Transfers

BIT 12 - BURST REQUEST. This bit indicates the state of the request line. In the BACK-TO-BACK MODE, it is the same as STATUS A.

BIT 11 - C1. This bit indicates the state of the C1 line. In the BACK-TO-BACK MODE, C1 is controlled by FUNCTION 1 of the same board.

C1	PROGRAM OCR BIT 5	THIS DR11W
0	0	Transmitter
1	1	Receiver

BIT 10 - ATTN. This bit indicates the state of the ATTN line. In BACK-TO-BACK MODE, it is the same as Status B. A positive edge on the ATTN input will generate an interrupt (if enabled); therefore, the other DR11W can generate an interrupt by pulsing the ATTN line.

BIT 9 - CLR GO BIT (CLEAR GO BIT). When set to a logic "one", this bit clears the state of the GO BIT to a logic "zero". This write only bit is not stored and does not need to be reset to "zero".

BIT 8 - MASTER RESET. When set to a logic "one", this bit clears all resettable registers and status on the VMIVME-DR11W-A interface as follows. This bit is a write-only control bit that is not stored, and does not need to be reset to "zero".

Board Control Register - Bits 15 through 10, Not Affected;
9, Momentarily Asserted; 8, This Bit
Momentarily Asserted; 7 Through 0, Cleared.

I/O Data Register High/Low - Not Affected
Extended Memory Address Register - All Bits
Address Modifier Register - All Bits
Master Control Register - All Bits
Board Status Register - All Bits
Output Data Register - Not Affected
Input Data Register - Not Affected

4.4.1.2 **BCRL (BCR Low) Bit Descriptions**

BIT 7 - FUNCTION 3. This bit is user-defined. It drives the STATUS A and BURST RQ lines of the other DR11W in BACK-TO-BACK MODE.

FNCT 1	TELLS OTHER DR11W TO USE
0	Burst Transfers
1	Normal (Single Cycle) Transfers

BIT 6 - FUNCTION 2. This bit is user-defined. It drives the STATUS B and ATTN lines of the other DR11W in BACK-TO-BACK MODE. It can be pulsed high to generate an attention interrupt.

BIT 5 - FUNCTION 1. This bit is defined. In the BACK-TO-BACK MODE, it drives its own C1 line and the STATUS C line of the other DR11W.

FNCT 1	THIS VMIVME-DR11W-A
0	Transmitter
1	Receiver

This bit should be the complement of STATUS C.

BIT 4 - RESERVED.

BIT 3 - LED CONTROL (SET FAIL LED LOW). When set to a logic "zero", this bit lights the red light-emitting diode (LED) located on the front panel of the VMIVME-DR11W-A interface board. It is usually used as a Fail LED to signify that the VMIVME-DR11W-A interface has in some way failed. When set to a logic "one", the LED is extinguished, indicating continuing successful operation as defined by the user.

0 = LED ON
1 = LED OFF

BIT 2 - ENABLE ATTN INTERRUPT. This bit is used to control the ATTN interrupt flip-flop. This bit must be set in addition to AICR bit 4 to enable external attention interrupts.

BIT 1 - CYCLE. This bit is used to start the first handshake cycle when the VMIVME-DR11W-A is the transmitter. It may be set at the same time as the GO bit.

BIT 0 - GO. This bit sets up the handshake logic to perform transfers and causes a pulse to be generated on the VMIVME-DR11W-A's GO output. It must be set before the start of each block of transfers. The DMA start bit (bit 7 of CCR) must be set before the GO bit is set.

4.4.2 VMIVME-DR11W-A I/O Data Register (IODR) High/Low*

The 16-bit Input/Output Data Register (IODR) is provided to maintain data register compatibility with the 16-bit I/O Data Register of the VMIVME-DR11W, VMEbus to DR11W Interface board. This register is written by the CPU either when operating as bus master (DMA transfer) or under program control. The outputs of the Output Data Register (ODR) are output 16-bits at a time via high-speed bus drivers toward the external DR11W (or VMIVME-DR11W-A compatible) interface during an output transfer. The IODR must be written at this address (\$XX62) as a 16-bit word only.

* Bit 6 (LONGWORD) of the Address Modifier Register (AMR) must be maintained to a logic "one" during 16-bit transfers.

The 16-bit IODR may be read under DMA control or program control. It is capable of 16-bit word transfers only. The Input Data Register receives and stores the data that are transferred from the external DR11W (or VMIVME-DR11W-A compatible) interface during an input transfer.

BITS 15 THROUGH 0 - I/O DATA D15 THROUGH D0. (Input/Output Data bits D15 through D0).

4.4.3 Extended Memory Address Register (EMAR)

The EMAR, a read/write register, holds bits A24 through A31 of VMEbus addresses for DMA transfers. It is resettable under program control using the Master Reset command or at power-up by the SYSRESET VMEbus signal. It must be loaded when the Address Modifier Register selects an extended address. The contents of this register may be examined with a read at any time under program control by the VMEbus CPU.

BITS 15 THROUGH 8 - EMA BIT 31 THROUGH EMA BIT 24.

EMA bits 31 through 24 correspond to VMEbus address bits A31 through A24.

4.4.4 Address Modifier Register (AMR)*

The AMR is a read/write register that stores the address modifier and longword bits that are asserted while the VMIVME-DR11W-A is bus master. It will be reset by the assertion of the DR11W-A Master Reset command under program control or by the VMEbus signal SYSRESET at power-up.

BIT 7 - Not Used.

BIT 6 - Longword. This bit controls the assertion of the VMEbus LWORDL signal and selects either 8-, 16-, or 32-bit VMEbus transfers. The operand size selected in the OCR bits 4 and 5 (in the SCB68430 at address \$XX05) must be programmed for the same transfer size as shown in the following table:

<u>LONGWORD</u>	<u>TRANSFER SIZE</u>	<u>BITS 5, 4 OF OCR</u>
0	32-Bit	11
1	16-Bit	01
1	8-Bit	00

BITS 5, 4, 3, 2, 1, AND 0 - ADDRESS MODIFIER BITS. These bits drive the VMEbus Address Modifier Bits 5, 4, 3, 2, 1, and 0, respectively, during a DMA transfer. Refer to Table 4.4.4-1 for a description of the VMEbus address modifier codes.

* Bit 6 (LONGWORD) of the Address Modifier Register (AMR) must be maintained to a logic "one" during 16-bit transfers.

Table 4.4.4-1. Address Modifier Codes

HEXADECIMAL CODE	ADDRESS MODIFIER								FUNCTION	DEFINED BY
	5	4	3	2	1	0				
3F	H	H	H	H	H	H			Standard Supervisory Ascending Access	VMEbus Spec
3E	H	H	H	H	H	L			Standard Supervisory Program Access	VMEbus Spec
3D	H	H	H	H	L	H			Standard Supervisory Data Access	VMEbus Spec
3C	H	H	H	H	L	L			Undefined	Reserved
3B	H	H	H	L	H	H			Standard Nonprivileged Ascending Access	VMEbus Spec
3A	H	H	H	L	H	L			Standard Nonprivileged Program Access	VMEbus Spec
39	H	H	H	L	L	H			Standard Nonprivileged Data Access	VMEbus Spec
38	H	H	H	L	L	L			Undefined	Reserved
30-37	H	H	L	X	X	X			Undefined	Reserved
2F	H	L	H	H	H	H			Undefined	Reserved
2E	H	L	H	H	H	L			Undefined	Reserved
2D	H	L	H	H	H	L			Undefined	Reserved
2C	H	L	H	H	L	H			Short Supervisory I/O Access	VMEbus Spec
2B	H	L	H	L	H	H			Undefined	Reserved
2A	H	L	H	L	H	L			Undefined	Reserved
29	H	L	H	L	L	H			Short Nonprivileged Access	Reserved
28	H	L	H	L	L	L			Undefined	Reserved
20-27	H	L	L	X	X	X			Undefined	VEMbus Spec
10-1F	L	H	X	X	X	X			Undefined	Reserved
0F	L	L	H	H	H	H			Extended Supervisory Ascending Access	User
0E	L	L	H	H	H	L			Extended Supervisory Program Access	VMEbus Spec
0D	L	L	H	H	L	H			Extended Supervisory Data Access	VMEbus Spec
0C	L	L	H	H	L	L			Undefined	Reserved
0B	L	L	H	L	H	H			Extended Nonprivileged Ascending Access	VMEbus Spec
0A	L	L	H	L	H	L			Extended Nonprivileged Program Access	VMEbus Spec
09	L	L	H	L	L	H			Extended Nonprivileged Data Access	VMEbus Spec
08	L	L	H	L	L	L			Undefined	Reserved
00-07	L	L	L	X	X	X			Undefined	Reserved

MDR11W-A/T4.4.4-1

4.4.5 Master Control Register (MCR)

The MCR is a 16-bit register that is used to control the transfer activities of the VMIVME-DR11W-A. All bits of the MCR are cleared to a logic "zero" by the assertion of the VMEbus SYS RESET* signal or by the assertion of the Master Reset command via the Board Control Register (BCR).

BIT 15 - Not Used.

BIT 14 - ENABLE PROGRAM SET CYC REQ (Enable Program Set Cycle Request). This bit, if set to a logic "one", enables the program to use the SET CYCLE REQUEST command to assert the Send Next Output Flip-Flop, requesting the next 16-bit output data word (see also paragraph 4.4.8). As long as this bit remains asserted, the Cycle Req A and the Cycle Req B input interface signals will be inhibited from setting the Send Next Output Flip-Flop.

BITS 13, 12, 11, 10 - Not Used.

BIT 9 - ENABLE ERROR IRQ (Enable Error Interrupt Request). This bit, if set to a logic "one", enables the Error Interrupt Request to be set by the assertion of one of the three following error conditions:

Cable WDT Time-out Error (18.3 ms)
 Bus Time-out Error (18.3 ms)
 Bus Error

BIT 8 - ENABLE WDT (Enable Watchdog Timer). This bit, if set, will enable the Watchdog Timer (18.3 ms) to generate either a Cable WDT Time-out Error and an Error Interrupt Request (if enabled), or:

- (a) if the GO BIT is set, and if the VMIVME-DR11W-A is receiving input data from the attached DR11W compatible host interface and, the input data word is not received in the Input Data Register within the Watchdog Time-out period (18.3 ms) from the assertion of the GO BIT, for the first DMA input data transfer request, or from the receipt and storage of the previous input data word, for subsequent DMA input data transfers, or
- (b) if the GO BIT is set and the VMIVME-DR11W-A is outputting data and the next DMA output transfer is not requested by the VMIVME-DR11W-A interface "Cycle" flip-flop and received in the Output Data Register within the Watchdog Time-out Period (18.3 ms) from the previous output cycle, or
- (c) a Bus Time-out Error and an Error Interrupt Request (if enabled), if, while the VMIVME-DR11W-A interface is acting as a VMEbus Master, the DTACK acknowledge signal is not received asserted from the addressed VMEbus slave within the Watchdog Timer Time-out Period

(which begins at the assertion of the VMEbus DATA STROBE* signal by the VMIVME-DR11W-A Master).

BIT 7 - ENABLE PROG LD IN DTA REG (Enable Programmed Load Input Data Register). This bit, when set to a logic "one", enables the program to load the Input Data Register (IDR) by issuing Load Input Data Register commands under program control. Refer to the description of the LOAD INPUT DATA REGISTER COMMAND in paragraph 4.4.7.

BIT 6 - DISABLE CLK & RD INPUT REG (Disable Clock and Read Input Register). Assertion of this bit will disable the programmed I/O CLOCK AND READ INPUT REGISTER mode of operation.

The programmed I/O CLOCK AND READ INPUT REGISTER MODE is the normal mode of program controlled Input Data Register (IDR) read operation. In this mode, the IDR is strobed (clocked) during execution of the Read Input Data Register command and is, therefore, updated (loaded) with the current states of the DI15 through DI00 ribbon-cable interface signals as the read occurs. With the DISABLE CLK & RD INPUT REG bit asserted, the current contents of the Input Data Register (IDR) can be read without being updated to the current interface signal states. Thus, the last value loaded in the IDR by the programmed Load Input Data Register command or by the busy signal from the other VMIVME-DR11W-A compatible interface will not be lost when read under programmed control with the Read Input Data Register command.

With the DISABLE CLK & RD INPUT REG bit not asserted, a test loop can be established consisting of a single DMA output transfer cycle, followed by a Read Input Data Register command (with the GO, SET TEST MODE IN, and SET TEST MODE OUT bits **NOT** asserted) to verify single cycle DMA output operation. While only the interface cable DO15 through DO00 signals need to be wrapped back to the DI15 through DI00 signals for verification in this mode, a full wraparound cable, such as that described later in the BIT 5 description, may be used.

BIT 5 - SET TEST MODE IN. When set to a logic "one", this bit enables programmed control of VMIVME-DR11W-A input functions that would otherwise be prevented from operating while the TRANSMIT MODE is enabled with the FUNCTION 1 bit set to a logic "zero", or while the other board's READY signal is set to a logic "one". This enables the VMIVME-DR11W-A to operate in a program controlled input (receive) mode for BIT, concurrent with DMA operation of the output data function.

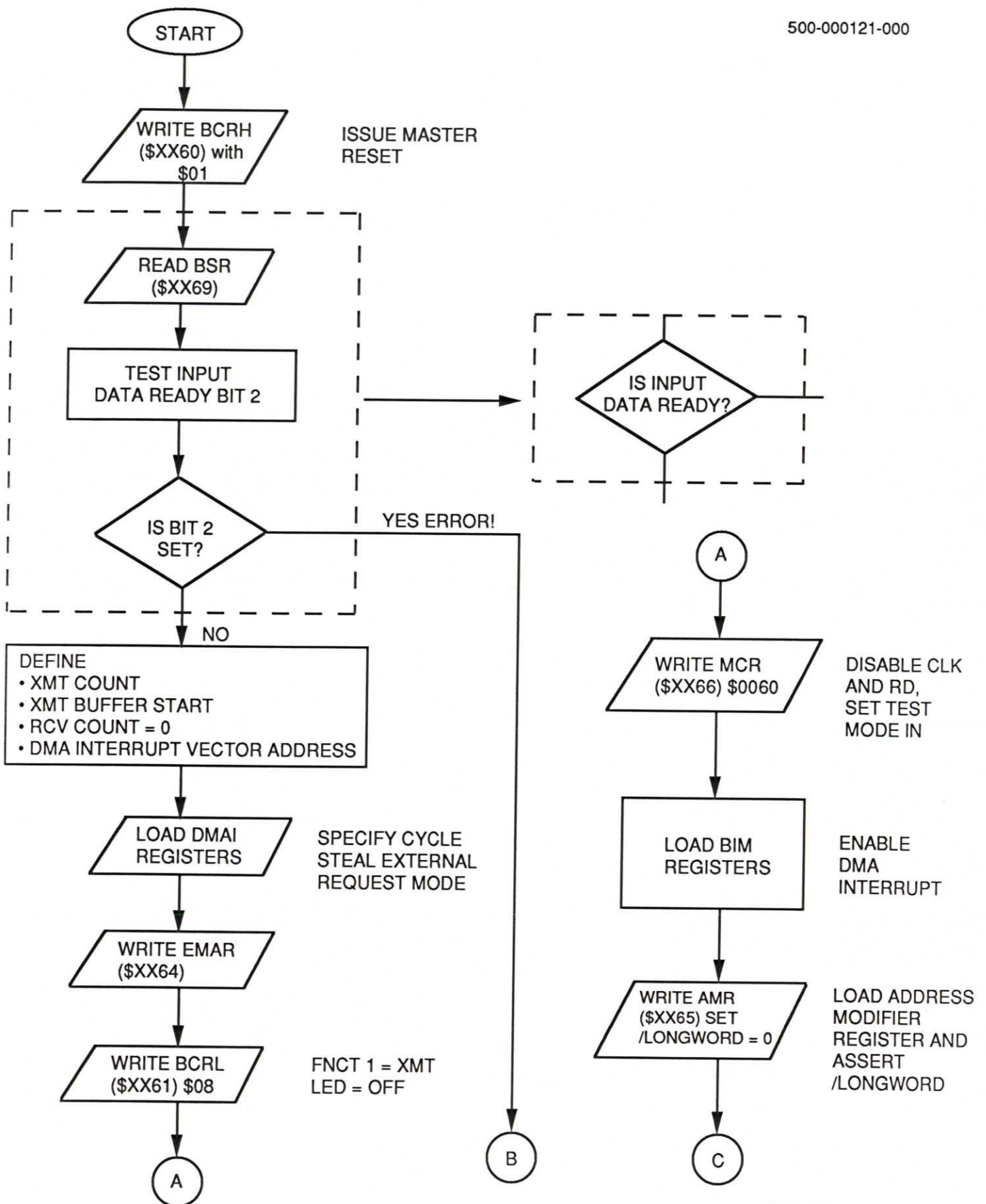
Enabling the TEST MODE IN in the TRANSMIT MODE with the FUNCTION 1 bit set to a logic "zero" allows an Input Data Register strobe, whether initiated by a program generated LD IN DATA REQ command, a SET CYCLE REQ command or an externally generated CYCLE REQUEST A (or CYCLE REQUEST B) input signal, to set the Input Data Ready status as an indication that the Input Data Register has been loaded with a new data word (or longword, if /LWORD is asserted in the AMR).

This feature can be utilized to establish a test WRAPAROUND MODE. Using a special wraparound test cable, the user interface signals of connector P3 can be connected to those of connector P4. With this cable, the Data Output Bus, DO00 to DO15, connects to the Data Input Bus, DI15 to DI00, BUSY connects to CYCLE REQUEST A, etc., so that the interface signal connections are identical to those that would be established in a back-to-back VMIVME-DR11W-A connection. With the TEST MODE IN asserted and the cycle steal (16-bit word or 32-bit longword) DMA TRANSMIT mode established, the assertion of the Input Data Ready status bit of the BSR can be used to queue a read back of the transmitted data via the IDR under program control for data verification. Figure 4.4.5-1 (A and B) provides a hypothetical program functional flow diagram for an exemplary test routine utilizing the TEST MODE IN feature.

BIT 4 - SET TEST MODE OUT. When set to a logic "one", this bit enables programmed control of VMIVME-DR11W-A output functions that would otherwise be prevented from operating while the RECEIVE MODE is enabled with the FUNCTION 1 bit set to a logic "one", or by an active, unasserted other board READY signal. Thus, programmed control of these output functions is made possible concurrent with DMA operation of the Receive function for BIT.

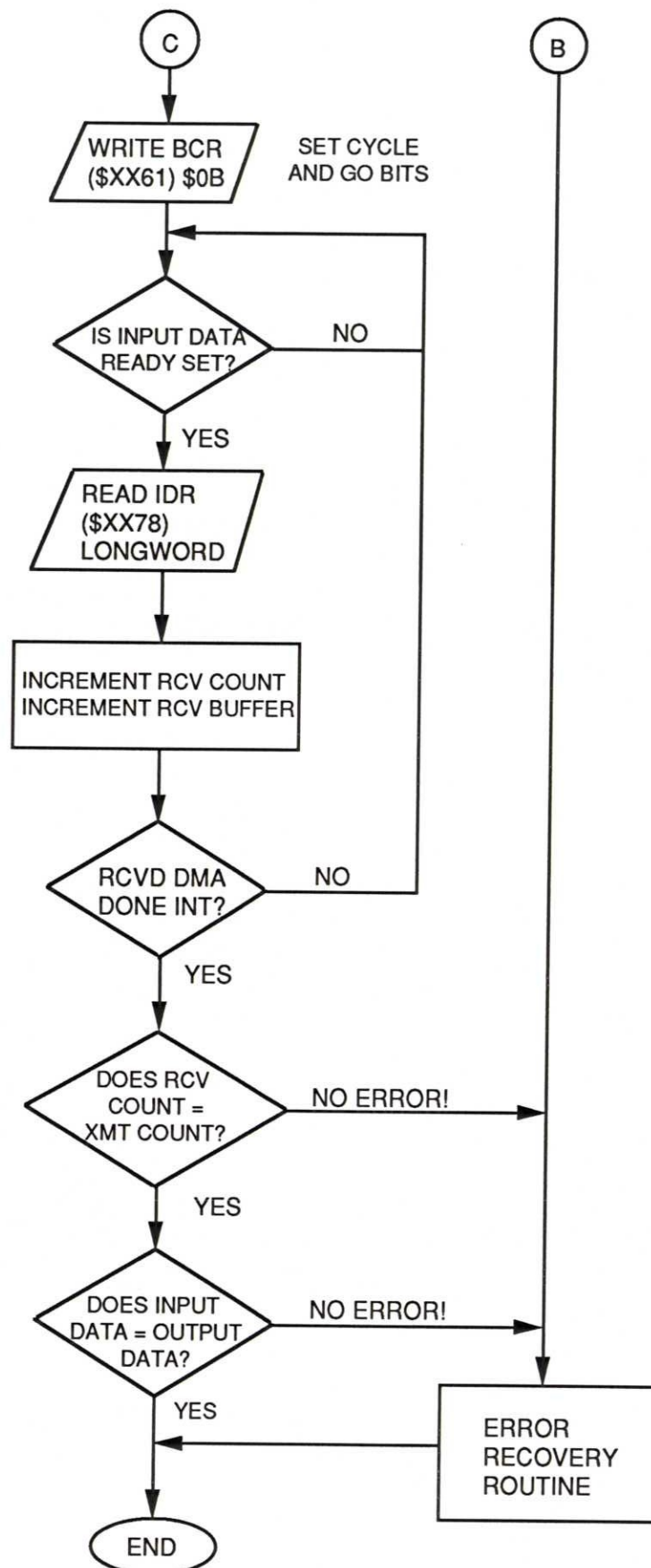
An asserted SET TEST MODE OUT bit enables:

- a. the BUSY handshake strobe to signify the presence of new output data on the interface cable during program controlled outputs, concurrent with an active DMA RECEIVE MODE (during which the GO and FUNCTION 1 bits are set),
- b. the Output Word Swap function during programmed output operation, concurrent with the DMA receive function (normally inhibited when the GO bit is asserted along with the FUNCTION 1 bit or with a deasserted OTHER SIDE READY FOR XFER H signal), or
- c. the CYCLE REQ A signal, CYCLE REQ B signal or the SET CYCLE REQ command (user-selected) to set the Send Next Output request for more output data while the interface is operating in the DMA RECEIVE MODE (also normally inhibited when the GO bit is asserted with the FUNCTION 1 bit or with a deasserted OTHER SIDE READY FOR XFER H signal).



MDR11W-A/F4.4.5-1A

Figure 4.4.5-1A. DMA Transmit (XMT), Program Controlled Receive (RCV), Wraparound Test Mode Program Functional Flow Diagram, Longword



MDR11W-A/F4.4.5-1B

Figure 4.4.5-1B. DMA Transmit (XMT), Program Controlled Receive (RCV), Wraparound Test Mode, Program Functional Flow Diagram, Longword, (Continued)

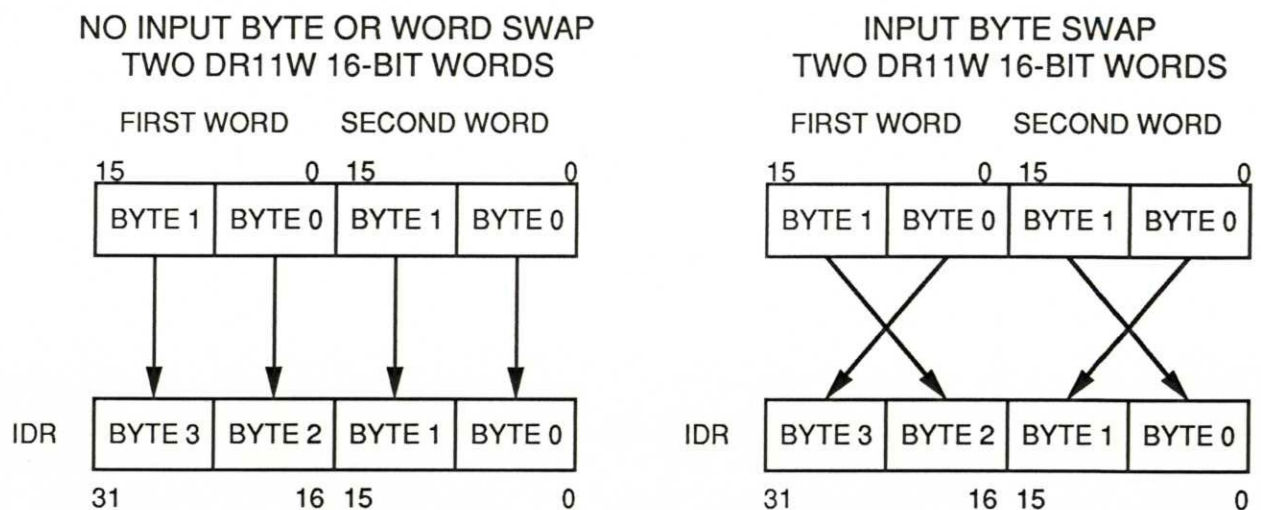
In a manner similar to that described for the TEST MODE IN bit previously, a WRAPAROUND test mode can be established that allows multiple program controlled output transmissions wrapped around from connector P3 to connector P4 with a WRAPAROUND cable to be received and input in a DMA Receive mode. To set up this mode, the SET TEST MODE OUT bit must be asserted, along with the DISABLE CLK & RD IN REG bit of the MCR.

The FUNCTION 1 bit of the BCR should also be asserted throughout the test to establish the receive mode. It will be necessary to specify a cycle steal mode when setting up the DMAI chip so that programmed controlled transfers can occur concurrent with the DMA receive process. When set up is completed, and GO has been asserted to allow DMA input transfers (Writes) to occur, the program should issue a Write to the ODR to start the data transfer process. Next, as Figure 4.4.5-2 illustrates, the SET OUT CYCLE REQ bit of the BSR should be tested to determine whether or not the DMA Receive has been completed. A transition from a logic "zero" to a "one" signifies that the data input cycle has been completed, and that the output circuit is prepared for the next program controlled Write to the ODR. While the transition may or may not be detectable, depending on other processor activities, a logic "one" signifies readiness for the next output data word. See Figure 4.4.5-2 for an example of a hypothetical test program functional flow diagram utilizing this feature in a 32-bit longword transfer mode.

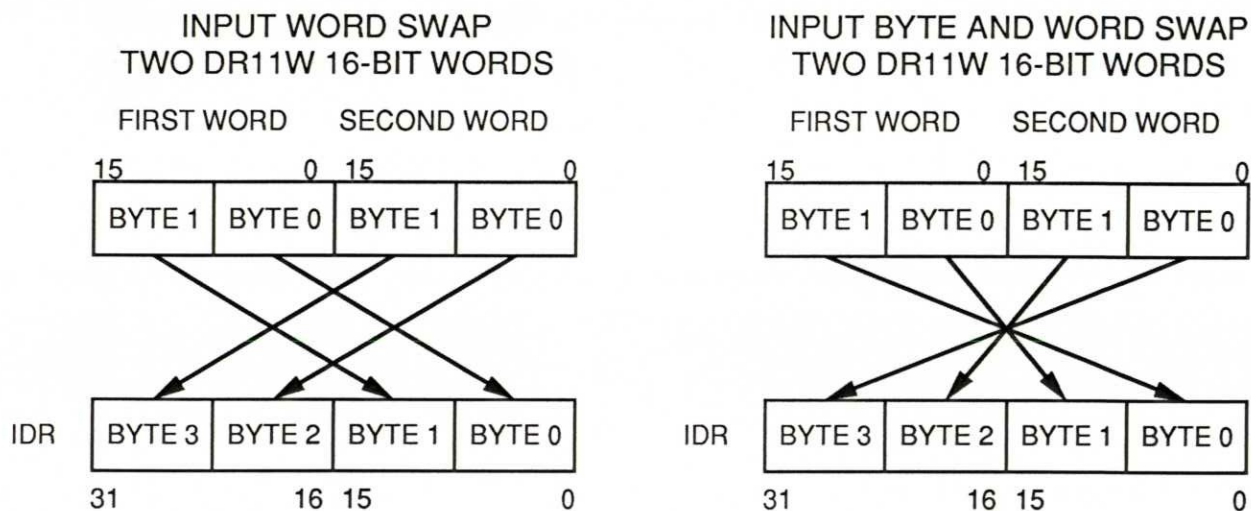
BIT 3 - SET INPUT WORD SWAP. This bit allows control of the 16-bit word position within each 32-bit longword Input Data Register (IDR). When asserted, the input word swap function will become operational for 32-bit transfers, if the FUNCTION 1 control bit is set to receive (logic "one") and, if enabled, the other board READY signal has transitioned to READY active low. The set input word swap function can also be enabled for 32-bit transfers, concurrent with an active OUTPUT TRANSFER MODE with FUNCTION 1 set to logic "zero", irrespective of the state of the other board's READY signal, by placing the VMIVME-DR11W-A in the TEST MODE with the TEST MODE IN BIT asserted.

If set to a logic "zero", the first word received by the VMIVME-DR11W-A will be directed by the load pointer to be loaded into the High Word Input Data Register as IDR bits 31 through 16. The second word received will be loaded into the Low Word Input Data Register as IDR bits 15 through 0. If byte swapping has not been also specified, the bit order within each 16-bit word will be maintained. Refer to Figure 4.4.5-1 for an illustration of the input data bit organization with the SET INPUT WORD SWAP bit NOT set.

If set to a logic "one", the order of the words loaded into the Input Data Register (IDR) is reversed (or swapped). The first word received is loaded into the Low Word, while the second word received is loaded into the High Word, as directed by the load pointer. Figure 4.4.5-2 illustrates this word reversal. Again, unless byte swapping has been specified, the bit order within each 16-bit word is maintained as shown. If byte swapping has been also specified, the byte position within each 16-bit word will be swapped as described below. It is not possible to swap input words to the 16-bit IODR located at word address \$XX62.



MDR11W-A/F4.4.5-1

Figure 4.4.5-1. Input Data Formats *WITHOUT* Word Swap

MDR11W-A/F4.4.5-2

Figure 4.4.5-2. Input Data Formats *WITH* Word Swap

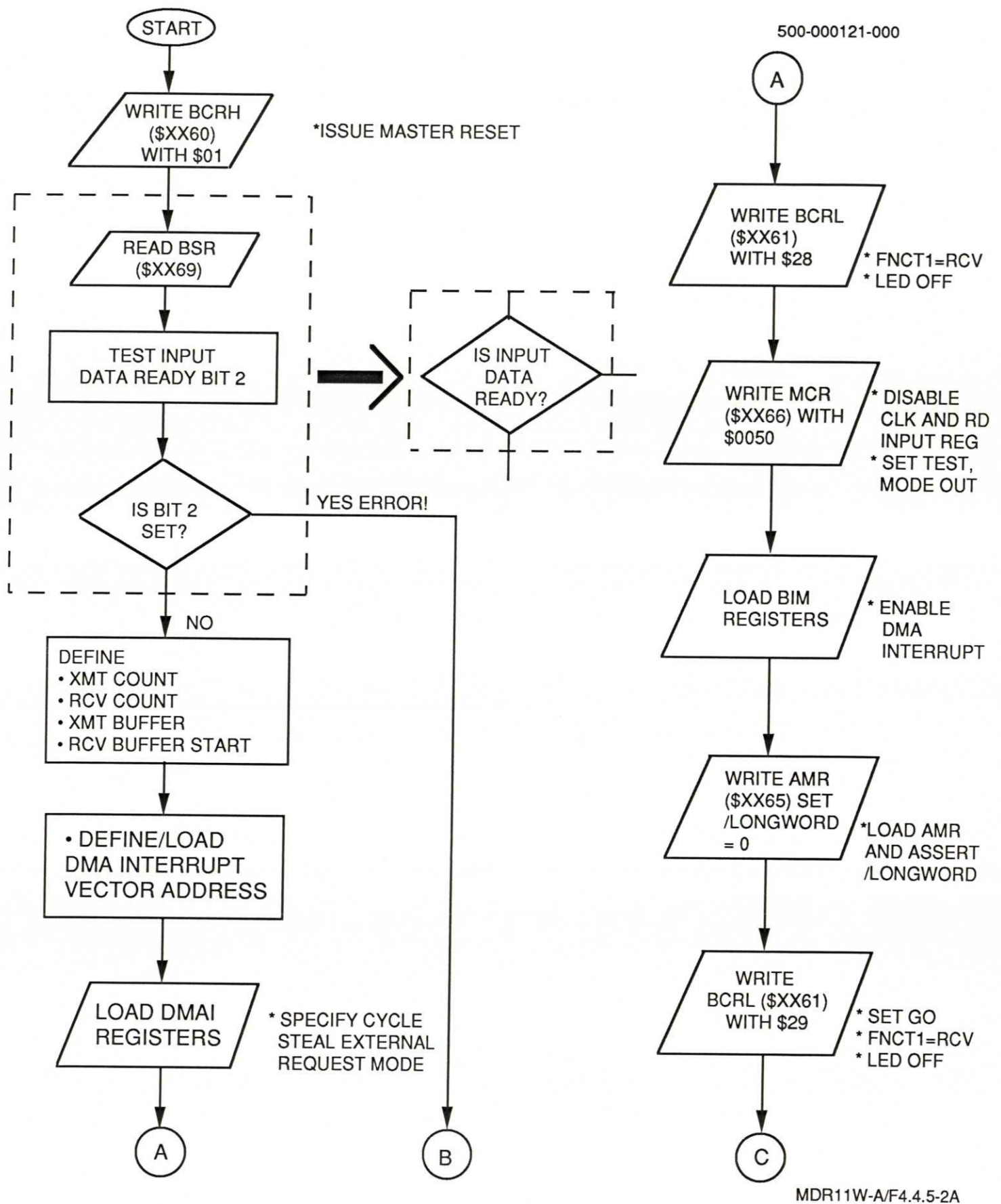
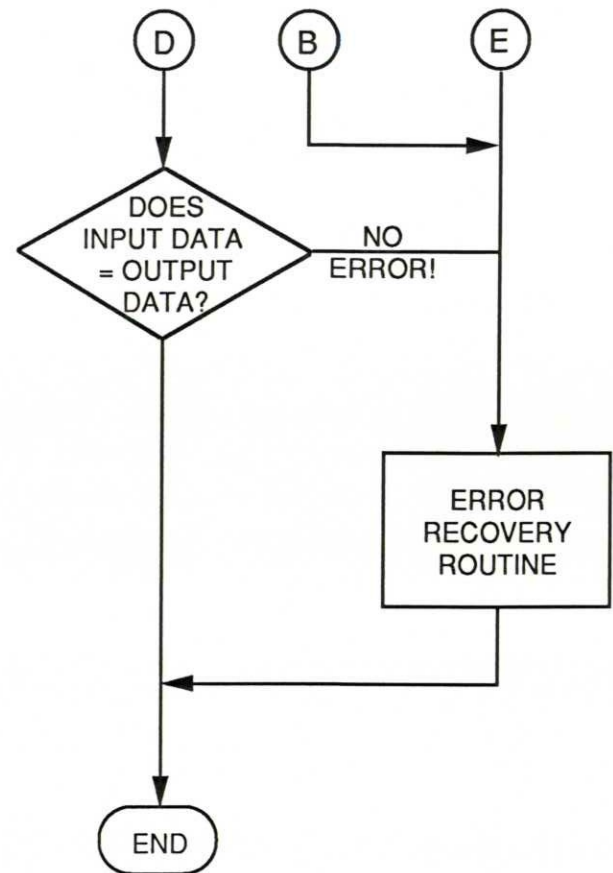
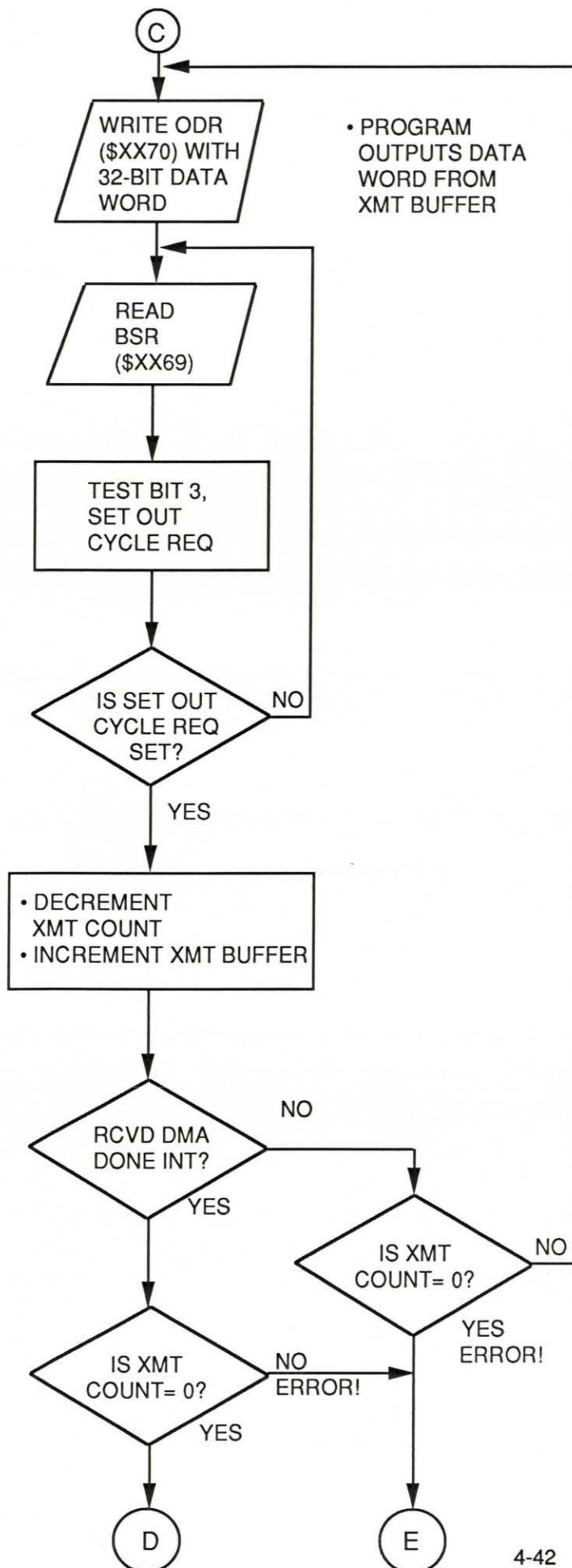


Figure 4.4.5-2A. DMA Receive (RCV), Program Controlled Transmit (XMT) Wraparound Test Mode Program, Functional Flow Diagram, Longword



MDR11W-A/F4.4.5-2B

Figure 4.4.5-2B. DMA Receive (RCV), Program Controlled Transmit (XMT) Wraparound Test Mode Program, Functional Flow Diagram, Longword (Continued)

BIT 2 - SET INPUT BYTE SWAP. The set input byte swap bit allows transposition of bytes within each word received from the other VMIVME-DR11W-A compatible interface as each word is loaded into the Input Data Register. If set to a logic "zero", no input byte swapping will occur, and input data will be loaded into the Input Data Register from the DI15 through DI00 bits of the interface ribbon cable.

If asserted to a logic "one", the set input byte swap bit will assert the BYTE SWAP MODE, causing the bytes received as bits DI15 through DI08 and DI07 through DI00 on the ribbon cable interface to be swapped prior to being written to the Input Data Register. For example, when receiving the first word during 32-bit Longword transfers, input data bits DI15 through DI08 will be loaded into Input Data Register bit positions 23 through 16 (or 07 through 00, if SET INPUT WORD SWAP is set), and data bits DI07 through DI00 will be loaded as Input Data Register bits 31 through 24 (or as bits 15 through 8, if SET INPUT WORD SWAP is asserted)

Figure 4.4.5-3 illustrates the input byte swap function as applied to the 16-bit I/O Data Register (IODR). Input byte swap formatting of the 32-bit IDR is illustrated in Figures 4.4.5-1 and 4.4.5-2.

BIT 1 - SET OUTPUT WORD SWAP. This bit allows control of the sequence in which the two words of the 32-bit longword Output Data Register are enabled to the interface cable signals DO15 through DO00. The output word swap will become operational if the VMIVME-DR11W-A interface is in a 32-bit TRANSMIT MODE with the /LONGWORD bit of the AMR asserted to a logic "zero", and the Other Side Ready for Transfer status bit asserted, and the FUNCTION 1 bit set to a logic "zero", or if 32-bit output transfers are specified in a test mode with the TEST MODE OUT bit asserted.

If set to a logic "zero", the first word enabled to the DR11W interface cable as an output word by the VMIVME-DR11W-A will be the High Word Output Data Register bits (ODR bits D31 through D16). The second word transmitted will be the Low Word Output Data Register bits (ODR bits D15 through D00). If byte swapping has not been also specified, the bit order within each 16-bit word will be maintained. Refer to Figure 4.4.5-4 for an illustration of the data bit organization with the SET OUTPUT WORD SWAP bit NOT set.

If set to a logic "one", the order in which the two words of the Output Data Register are enabled to the VMIVME-DR11W-A interface cable is reversed (or swapped). The first word enabled will be the Low Word Output Data Register bits, ODR bits D15 through D00. The High Word Output Data Register bits, ODR bits D31 through D16, will be the second word enabled, as directed by the load pointer. Figure 4.4.5-5 illustrates this word reversal. Again, unless byte swapping has been specified, the bit order within each 16-bit word is maintained. If byte swapping is specified, the byte position within each 16-bit output word will be swapped as described below.

BIT 0 - SET OUTPUT BYTE SWAP. The SET OUTPUT BYTE SWAP bit controls ordering of bytes within an output data word during output to the other VMIVME-DR11W-A compatible interface. If set to a logic "zero", no output byte swapping will occur for output data transfers.

If asserted to a logic "one", the SET OUTPUT BYTES SWAP bit will assert the BYTE SWAP MODE causing transposition of the bytes during output transfers. Thus data from the Output Register are byte swapped as they are enabled to DO15 through DO08 and DO07 through DO00. For example, when transmitting 32-bit longwords, data written as ODR bits 31 through 24 (or as bits 15 through 08, if output word swap is asserted) are enabled to bit positions DO07 through DO00 and bits written as ODR bits 23 through 16 (or as bits 07 through 00 if output word swap is asserted) are enabled as DO15 through DO08 in the first word output on the ribbon interface cable.

Figure 4.4.5-3 illustrates the output byte swap function for the 16-bit I/O Data Register. Output byte swapping from the 32-bit ODR is illustrated in Figures 4.4.5-4 and 4.4.5-5.

4.4.6 Board Status Register (BSR)

The BSR is an 8-bit read only register that allows the program to determine the status of various on-board and off-board I/O process events. The Board Status bits are registered, and are frozen in time during a read to prevent transitions on the VMEbus during the read window. All BSR status bits are cleared to a logic "zero" by either a Master Reset command issued via the BCR or by a VMEbus System Reset.

BITS 7 THROUGH 5 ARE NOT USED AND ARE SET TO "0".

BIT 4 - OTHER SIDE RDY FOR XFER (Other Side Ready for Transfer). This bit, if jumper JF is installed in the ENABLE position, indicates whether the other VMIVME-DR11W-A compatible interface has transitioned its READY H signal from High to Low to indicate that its GO bit has been set and that it is ready for the next group of data transfers to occur. In the DMA MODE with the GO bit set, I/O data transfers will be inhibited until this is asserted.

If jumper JF is installed in the DISABLE position, the OTHER SIDE RDY FOR XFER status bit will be forced to an asserted state. This, in effect, disables the use of the READY H signal during data transfers.

BIT 3 - SET OUT CYCLE REQ (Set Output Cycle Request). The SET OUT CYCLE REQ status bit will be set to a logic "zero" when an output transfer has occurred to the ODR (or the IODR) for 16-bit word operations and after the first word output has been acknowledged with a returned BUSY (Cycle Request A or B). This signifies that the ODR has been written with a new data word (or longword). This bit will be set to a logic "one" as a new output cycle is being requested and will return to a logic "zero" as the next write to the ODR completes. This bit can be used as an indicator of output data transfer activity.

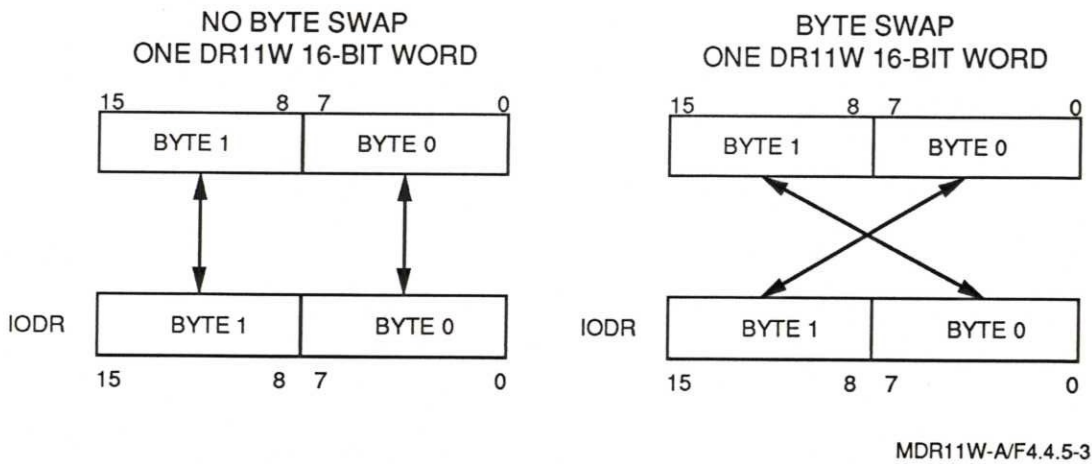
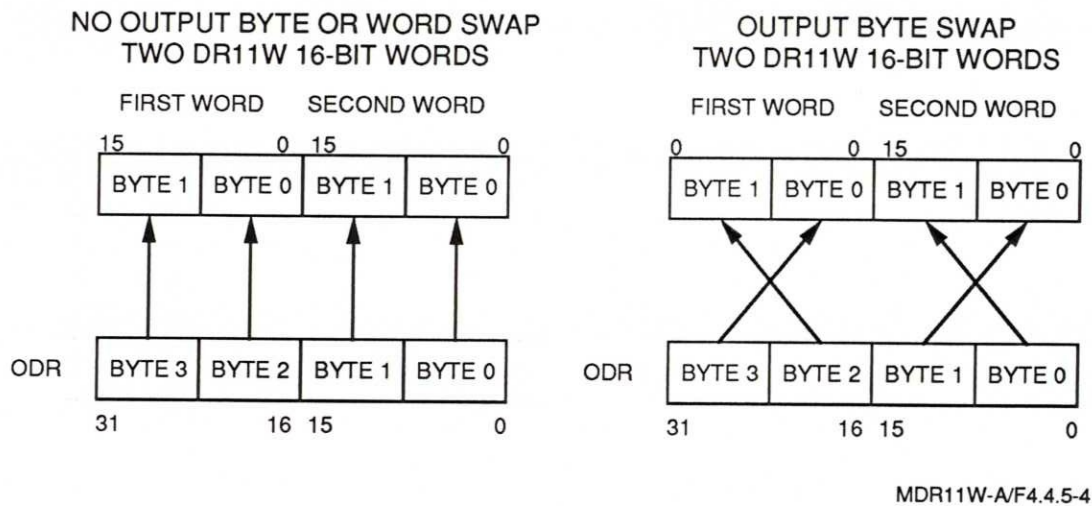
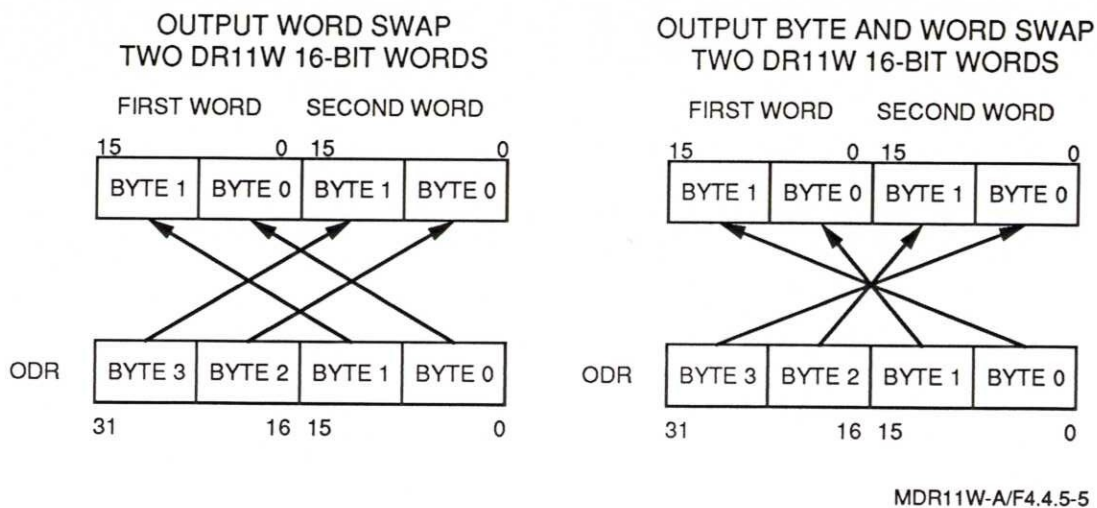


Figure 4.4.5-3. 16-Bit I/O Data Register Formats

Figure 4.4.5-4. Output Data Register *WITHOUT* Word SwapFigure 4.4.5-5. Output Data Register *WITH* Word Swap

The SET OUT CYCLE REQ status flag will be enabled, if the OTHER SIDE RDY FOR XFER bit is asserted, and the BCR FUNCTION 1 bit is set to a logic "zero" (selecting this board as a transmitter), or if the TEST MODE OUT bit is asserted. When enabled, it can be asserted by each occurrence, if 16-bit DATA MODE, or by the second occurrence, if 32-bit DATA MODE, of the Cycle Req A signal, the Cycle Req B signal or the Set Cycle Req command, depending on the user configuration.

BIT 2 - INPUT DATA READY. The INPUT DATA READY status bit, when asserted, is an indicator that new input data has been loaded into the Input Data Register, and that an input data transfer can be initiated to read the data. If DMA MODE is active with the GO and FUNCTION 1 bits asserted, a DMA request to write the data to memory will automatically be initiated (if enabled). In the programmed I/O MODE, the assertion of this bit indicates that data are ready for a programmed input transfer.

BIT 1 - BUS T.O. ERR (Bus Time-Out Error). The Bus Time-out Error flag will be set as the WDT times out (18.3 ms) if the VMIVME-DR11W-A interface, while operating in the DMA MODE, fails to receive a DTACK assertion within the WDT time-out period after the leading edge of the VMIVME-DR11W-A data strobe as described in (c.) of the description of the Bit 8 - ENABLE WDT control bit of the MCR in paragraph 4.4.5. See the NOTE after the description of the WDT T.O. ERR bit that follows.

The BUS T.O. ERR bit can be reset to a logic "zero" by writing a logic "zero" to the ENABLE WDT bit of the MCR after the Board Status read is completed. It is also reset when the ENA WDT bit of the Master Control Register is set to a logic "zero" during a Master Reset command or during the assertion of the VMEbus signal RESET* during power-up.

BIT 0 - WDT T.O. ERR (Watchdog Time-out Error). The Watchdog Time-out Error flag will be set (if enabled) if the Watchdog Timer times out (18.3 ms) because of either of the two conditions (a) or (b) detailed in the description of the Bit 8 - ENABLE WDT control bit of the MCR in paragraph 4.4.5. This bit, if set, may be reset to a logic "zero" by writing a logic "zero" to the ENABLE WDT bit of the MCR after the Board Status read command is completed. It is also cleared to a logic "zero" when the ENA WDT bit of Master Control Register is set to a logic "zero" by a Master Reset command and at power-up by the assertion of the VMEbus RESET* signal.

NOTE

THE VMIVME-DR11W-A HARDWARE DESIGN IS SUCH THAT IF THE WDT ERROR STATUS AND THE BUS TIME-OUT ERROR STATUS OCCUR CONCURRENTLY, AS WILL OFTEN BE THE CASE IN THE EVENT OF A WDT ERROR, THE FIRST ERROR TO BECOME ASSERTED WILL LOCKOUT (OR PREVENT) THE OCCURRENCE OF THE OTHER ERROR. THUS, ERROR IDENTIFICATION AMBIGUITY IS AVOIDED.

4.4.7 Set Cycle Req (SCRQ)

Under normal operating conditions in the DMA OUTPUT MODE, the next output cycle request is initiated by either the Cycle Req A or the Cycle Req B interface signal input, depending on the user setup and/or the position of jumper JB. The SET CYCLE REQ command (\$006A), when enabled by the ENABLE PROGRAM SET CYC REQ bit of the MCR (see bit 14 of paragraph 4.4.5), allows the program to set the SEND NEXT OUTPUT flip-flop, requesting the next output data word transfer cycle.

If LWORDL is not asserted, a DMA request for more output data will be generated (if not DONE) for each SET CYCLE REQ command issued.

If LWORDL is asserted, the first SET CYCLE REQ command will cause the second 16-bit word of the 32-bit Output Register to be output on the interface cable bits DO15 through DO00. A second SET CYCLE REQ command will generate a DMA request for more 32-bit output data. The SET OUT CYCLE REQ status bit of the BSR can be tested at the appropriate times to determine when each DMA request starts and completes.

A Cycle Request for Output Data will be set if the ODR (or the IODR) has been loaded with a new output data word, and :

- a. TEST MODE OUT is set or
- b. if TEST MODE OUT is NOT set and FUNCTION 1 is specifying the TRANSMIT MODE (a logic "zero"), and the Other Side Ready for Transfer bit has been asserted as a result of:
 - either the Enable Other BD Ready L jumper JF having been installed in the "Disable" position, or
 - with the Enable Other BD Ready L jumper JF installed in the "Enable" position, by the high to low transition of the Other Bd Ready signal from the other DR11W board on the A00 H interface signal input to the VMIVME-DR11W-A,

Figure 4.4.7-1 shows a Functional Flow Diagram of an example DMA transmit test program utilizing the SET CYCLE REQ command.

4.4.8 Load Input Data Register (LDIDR)

The Load Input Data Register (LDIDR) command allows the Input Data Register to be loaded under program control with a known data pattern for BIT verification in a test mode. For this mode to become operational, the ENABLE PROG LD IN DTA REG bit of the MCR must be asserted, along with the TEST MODE IN bit. The LDIDR function supports 16-bit word and 32-bit longword writes only. If a 32-bit capability does not exist in the user system, a 16-bit word LDIDR

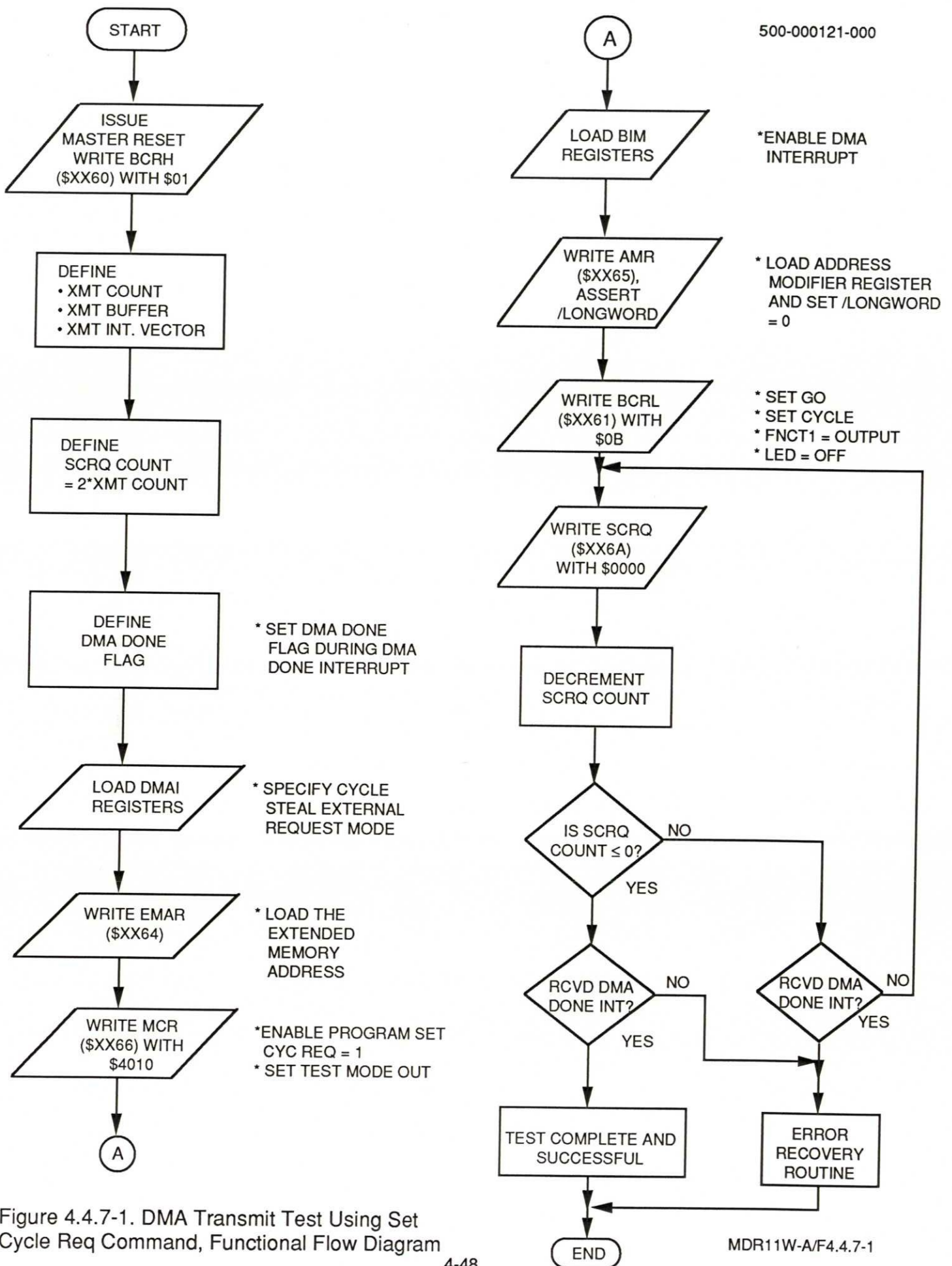


Figure 4.4.7-1. DMA Transmit Test Using Set Cycle Req Command, Functional Flow Diagram

can be followed by a 16-bit read of the IODR at address (\$XX62) and can be used to verify the register as a single 16-bit word Input Data Register.

In the 32-bit longword mode, the Input Data Register must **always** be loaded with two successive 32-bit longword writes to load both words of the 32-bit register, and to reinitialize the load pointer. This is because the 32-bit IDR is loaded from the 32-bit LDIDR command, 16-bits at a time. As the LDIDR command loads the IDR, the Input Data Ready status bit will be set in the BSR to indicate that data is available in the IDR. It will be asserted during the second LDIDR of a 32-bit longword IDR load operation, and once for every LDIDR of a 16-bit word IDR load operation.

If the SET INPUT WORD SWAP bit is not asserted in the MCR, the first LDIDR command (write) will load the associated upper 16-bit data word into the High Word Input Data Register. A second identical LDIDR command will then load the lower 16-bit data word to the Low Word Input Data Register. A 32-bit read of the Input Data Register at address (\$XX78) can then be used to verify the contents of the 32-bit Input Data Register while still in the TEST MODE. Figure 4.4.8-1 illustrates this two command load process.

Asserting the SET INPUT WORD SWAP bit in the MCR will reverse the pointer action in that the first word written with a longword LDIDR command will load the Low Word Input Data Register, and the second word written will load the High Word Input Data Register. Refer to Figure 4.4.8-2 for an illustration of the load process with the SET INPUT WORD SWAP bit asserted. Functional Flow Diagrams of sample test mode programs have been developed as examples of how this BIT function might be utilized. These examples test the integrity of the IDR and the function of the Input Data Ready status and are included as Figure 4.4.8-1 (A and B) for a 16-bit LDIDR command, and Figure 4.4.8-2 (A and B) for the 32-bit LDIDR operation.

4.4.9 VMIVME-DR11W-A 32-Bit Output Data Register (ODR)

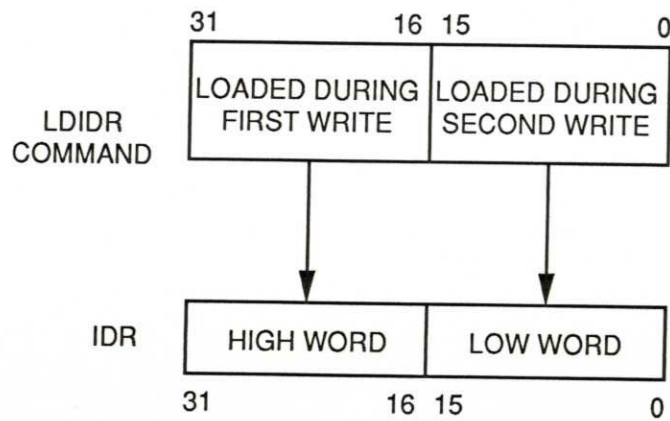
The 32-bit ODR is written by the CPU either when operating as bus master (DMA transfer) or under program control. The outputs of the ODR are enabled 16-bits at a time via high-speed bus drivers toward the external VMIVME-DR11W-A (or VMIVME-DR11W-A compatible) interface during an output transfer. The ODR must be written as a 32-bit longword only.

BITS 31 THROUGH 0 - OUTPUT DATA D31 THROUGH D0 (Output Data bits D31 through D0).

4.4.10 VMIVME-DR11W-A 32-Bit Input Data Register (IDR)

The 32-bit IDR may be read under DMA control or under program control. It is capable of longword input transfers (i.e., 32-bits per transfer cycle). The Input Data Register receives and stores the data that are transferred in a two-word

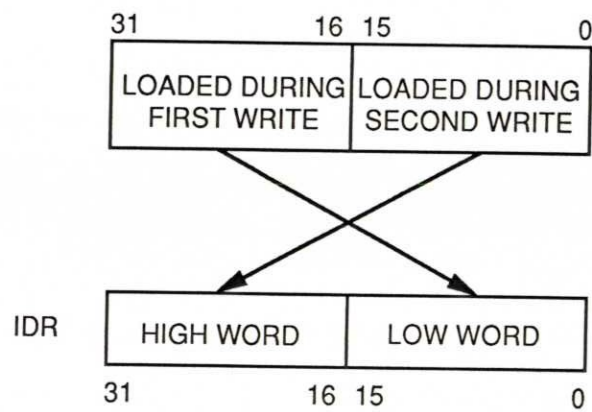
NO INPUT WORD SWAP SET
TWO DR11W-A LONGWORD WRITES



MDR11W-A/F4.4.8-1

Figure 4.4.8-1. LDIDR Command Format *WITHOUT* Word Swap, 32-Bit

INPUT WORD SWAP SET
TWO DR11W-A LONGWORD WRITES



MDR11W-A/F4.4.8-2

Figure 4.4.8-2. LDIDR Command Format *WITH* Word Swap, 32-Bit

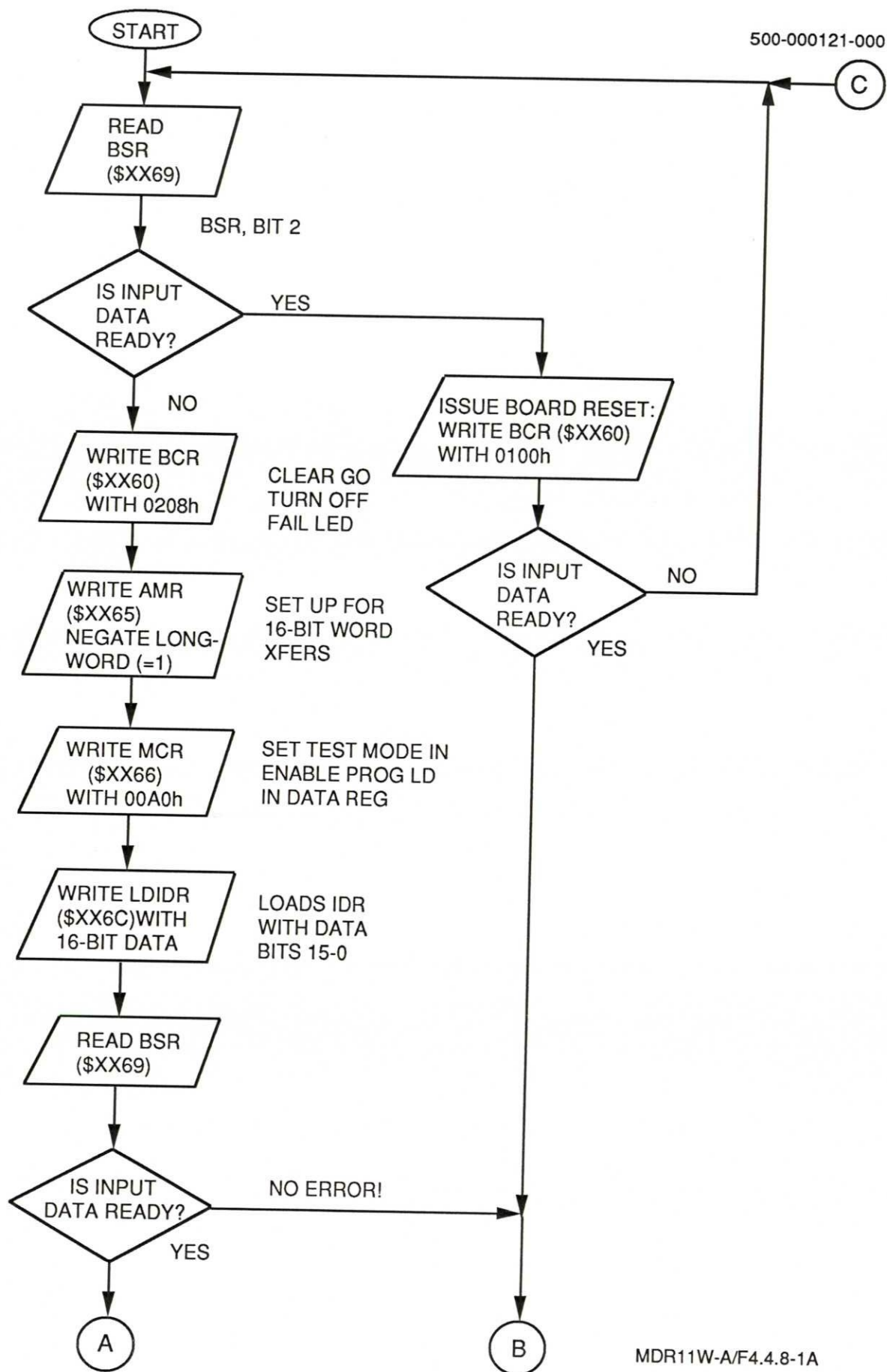
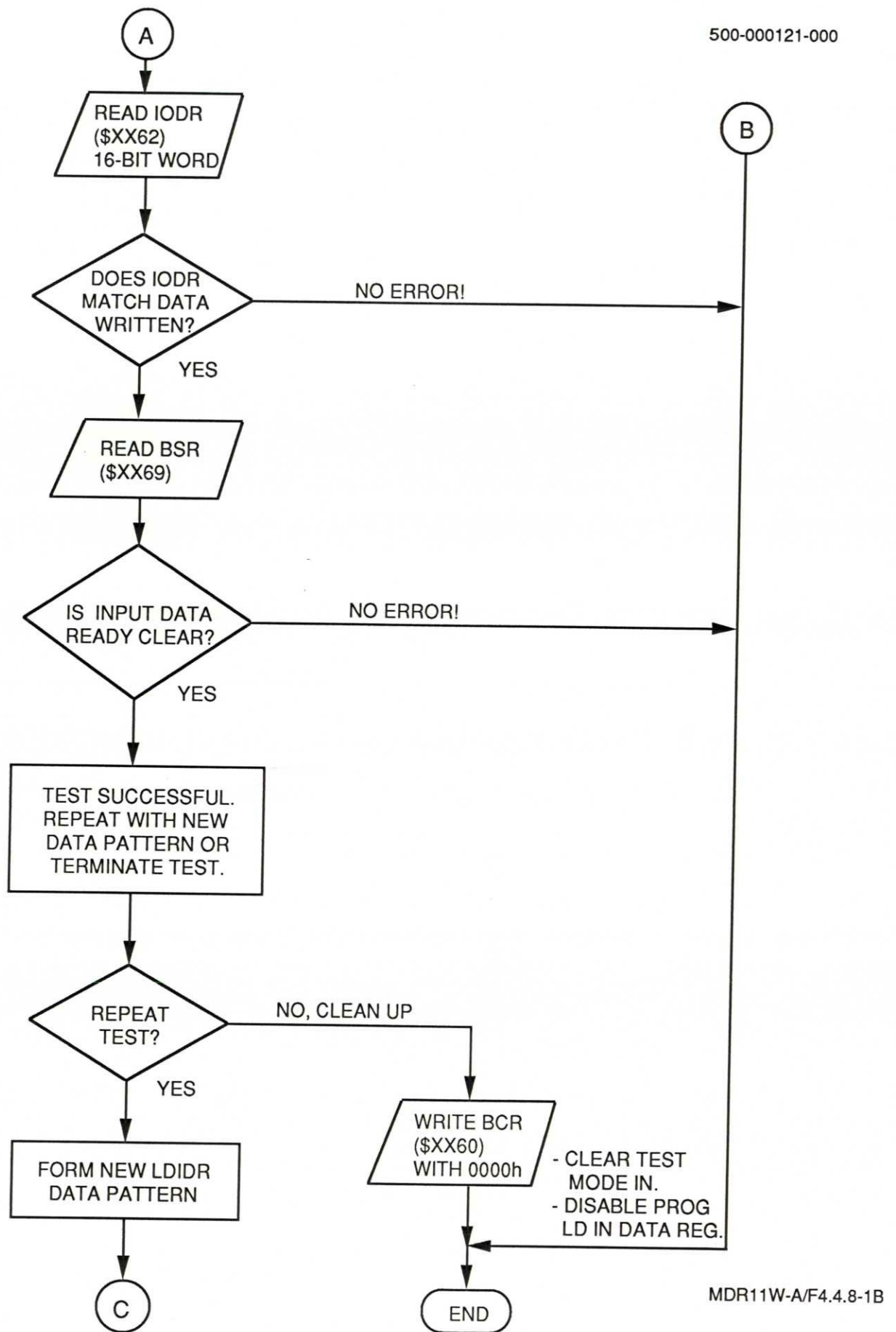


Figure 4.4.8-1A. 16-Bit LDIDR Bit Program Functional Flow Diagram



MDR11W-A/F4.4.8-1B

Figure 4.4.8-1B. 16-Bit LDIDR Bit Program Functional Flow Diagram (Continued)

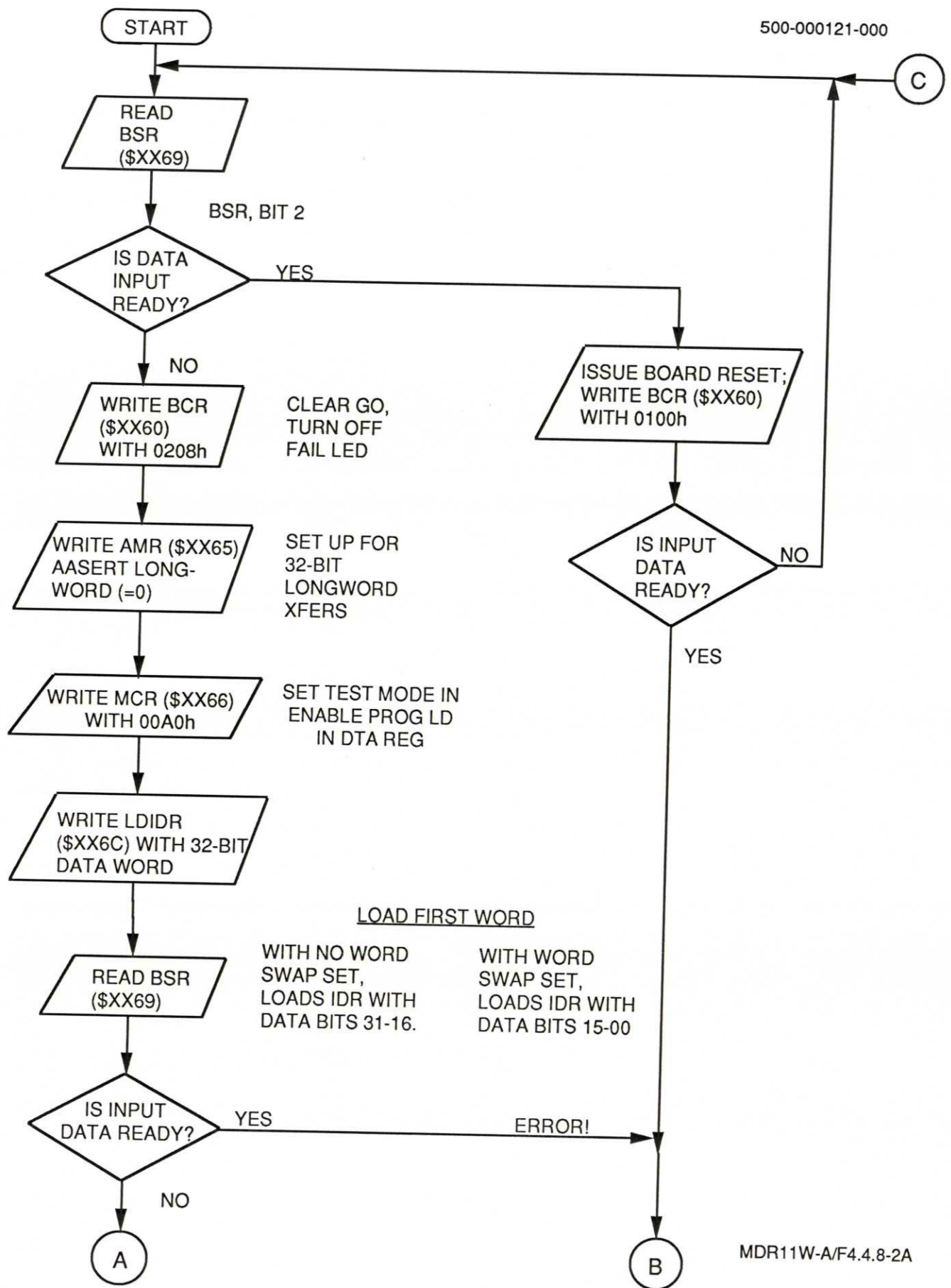


Figure 4.4.8-2A. 32-Bit LDIDR Bit Program Functional Flow Diagram

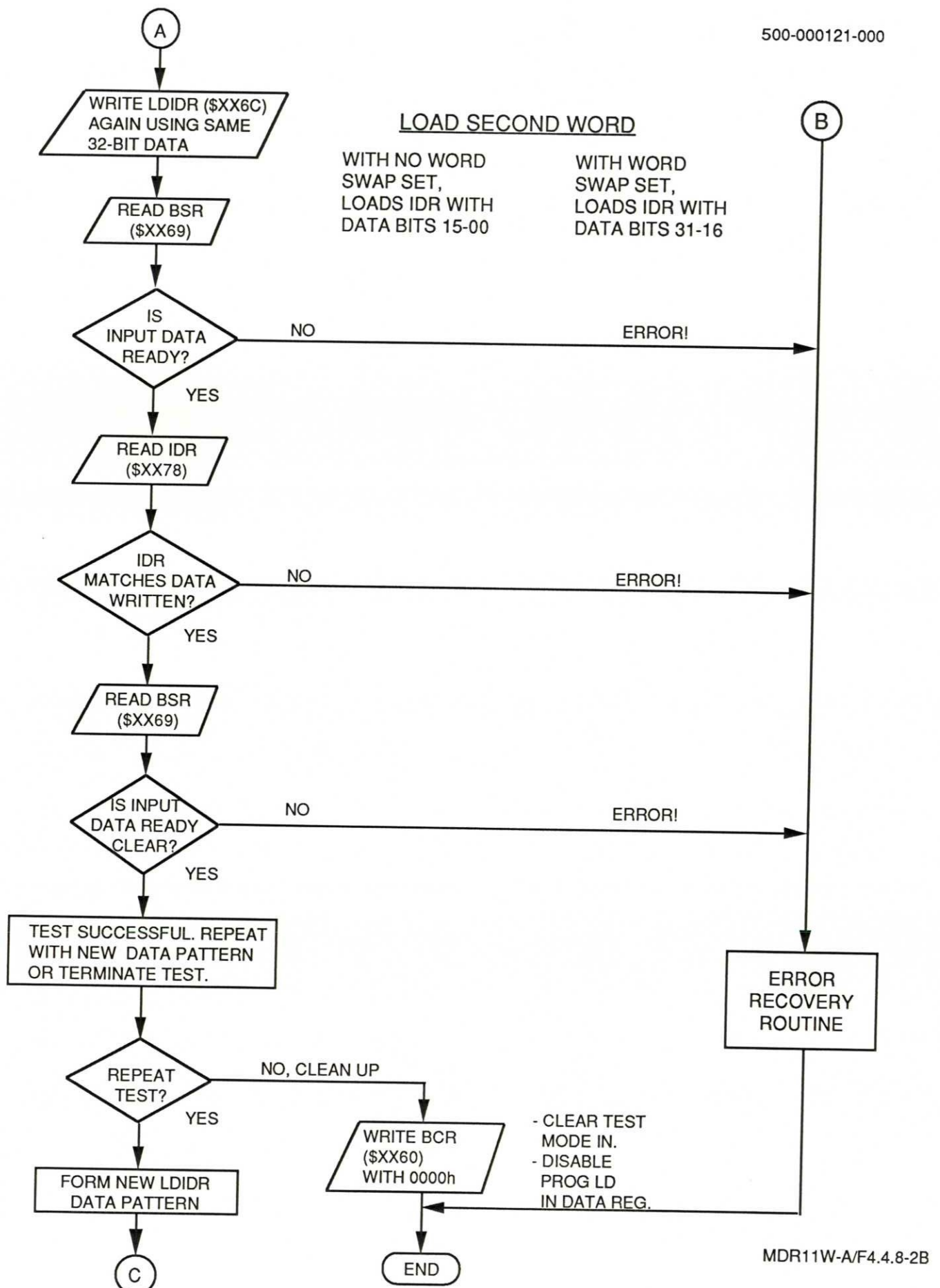


Figure 4.4.8-2B. 32-Bit LDIDR Bit Program Functional Flow Diagram (Continued)

sequence from the external VMIVME-DR11W-A (or compatible) interface during an input transfer. The IDR is loaded with 16-bits at a time, as clocked, depending on the user configuration, by the Cycle Req A (or the Cycle Req B) signal from the other VMIVME-DR11W-A compatible interface, or by the Set Cycle Req command.

The IDR can also be written under program control in a test mode. Refer to the description of the Load Input Data Register command in paragraph 4.4.7 for a description of that procedure.

4.5 SEQUENCE OF REGISTER LOADING

The receiving VMIVME-DR11W-A compatible interface must be set up before the transmitting interface to avoid losing the first word transferred, if jumper JF is disabled.

To transfer a block of data the programming sequence of the VMIVME-DR11W-A should be as follows:

- a. Load the registers in the MC68153 and SCB68430.
- b. The CCR should be the last register loaded in the SCB68430.
- c. Load the AMR and EMAR.
- d. Load the BCR with the GO bit (bit 0) and the CYCLE bit (bit 1) (if transmitting) set to "zero" (this step needed only for assurance)
- e. Reload the BCR with the GO and CYCLE bits set to "one".

Note that the start bit (CCR bit 07) must be set inside in SCB68430 before the GO and CYCLE bits are set in the BCR. The start bit in the SCB68430 is independent of the CYCLE (start) bit in the BCR. The C1 interface signal input (BCR - bit 10) controls the direction of the I/O Data Register, while the direction bit in the SCB68430 (OCR - bit 07) controls the transfer direction of the SCB68430. These two bits must be in the same logic state for correct operation.

An example of register initialization sequence for transmitting data (from memory) is shown in Table 4.5-1. After the first DMA transfer is complete, the VMIVME-DR11W-A can be reinitialized with only seven steps to transmit a second block of data (see Table 4.5-2).

An example of a register initialization sequence for receiving data (transfer to memory) is shown in Table 4.5-3. After the first block transfer is complete, the VMIVME-DR11W-A can be reinitialized with only eight steps to receive a second block of data (see Table 4.5-4).

4.6 SAMPLE SOFTWARE LISTINGS

VMIC has provided sample software listings in Appendix C to assist the user in programming the VMIVME-DR11W-A. Refer to Appendix C for an itemized list of software listings provided.

Table 4.5-1. Register Initialization Sequence for Transmitting a 4 k Word Block
Starting Data Address \$40000

STEP	REGISTER LOCATION	REGISTER NAME	REGISTER ADDRESS OFFSET	DATA LOADED (HEXADECIMAL)	COMMENT
1	68430	DCR	04	B8	Cycle Steal
2	68430	OCR	05	12	Word from memory
3	68430	MTCH	0A	1000	16-bit transfer count
4	68430	MACMH	0D	04	Upper 8 bits of memory address
5	68430	MACML	0E	0000	Lower 16 bits of memory address
6	68430	DIVR	25	42	Done interrupt vector
7	68153	AIVR	4D	40	Attention interrupt vector
8	68153	AICR	45	1F	Enable internal vector with auto clear
9	68153	DICR	47	3F	Enable external vector with auto clear
10	On-Board	EMAR AND AMR	64	0079	Word, ADDR MOD=39
11	68430	CSR	00	B9	Clear channel Status Register
12	68430	CCR	07	88	Start DMA chip
13	On-Board	BCR	61	8F	Go, enable ATTN, LED OFF, Cycle, Transmit

MDR11W-A/T4.5-1

Table 4.5-2. Register Initialization Sequence for Transmitting a Second 4 K Word Block Starting Data Address \$20000

STEP	REGISTER LOCATION	REGISTER NAME	REGISTER ADDRESS OFFSET	DATA LOADED (HEXADECIMAL)	COMMENT
1	68430	MTCH	0A	1000	16-bit transfer count
2	68430	MACMH	0D	02	Upper 8 bits of memory address
3	68430	MACML	0E	0000	Lower 16 bits of memory address
4	68153	DICR	47	3F	Enable external vector with auto clear
5	68430	CSR	00	B9	Register
6	68430	CCR	07	88	Start DMA chip
7	On-Board	BCR	61	8F	Go, enable ATTN, LED OFF, Cycle, Transmit

MDR11W-A/T4.5-2

Table 4.5-3. Register Initialization Sequence for Receiving a 4 k Word Block
Starting Data Address \$40000

STEP	REGISTER LOCATION	REGISTER NAME	REGISTER ADDRESS OFFSET	DATA LOADED (HEXADECIMAL)	COMMENT
1	68430	DCR	04	B8	Cycle Steal
2	68430	OCR	05	92	Word to memory
3	68430	MTCH	0A	1000	16-bit transfer count
4	68430	MACMH	0D	04	Upper 8 bits of memory address
5	68430	MACML	0E	0000	Lower 16 bits of memory address
6	68430	DIVR	25	42	Done interrupt vector
7	68153	AIVR	4D	40	Attention interrupt vector
8	68153	AICR	45	1F	Enable internal vector with auto clear
9	68153	DICR	47	3F	Enable external vector with auto clear
10	On-Board	EMAR AND AMR	64	0079	Word, ADDR MOD=39
11	68430	CSR	00	B9	Clear channel Status Register
12	68430	CCR	07	88	Start DMA chip
13	On-Board	BCR	61	AC	Go=0, Receive direction, enable ATTN, LED OFF
14	On-Board	BCR	61	AD	Go, Receive direction, enable ATTN, LED OFF

MDR11W-AT4.5-3

Table 4.5-4. Register Initialization Sequence for Receiving a Second 4 K Word Block Starting Data Address \$20000

STEP	REGISTER LOCATION	REGISTER NAME	REGISTER ADDRESS OFFSET	DATA LOADED (HEXADECIMAL)	COMMENT
1	68430	MTCH	0A	1000	16-bit transfer count
2	68430	MACMH	0D	02	Upper 8 bits of memory address
3	68430	MACML	0E	0000	Lower 16 bits of memory address
4	68153	DICR	47	3F	Enable external vector with auto clear
5	68153	AICR	45	1F	Enable internal vector with auto clear
6	68430	CSR	00	B9	Clear channel Status Register
7	68430	CCR	07	88	Start DMA chip
8	On-Board	BCR	61	AD	Go, receive direction, enable ATTN, LED OFF

MDR11W-A/T4.5-4

SECTION 5

CONFIGURATION AND INSTALLATION

5.1 UNPACKING PROCEDURES

CAUTION

SOME OF THE COMPONENTS ASSEMBLED ON VMIC's PRODUCTS MAY BE SENSITIVE TO ELECTROSTATIC DISCHARGE AND DAMAGE MAY OCCUR ON BOARDS THAT ARE SUBJECTED TO A HIGH ENERGY ELECTROSTATIC FIELD. WHEN THE BOARD IS TO BE LAID ON A BENCH FOR CONFIGURING, ETC., IT IS SUGGESTED THAT CONDUCTIVE MATERIAL BE INSERTED UNDER THE BOARD TO PROVIDE A CONDUCTIVE SHUNT. UNUSED BOARDS SHOULD BE STORED IN THE SAME PROTECTIVE BOXES IN WHICH THEY WERE SHIPPED.

Upon receipt, any precautions found in the shipping container should be observed. All items should be carefully unpacked and thoroughly inspected for damage that might have occurred during shipment. The board(s) should be checked for broken components, damaged printed circuit board(s), heat damage, and other visible contamination. All claims arising from shipping damage should be filed with the carrier and a complete report sent to VMIC together with a request for advice concerning disposition of the damaged item(s).

5.2 PHYSICAL INSTALLATION

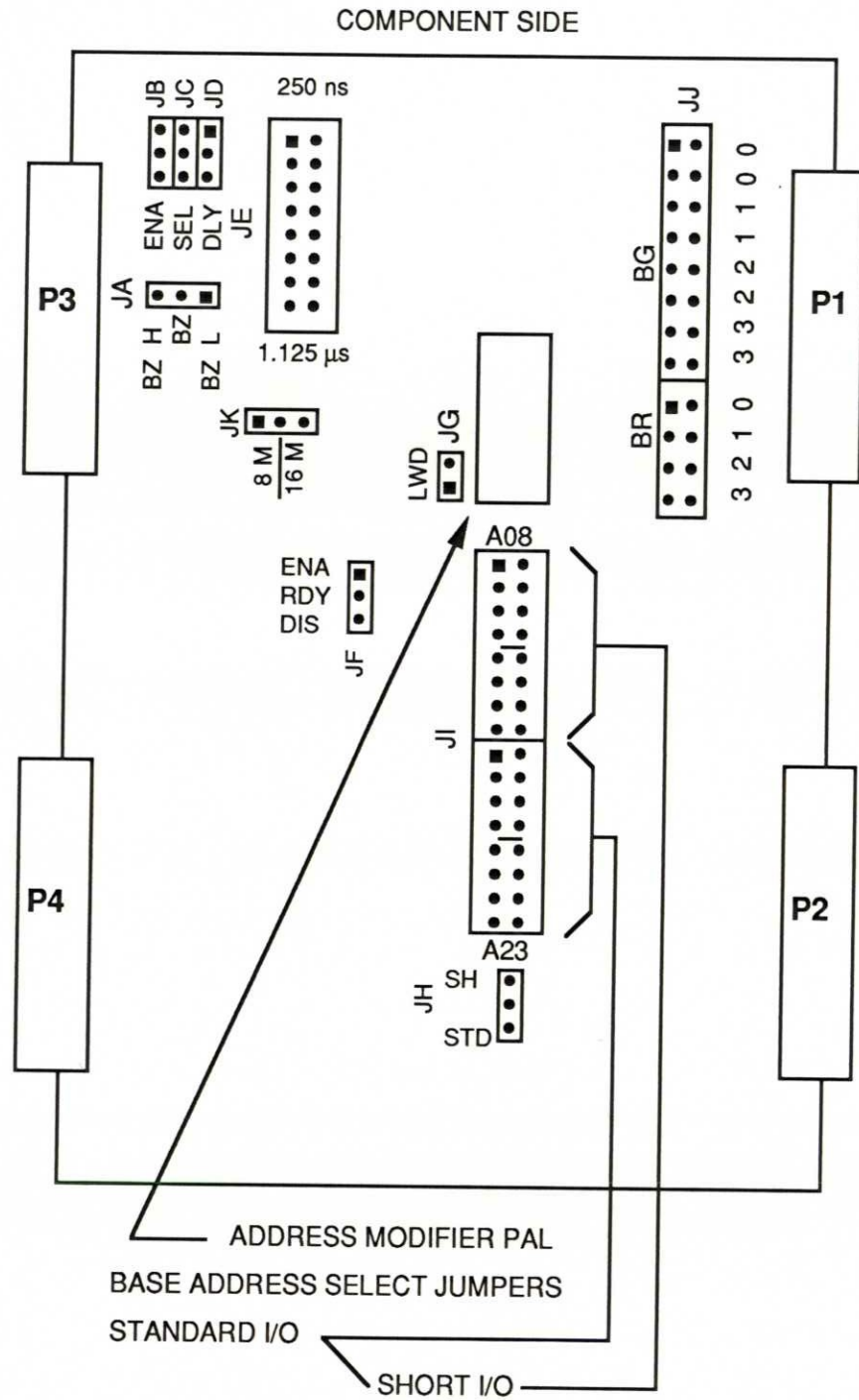
CAUTION

DO NOT INSTALL OR REMOVE BOARD WHILE POWER IS APPLIED.

De-energize the equipment and insert the board into an appropriate slot of the chassis. While ensuring that the board is properly aligned and oriented in the supporting card guides, slide the board smoothly forward against the mating connector until firmly seated.

5.3 JUMPER INSTALLATIONS

The VMIVME-DR11W-A interface boards provide twelve groups of jumpers for jumper-selection of the various user-determined control options. The BUSY handshake signal polarity, the VMEbus priority level (bus request and bus grant levels), either standard or short I/O on-board register base addressing, the standard I/O address (if selected), the short I/O base address (if selected), Cycle Req A/Cycle Req B handshake optioning, Cycle Req A (or B) handshake response polarity, BUSY DELAY clock and the BUSY signal deskew delay are all jumper-selectable. Use of the LWORD* signal while operating as a VMEbus Master, recognition of the other board READY signal, and enabling or disabling of the Cycle Req A (or B) input signal delay are also jumper-determined. Refer to Figure 5.3-1 for jumper locations.



MDR11W-A/F5.3-1

Figure 5.3-1. VMIVME-DR11W-A Configuration Information

5.3.1 Busy Polarity

The polarity of the BUSY (BZ) handshake signal can be selected to be active H or L using jumper JA. As shown in Figure 5.3.1-1, BZ L must be selected for back-to-back operation of two VMIVME-DR11W-A Boards. The factory configuration is BZ L.

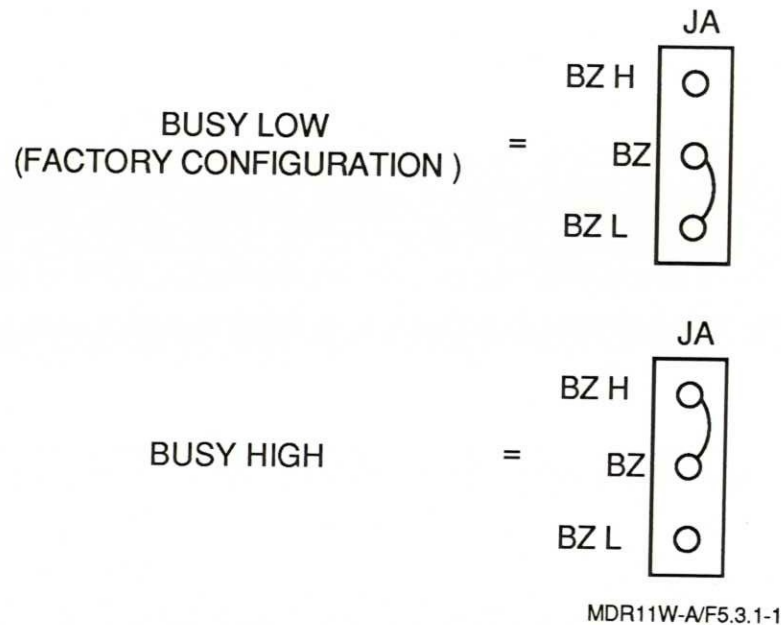


Figure 5.3.1-1. Busy Signal Polarity Selection, Busy L Must Be Selected for Back-to-Back Operation of Two VMIVME-DR11W Boards

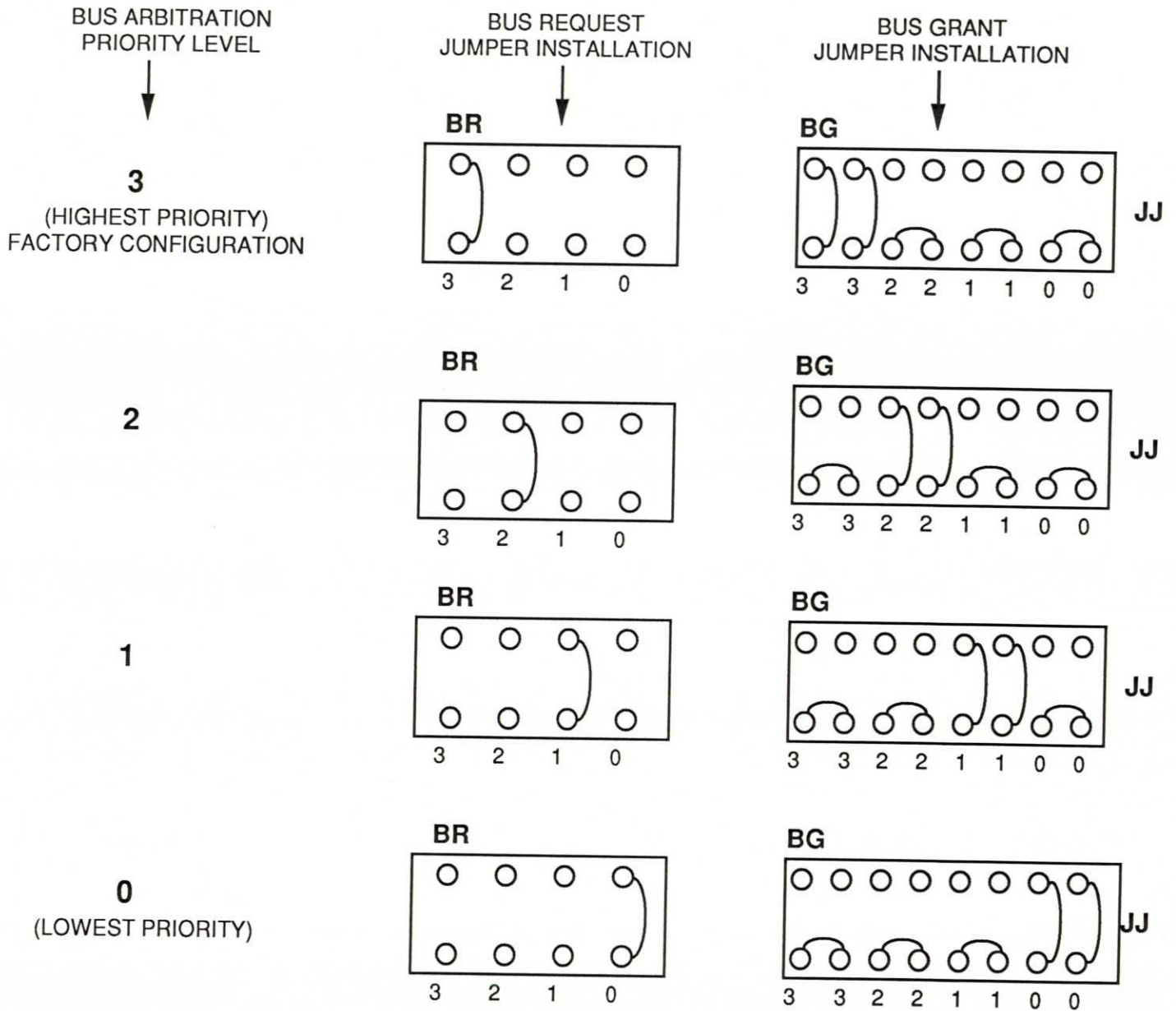
5.3.2 VMEbus Priority Jumpers

Jumper JJ provides for the selection of bus request level and grant level. The reader should refer to Figure 5.3.2-1 for selection of bus priority level (3, 2, 1, or 0). The factory configuration is level 3.

5.3.3 Board Base Address

The VMIVME-DR11W-A occupies 256 bytes of the VMEbus I/O address space. Using jumper JH the user can configure the board to locate the board base address in either the VMEbus short (SH) I/O space or the VMEbus standard (STD) I/O space. The factory configuration is SH.

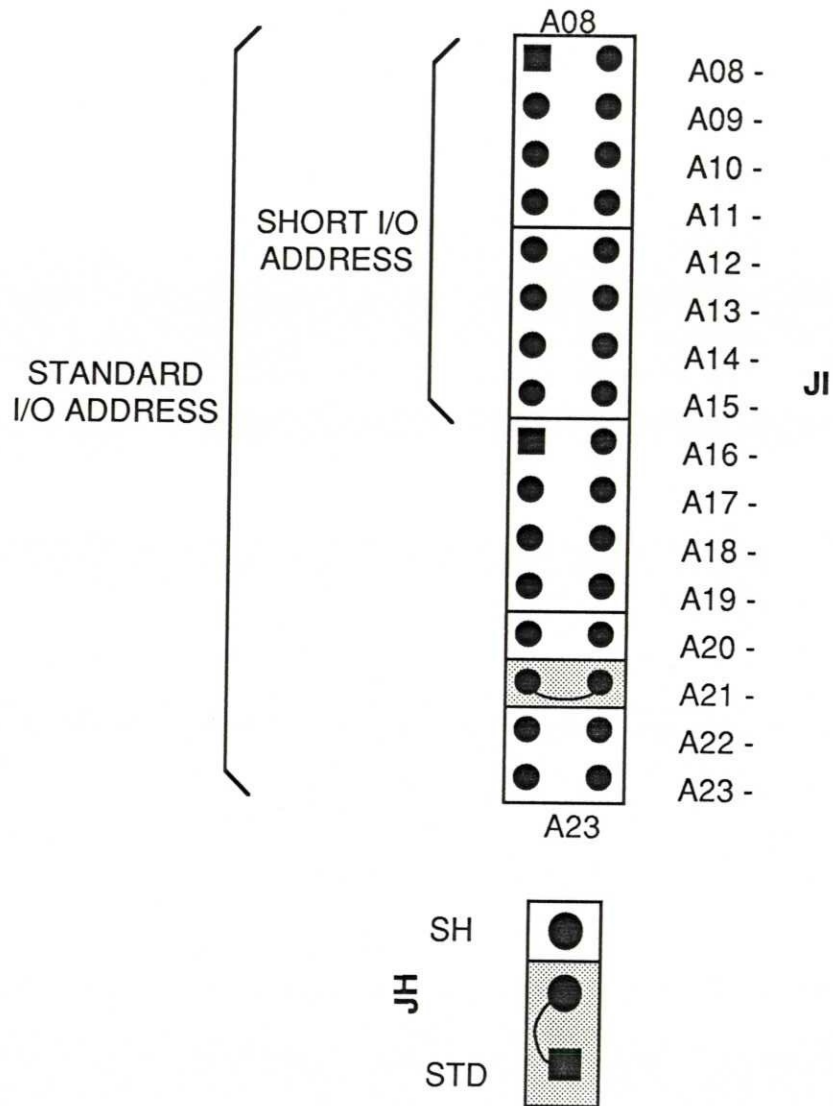
The upper sixteen bits of the STD I/O address are jumper-selectable. Jumper JI must be configured to select a STD I/O address space if



NOTE: THIS BOARD IS FACTORY CONFIGURED FOR LEVEL 3.

MDR11W-A/F5.3.2-1

Figure 5.3.2-1. Jumper Installation for Selection of VMEbus Priority Level



MDR11W-A/F5.3.3-1

Figure 5.3.3-1. Board Base Address Jumpers

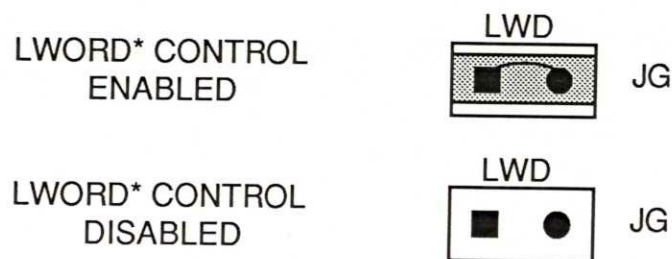
jumper JH has been configured for STD. Figure 5.3.3-1 shows a STD I/O address selection of \$DFFFXX. The factory configuration is for address \$XXFFE0XX.

If the SH I/O space is chosen with jumper JH, the upper 8 address bits (A16 through A23) selectable by jumper JI are ignored, and the short I/O address will be determined by the 8 jumpers of JI (A08 through A15, refer to Figure 5.3.3-1).

5.3.4 LWORD* Control Jumper

The LWD jumper has been provided to maintain compatibility with VMIC's earlier VMIVME-DR11W Board and should be removed for those 16-bit transfer only applications in which it is desirable for bit 6 of the Address Modifier Register to be set to a logic level other than that required for a 32-bit longword transfer (see paragraph 4.4.4). The LWD jumper, JG, when removed, causes the LONGWORD bit (bit 6) of the Address Modifier Register to be ignored. The LWORD* signal will always be output from the board unasserted (high) when LWORD* is enabled during DMA transfers to specify a 16-bit word transfer size.

When operating in a 32-bit DMA transfer application, this jumper must be installed so that the LONGWORD bit will be used to determine the state of the LWORD* address signal during DMA transfers. The upper half of Figure 5.3.4-1 shows this jumper installed. This is the factory selected configuration.



MDR11W-A/F5.3.4-1

Figure 5.3.4-1. LWD Jumper

5.3.5 Enable Other Board Ready Jumper

This jumper, JF, is a two position jumper that allows the user to either enable (ENA) or disable (DIS) the "Other Board Ready" feature of the VMIVME-DR11W-A Board. Figure 5.3.5-1 shows this jumper. The factory selected configuration is the ENA position.

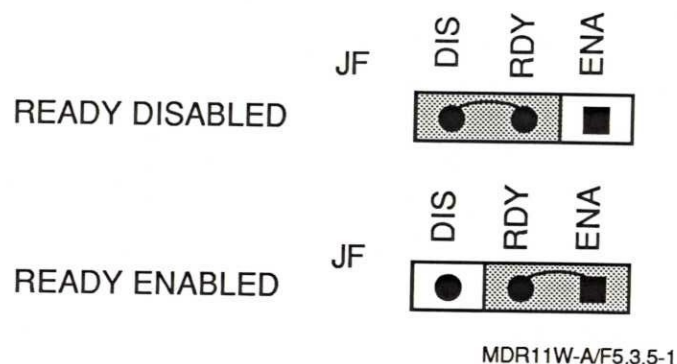


Figure 5.3.5-1. Other Board READY Jumper

The "Other Board Ready" feature of the VMIVME-DR11W-A Board, when enabled, establishes the condition that the transfer request circuitry will wait for the other board's READY H interface signal to transition from a High state to a Low state before allowing the CYCLE REQ A or the CYCLE REQ B input to be recognized as a valid transfer cycle request.

When disabled, the "Other Board Ready" feature causes the transfer request circuitry to ignore the other board's READY H signal when responding to a CYCLE REQ A (or B) transfer cycle request.

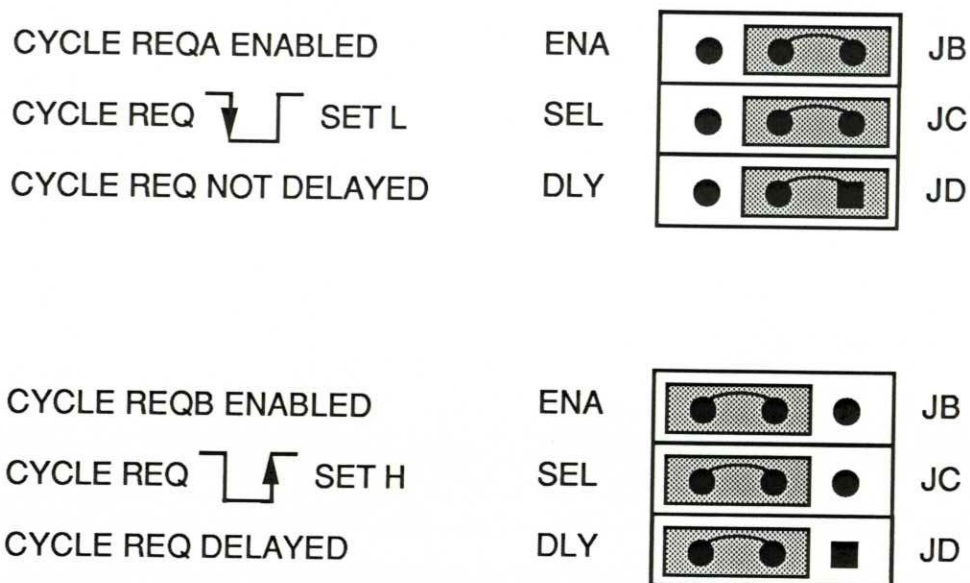
5.3.6 Cycle Request Jumpers

There are three jumpers that affect the operating modes of the Cycle Request logic, jumpers JB, JC, and JD. Refer to Figure 5.3.6-1 for these jumpers.

The enable (ENA) REQA or REQB jumper, JB, allows the user to enable either the CYCLE REQA H or the CYCLE REQB H input signal to be used as the active Cycle Request input signal. Thus, there is no requirement for the user to specially ground the inactive Cycle Request input. The factory setting is REQA enabled.

The select (SEL) H or L jumper, JC, selects between use of the leading (Low going) or the trailing (High going) edge of the enabled CYCLE REQ input signal to set the cycle request flip-flop of the VMIVME-DR11W-A interface. The factory setting is CYCLE REQUEST SET H.

The delay (DLY) jumper, JD, specifies that the active cycle request signal, CYCLE REQA (or CYCLE REQB), be delayed by at least one VMEbus SYS CLK clock cycle before being input to the cycle request logic of the VMIVME-DR11W-A interface. This feature may be invoked to improve noise immunity of the cycle request input circuitry, or to provide an extra clock cycle of skew delay for data presented from the other board's output data signals (DO15 through DO00) while this board is receiving data. The factory setting is CYCLE REQUEST not delayed.



MDR11W-A/F5.3.6-1

Figure 5.3.6-1. Cycle Request Jumper

5.3.7 Busy Delay Clock Jumper

The Busy Delay Clock jumper, JK, is a two position jumper that allows the user to select between two fundamental clock rates for determining the BUSY DELAY selection range. With the jumper in the 8M position, the input clock to the Busy Delay Counter is 8 MHz with a 125 ns (nanosecond) nominal period. This allows selection of a BUSY (deskew) DELAY ranging from 250 ns to 1125 ns (see Section 5.3.8). With the jumper on the 16M position, the Busy Delay Clock is selected to be 16 MHz with a 62.5 ns nominal period resulting in a selection range of 125 ns to 625 ns. Figure 5.3.7-1 shows this jumper with the 16M factory setting selected.

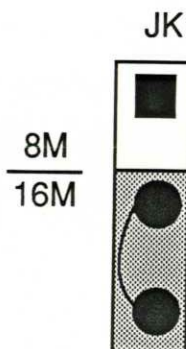


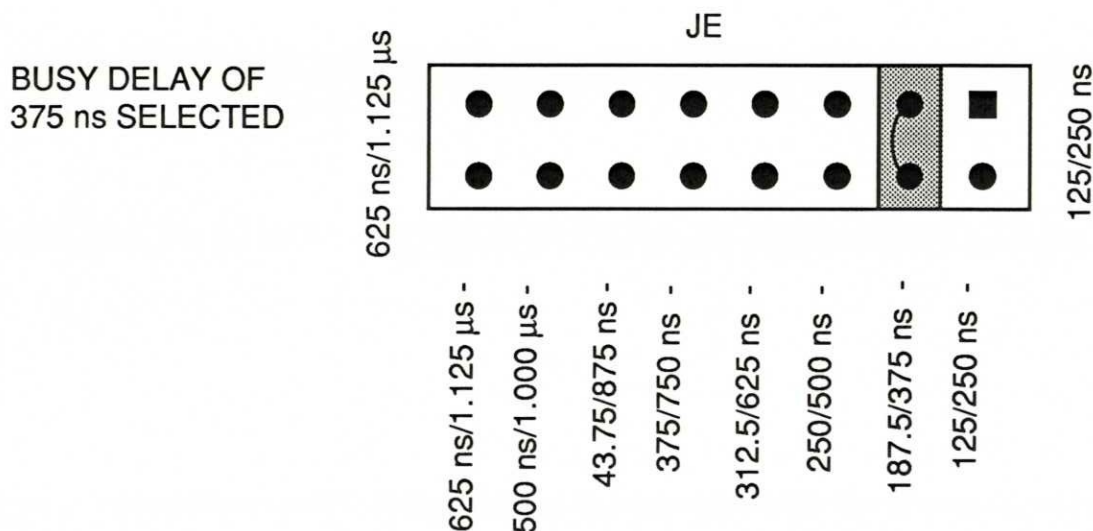
Figure 5.3.7-1. Busy Delay Clock Jumper

MDR11W-A/F5.3.7-1

5.3.8 Busy Delay

The BUSY DELAY jumper, JE, is an eight position jumper that allows the user to adjust the data skew delay on data output transfers. Depending on the Busy Delay Clock setting (see paragraph 5.3.7) chosen by jumper JK, the BUSY DELAY is adjustable in 62.5 ns intervals from 125 ns to 625 ns or in 125 ns intervals from 250 ns to 1125 ns. This delay time represents the minimum amount of delay added from presentation of output data from the Output Register until the BUSY output handshake signal is asserted. Figure 5.3.8-1 shows this jumper set with a 187.5/375 ns skew delay selected (the factory setting).

The longer duration delay range facilitates interfacing with user devices requiring relatively long data deskew times such as that required for the DEC DRV11W interface module. The shorter duration delay range accommodates the much shorter minimum data deskew delay requirement of the DEC DR11W as well as other user interfaces with relatively short data deskew delay time requirements. The 125 ns minimum BUSY DELAY can be useful in a controlled environment to maximize the data transfer rate between two VMIVME-DR11W-A Interface Boards in a back-to-back interface application.



MDR11W-A/F5.3.8-1

Figure 5.3.8-1. BUSY DELAY Jumper

5.4 ADDRESS MODIFIERS

The board is factory-configured via a programmed PAL to respond to either of four address modifier codes in the VMEbus slave short and standard I/O address space: short supervisory (\$2D), and short nonprivileged access (\$29), or standard supervisory access (\$3D), and standard nonprivileged (\$39). Figure 5.3-1 shows the location of the address modifier PAL. Figure 5.3.3-1 shows JH jumper used for selection of short I/O space or standard I/O space.

5.5 I/O CABLES

5.5.1 User Interface Cables

The VMIVME-DR11W-A provides a TTL compatible user interface that is terminated in 120 Ω via 180/390 Ω terminating resistors. The VMIVME-DR11W-A may be connected to external devices, or to another VMIVME-DR11W-A using up to fifty (50) foot (15.2m) cables if the following guidelines are followed:

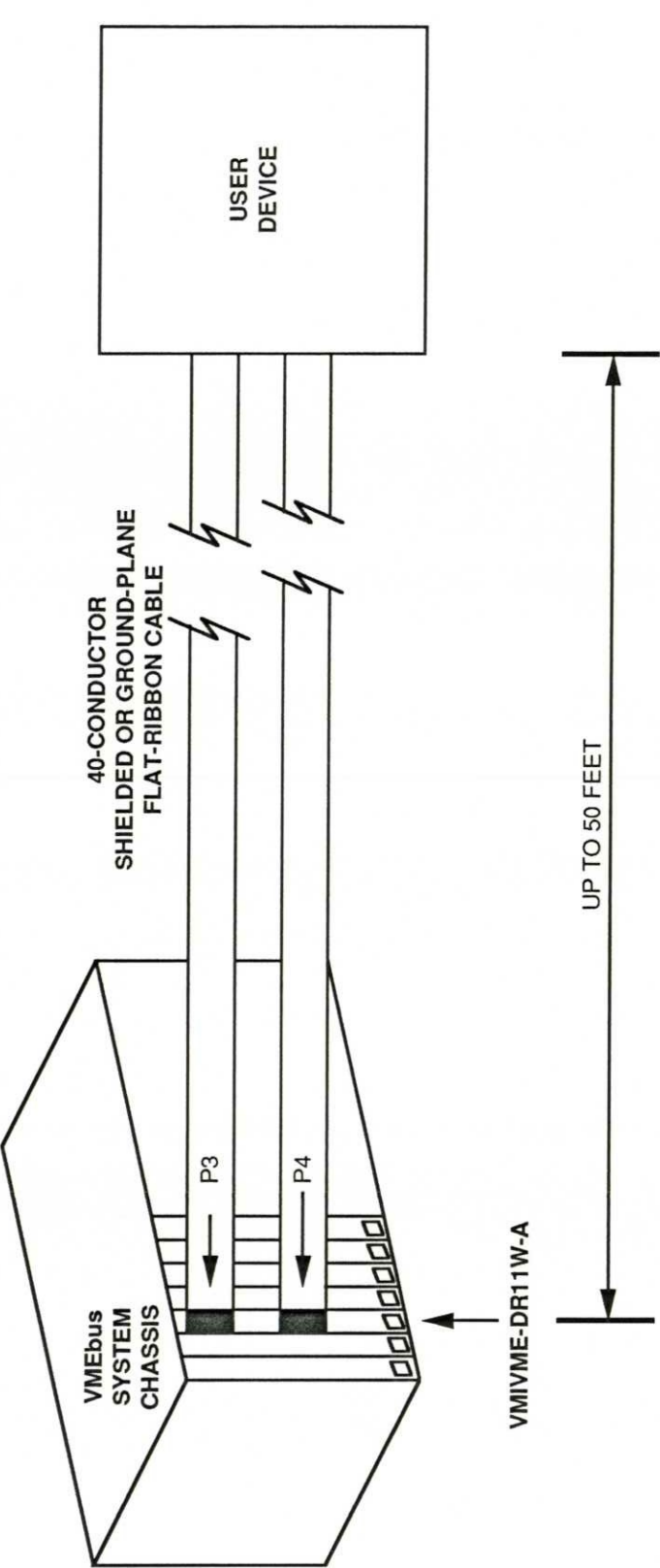
1. Shielded or ground-plane flat-cable (or superior cable) must be used. Mass-terminated unshielded flat-cable will cause data errors. A cable with individually shielded conductors or a signal/ground wire pair for each signal (40 pairs) should provide best results.
2. The cable shield must be grounded at both ends of the interface cable if a shielded cable is used. The cable grounds should have low impedance at high frequencies.
3. Shielded flat-cables typically have the shield connected to pin 1; therefore, pin 1 of the cable must connect to pin 40 of the connector (because the standard DR11W pin-out has data bit 15 tied to pin 1).
4. A special cable is required for the Macrolink interface. The interface on the Macrolink side requires that pin 1 on the connector connects to pin 1 of the cable and pin 40 of the connector connects to pin 40 of the cable.

Refer to Figures 5.5.1-1, 3.1-2, and 3.1-3 for proper cable connection to the user device. To connect two VMIVME-DR11W's back-to-back, P3 should be connected to P4 on the other device, and P4 should be connected to P3 on the other device.

The VMIVME-DR11W-A is pinout compatible with DR11-W and DRV-11B type devices. It is NOT pinout compatible with DR11-B type devices and damage may result if it is cabled directly to a DR11-B type device.

5.5.2 Macrolink Pin Number Reversal

The Macrolink DR11W compatible interface has pin 1 of the connector connected to ground and pin 40 connected to data bit 15. The special cable required can be ordered from VMIC.



MDR11W-A/F5.5.1-1

Figure 5.5.1-1. System Interconnection Pictorial Diagram

5.5.3 Pin Number Reversal Through Bulkhead Connector

If two flat cables are mated together by back-to-back male connectors, a pin number reversal will occur, i.e., the odd numbered conductors will be swapped with the even numbered conductors. Therefore, if the Digital Equipment Corporation DC06 cable kit is utilized, the short pin number reversing cable (in the kit) must be installed to correct the pin number reversal.

5.6 CABLE CONNECTOR

A compatible cable connector for the VMIVME-DR11W-A is Panduit No. 050-040-455. Strain relief Panduit No. is 100-000-058.

5.7 USER CONNECTOR PIN ASSIGNMENTS

User connector pin assignments and signal names are shown in Table 5.7-1.

5.8 INSTALLATION

The VMIVME-DR11W-A is compatible with any VMEbus chassis which can accept double Eurocard form factor boards with front panels. The board requires that the P2 backplane and memory be capable of supporting 32-bit transfers. Two captive screws are provided on the front panel to secure the board to the chassis, and handles are provided for removal and installation. A VMEbus CPU that is capable of supporting either 16-bit or 32-bit transfers to either standard or short I/O address space is desirable.

Table 5.7-1. Connector Pin Assignments

CONNECTOR P3			
PIN	SIGNAL	PIN	SIGNAL
1 VV	D0 15 H	21 X	END CYCLE H
2 UU	D0 00 H	22 W	GND
3 TT	D0 14 H	23 V	STATUS C H
4 SS	D0 01 H	24 U	GND
5 RR	D0 13 H	25 T	STATUS C H
6 PP	D0 02 H	26 S	GND
7 NN	D0 12 H	27 R	STATUS B H
8 MM	D0 03 H	28 P	GND
9 LL	D0 11 H	29 N	INIT H
10 KK	D0 04 H	30 M	GND
11 JJ	D0 10 H	31 L	STATUS A H
12 HH	D0 05 H	32 K	BURST RQ L
13 FF	D0 09 H	33 J	WC INC ENB H*
14 EE	D0 06 H	34 H	GND
15 DD	D0 08 H	35 F	READY H
16 CC	D0 07 H	36 E	GND
17 BB	GND	37 D	ACLO FNCT 2 H
18 AA	GND	38 C	GND
19 Z	CYCLE RQB H	39 B	CYCLE RQA H
20 Y	GND	40 A	GND

CONNECTOR P4			
PIN	SIGNAL	PIN	SIGNAL
1 VV	DI 15 H	21 X	GO H
2 UU	DI 00 H	22 W	GND
3 TT	DI 14 H	23 V	FNCT 1 H
4 SS	DI 01 H	24 U	GND
5 RR	DI 13 H	25 T	C1 H
6 PP	DI 02 H	26 S	GND
7 NN	DI 12 H	27 R	FNCT 2 H
8 MM	DI 03 H	28 P	GND
9 LL	DI 11 H	29 N	CO H*
10 KK	DI 04 H	30 M	GND
11 JJ	DI 10 H	31 L	FNCT 3 H
12 HH	DI 05 H	32 K	FNCT 3 H
13 FF	DI 09 H	33 J	BA IND ENB H*
14 EE	DI 06 H	34 H	GND
15 DD	DI 08 H	35 F	AOO H***
16 CC	DI 07 H	36 E	GND
17 BB	GND	37 D	ATTN H
18 AA	GND	38 C	GND
19 Z	GND	39 B	BUSY**
20 Y	GND	40 A	GND

*Not utilized by or necessary for operation of DR11W link.

**See Section 5.3.1 for polarity selection.

***Becomes "Other Board Ready" on-board.

MDR11W-A/T5.7-1

SECTION 6

MAINTENANCE AND WARRANTY

6.1 MAINTENANCE

This section of the technical manual provides information relative to the care and maintenance of VMIC's products. Should the products malfunction, the user should verify the following:

- a. Software
- b. System configuration
- c. Electrical connections
- d. Jumper or configuration options
- e. Boards fully inserted into their proper connector location
- f. Connector pins are clean and free from contamination
- g. No components of adjacent boards are disturbed when inserting or removing the board from the VMEbus card cage
- h. Quality of cables and I/O connections

User level repairs are not recommended. Contact VMIC for a Return Material Authorization (RMA) Number. This RMA Number must be obtained prior to any return.

6.2 MAINTENANCE PRINTS

The appendix(ices) to this manual contain(s) drawings and diagrams for reference purposes.

6.3 WARRANTY

VMIC's Standard Products are warranted to be free from defects in material and workmanship for a period of two years (24 months) from the date of shipment. In discharge of this warranty, VMIC, at its option, agrees to either repair or replace, at VMIC's facility and at VMIC's discretion, any part, component, subassembly accessory, or any hardware, software, or system product, which under proper and normal use proves defective in material and workmanship.

The customer shall provide notice to VMIC of each such defect within a reasonable time after the customer's discovery of such defect.

In order to return the defective product(s) or part(s), the customer must contact VMIC's Customer Service Department to obtain a Call Ticket Number. The

defective product(s) or part(s) must also be properly boxed and weighed. After a VMIC Call Ticket Number and RMA Number have been obtained, the defective product(s) or part(s) may be returned (transportation collect for surface UPS) to VMIC. Any replaced or repaired product(s) or part(s) will be shipped back to the customer's at the expense of VMIC (also UPS surface).

The customer should be aware that the above process can sometimes take up to eight (8) days for the shipment to reach VMIC. The customer has the option to ship the defective product(s) or part(s) at the customer's own expense if the customer cannot afford this possible delay.

There shall be no warranty or liability on any VMIC product(s) or part(s) that is (are) damaged or subjected to accident(s), perils of nature, negligence, overtemperature, overvoltage, misapplication of electrical power, insertion or removal of boards from backplanes and/or I/O connectors with power applied by the customer(s), appointee(s), or any other person(s) without the expressed approval of VMIC.

Final determination of warranty eligibility shall be made by VMIC, and if a warranty claim is considered invalid for any reason, the customer will be charged for services performed and expenses incurred by VMIC in repair, handling and shipping the returned product or part. Determination as to whether the item is within warranty, coverage shall not be unreasonably withheld.

The warranty period of the replacement or repaired product(s) or part(s) shall terminate with the termination of the warranty period with respect to the original product(s) or part(s) for all replacement parts supplied or repairs made during the original warranty period.

THE FOREGOING WARRANTY AND REMEDY ARE EXCLUSIVE AND VMIC SHALL HAVE NO OTHER OR ADDITIONAL LIABILITY TO BUYER OR TO ANYONE CLAIMING UNDER BUYER (THIRD PARTY) UNDER ANY OTHER AGREEMENT OR WARRANTY, EXPRESS OR IMPLIED EITHER IN FACT OR BY OPERATION OF THE LAW, INCLUDING ANY IMPLIED WARRANTY OF MERCHANTABILITY OR FITNESS, STATUTORY, OR OTHERWISE. VMIC SHALL HAVE NO LIABILITY FOR SPECIAL OR CONSEQUENTIAL DAMAGES OF ANY KIND OR FROM ANY CAUSE ARISING OUT OF THE INSTALLATION OR USE OF ANY PRODUCT FURNISHED HEREUNDER.

6.4 OUT-OF-WARRANTY REPAIR POLICY

The following sections describe VMIC's policy on repairs and warranties on repaired products.

6.4.1 Repair Category

VMIC's repair policy of standard products is divided into two categories, depending on the item to be repaired. These categories are:

- a. Product Exchange
- b. Fixed Price Repair

Category 1 (product exchange) represents the fastest turn around of the two categories. In this case, the customer sends the malfunctioning product to VMIC. VMIC will return an operational product to the customer within 72 hours of receipt provided VMIC has the product in stock.

Provided that the returned product is repairable customers should contact VMIC prior to returning products for repair to determine stocking status.

Category 2 (Fixed Price Repair) applies to products returned to VMIC for repair and subsequent return to the customer.

Return authorizations are required on all product repairs, and all purchase orders should refer to VMIC's RMA Number which is assigned by VMIC's Customer Service Department.

6.4.2 Repair Pricing

Contact your factory representative for repair pricing. Current pricing can be found in the Repair and Replacement Policy in the most current Standard Conditions of Sales Document (F0109-91). Refer to exclusions (Section 6.4.7).

6.4.3 Payment

Payment is due upon delivery or at VMIC's option, net thirty (30) days from the date of delivery. Payment should be made to:

VME Microsystems International Corporation
12090 South Memorial Parkway
Huntsville, Alabama 35803-3308
Attention: Accounts Receivable

VMIC allows a one (1) percent discount for payment made within ten (10) days of invoice date or a two (2) percent discount on payment made prior to shipment of order. This payment discount, however, does not apply to freight.

6.4.4 Shipping Charges

Shipping charges are the customer's responsibility, with the exception of warranty repairs, whereby VMIC will pay the return to customer shipping charges.

6.4.5 Shipping Instructions

The type of packaging used to ship the product depends on whether the product is shipped singly, in a chassis, or packaged with other boards. The shipper should carefully pack the product(s), using the same precautions listed in the "unpacking procedures". The user should utilize the same (or equivalent) protective packaging container for re-shipment as provided by VMIC. Approved ESD procedures are recommended when handling VMIC's products.

6.4.6 Warranty on Repairs

Products repaired by VMIC are warranted against defects in workmanship and material for a period of ninety (90) days from date of shipment to the customer for all products that were repaired out of warranty. See Standard Conditions of Sale for products repaired within the warranty.

6.4.7 Exclusions

Repair rates may not apply to products which have received unusual physical or electrical damage. In such cases, VMIC will provide an estimated price for product repair or replacement. The customer may then choose to have the product repaired at the estimated price, returned unrepaired at no charge, or replaced at VMIC's current list price.

APPENDIX A

**ASSEMBLY DRAWING, PARTS LIST,
AND SCHEMATIC**

APPENDIX B

INTEGRATED CIRCUIT SPECIFICATIONS

DESCRIPTION

PART NO.

Bus Interrupter Module

MC68153

Direct Memory Access
Interface (DMAI)

SCB68430

**MOTOROLA**

SEMICONDUCTORS

P.O. BOX 20912 • PHOENIX, ARIZONA 85036

Advance Information

BUS INTERRUPTER MODULE

The bipolar LSI MC68153 Bus Interrupter interfaces a micro-computer system bus to multiple slave devices requiring interrupt capabilities. It handles up to 4 independent sources of interrupt requests and is fully programmable.

- VERSAbus/VMEbus Compatible
- MC68000 Compatible
- Handles 4 Independent Interrupt Sources
- 8 Programmable Read/Write Registers
- Programmable Interrupt Request Levels
- Programmable Interrupt Vectors
- Supports Interrupt Acknowledge Daisy Chain
- Control Registers Contain Flag Bits
- Single +5.0 Volt Supply
- Total Power Dissipation = 1.5 W Typical
- Temperature Range of 0°C to 70°C
- Chip Access Time = 200 ns Typical with 16 MHz Clock
- 40-Pin Dual-In-Line Package

MC68153**TTL**

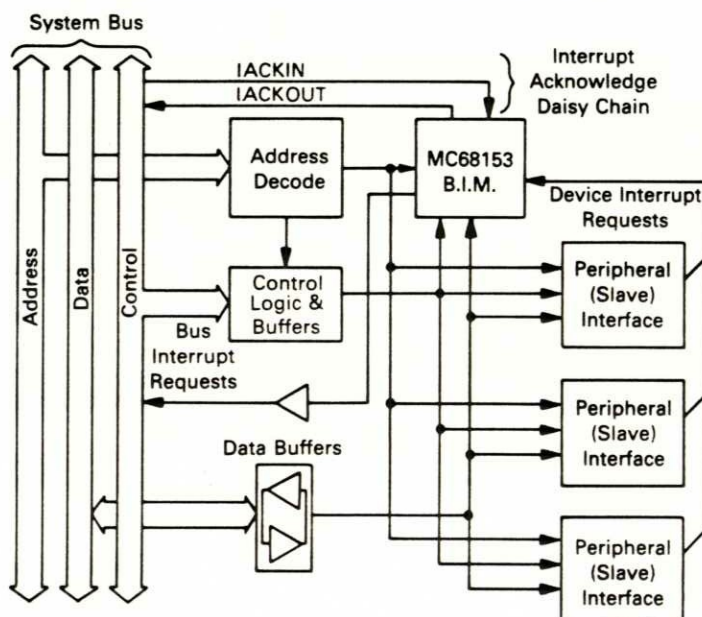
BUS INTERRUPTER MODULE

ADVANCED LOW POWER SCHOTTKY

P SUFFIX
PLASTIC PACKAGE
CASE 711-03



L SUFFIX
CERAMIC PACKAGE
CASE 734-04

FIGURE 1 — MC68153 SYSTEM BLOCK DIAGRAM

VERSAbus is a trademark of Motorola.

PIN ASSIGNMENTS

VCC	1	40	A3
R/W	2	39	A2
CS	3	38	A1
DTACK	4	37	D7
IACK	5	36	D6
IACKIN	6	35	D5
IACKOUT	7	34	D4
IRQ1	8	33	D3
GND	9	32	D2
GND	10	31	GND
VCC	11	30	VCC
IRQ2	12	29	D1
IRQ3	13	28	D0
IRQ4	14	27	INTAE
IRQ5	15	26	INTAL1
IRQ6	16	25	INTAL0
IRQ7	17	24	INT3
CLK	18	23	INT2
INT0	19	22	INT1
GND	20	21	VCC

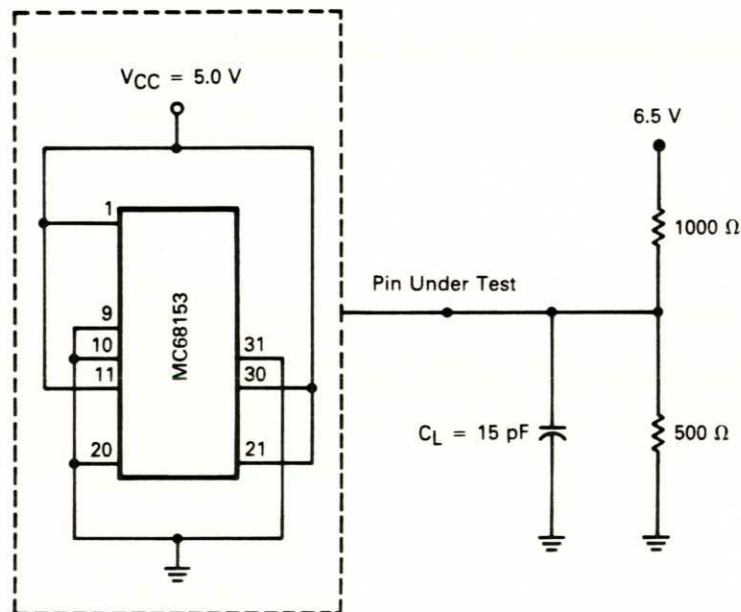
ABSOLUTE MAXIMUM RATINGS (Beyond which useful life may be impaired.)

Parameter	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.5 to +7.0	V
Input Voltage	V_{in}	-0.5 to +7.0	V
Input Current	I_{in}	-30 to +5.0	mA
Output Voltage	V_{out}	-0.5 to +5.5	V
Output Current	I_{OL}	Twice Rated I_{OL}	mA
Storage Temperature	T_{stg}	-65 to +140	°C
Junction Operating Temperature	T_J	-55 to +140	°C

BURN-IN LIMITS: A maximum T_J of +175°C may be used for periods not to exceed 250 hours.

DC ELECTRICAL SPECIFICATIONS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $T_A = 0^\circ\text{C}$ to 70°C)

Parameter	Symbol	Min	Max	Unit	Test Conditions
High Level Input Voltage	V_{IH}	2.0	—	V	
Low Level Input Voltage	V_{IL}	—	0.8	V	
Input Clamp Voltage	V_{IK}	—	-1.5	V	$V_{CC} = \text{MIN}$, $I_{IN} = -18 \text{ mA}$
High Level Output Voltage ⁽¹⁾	V_{OH}	2.7	—	V	$V_{CC} = \text{MIN}$, $I_{OH} = -400 \mu\text{A}$
Low Level Output Voltage	V_{OL}	—	0.4	V	$V_{CC} = \text{MIN}$, $I_{OL} = 8.0 \text{ mA}$
Output Short Circuit Current ⁽²⁾	I_{OS}	-15	-130	mA	$V_{CC} = \text{MAX}$, $V_{OUT} = 0 \text{ V}$
High Level Input Current	I_{IH}	—	20	μA	$V_{CC} = \text{MAX}$, $V_{IN} = 2.7 \text{ V}$
Low Level Input Current	I_{IL}	—	-0.4	mA	$V_{CC} = \text{MAX}$, $V_{IN} = 0.4 \text{ V}$
Supply Current	I_{CC}	225	385	mA	$V_{CC} = \text{MAX}$
Output Off Current (High)	I_{OZH}	—	20	μA	$V_{CC} = \text{MAX}$, $V_{OUT} = 2.4 \text{ V}$
Output Off Current (Low)	I_{OZL}	—	-20	μA	$V_{CC} = \text{MAX}$, $V_{OUT} = 0.4 \text{ V}$

AC TEST CIRCUIT — AC Testing of All Outputs

NOTES:

1. Not applicable to open-collector outputs.
2. Not more than one output should be shorted at a time for longer than one second.
3. \overline{CS} Low to CLK High (Setup Time) of 15 ns Min must be observed.
4. \overline{IACK} Low to CLK High and \overline{IACKIN} Low to CLK High (Setup Times) of 15 ns Min must be observed.
5. See Table 1 for additional performance guidelines.



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AC ELECTRICAL SPECIFICATIONS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $T_A = 0^\circ\text{C}$ to 70°C)

Parameter	Test Number(5)	Max (ns)
CLK High to Data Out Valid (Delay)(3)	1	55
CLK High to DTACK Low (Delay)(3)	2	40
\overline{CS} High to DTACK High (Delay)	3	35
CLK High to Data Out Valid (Delay)(4)	4	55
CLK High to INTAE Low (Delay)(4)	5	40
IACK High to Data Out High Impedance (Delay)	6	60
IACK High to DTACK High (Delay)	7	45
\overline{CS} High to Data Out High (Delay)	8	45
\overline{CS} High to IRQ High (Delay)	9	60
IACK High to INTAE High (Delay)	10	35

GENERAL DESCRIPTION

The MC68153 Bus Interrupter Module (BIM) is designed to serve as an interrupt requester for peripheral devices in a microcomputer system. Up to 4 independent devices can be interfaced to the system bus by the MC68153. Intended for asynchronous master/slave bus operation, the BIM is compatible with VERSAbus, VMEbus, MC68000 device bus, and other system buses. Figure 1 shows a block diagram of a typical configuration. In this example, three peripheral devices (bus slaves) are connected to the system data bus. Each of these devices could be parallel I/O, serial I/O, or some other function. An interrupt request from any device is routed to the MC68153, and the BIM handles all interface to the system bus. It generates a bus interrupt request as a result of the device interrupt request. When the system interrupt handler or processor responds with an interrupt acknowledge cycle, the MC68153 can answer supplying an interrupt vector and handling all timing.

The functional block diagram of the MC68153 is shown in Figure 2. The device contains circuitry to accept four separate interrupt sources ($\overline{INT0}$ – $\overline{INT3}$). Interface to the system bus includes generation of bus interrupt requests ($\overline{IRQ1}$ – $\overline{IRQ7}$), response to a bus interrupt acknowledge cycle (either supplying a vector or passing on a daisy chain signal), and releasing the bus interrupt request signal at the proper time. The BIM has flexibility provided by eight programmable read/write registers. Four 8-bit vector registers ($VR0$ – $VR3$) contain status/address information and supply a byte vector in response to an interrupt acknowledge cycle for the corresponding interrupt source. Four other 8-bit control registers ($CR0$ – $CR3$) contain information that oversees operation of the interrupt circuitry. The control information is programmable and includes interrupt request level and interrupt enable and disable. Also contained in the control registers are flag-bits. These flags are useful for task coordination, resource management, and interprocessor communication.

SIGNAL DESCRIPTION

Throughout the data sheet, signals are presented using the terms asserted and negated independent of whether the signal is asserted in the high voltage or low voltage state. Active low signals are denoted by a superscript bar.

BIDIRECTIONAL DATA BUS — D0 – D7

Pins D0 – D7 form an 8-bit bidirectional data bus to/from the system bus. These are active high, 3-state pins. D7 is the most significant bit.

ADDRESS INPUTS — A1 – A3

These active high inputs serve two functions. One function is to select one of the eight possible registers during a read or write cycle. Secondly, during an interrupt acknowledge A1 – A3 show the level of interrupt being acknowledged, and the BIM uses these to determine if a match exists with an internal level.

CHIP SELECT — \overline{CS}

\overline{CS} is an active low input used to select the BIM's registers for the current bus cycle. Address strobe, data strobe, and appropriate address bits must be included in the chip select equation.

READ/WRITE — $\overline{R/\overline{W}}$

The $\overline{R/\overline{W}}$ input is a signal from the system bus used to determine if the current bus cycle is a read (high) or write (low).

DATA TRANSFER ACKNOWLEDGE — DTACK

DTACK is an open-collector, active low output that signals the completion of a read, write, or interrupt acknowledge cycle. During read or interrupt acknowledge cycles, DTACK is asserted by the MC68153 after data has been provided on the data bus; during write cycles it is asserted after data has been accepted from the data bus. A pullup resistor is required to maintain DTACK high between bus cycles.



FIGURE 2 — MC68153 FUNCTIONAL BLOCK DIAGRAM

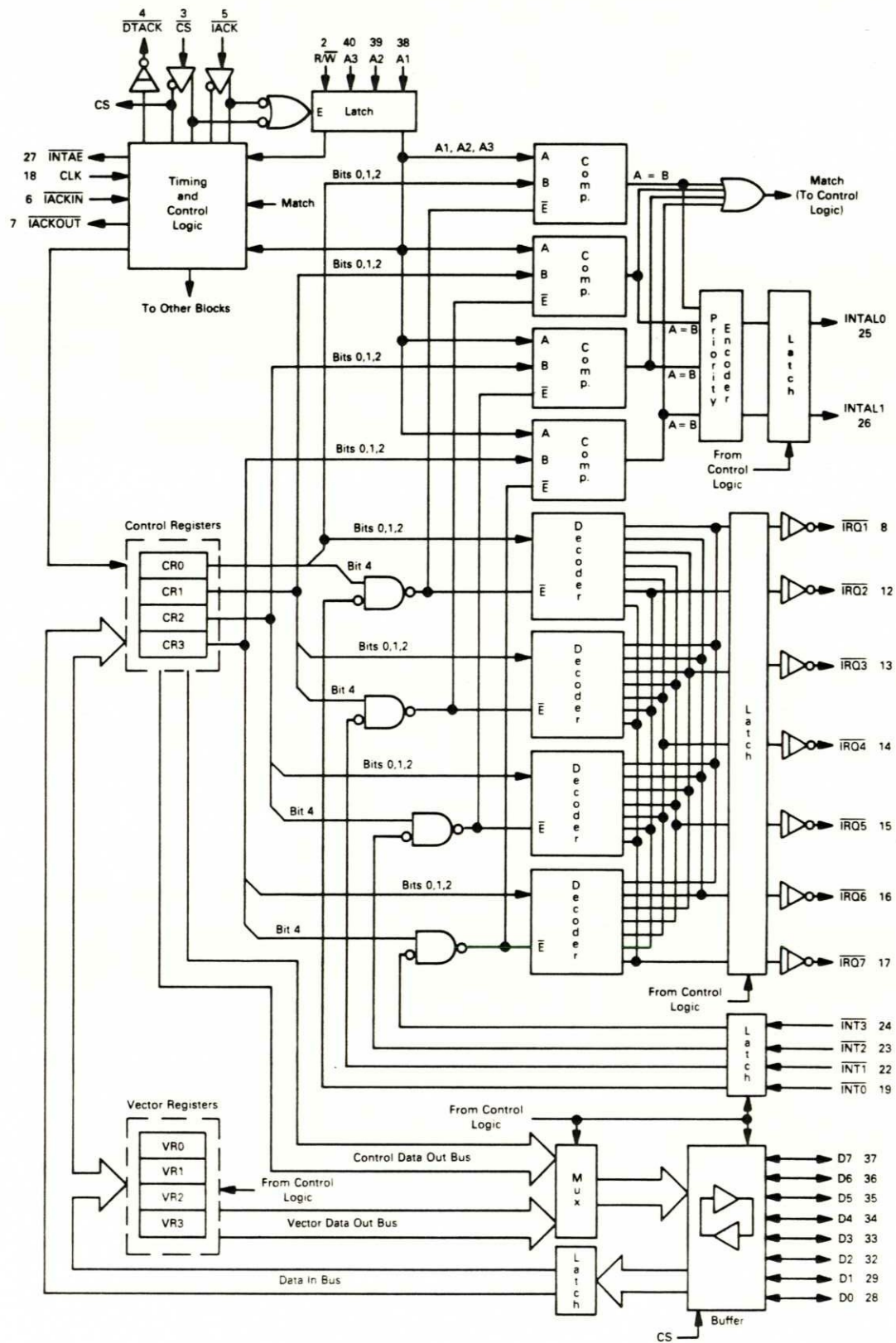
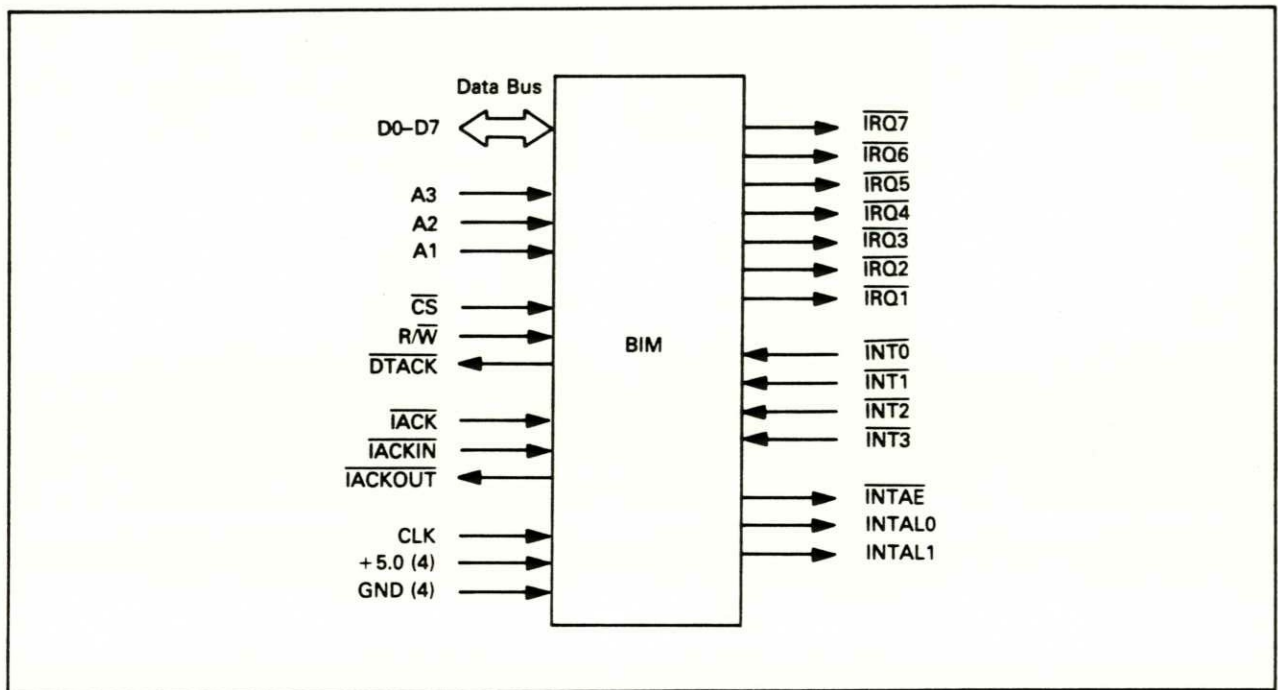


FIGURE 3 — LOGICAL PIN ASSIGNMENT



INTERRUPT ACKNOWLEDGE SIGNALS — $\overline{\text{IACK}}$, $\overline{\text{IACKIN}}$, $\overline{\text{IACKOUT}}$

These three pins support the interrupt acknowledge cycle. A low level on the $\overline{\text{IACK}}$ input indicates an interrupt acknowledge cycle has been initiated. This signal is conditioned externally with Address Strobe and the lower data strobe of an MC68000 type bus. After $\overline{\text{IACK}}$ is asserted the BIM compares the interrupt level presented on address lines A1, A2, and A3 with the current levels generated internally and determines if a match exists. Then, if input $\overline{\text{IACKIN}}$ is asserted (driven low), the BIM will either complete the interrupt acknowledge cycle if a match exists or assert output $\overline{\text{IACKOUT}}$ if no match exists.

$\overline{\text{IACKIN}}$ and $\overline{\text{IACKOUT}}$ form part of a prioritized interrupt acknowledge daisy chain. The daisy chain prioritizes interrupters and guarantees that two or more devices requesting an interrupt on the same level will not respond to the same cycle. The requesting device (or interrupter) must wait until $\overline{\text{IACKIN}}$ is asserted and not pass the signal on (assert $\overline{\text{IACKOUT}}$) if it is to complete the interrupt acknowledge cycle.

BUS INTERRUPT REQUEST SIGNALS — $\overline{\text{IRQ1}}$ – $\overline{\text{IRQ7}}$

These open-collector outputs are low when asserted, indicating a bus interrupt is requested at the corresponding level. An open-collector buffer is normally required for sufficient drive when interfacing to a system bus. A pullup resistor is required to maintain $\overline{\text{IRQ1}}$ – $\overline{\text{IRQ7}}$ high between interrupt requests.

DEVICE INTERRUPT REQUEST SIGNALS — $\overline{\text{INT0}}$ – $\overline{\text{INT3}}$

$\overline{\text{INT0}}$ – $\overline{\text{INT3}}$ are active low inputs used to indicate to the BIM that a device wants a bus interrupt.

INTERRUPT ACKNOWLEDGE ENABLE — $\overline{\text{INTAE}}$

During an interrupt acknowledge cycle, this output pin is asserted low to indicate that outputs $\overline{\text{INTAL0}}$ and $\overline{\text{INTAL1}}$ are valid. These two outputs contain an encoded number (x) corresponding to the interrupt ($\overline{\text{INTx}}$) being acknowledged. This feature can be used to signal interrupting devices, which supply their own vector, when to respond to the interrupt acknowledge cycle with the vector and a $\overline{\text{DTACK}}$ signal.

INTERRUPT ACKNOWLEDGE LEVEL — $\overline{\text{INTAL0}}$, $\overline{\text{INTAL1}}$

These active high outputs contain an encoded number corresponding to the interrupt level being acknowledged. They are valid only when $\overline{\text{INTAE}}$ is asserted low.

CLOCK — CLK

The CLK input is used to supply the clock for internal operations of the MC68153.

RESET — $\overline{\text{CS}}$, $\overline{\text{IACK}}$

Although a reset input is not supplied, an on-board reset is performed if $\overline{\text{CS}}$ and $\overline{\text{IACK}}$ are asserted simultaneously.



FIGURE 4 — MC68153 REGISTER MODEL

ADDRESS BIT											REGISTER NAME
A3	A2	A1	FLAG	FLAG AUTO-CLEAR	EXTERNAL/INTERNAL	INTERRUPT ENABLE	INTERRUPT AUTO-CLEAR	INTERRUPT LEVEL			
0	0	0	F	FAC	X/IN	IRE	IRAC	L2	L1	L0	CONTROL REGISTER 0
0	0	1	F	FAC	X/IN	IRE	IRAC	L2	L1	L0	CONTROL REGISTER 1
0	1	0	F	FAC	X/IN	IRE	IRAC	L2	L1	L0	CONTROL REGISTER 2
1	1	1	F	FAC	X/IN	IRE	IRAC	L2	L1	L0	CONTROL REGISTER 3
1	0	0	V7	V6	V5	V4	V3	V2	V1	V0	VECTOR REGISTER 0
1	0	1	V7	V6	V5	V4	V3	V2	V1	V0	VECTOR REGISTER 1
1	1	0	V7	V6	V5	V4	V3	V2	V1	V0	VECTOR REGISTER 2
1	1	1	V7	V6	V5	V4	V3	V2	V1	V0	VECTOR REGISTER 3
			7	6	5	4	3	2	1	0	REGISTER BIT
											REGISTER NAME

REGISTER DESCRIPTION

The MC68153 contains 8 programmable read/write registers. There are four control registers (CR0 – CR3) that govern operation of the device. The other four (VR0 – VR3) are vector registers that contain the vector data used during an interrupt acknowledge cycle. Figure 4 illustrates the device register model.

CONTROL REGISTERS

There is a control register for each interrupt source, i.e., CR0 controls $\overline{INT0}$, CR1 controls $\overline{INT1}$, etc. The control registers are divided into several fields:

1. Interrupt level (L2, L1, L0) — The least significant 3-bit field of the register determines the level at which an interrupt will be generated:

L2	L1	L0	IRQ LEVEL
0	0	0	DISABLED
0	0	1	IRQ1
0	1	0	IRQ2
0	1	1	IRQ3
1	0	0	IRQ4
1	0	1	IRQ5
1	1	0	IRQ6
1	1	1	IRQ7

A value of zero in the field disables the interrupt.

2. Interrupt Enable (IRE) — This field (Bit 4) must be set (high level) to enable the bus interrupt request associated with the control register. Thus, if the \overline{INTX} line is asserted and IRE is cleared, no interrupt request (\overline{IRQX}) will be asserted.
3. Interrupt Auto-Clear (IRAC) — If the IRAC is set (Bit 3), IRE (Bit 4) is cleared during an interrupt acknowledge cycle responding to this request. This action of

clearing IRE disables the interrupt request. To re-enable the interrupt associated with this register, IRE must be set again by writing to the control register.

4. External/Internal (X/IN) — Bit 5 of the control register determines the response of the MC68153 during an interrupt acknowledge cycle. If the X/IN bit is clear (low level) the BIM will respond with vector data and a \overline{DTACK} signal, i.e., an internal response. If X/IN is set, the vector is not supplied and no \overline{DTACK} is given by the BIM, i.e., an external device should respond.
5. Flag (F) — Bit 7 is a flag that can be used in conjunction with the test and set instruction of the MC68000. It can be changed without affecting chip operation. It is useful for processor-to-processor communication and resource allocation.
6. Flag Auto-Clear (FAC) — If FAC (Bit 6) is set, the Flag bit is automatically cleared during an interrupt acknowledge cycle.

VECTOR REGISTERS

Each interrupt input has its own associated vector register. Each register is 8 bits wide and supplies a data byte during its interrupt acknowledge cycle if the associated External/Internal (X/IN) control register bit is clear (zero). This data can be status, identification, or address information depending on system usage. The information is programmed by the system user.

DEVICE RESET

When the MC68153 is reset, the registers are set to a known condition. The control registers are set to all zeros (low). The vector registers are set to \$0F. This value is the MC68000 vector for an uninitialized interrupt vector.



FUNCTIONAL DESCRIPTION

SYSTEM OVERVIEW

The MC68153 can be used with many system buses, however, it is primarily intended for VMEbus, VERSAbus and MC68000 applications. Figure 5 shows a system configuration similar to VMEbus. In the figure only one system Data Transfer Bus (DTB) master is used. The Priority Interrupt structure provides a means for peripheral slave devices to ask for an interrupt of other processor (DTB master) activity and receive service from the processor. The MC68153 BIM acts as an interface device requesting and responding to interrupt acknowledge cycles for up to 4 independent slaves.

In Figure 5, functional modules are identified as Interrupters and an Interrupt Handler. An Interrupter (such as the MC68153) receives slave requests for an interrupt and handles all interface to the system bus required to ask for and respond to interrupt requests. The Interrupt Handler receives the bus interrupt requests, determines when an interrupt acknowledge will occur and at which level, and finally either performs the interrupt acknowledge (IACK) cycle or tells the DTB master to execute the IACK cycle.

The signal lines in the Priority Interrupt structure include (* — indicates active low):

1. IRQ1*–IRQ7* — seven prioritized interrupt request lines.
 2. IACK* — signal line that indicates an interrupt acknowledge cycle is occurring.
 3. IACKIN*/IACKOUT* — two signals that form part of a daisy chain that prioritizes interrupters.
- In addition Data Transfer Bus control signals are involved in the IACK bus cycle:
1. AS* — the Address Strobe asserted low indicates a valid address is on the bus.
 2. DSO* — the lower Data Strobe asserted low indicates a data transfer will occur on bus bits D00–D07.
 3. WRITE* — the Read/Write is negated indicating the data is to be read from the Interrupter.
 4. A01–A03 — Address lines A01–A03 contain the encoded priority level of the IACK cycle.
 5. D00–D07 — Data bus lines D00–D07 are used to pass the interrupt vector from the responding Interrupter to the Interrupt Handler.
 6. DTACK* — Data Transfer Acknowledge asserted low signals that the Interrupter has put the vector on the data bus.

FIGURE 5 — SIMPLE VMEbus CONFIGURATION

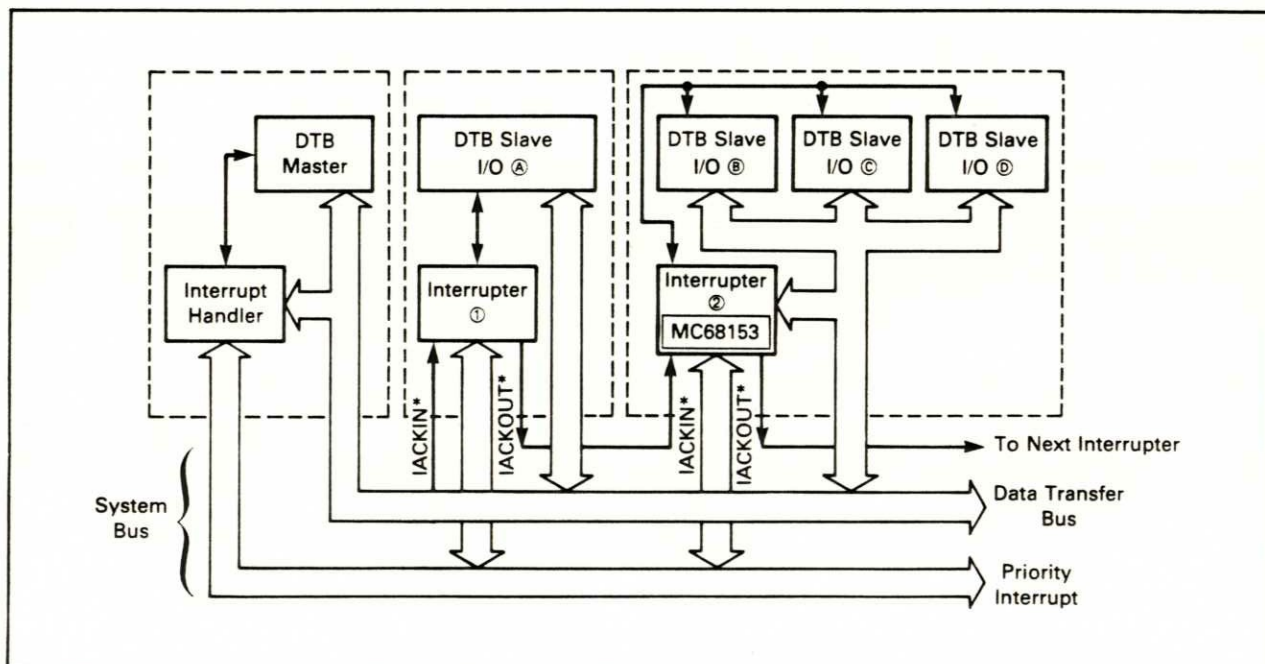
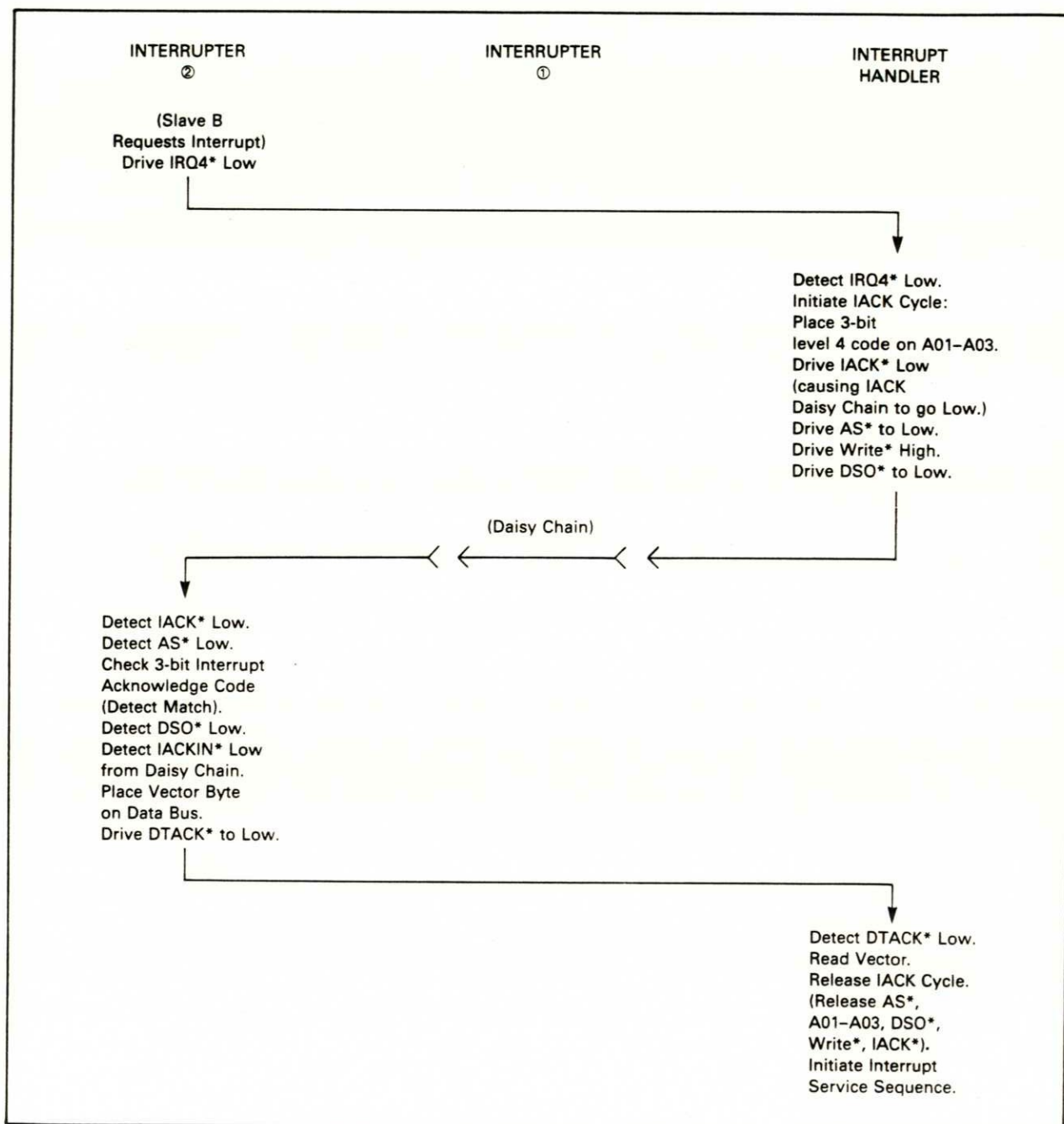


Figure 6 shows a flow diagram of a typical interrupt request and acknowledge operation. Briefly, the sequence of events is first, an Interrupter makes a request, next the Handler responds with an IACK cycle, then the Interrupter passes a vector to the Handler completing the IACK cycle, and finally the Handler uses the vector to determine additional action. Typically, an interrupt service routine is stored in software and the vector determines where its starting address is stored.

Note the daisy chain operation. If the IACK level (on A01-A03) does not match the Interrupter's request level or if no request is pending, the Interrupter passes the IACKIN* signal on and asserts IACKOUT*. This sequential action automatically prioritizes Requesters on the same level (first one in line with a request pending gets serviced) and prevents two or more Interrupters from responding simultaneously.

FIGURE 6 — INTERRUPT REQUEST AND ACKNOWLEDGE OPERATION FLOW DIAGRAM



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This discussion is a very cursory look at the bus operation. For more details including situations with multiple bus masters, the user is directed to the VMEbus Specification MVMEBS or VERSAbus Specification M68KVBS. Also, the MC68153 can be used with other buses having similar interrupt structures.

BIM BUS INTERFACE

Figure 7 shows a simplified block diagram of the MC68153 interface to VERSAbus or VMEbus. Address Decode and Control Logic are dependent on the application and must be designed to guarantee BIM ac specifications. It is possible in most cases that the decode logic can be shared with the slave devices. Buffers are provided where shown to comply with bus loading and drive specifications. It is also possible that buffers can be shared with the slave bus interface.

READ/WRITE OPERATION

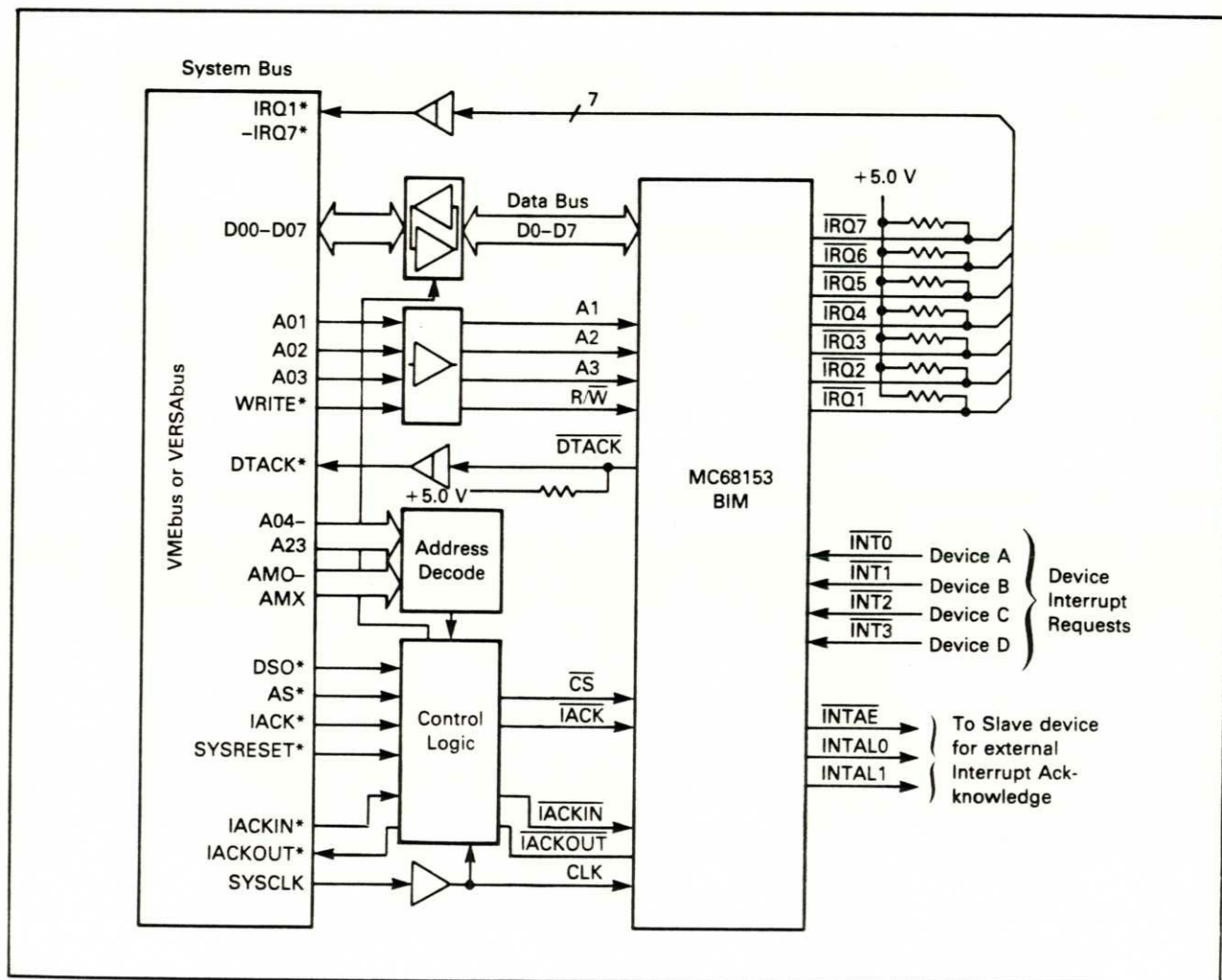
All eight BIM registers can be accessed from the sys-

tem bus in both read and write modes. The BIM has an asynchronous bus interface, primarily designed for MC68000-like buses. The following BIM signals generate read and write cycles: Chip Select (\overline{CS}), Read/Write (R/\overline{W}), Address Inputs (A1–A3), Data Bus (D0–D7), and Data Transfer Acknowledge (\overline{DTACK}). During read and write cycles the internal registers are selected by A1, A2, and A3 in compliance with the Figure 4 Truth Table.

Figure 8 shows the device timing for a read cycle. R/\overline{W} and A1–A3 are latched on the falling edge of \overline{CS} and must meet specified setup and hold times. Chip access time for valid data and \overline{DTACK} are dependent on the clock frequency as shown in the figure.

Figure 9 shows the device timing for a write cycle. R/\overline{W} , A1–A3, and D0–D7 are latched on the falling edge of \overline{CS} and must meet specified setup and hold times. Chip access time for \overline{DTACK} is dependent on the clock frequency as shown in the figure.

FIGURE 7 — VMEbus/VERSAbus INTERFACE BLOCK DIAGRAM



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FIGURE 8 — READ CYCLE

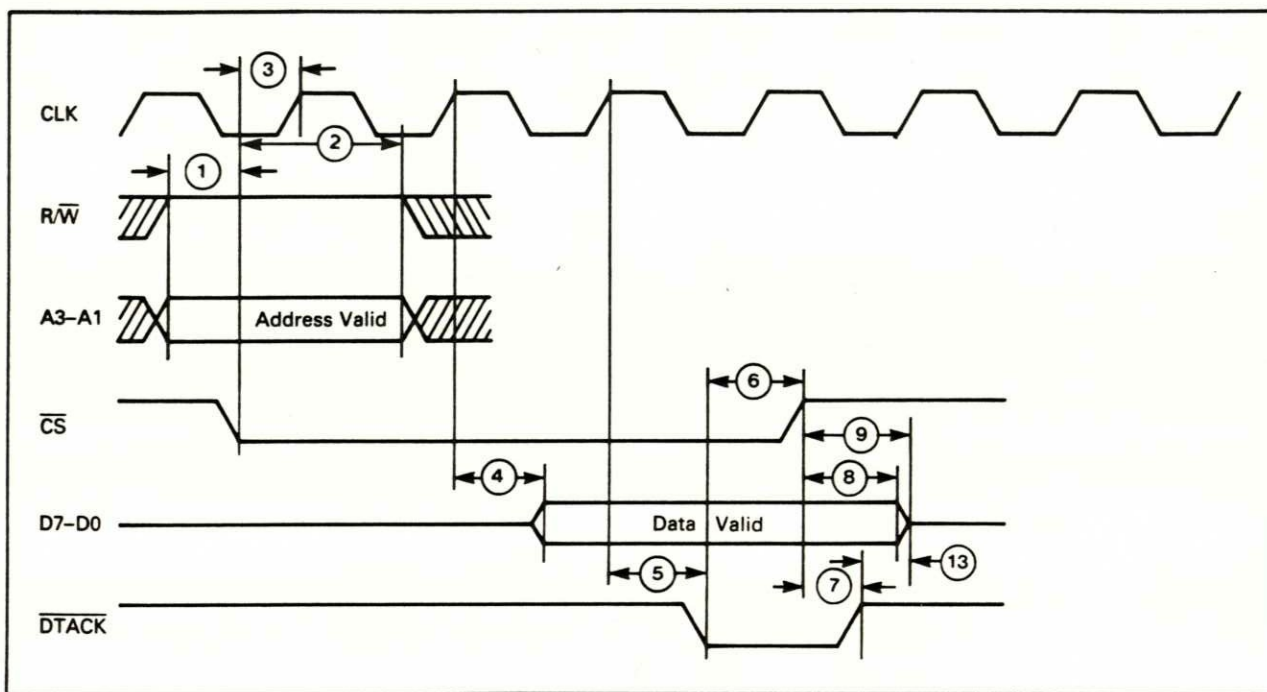
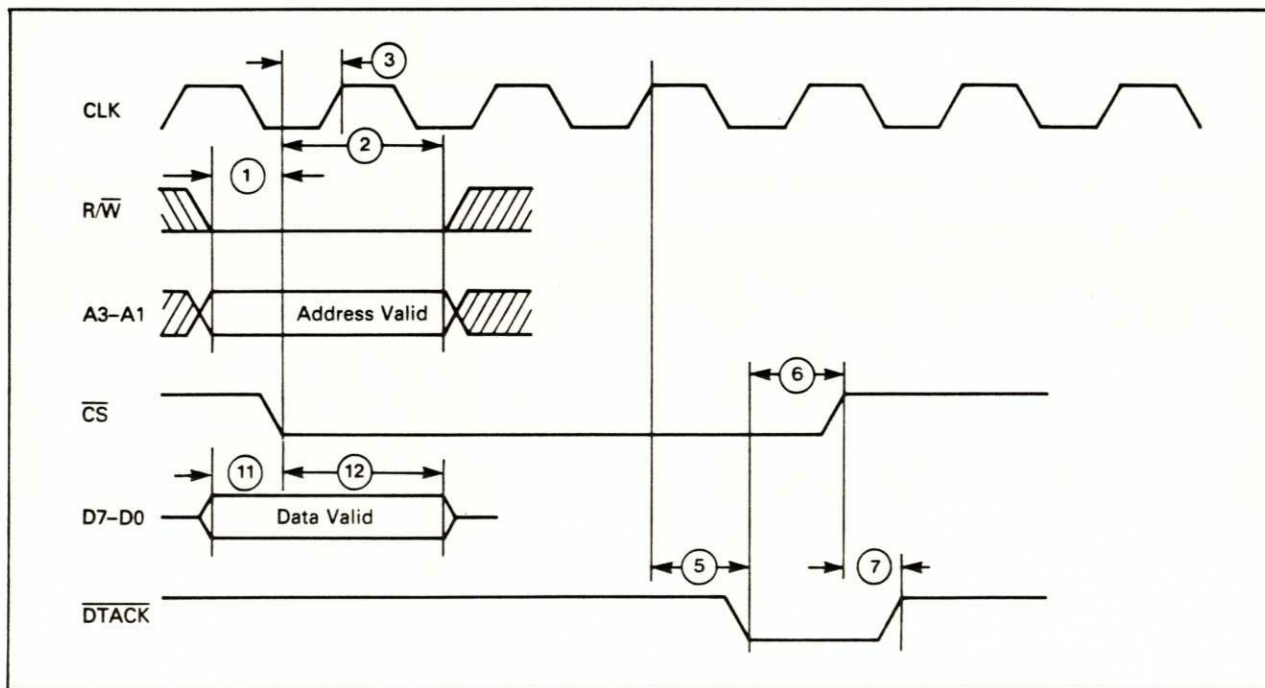


FIGURE 9 — WRITE CYCLE



INTERRUPT REQUESTS

The MC68153 accepts device interrupt requests on inputs $\overline{INT0}$, $\overline{INT1}$, $\overline{INT2}$, and $\overline{INT3}$. Each input is regulated by Bit 4 (IRE) of the associated control register (CR0 controls $\overline{INT0}$, CR1 controls $\overline{INT1}$, etc). If IRE (Interrupt Enable) is set and a device input is asserted, an Interrupt Request open-collector output ($\overline{IRQ1}$ – $\overline{IRQ7}$) is asserted. The asserted \overline{IRQX} output is selected by the value programmed in Bits 0, 1, and 2 of the control register (L0, L1, and L2). This 3-bit field determines the interrupt request level as set by software.

Two or more interrupt sources can be programmed to the same request level. The corresponding \overline{IRQX} output will remain asserted until multiple interrupt acknowledge cycles respond to all requests.

If the interrupt request level is set to zero, the interrupt is disabled because there is no corresponding IRQ output.

INTERRUPT ACKNOWLEDGE

The response of an Interrupt Handler to a bus interrupt request is an interrupt acknowledge cycle. The IACK cycle is initiated in the MC68153 by receiving \overline{IACK} low. R/\overline{W} , A1, A2, A3 are latched, and the interrupt level on line A1–A3 is compared with any interrupt requests pending in the chip. Further activity can be one of four cases:

1. No further action required — This occurs if \overline{IACKIN} is not asserted. Asserting \overline{IACK} only starts the BIM activity. If the daisy chain signal never reaches the MC68153 (\overline{IACKIN} is not asserted), another Interrupter has responded to the \overline{IACK} cycle. The cycle will end, the chip \overline{IACK} is negated, and no additional action is required.
2. Pass on the interrupt acknowledge daisy chain — For this case, \overline{IACKIN} input is asserted by the preceding daisy chain Interrupter, and $\overline{IACKOUT}$ output is in turn asserted. The daisy chain signal is passed on when no interrupts are pending on a matching level or when any possible interrupts are disabled. The Interrupt Enable (IRE) bit of a control register can disable any interrupt requests, and in turn, any possible matches.
3. Respond internally — For this case, \overline{IACKIN} is asserted and a match is found. The MC68153 completes the IACK cycle by supplying an interrupt vector from the proper vector register followed by a \overline{DTACK} signal asserted. $\overline{IACKOUT}$ is not asserted because the interrupt acknowledge cycle is completed by this device.

For the MC68153 to respond in this mode of operation, the EXTERNAL/INTERNAL control register bit (X/\overline{IN}) must be zero. For each source of interrupt request, the associated control register determines the BIM response to an IACK cycle, and the X/\overline{IN}

bit sets this response either internally ($X/\overline{IN} = 0$) or externally ($X/\overline{IN} = 1$).

4. Respond externally — For the final case, \overline{IACKIN} is also asserted, a match is found and the associated control register has X/\overline{IN} bit set to one. The MC68153 does not assert $\overline{IACKOUT}$ and does assert \overline{INTAE} low. \overline{INTAE} signals that the requesting device must complete the IACK cycle (supplying a vector and \overline{DTACK}) and that the 2-bit code contained on outputs $\overline{INTAL0}$ and $\overline{INTAL1}$ shows which interrupt source is being acknowledged.

These cases are discussed in more detail in the following paragraphs.

Internal Interrupt Acknowledge

For an internal interrupt acknowledge to occur, the following conditions must be met:

1. One or more device interrupt inputs ($\overline{INT0}$ – $\overline{INT3}$) has been asserted and corresponding control bit IRE value is one.
2. \overline{IACK} asserted.
3. A match exists between [A3, A2, A1] and the [L2, L1, L0] field of an enabled, requesting control register. If two or more devices are requesting at the same interrupt level, preference is given to the highest number requester, that is, $\overline{INT3}$ has highest priority and $\overline{INT0}$ has lowest.
4. Control register bit X/\overline{IN} of matching interrupt source must be zero.
5. \overline{IACKIN} asserted.

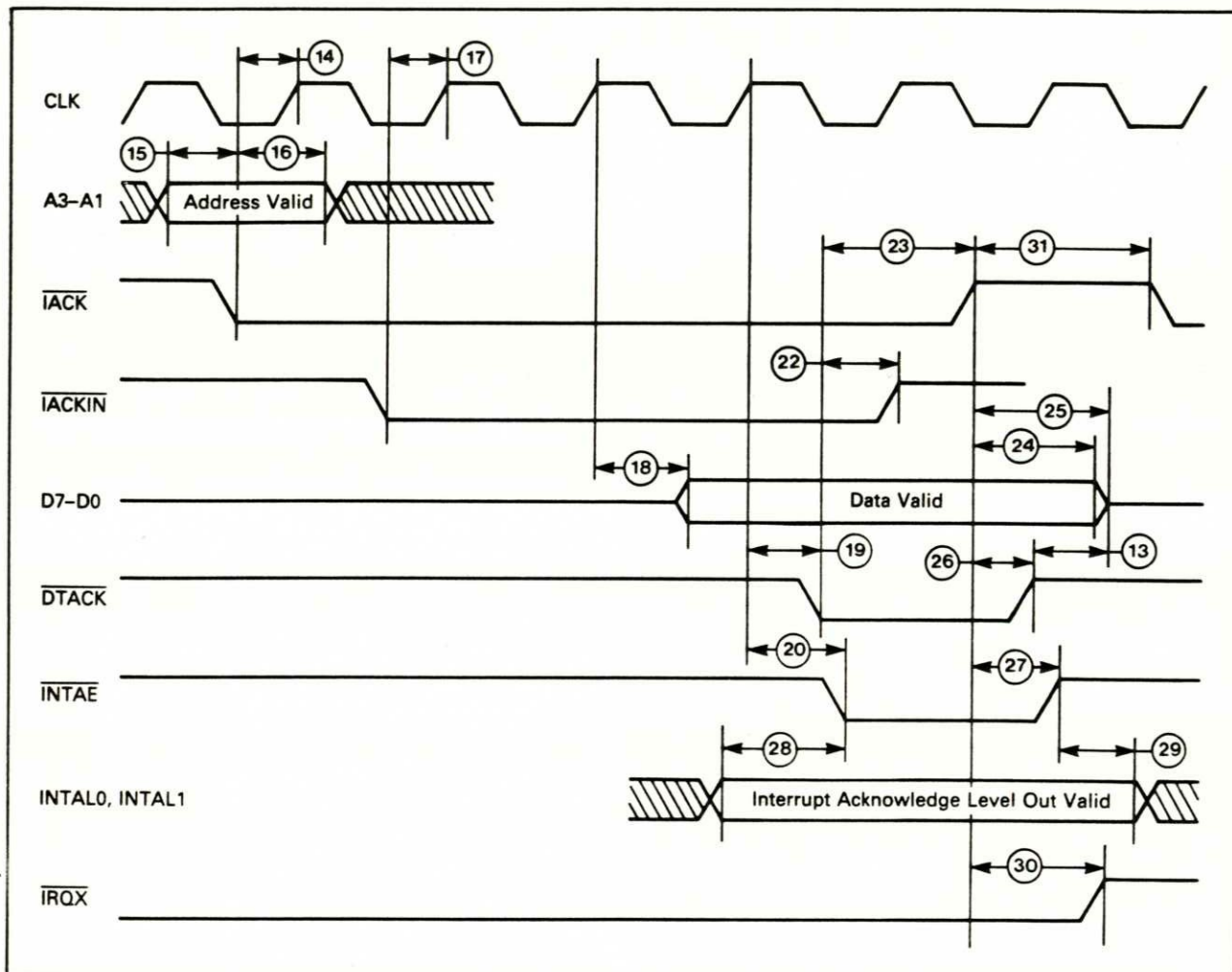
The internal interrupt acknowledge cycle timing is shown in Figure 10. The 8-bit interrupt acknowledge vector is presented to the data bus and \overline{DTACK} is asserted. Note also that $\overline{INTAL0}$ and $\overline{INTAL1}$ are valid and \overline{INTAE} is asserted during this cycle although they would normally not be used. The cycle is terminated (data and \overline{DTACK} released) after \overline{IACK} is negated.

During the IACK cycle, the INTERRUPT AUTO-CLEAR control bit (IRAC) comes into play. If the IRAC = one for the responding interrupt source, the INTERRUPT ENABLE (IRE) bit is automatically cleared during the IACK cycle, thus disabling the associated interrupt input and any \overline{IRQX} output asserted due to this interrupt input. Before another interrupt can be requested from this source, IRE must be set to one by writing to the control register.

Note that $\overline{IACKOUT}$ is not asserted because this device is responding to the IACK and does not pass the daisy chain signal on. Also, new device interrupt requests occurring on $\overline{INT0}$ – $\overline{INT3}$ after \overline{IACK} is asserted are locked out to prevent any race conditions on the daisy chain.



FIGURE 10 — INTERRUPT ACKNOWLEDGE CYCLE — INTERNAL VECTOR



External Interrupt Acknowledge

For an external interrupt acknowledge, the same conditions as listed above are met with one exception. Control register bit X/\overline{IN} of matching interrupt source must be set to one. The timing is shown in Figure 11. For this cycle, the interrupt vector and \overline{DTACK} must be supplied by an external device. \overline{INTAE} is asserted indicating that $INTAL0$ and $INTAL1$ are valid. The external device can use these signals to enable the vector and \overline{DTACK} . The cycle is terminated after \overline{IACK} is negated.

The IRAC control bit acts in the external interrupt acknowledge the same as described for the internal response (see above). Also, $\overline{IACKOUT}$ is not asserted and new device interrupts are disabled for reasons discussed above.

Pass On IACK Daisy Chain

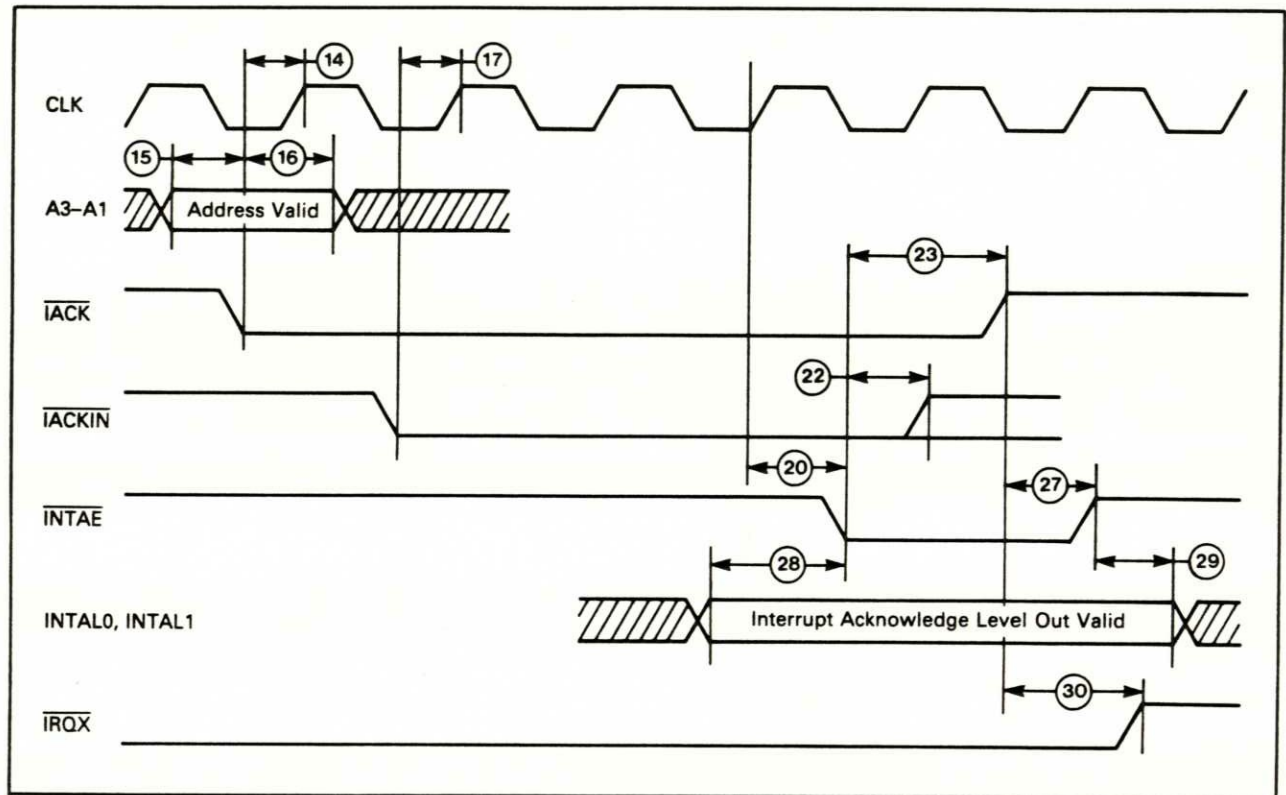
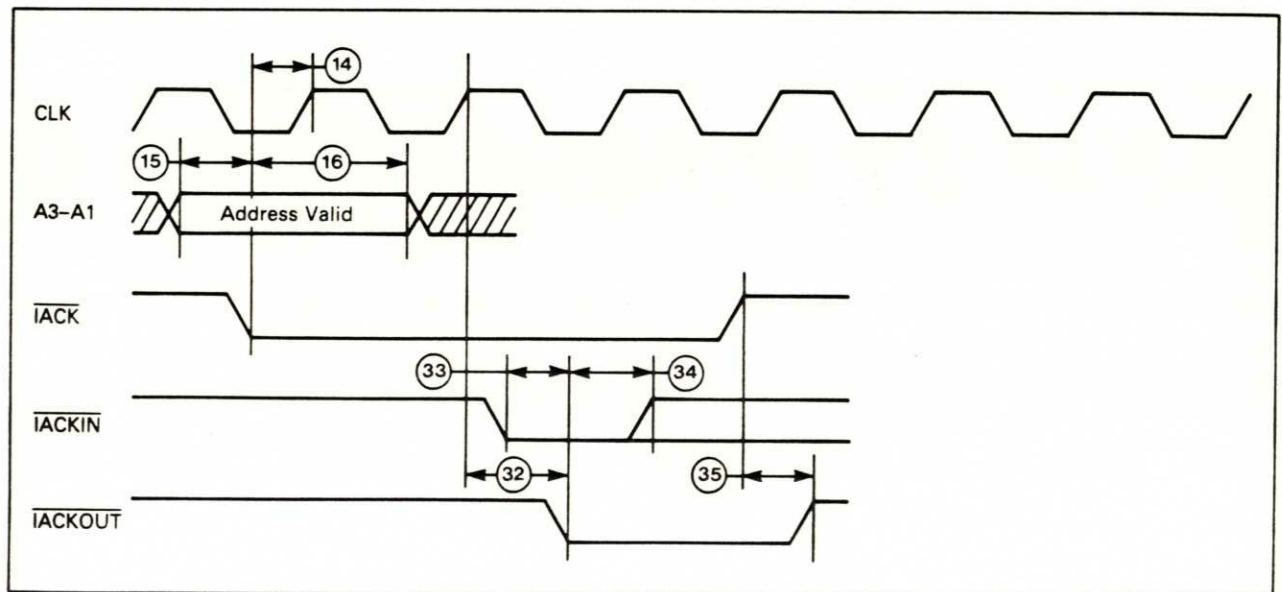
If the MC68153 has no interrupt request pending at the same level as the interrupt acknowledge, the \overline{IACK} daisy chain signal is passed on to the next device if \overline{IACKIN} is asserted. The following conditions are thus met:

1. \overline{IACK} asserted.
2. No match exists between $[A3, A2, A1]$ and the $[L2, L1, L0]$ field of an enabled, requesting control register.
3. \overline{IACKIN} is asserted.

$\overline{IACKOUT}$ is asserted if these conditions are valid. This output drives \overline{IACKIN} of the next Interrupter on the daisy chain, passing the signal along. Figure 12 shows the timing for this case. $\overline{IACKOUT}$ is negated after \overline{IACK} is negated.



FIGURE 11 — INTERRUPT ACKNOWLEDGE CYCLE — EXTERNAL VECTOR

FIGURE 12 — INTERRUPT ACKNOWLEDGE CYCLE — $\overline{\text{IACKOUT}}$ 

CONTROL REGISTER FLAGS

Each control register contains a Flag bit (F) and a Flag Auto-Clear bit (FAC). Both bits can be read or altered via a register write without affecting the interrupt operation of the device. The Flag is useful as a status indicator for resource management and as a semaphore in multitasking or multiprocessor systems. Flag (F) is located in bit position 7 and can be used with the MC68000 Test and Set (TAS) instruction.

The Flag Auto-Clear (FAC) is used to manipulate the Flag bit. If the Flag is set to one and the FAC is also one, an interrupt acknowledge cycle to the associated interrupt source clears the Flag bit. This feature is useful in determining the interrupt status and passing messages.

RESET

There is no reset input, however, a chip reset is activated by asserting both \overline{CS} and \overline{IAK} simultaneously (Figure 13). These inputs should be held low for a minimum of two clock cycles for a full reset function. The control registers are reset to all zeroes and the Vector Registers are set to a value of \$0F. This vector value is the uninitialized vector for the MC68000. See the MC68000 Users Manual for more details on this vector.

CLOCK

The chip clock is required for internal operation to occur. Typical frequency is 16 MHz in VMEbus and VERSAbus applications derived from the system clock. Any frequency can be used, however, up to 25 MHz (Figure 14).

FIGURE 13 — RESET

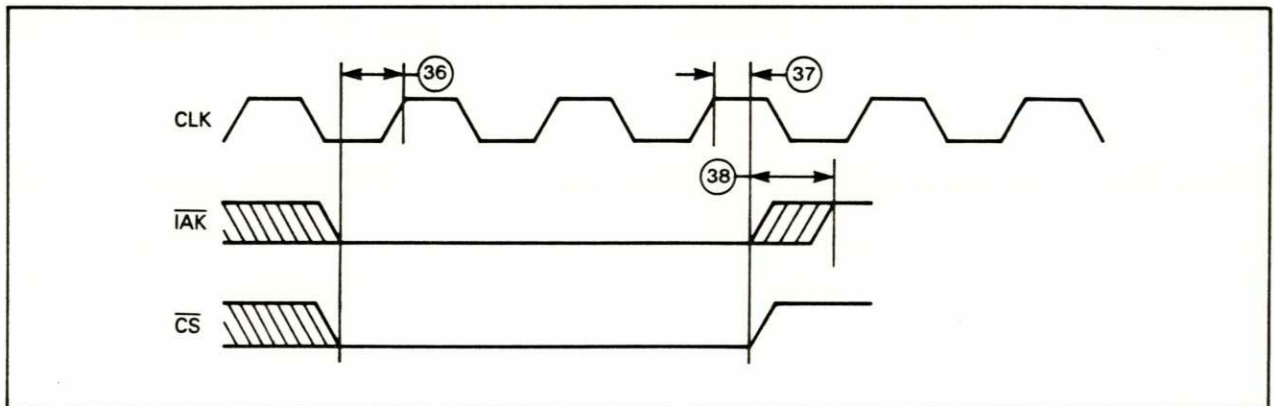


FIGURE 14 — CLOCK WAVEFORM

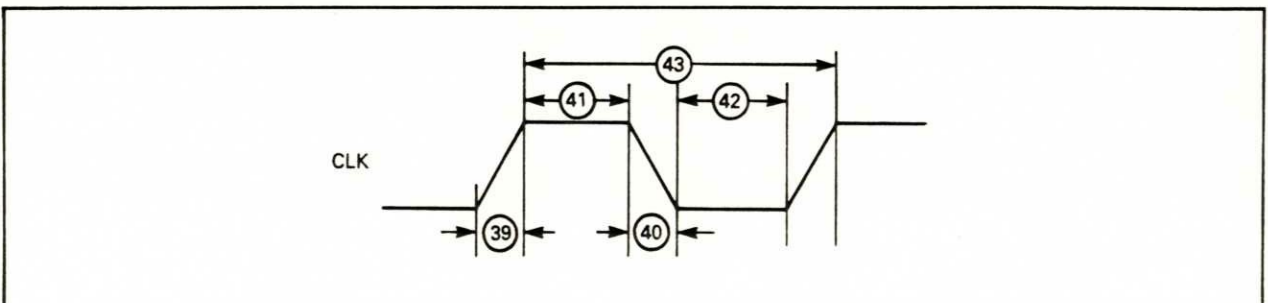


TABLE 1
AC PERFORMANCE SPECIFICATIONS
(VCC = 5.0 V ±5%, TA = 0°C to 70°C)

Number	Characteristic	Min	Max	Units	Notes
1	R/W, A1-A3 Valid to \overline{CS} Low (Setup Time)	10	—	ns	
2	\overline{CS} Low to R/W, A1-A3 Invalid (Hold Time)	5.0	—	ns	
3	\overline{CS} Low to CLK High (Setup Time)	15	—	ns	1
4	CLK High to Data Out Valid (Delay)	—	55	ns	2
5	CLK High to \overline{DTACK} Low (Delay)	—	40	ns	2
6	\overline{DTACK} Low to \overline{CS} High	0	—	ns	
7	\overline{CS} High to \overline{DTACK} High (Delay)	—	35	ns	10
8	\overline{CS} High to Data Out Invalid (Hold Time)	0	—	ns	
9	\overline{CS} High to Data Out High-Impedance (Hold Time)	—	50	ns	
10	\overline{CS} High to \overline{CS} or \overline{IACK} Low	20	—	ns	
11	Data In Valid to \overline{CS} Low (Setup Time)	10	—	ns	
12	\overline{CS} Low to Data In Invalid (Hold Time)	5.0	—	ns	
13	\overline{DTACK} High to Data Out High-Impedance	—	25	ns	10
14	\overline{IACK} Low to CLK High (Setup Time)	15	—	ns	1
15	A1-A3 Valid to \overline{IACK} Low (Setup Time)	10	—	ns	
16	\overline{IACK} Low to A1-A3 Invalid (Hold Time)	5.0	—	ns	
17	\overline{IACKIN} Low to CLK High (Setup Time)	15	—	ns	1, 8
18	CLK High to Data Out Valid (Delay)	—	55	ns	3
19	CLK High to \overline{DTACK} Low (Delay)	—	40	ns	3
20	CLK High to \overline{INTAE} Low (Delay)	—	40	ns	3
22	\overline{DTACK} Low to \overline{IACKIN} High	0	—	ns	8
23	\overline{DTACK} Low to \overline{IACK} High	0	—	ns	
24	\overline{IACK} High to Data Out Invalid (Hold Time)	0	—	ns	
25	\overline{IACK} High to Data Out High Impedance (Delay)	—	60	ns	
26	\overline{IACK} High to \overline{DTACK} High (Delay)	—	45	ns	10
27	\overline{IACK} High to \overline{INTAE} High (Delay)	—	35	ns	
28	$\overline{INTAL0}$, $\overline{INTAL1}$ Valid to \overline{INTAE} Low (Setup Time)	1.0	2.0	CLK Per	
29	\overline{INTAE} High to $\overline{INTAL0}$, $\overline{INTAL1}$ Invalid (Hold Time)	1.0	2.0	CLK Per	
30	\overline{IACK} High to \overline{IRQx} High (Delay)	—	50	ns	7, 10
31	\overline{IACK} High to \overline{IACK} or \overline{CS} Low	20	—	ns	
32	CLK High to $\overline{IACKOUT}$ Low (Delay)	—	40	ns	5
33	\overline{IACKIN} Low to $\overline{IACKOUT}$ Low (Delay)	—	30	ns	4, 8
34	$\overline{IACKOUT}$ Low to \overline{IACKIN} , \overline{IACK} High	0	—	ns	8
35	\overline{IACK} High to $\overline{IACKOUT}$ High (Delay)	—	35	ns	
36	\overline{IACK} and \overline{CS} both Low to CLK High (Setup Time)	15	—	ns	9
37	CLK High to \overline{IACK} or \overline{CS} High (Hold Time)	0	—	ns	
38	\overline{IACK} or \overline{CS} High to \overline{IACK} and \overline{CS} High (Skew)	—	1.0	CLK Per	6
39	Clock Rise Time	—	10	ns	
40	Clock Fall Time	—	10	ns	
41	Clock High Time	20	—	ns	
42	Clock Low Time	20	—	ns	
43	Clock Period	40	—	ns	

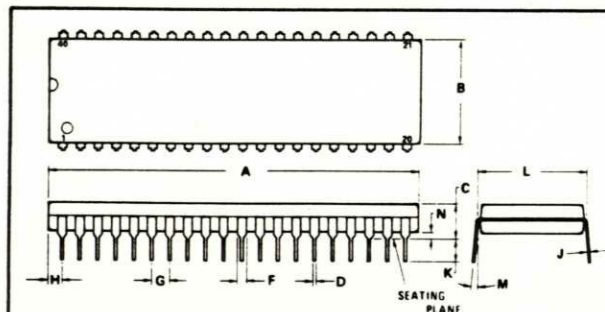
NOTES:

1. This specification only applies if the VBIM had completed all operations initiated by the previous bus cycle when \overline{CS} or \overline{IACK} was asserted. Following a normal bus cycle, all operations are completed within 2 clock cycles after \overline{CS} or \overline{IACK} have been negated. If \overline{IACK} or \overline{CS} is asserted prior to completion of these operations, the new cycle, and hence, \overline{DTACK} is postponed.
If the \overline{IACK} , \overline{IACKIN} or \overline{CS} setup time is violated, \overline{DTACK} may be asserted as shown, or may be asserted one clock cycle later (i.e. \overline{IACK} will not be recognized until the next rising edge of the clock).
2. Assumes that 3 has been met.
3. Assumes that 14 and 17 have both been met.
4. Assumes that 14 has been met. ($\overline{IACKOUT}$ cannot go low prior to \overline{IACKIN} going low).
5. Assumes that 14 has been met and \overline{IACKIN} has been low for at least the amount of time specified by 33.
6. 38 is the minimum skew between the last moment when both \overline{IACK} and \overline{CS} are asserted to when both are negated, to insure that an access cycle is not unintentionally started.
7. Assumes no other \overline{INTx} input is causing \overline{IRQx} to be driven low.
8. In non-daisy chain systems, \overline{IACKIN} may be tied low.
9. Failure to meet this spec. causes RESET to be ignored for 1 clock period. It is then necessary to keep these signals low for 3 clock periods instead of 2.
10. Delay time is specified from Input signal to Open-Collector Output pulled High thru 1.0 k Ω resistor to +6.5 V.



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OUTLINE DIMENSIONS

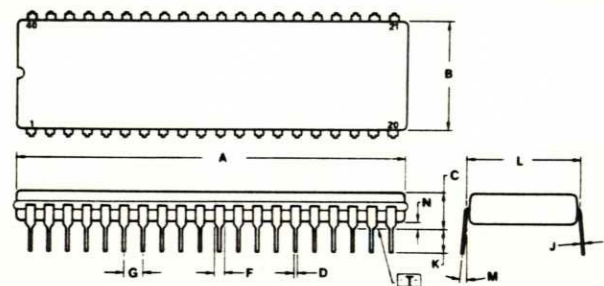


DIM	MIN	MAX	MIN	MAX
A	51.69	52.45	2.035	2.065
B	13.72	14.22	0.540	0.560
C	3.94	5.08	0.155	0.200
D	0.36	0.56	0.014	0.022
F	1.02	1.52	0.040	0.060
G	2.54	BSC	0.100	BSC
H	1.65	2.16	0.065	0.085
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	15.24	BSC	0.600	BSC
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040

NOTES

1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 mm (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

CASE 711-03
PLASTIC PACKAGE



DIM	MIN	MAX	MIN	MAX
A	51.31	53.24	2.020	2.096
B	12.70	15.49	0.500	0.610
C	4.06	5.84	0.160	0.230
D	0.38	0.56	0.015	0.022
F	1.27	1.65	0.050	0.065
G	2.54	BSC	0.100	BSC
J	0.20	0.30	0.008	0.012
K	3.18	4.06	0.125	0.160
L	15.24	BSC	0.600	BSC
M	5°	15°	5°	15°
N	0.51	1.27	0.020	0.050

NOTES

1. DIM - A IS DATUM
2. POSITIONAL TOLERANCE FOR LEADS
 $\phi 0.25(0.010) \text{ (M) T A (M)}$
3. (T) IS SEATING PLANE
4. DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL
5. DIMENSIONS A AND B INCLUDE MENISCUS
6. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973


CASE 734-04
CERAMIC PACKAGE

TYPICAL THERMAL CHARACTERISTICS

Package	θ_{JA} (Junction to Ambient) Still Air	Junction Temperature Still Air @ 70°C Ambient
L Suffix	40°C/W	147°C
P Suffix ¹	35°C/W	137°C

NOTES:

1. For reliable system operation the maximum allowable junction temperature (T_J) for plastic encapsulated packages has been limited to +140°C. Exceeding this limit will accelerate "wear-out" mechanisms associated with industry standard assembly methods using thermosonic ball bonds to attach gold (Au) bond wire to aluminum (Al) bond pads on the die surface.
2. At $T_J = 140^\circ\text{C}$, time to 0.1% failure due to Au/Al interconnect = 8,920 Hours.

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AD1-1057

SCB68430 Direct Memory Access Interface (DMAI)

Preliminary Specification

Microprocessor Products

DESCRIPTION

The SCB68430 Direct Memory Access Interface (DMAI) is a single channel interface circuit which is intended to complement the performance and architectural capabilities of the SCN68000 microprocessor. The DMAI functions by transferring a series of operands (data) between memory and a device; operand sizes may be byte, word, or long word. A block is a sequence of operands; the number of operands in the block is determined by a transfer count stored within the DMAI. The SCB68430 can be programmed to utilize single cycle (cycle stealing) or burst data transfers.

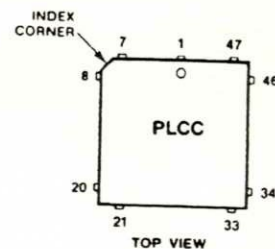
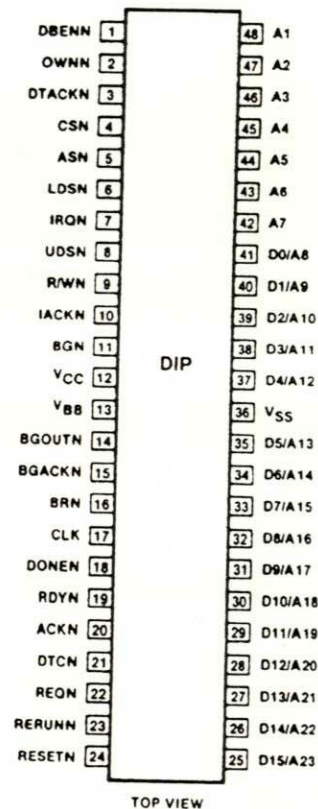
The DMAI provides two interfaces. The microprocessor interface is fully compatible with the SCN68000 microprocessor. The device interface includes lines for requesting, acknowledging, controlling, and timing the data transfers. The DMAI is a single-channel subset of the other 68000 family DMA controllers (68440 and 68450). It is software compatible with these devices and provides similar interfacing signals to both the system bus and the device.

The SCB68430 is constructed using Signetics ISL bipolar technology.

FEATURES

- Bus compatible with SCN68000 microprocessor
- Software compatible with other 68K family DMA controllers
- Single address transfers
- Cycle steal and burst mode operation
- Bus arbitration daisy chain
- Automatic rerun on bus error
- Supports 32-bit transfers for VME bus
- Supports SCN68000 vectored interrupts
- 24-bit address counter
- 16-bit transfer counter
- Maximum transfer rate of 5 Mbytes per second
- Signetics ISL bipolar technology

PIN CONFIGURATION



Pin	Function	Pin	Function	Pin	Function
1	NC	19	CLK	36	D7/A15
2	DBENN	20	DONEN	37	D6/A14
3	OWNN	21	RDYN	38	D5/A13
4	DTACKN	22	ACKN	39	V _{SS}
5	CSN	23	DTCN	40	NC
6	ASN	24	REON	41	D4/A12
7	LDSN	25	RERUNN	42	D3/A11
8	IRON	26	RESETN	43	D2/A10
9	UDSN	27	NC	44	D1/A9
10	R/WN	28	D15/A23	45	D0/A8
11	IACKN	29	D14/A22	46	A7
12	BGN	30	D13/A21	47	A6
13	V _{CC}	31	D12/A20	48	A5
14	NC	32	D11/A19	49	A4
15	V _{BB}	33	D10/A18	50	A3
16	BGOUTN	34	D9/A17	51	A2
17	BGACKN	35	D8/A16	52	A1
18	BRN				

Direct Memory Access Interface (DMAI)

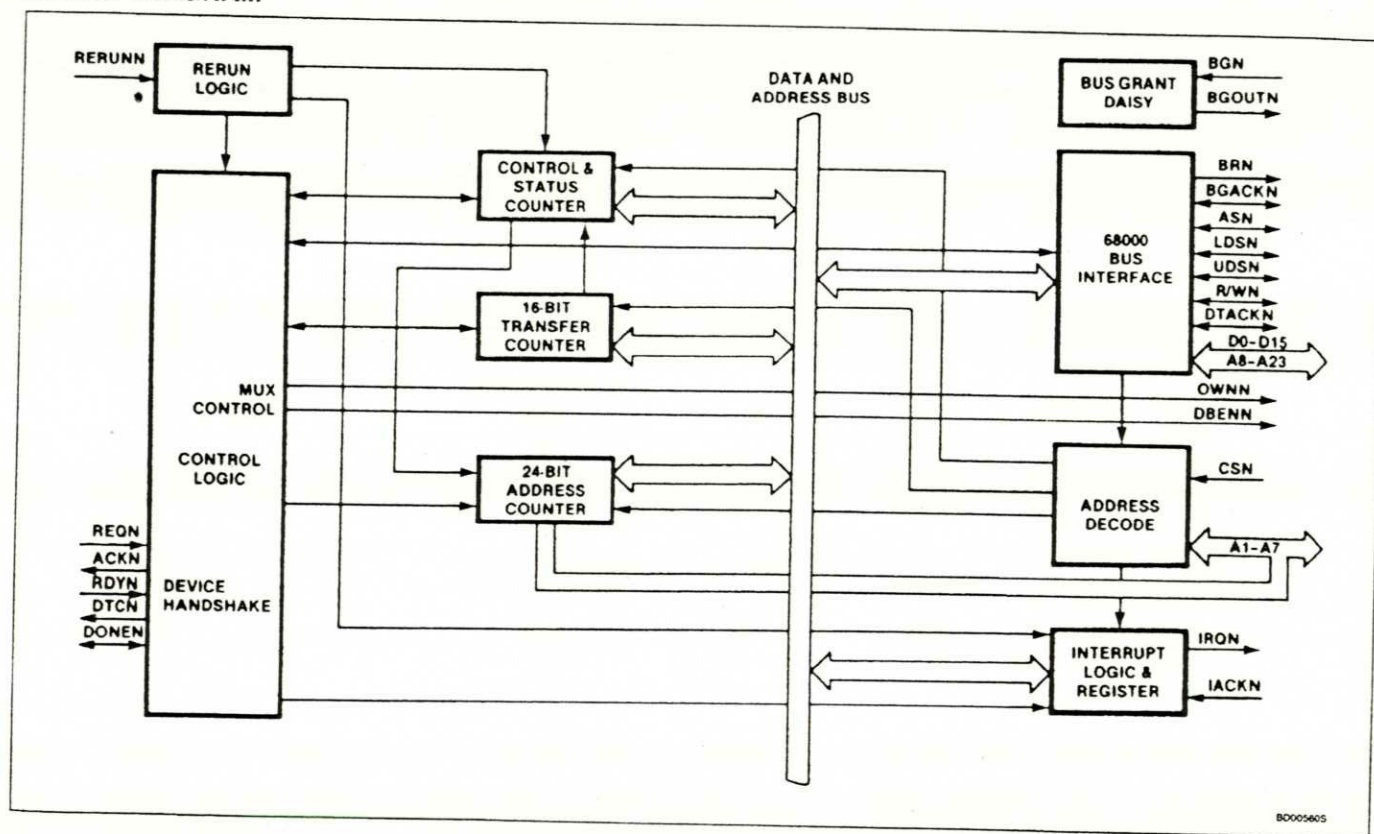
SCB68430

ORDERING CODE

PACKAGES	$V_{CC} = 5V \pm 5\%$, $T_A = 0^\circ C$ to $70^\circ C$	
	10MHz	12.5MHz
Ceramic DIP	SCB68430CAI48	SCB68430CCI48
Plastic DIP	SCB68430CAN48	SCB68430CCN48
Plastic LCC	SCB68430CAA52	SCB68430CCA52

2

BLOCK DIAGRAM



Direct Memory Access Interface (DMAI)

SCB68430

PIN DESCRIPTION

MNEMONIC	PIN NO.	TYPE	DESCRIPTION
A1 – A7	48 – 42	I/O	Address Lines: Active high, three-state. In the MPU mode, these low order address lines specify which internal register of the DMAI is being accessed. In DMA mode, A1 – A7 are outputs which provide the low order address bits of the location being accessed. Three-stated in IDLE Mode.
A8 – A23/ D0 – D15	41 – 37 35 – 25	I/O	Address/Data Lines: Active high, three-state. These lines are time multiplexed for data and address leads. The lines OWNN, RWN, CSN, and DBENN are used to control the demultiplexing of the address and data using external circuitry. In MPU mode, the bidirectional data lines (D0 – D15) are used to transfer data between the MPU and the DMAI. In the DMA mode, A8 – A23 provide the high order address bits of the location being accessed. Three-stated in IDLE mode.
ASN	5	I/O	Address Strobe: Active low, three-state. In MPU and IDLE modes, ASN is an input which indicates that the current bus master has placed a valid address on the bus. It is monitored by the DMAI during bus arbitration to ascertain that the previous bus master has completed the current bus cycle. In DMA mode, it is an output indicating that the DMAI has placed a valid address on the bus.
UDSN	8	I/O	Upper Data Strobe: Active low, three-state. In MPU and IDLE modes, UDSN is an input which indicates that the upper data byte of the addressed word is being addressed. In DMA mode, it is an output with the same meaning.
LDSN	6	I/O	Lower Data Strobe: Active low, three-state. In MPU and IDLE modes, LDSN is an input which indicates that the lower data byte of the addressed word is being addressed. In DMA mode, it is an output with the same meaning.
R/WN	9	I/O	Read/Write: Active high for read, low for write, three-state. In MPU mode, R/WN is an input which controls the direction of data flow through the DMAI's input/output data bus interface and, if required, through an external data bus buffer. R/WN high causes the DMAI to place the data from the addressed register on the data bus, while R/WN low causes the DMAI to accept data from the data bus. In DMA mode, R/WN is an output to memory and I/O controllers indicating the type of bus cycle. It is held three-stated during IDLE mode.
CSN	4	I	Chip Select: Active low. When low, places the DMAI into the MPU mode. This input signal is used to select the DMAI for programmed data transfers. These transfers take place over D0 – D15 as controlled by the R/WN and A1 – A7 inputs. The DMAI is deselected when CSN is high. CSN is ignored during DMA mode.
DTACKN	3	I/O	Data Transfer Acknowledge: Active low, three-state. In MPU mode, DTACKN is asserted on a write cycle to indicate that the data on the bus has been latched, and on a read cycle or interrupt acknowledge cycle to indicate that valid data is present on the bus. The signal is negated (driven high) when completion of the cycle is indicated by negation of the CSN or IACKN input, and returns to the inactive third state a short time after it is negated. In DMA Mode, DTACKN is an input monitored by the DMAI to determine when the addressed device (memory) has latched the data (write cycle) or put valid data on the bus (read cycle).
RESETN	24	I	Master Reset: Active low. Assertion of this pin clears internal control registers (See table 1), initializes the interrupt vector register to H'0F', and sets the status register to the default value B'0000 000X', where X is the state of RDYN. All bidirectional I/O lines are three-stated and the DMAI is placed in the IDLE mode.
CLK	17	I	Clock: Active high. Usually the system clock, but may be any clock meeting the electrical specifications. Used by the DMAI to synchronize device functions and external control lines, and may not be gated off at any time.
IRQN	7	O	Interrupt Request: Active low, open collector. This output is asserted, if interrupts are enabled, upon end of transfer, on occurrence of a bus error, and on receipt of an abort from the MPU. The CPU can read the status register to determine the interrupting condition(s), or can respond with an interrupt acknowledge cycle to cause the DMAI to output an interrupt vector on the data bus.
IACKN	10	I	Interrupt Acknowledge: Active low. When asserted, indicates that the current cycle is an interrupt acknowledge cycle. The DMAI normally responds by placing the contents of the interrupt vector register on the data bus and asserting DTACKN. IACKN is not serviced if the DMAI has not generated an interrupt request.
BRN	16	O	Bus Request: Active low, open collector. BRN is asserted by the DMAI to request ownership of the bus after a DMA request is sensed on the REQN input from the I/O device. It is negated when the bus has been granted (BGN low) and BGACKN has been asserted, or, in burst DMA request mode, if the I/O device negates its request at least one clock cycle before BGACKN is asserted.
BGN	11	I	Bus Grant: Active low. BGN indicates to the DMAI that it is to be the next bus master. This signal is originated by the MPU and propagated via a daisy chain or other prioritization mechanism. After BGN is asserted, the DMAI waits until DTACKN, ASN, and BGACKN have become inactive before assuming ownership of the bus by asserting BGACKN.

Direct Memory Access Interface (DMAI)

SCB68430

PIN DESCRIPTION (Continued)

MNEMONIC	PIN NO.	TYPE	DESCRIPTION
BGOUTN	14	O	Bus Grant Output: Active low. Daisy chain output which is asserted by the DMAI when BGN is asserted and the DMAI does not have a bus request pending.
BGACKN	15	I/O	Bus Grant Acknowledge: Active low, three-state. As an input, BGACKN is monitored by the DMAI during the bus arbitration cycle to determine when it can assume ownership of the bus (BGACKN negated). In DMA mode, it is asserted by the DMAI to indicate that it is the bus master. Three-stated in MPU and IDLE modes.
RERUNN	23	I	Rerun: Active low. This input is asserted by external error detect logic to indicate a bus error. In DMA mode, the DMAI stops operation and three-states the data, address, and control lines, except BGACKN. It remains halted until RERUNN becomes inactive, and then re-tries the last bus cycle. If RERUNN is asserted again, the DMAI sets the ERR bit in the status register, stops DMA operation, releases the bus, and interrupts the CPU, if interrupts are enabled, responding with a special interrupt vector when IACKN is asserted. Not monitored in MPU and IDLE modes.
REQN	22	I	DMA Request: Active low. This input from the I/O device requests service from the DMAI and causes the DMAI to request control of the bus. In burst mode, the input is level sensitive, and the DMAI releases the bus after REQN is negated and the current DMA cycle is completed. In cycle steal mode, the REQN input is negative edge triggered. A negative going edge must occur at least one clock cycle before DTCN is asserted to accomplish continuous transfer cycles but not earlier than beginning of master cycle.
ACKN	20	O	DMA Request Acknowledge: Active low. ACKN is asserted by the DMAI to indicate that it has gained the bus and the requested bus cycle is now beginning. It is asserted at the beginning of every bus cycle after ASN has been asserted, and is negated at the end of every bus cycle.
RDYN	19	I	Device Ready: Active low. RDYN is asserted by the requesting device to indicate to the DMAI that valid data has either been stored or put on the bus. If negated, it indicates that the data has not been stored or presented, causing the DMAI to enter wait states. RDYN can be held low continuously if the device is fast enough so that wait states are not required.
DTCN	21	O	Device Transfer Complete: Active low. In DMA mode, DTCN is asserted by the DMAI to indicate to the device that the requested data transfer is complete. On a write to memory operation, it indicates that the data provided by the device has been successfully stored. On a read from memory operation, it indicates to the device that the data from memory is present on the data bus and should be latched.
DONEN	18	I/O	Done: Active low, open collector. As an output, DONEN is asserted by the DMAI concurrent with the ACKN output to indicate to the device that the transfer count is exhausted and that the DMAI's operation is completed as a result of that transfer. As an input, if asserted by the device before the transfer count became zero, it causes the DMAI to abort service and generate an interrupt request, if interrupts are enabled.
OWNN	2	O	Own: Active low, open collector. This output is asserted by DMAI during the DMA mode to indicate bus mastership. It can be used to enable external address/data and control buffers. Inactive in MPU and IDLE modes.
DBENN	1	O	Data Bus Enable: Active low, open collector. Asserted by the DMAI when CSN is asserted or when IACKN is asserted and the DMAI has an interrupt request pending. Can be used to enable bidirectional data buffers for D0-D15. Inactive in IDLE and DMA mode.
V _{CC}	12	I	Power Supply: +5 volt power input.
V _{BB}	13	I	Power Supply: +1.5 volt power input.
V _{SS}	36	I	Ground: Signal and power ground input.

PIN DESCRIPTION

The Pin Description table describes the function of each of the pins of the DMAI. Signal names ending in 'N' are active low. All other signals are active high. In the descriptions, 'MPU mode' refers to the state when the DMAI is chip selected. The term 'DMA mode' refers to the state when the DMAI assumes ownership of the bus. The DMAI is in the 'IDLE mode' at all other times.

In this data sheet signals are discussed using the terms 'active' and 'inactive' or 'asserted' and 'negated' independent of whether the

signal is active in the high (logic one) state or the low (logic zero) state. Refer to the individual pin descriptions for the definition of the active level of each signal.

REGISTERS AND COUNTERS

Register Map

The internal accessible register organization of the DMAI is shown in table 1. The following rules apply to all registers:

1. A read from a reserved location in the map results in a read from the 'null

register'. The null register returns all ones for data and results in a normal bus cycle. A write to one of these locations results in a normal bus cycle but no write occurs.

2. Unused bits of a defined register are read as indicated in the register descriptions.
3. All registers are addressable as 8-bit quantities. To facilitate operation with the 68K MOVEP instruction, addresses are ordered such that certain sets of registers may also be accessed as words or long words.

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The operation of the DMAI is programmed by writing control words into the appropriate registers. Operational feedback is provided via status registers which can be read by the CPU. The contents of certain control and status registers are initialized on RESET.

To provide compatibility with the other 68K family DMA controllers, control and status

bits are mapped in bit positions equivalent to where they are located in the register map of the other devices. Bits which are used in the other devices but not in the DMAI are assigned default values. If upward compatibility to the other controllers is required, the programmer should use these default values when writing the control words to the regis-

ters, although they have no effect in the DMAI. When a register is read, the default value is returned regardless of the value used when the register is programmed. The default value is indicated by '(x)' in unused bit positions in the register formats, which are illustrated in table 2.

Table 1. DMAI ADDRESS MAP

ADDRESS BITS ^{1,2} 7 6 5 4 3 2 1 0	ACRONYM	REGISTER NAME	MODE	AFFECTED BY RESET
d d 0 0 0 0 0 0	CSR	Channel Status Register	R/W ³	Yes
d d 0 0 0 0 0 1	CER	Channel Error Register	R	Yes
d d 0 0 0 0 1 0		Reserved		
d d 0 0 0 0 1 1		Reserved		
d d 0 0 0 1 0 0	DCR	Device Control Register	R/W	Yes
d d 0 0 0 1 0 1	OCR	Operation Control Register	R/W	Yes
d d 0 0 0 1 1 0	SCR	Sequence Control Register	R/W ⁴	No
d d 0 0 0 1 1 1	CCR	Channel Control Register	R/W	Yes
d d 0 0 1 0 0 0		Reserved		
d d 0 0 1 0 0 1		Reserved		
d d 0 0 1 0 1 0	MTCH	Memory Transfer Counter High	R/W	No
d d 0 0 1 0 1 1	MTCL	Memory Transfer Counter Low	R/W	No
d d 0 0 1 1 0 0	MACH	Memory Address Counter High	R/W ⁴	No
d d 0 0 1 1 0 1	MACMH	Memory Address Counter Middle High	R/W	No
d d 0 0 1 1 1 0	MACML	Memory Address Counter Middle Low	R/W	No
d d 0 0 1 1 1 1	MACL	Memory Address Counter Low	R/W	No
d d 0 1 d d d d		Reserved		
d d 1 0 0 0 d d		Reserved		
d d 1 0 0 1 0 0		Reserved		
d d 1 0 0 1 0 1	IVR	Interrupt Vector Register - Normal	R/W	Yes
d d 1 0 0 1 1 0		Reserved		
d d 1 0 0 1 1 1	IVR	Interrupt Vector Register - Error	R/W	Yes
d d 1 0 1 0 d d		Reserved		
d d 1 0 1 1 0 0		Reserved		
d d 1 0 1 1 0 1	CPR	Channel Priority Register	R/W ⁴	No
d d 1 0 1 1 1 0		Reserved		
d d 1 0 1 1 1 1		Reserved		
d d 1 1 d d d d		Reserved		

NOTES:

1. A0 = 0 for UDSN asserted, A0 = 1 for LDSN asserted.
2. 'd' designates don't care.
3. A write to this register may perform a status resetting operation.
4. This register is a dummy register present only to provide compatibility with other 68K family DMA controllers. A write to this register has no effect on the DMAI.

Table 2. REGISTER BIT FORMATS

DEVICE CONTROL REGISTER

	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT09	BIT08
DCR	EXTERNAL REQUEST MODE	NOT USED (0)	NOT USED (1)	NOT USED (1)	NOT USED (*)	NOT USED (0)	NOT USED (0)	NOT USED (0)
	0 = BURST 1 = CYCLE STEAL							

*Should be programmed as '0' for SIZE (OCR[5:4]) = 00 and as '1' otherwise. When read, the value of this bit is OCR[5]. .OR.OCR[4].

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OPERATION CONTROL REGISTER (OCR)

	BIT07	BIT06	BIT05	BIT04	BIT03	BIT02	BIT01	BIT00
OCR	DIRECTION	NOT USED (0)	OPERAND SIZE		NOT USED (0)	NOT USED (0)	NOT USED (1)	NOT USED (0)
	0 = MEM TO DEV 1 = DEV TO MEM		00 = BYTE 01 = WORD (16 BIT) 10 = LONG WORD* 11 = WORD (32-BIT)*					

*Long word and 32-bit word modes are not supported by 68440. 32-bit word mode is not supported by 68450.

SEQUENCE CONTROL REGISTER (SCR)

	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT09	BIT08
SCR	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (1)	NOT USED (0)	NOT USED (0)

CHANNEL CONTROL REGISTER (CCR)

	BIT07	BIT06	BIT05	BIT04	BIT03	BIT02	BIT01	BIT00
CCR	START	NOT USED (0)	NOT USED (0)	SOFTWARE ABORT	INTERRUPT ENABLE	NOT USED (0)	NOT USED (0)	NOT USED (0)
	0 = NO 1 = YES			0 = NO 1 = YES	0 = NO 1 = YES			

CHANNEL STATUS REGISTER (CSR)

	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT09	BIT08
CSR	CHANNEL OPERATION COMPLETE	NOT USED (0)	NORMAL DEVICE TERMINATE	ERROR	CHANNEL ACTIVE	NOT USED (0)	NOT USED (0)	READY INPUT STATE
	0 = NO 1 = YES		0 = NO 1 = YES	0 = NO 1 = YES	0 = NO 1 = YES			0 = LOW 1 = HIGH

CHANNEL ERROR REGISTER (CER)

	BIT07	BIT06	BIT05	BIT04	BIT03	BIT02	BIT01	BIT00
CER	NOT USED (0)	NOT USED (0)	NOT USED (0)	ERROR CODE				
				00000 = NO ERROR 01001 = BUS ERROR 10001 = SOFTWARE ABORT				

CHANNEL PRIORITY REGISTER (CPR)

	BIT07	BIT06	BIT05	BIT04	BIT03	BIT02	BIT01	BIT00
CPR	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)	NOT USED (0)

Device Control Register (DCR)

[15] External Request Mode

This bit selects whether the DMAI operates in burst or cycle steal mode.

- 0 Burst mode. This mode allows a device to request the transfer of multiple operands using consecutive bus cycles. In this mode the request (REQN) line is an active low input which is asserted by the device to request an operand transfer.

The DMAI services the request by arbitrating for the bus, obtaining the bus, and notifying the peripheral by asserting the acknowledge (ACKN) output. If the request line is active when the DMAI asserts ACKN, and remains active at least until the DMAI asserts device transfer complete (DTCN), the DMAI recognizes a valid request for another operand, which will be transferred during the next bus cycle. If the request line is negated be-

fore the DMAI asserts DTCN, the DMAI relinquishes the bus and waits for the next request, but the current transfer will be completed.

- 1 Cycle steal mode. In this mode, the device requests an operand transfer by generating a falling edge on the request (REQN) line. The DMAI services the request by arbitrating for the bus, obtaining the bus, and notifying the peripheral by asserting the acknowledge (ACKN)

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output. The request line must be in the inactive state for at least one clock cycle before a request is made. After a request has been asserted, it must remain at the assertion level for at least one clock cycle. If another request is received before the first operand part of a former request is acknowledged, the second request is not recognized. Normally, the DMAI will relinquish the bus after servicing a valid request. However, if the device generates a new request before the DMAI asserts DTCN for the last operand part, the DMAI will retain ownership of the bus and that request will be serviced before the bus is relinquished.

Operation Control Register (OCR)

[7] Direction

- 0 Transfer is from memory to device.
- 1 Transfer is from device to memory.

[5:4] Operand Size

The programming of these bits determine whether UDSN, LDSN, or both are generated during the transfer cycle and the increment by which the memory address counter (MAC) is changed in each transfer cycle.

- 00 Byte. The operand size is 8 bits. The MAC is incremented by one after each operand transfer. If the LSB of the MAC is a '0', UDSN is asserted during the transfer. If the LSB of a MAC is a '1', LDSN is asserted during the transfer. The transfer counter decrements by one before each byte is transferred.
- 01 Word. The operand size is 16 bits. The MAC is incremented by two after each operand transfer. The value of the LSB of the MAC is ignored and both UDSN and LDSN are asserted during the transfer. The transfer counter decrements by one before each word is transferred.
- 10 Long word. The operand size is 32 bits. The operand is transferred as two 16-bit words. The MAC is incremented by two after each 16-bit word is transferred. The value of the LSB of the MAC is ignored and both UDSN and LDSN are asserted during the transfer. The transfer counter decrements by one before the entire long word is transferred. Note that this mode is not implemented in the 68440.
- 11 Double word. The operand size is 32 bits. The operand is transferred as a single 32-bit word. The MAC is incremented by four after each operand transfer. The value of the two LSBs of the MAC is ignored (the A1 output will always be a zero in this mode) and both UDSN and LDSN are asserted during the transfer. The transfer counter decrements by one before the double word is transferred. Note that this mode is not implemented

in the 68440 or 68450; it is included in the DMAI to support VME bus operations.

Sequence Control Register (SCR)

This register serves no function in the DMAI. It is included only to provide compatibility with the programming for the 68440 and 68450 DMA controllers.

Channel Control Register (CCR)

[7] Start Operation

- 0 No start pending.
- 1 Start operation. The start bit is set to initiate operation of the DMAI. The memory address counter and the memory transfer counter should have been previously initialized, and all bits of the channel status register (CSR) should have previously been reset. The DMAI initiates operation by clearing any pending requests, clearing the start bit, and setting the channel active bit in the CSR. The DMAI is then ready to receive requests for an operation. The channel cannot be started if any of the internal status bits in the CSR (CSR[15:11]) have not been cleared.

A pending start cannot be reset by a write to the register. START can be cleared only by the DMAI when it starts operation or by setting the software abort bit (CCR[4]).

[4] Software Abort

- 0 Do not abort.
- 1 Abort operation. Setting this bit terminates the current operation of the DMAI and places it in the IDLE state. The channel operation complete and error bits in the CSR are set, the channel active bit in the CSR is reset, and an ABORT ERROR condition is signaled in the CER. Setting this bit causes a pending start to be reset.

[3] Interrupt Enable

- 0 Interrupts not enabled.
- 1 Enable interrupts. An interrupt request is generated if the channel operation complete bit in the CSR is set. When the IACKN input is asserted, the DMAI returns the normal interrupt vector if the error bit in the CSR is not set, or the error interrupt vector if error is set.

Channel Status Register (CSR)

A read of this register provides the status of the DMAI. The COC, NDT, and ERR bits can be cleared by writing a '1' to the bit positions of the register which are to be cleared. Those bit positions which are written with a '0' remain unaffected.

[15] Channel Operation Complete

This bit is set following the termination, whether successful or not, of any DMAI

operation and indicates that the DMA transfer has completed. This bit must be cleared to start another channel operation.

[13] Normal Device Termination

This bit is set when the device terminates the DMAI operation by asserting the DONEN line while the device was being acknowledged. This bit must be cleared to start another channel operation.

[12] Error

This bit is used to report that the DMAI's operation was terminated due to the occurrence of an error. The condition which caused the error can be determined by reading the channel error register (CER). This bit must be cleared to start another channel operation. When this bit is cleared, the CER is also cleared.

[11] Channel Active

This bit is set after the channel has been started and remains set until the channel operation terminates. It is then automatically cleared by the DMAI. The bit is unaffected by the write operations.

[8] Ready Input State

This bit reflects the state of the RDYN input at the time the CSR is read. The bit is a '0' if RDYN is low and a '1' if RDYN is high. This bit is unaffected by write or reset operations.

Channel Error Register (CER)

[4:0] Error Code

This field indicates the source of error when an error is indicated in CER[12]. The contents of this register are cleared when CER[12] is cleared.

00000 No error.

01001 Bus error. A bus error occurred during the last bus cycle generated by the DMAI. See rerun description in OPERATION section.

10001 Software abort. The channel operation was terminated by a software abort command. See CCR[4].

Channel Priority Register (CPR)

This register serves no function in the DMAI. It is included only to provide compatibility with the programming for the other 68K family DMA controllers.

Memory Address Counter (MACH, MACMH, MACML, MACL)

The 32-bit memory address counter is used to program the memory location where the first operand to be transferred is located or is to be transferred to, depending on the direction of transfer. The counter must be initialized prior to beginning the transfer of a block of data and then increments automatically depending on the operand length, as de-

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scribed in the Operation Control Register description.

Only the least significant 24 bits of the counter (MACMH, MACML, and MACL) are implemented in the DMAI. The most significant byte of the counter, MACH, is provided only to allow compatibility with programming of the 68440 and 68450. Writing to MACH has no effect on the DMAI operation. Reading MACH always returns H'00'.

Memory Transfer Counter (MTCH, MTCL)

The 16-bit memory transfer counter programs the number of operands to be transferred by the DMAI. The counter must be initialized prior to beginning the transfer of a block of data and then decrements once per operand transfer (regardless of operand size) until it reaches the terminal value of zero. Channel operation then terminates and the COC bit in the CSR will be asserted.

Interrupt Vector Register (IVR)

The IVR contains the value to be placed on the data bus upon receipt of an interrupt acknowledge from the MPU. Only the seven most significant bits of the programmed value are used by the DMAI. The output vector from the DMAI contains a zero in the least significant bit position if a normal termination occurred (error bit not set) and contains a one in the least significant bit position if termination was due to an error (error bit set).

The contents of this register are initialized to H'0F' by a reset. The value returned will be H'0F', regardless of the error state, until the register is programmed by the MPU.

To provide compatibility with the other 68K family DMA controllers, the IVR has two addresses (see table 1). If program compatibility is required, the value written at the normal IVR address should have a zero as its LSB, and the value written at the error IVR address should be the same but with the LSB equal to one.

OPERATION

A DMAI operation proceeds in three principal phases. During the initialization phase, the MPU configures the channel control registers, loads the initial memory address and transfer count, and starts the channel. During the transfer phase, the DMAI accepts requests for transfers from the device, arbitrates for and acquires ownership of the bus, and provides for addressing and bus controls for the transfers. The termination phase occurs after the operation is complete, when the DMAI reports the status of the operation.

Operation Initiation

After having programmed the control registers, the memory address counter, and the

memory transfer counter, the MPU sets the start bit (CCR[7]). The DMAI initiates the operation by clearing any pending requests, clearing the start bit, and setting the channel active bit in the CSR. The DMAI is then ready to receive valid requests for an operation.

The channel cannot be started if any of the internal status bits in the CSR (CSR[15:11]) have not been cleared. An error is not signaled if this condition occurs. The only indication of this state is that the start bit remains set in the CCR. A pending start cannot be reset by a write to the register. START can be cleared only by the DMAI when it starts operation or by setting the software abort bit (CCR[4]).

Device/DMAI Communication

Communication between the peripheral device and the DMAI is accommodated by five signal lines:

Request (REQN)

The device makes a request for service by asserting the request line. The DMAI can operate in either the burst request mode or the cycle stealing request mode, as programmed by the external request mode bit (DCR[15]).

The burst mode allows a device to request the transfer of multiple operands using consecutive bus cycles. In this mode the request line is an active low input. The DMAI services the request by arbitrating for the bus, obtaining the bus, and notifying the peripheral by asserting the acknowledge (ACKN) output. If the request line is active when the DMAI asserts ACKN, and remains active at least until the DMAI asserts device transfer complete (DTCN), the DMAI recognizes a valid request for another operand, which will be transferred during the next bus cycle. If the request line is negated before the DMAI asserts DTCN, the DMAI relinquishes the bus and waits for the next request. For long word transfers (2 x 16), the request must be asserted at least until the acknowledge for the second part of the operand has been asserted.

In the cycle steal mode, the device requests an operand transfer by generating a falling edge on the request line. The DMAI services the request by arbitrating for the bus, obtaining the bus, and notifying the peripheral by asserting the acknowledge (ACKN) output. The request line must be in the inactive state for at least one clock cycle before a request is made. After a request has been asserted, it must remain at the assertion level for at least one clock cycle. If another request is received before the first operand part of a former request is acknowledged, the second request is not recognized. Normally, the DMAI will relinquish the bus after servicing a valid request. However, if the device generates a

new request before the DMAI asserts DTCN for the last operand part, the DMAI will retain ownership of the bus and that request will be serviced before the bus is relinquished.

Acknowledge (ACKN)

The DMAI asserts the acknowledge line, which implicitly addresses the device making the request, during transfers to and from the device. The line may be used to control buffering circuits between the data bus and the MPU bus.

During burst mode, REQN must not be deasserted for less than one CLK period plus four RC time constants, where R is the value of the resistor used for the pullup on BRN and C has a typical value of 20pF.

Ready (RDYN)

Ready is an active low input which is asserted by the requesting device to indicate to the DMAI that valid data has either been stored or put on the bus. If negated, it indicates that the data has not been stored or presented, causing the DMAI to enter wait states until RDYN is asserted. RDYN can be held low continuously if the device is fast enough so that wait states are not required. The current state of the ready input is reflected in CSR[8].

Done (DONEN)

Done is a bidirectional active low signal. As an output, it is asserted and negated by the DMAI concurrent with the ACKN output of the last operand part to indicate to the device that the memory transfer count is exhausted and that the DMAI's operation is completed as a result of that transfer.

The DMAI also monitors the state of the line while acknowledging a device. If the device asserts DONEN, the DMAI will terminate operation after the transfer of the current operand. In this case the DMAI clears the channel active bit and sets the channel operation complete and normal device termination bits in the CSR. If both the DMAI and the device assert DONEN, the device termination is not recognized, but the operation does terminate.

Device Transfer Complete (DTCN)

DTCN is an active low output which is asserted by the DMAI to indicate to the device that the requested data transfer is complete. On a write to memory operation, it indicates that the data provided by the device has been successfully stored. On a read from memory operation, it indicates to the device that the data from memory is present on the data bus and should be latched. DTCN is not asserted if assertion of the RERUNN input terminates the bus cycle.

Bus Arbitration

Upon receiving a valid request for a transfer from the device, the DMAI will arbitrate for and obtain ownership of the system bus.

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The DMAI indicates that it wishes to become the bus master by asserting its bus request (BRN) output. This is a wire-ORed signal that indicates to the MPU that some external device requires control of the bus. The processor is effectively at a lower priority level than external devices and will relinquish the bus after it has completed the last bus cycle it has started. The processor puts the bus up for external arbitration by asserting its bus grant (BGN) output. This signal may be routed through a daisy chain (such as provided by the DMAI) or through some other priority-encoded network. When the DMAI making the bus request receives the bus grant (indicated by its BGN input being asserted), it is to be the next bus master. It waits until address strobe (ASN), data transfer acknowledge (DTACKN) and bus grant acknowledge (BGACKN) become inactive and then assumes ownership of the bus by asserting its own BGACKN output. The DMAI then negates the BRN output and proceeds with the data transfer phase. After this phase is completed, the DMAI relinquishes bus ownership by negating the BGACKN output.

In burst DMA mode, detection of an active low request input after the DMAI operation has been started will begin the bus arbitration cycle. However, if the device negates its request at least one clock cycle before the DMAI asserts BGACKN, the DMAI will negate its bus request and will not assume ownership of the bus.

Data Transfers

The actual transfer of data between the memory and the device occurs during the data transfer phase. All transfers occur during a single cycle except in the case of long word operands, in which case two cycles are used to transfer the operand as two 16-bit words. The transfers take place using a 'single address' protocol; the DMAI addresses the memory via the bus address lines, while the device is implicitly addressed via the acknowledge output.

When a request is generated using the request method programmed in the control register, the DMAI obtains the bus and asserts acknowledge to notify the device that a transfer is to take place. The DMAI asserts all S68000 bus control signals needed for the transfer and holds them until the device responds with ready. The bus cycle then terminates normally. Ready may be tied low (asserted) if the device is fast enough.

When the transfer is from memory to the device, data is valid when DTACKN is asserted by the memory and remains valid until the data strobe(s) are negated. The assertion of DTCN from the DMAI can be used to latch the data, as the data strobes are not removed

until one-half clock after the assertion of DTCN.

When the transfer is from device to memory, the data must be valid on the bus before the DMAI asserts the data strobe(s). The device indicates valid data by asserting ready. The DMAI then asserts the strobes and holds them asserted until the memory accepts the data, indicated by the assertion of DTACKN. The DMAI then asserts DTCN and negates the data strobes.

Flow charts for these operations are shown in figures 1 and 2. Refer to the timing section for the equivalent timing diagrams.

Operation Termination

Termination of the block transfer occurs under the conditions detailed below.

Terminal Count

As part of each transfer of an operand, the DMAI decrements the memory transfer counter. If this counter is decremented to zero, the operand is the last operand of the block. The DMAI operation is complete and it notifies the device of completion by asserting the DONEN output during the last operand transfer cycle. When the transfer has been completed, the channel active bit in the CSR is cleared and the COC bit is set, unless an error occurs.

Device Termination

The DMAI monitors the state of the DONEN line while acknowledging a device transfer request. If the device asserts DONEN, the DMAI will terminate operation after the transfer of the current operand. When the transfer has been completed, the DMAI clears the channel active bit and sets the COC and normal device termination bits in the CSR. If both the DMAI and the device assert DONEN, the device termination is not recognized, but the operation does terminate.

Software Abort

The software abort bit (CCR[4]) allows the MPU to abort the current operation of the DMAI. The COC and error bits in the CSR are set, the channel active bit in the CSR is cleared, and an abort error condition is signaled in the CER.

Rerun Error

The DMAI provides a rerun input (RERUNN) to indicate a bus exception condition. RERUNN must arrive prior to or in coincidence with DTACKN in order to be recognized, and the DMAI verifies that the line has been stable for two clock cycles before acting on it. The occurrence of a rerun during a DMAI bus cycle forces it to terminate the bus cycle in an orderly manner.

When the assertion of rerun is verified, the DMAI stops operation and three-states the data, address, and control lines, except

BGACKN, so that it retains ownership of the bus. It remains halted until rerun becomes inactive, and then re-tries the last bus cycle. If rerun is asserted again, the DMAI stops DMA operation, releases the bus, sets the error and COC bits in the CSR, clears the active bit in the CSR, and sets the error code in the CER to indicate a bus error.

While stopped due to assertion of rerun, the DMAI does not generate any bus cycles and will not honor any requests until it is removed. However, the DMAI still recognizes requests.

Error Recovery Procedure

If an error occurs during a DMA transfer such that the DMAI stops the DMA operation, information is available to the operating system for an error recovery routine.

The information available to the operating system consists of the memory address counter, the memory transfer counter, and the control, status, and error registers. The DMAI decrements the memory transfer counter before attempting a DMA operation, so the register will contain the count minus one of the attempted transfer. The memory address counter will contain the address at which the DMA operation was attempted.

Reset

The reset input (RESETN) provides a means of resetting and initializing the DMAI from an external source. If the DMAI is a bus master when reset is received, the DMAI relinquishes the bus. Reset clears the control and error registers, sets all bits of the status register except CSR[8] to zero, and initializes the interrupt vector register to H'0'F.

Interrupts

The interrupt enable bit (CCR[3]) determines whether the DMAI generates interrupt requests. When the bit is set, an interrupt request is generated if the channel operation complete bit in the CSR is set. When the IACKN input is asserted, and the DMAI has an interrupt request pending, the DMAI returns an interrupt vector on the data bus.

The interrupt vector issued is the contents of the IVR. Only the seven most significant bits of the programmed value are used by the DMAI. The vector from the DMAI contains a zero in the LSB position if a normal termination occurred (error bit not set) and contains a one in the LSB position if termination was due to an error (error bit set).

The contents of this register are initialized to H'0'F by a reset. The value returned will be H'0'F, regardless of the error state, until the register is programmed by the MPU.

To provide compatibility with the other 68K family DMA controllers, the IVR has two addresses (see table 1). If program compatibility is required, the value written at the

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2

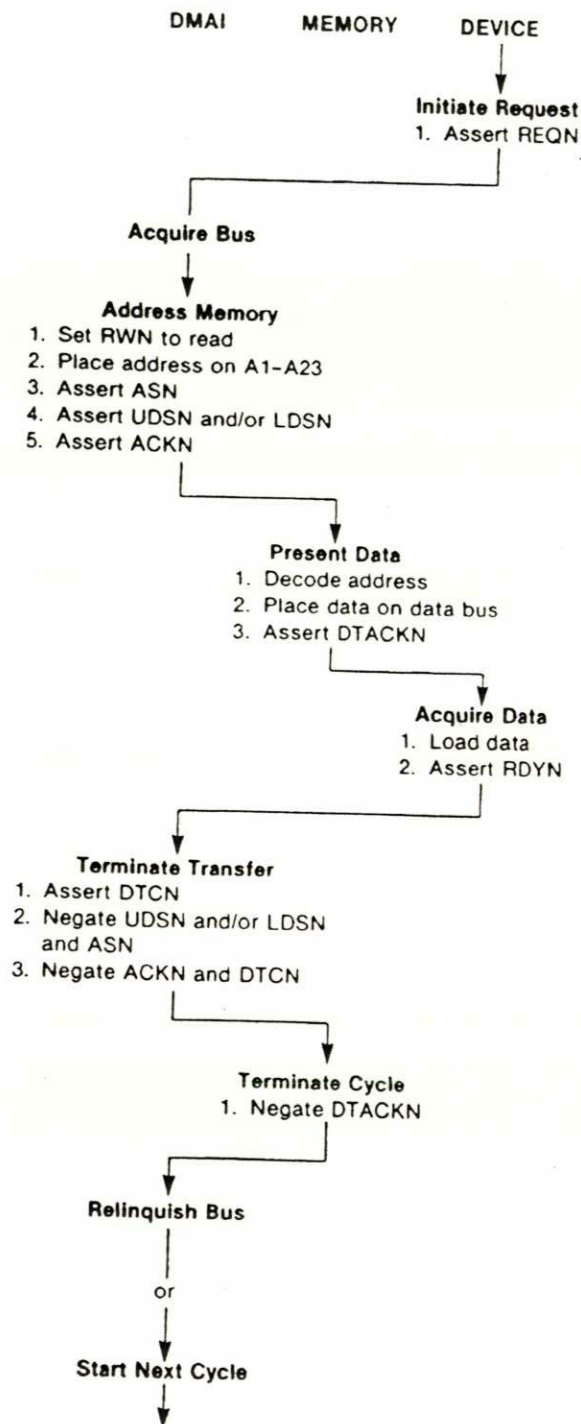


Figure 1. Transfer from Memory to Device Flowchart

PF004605

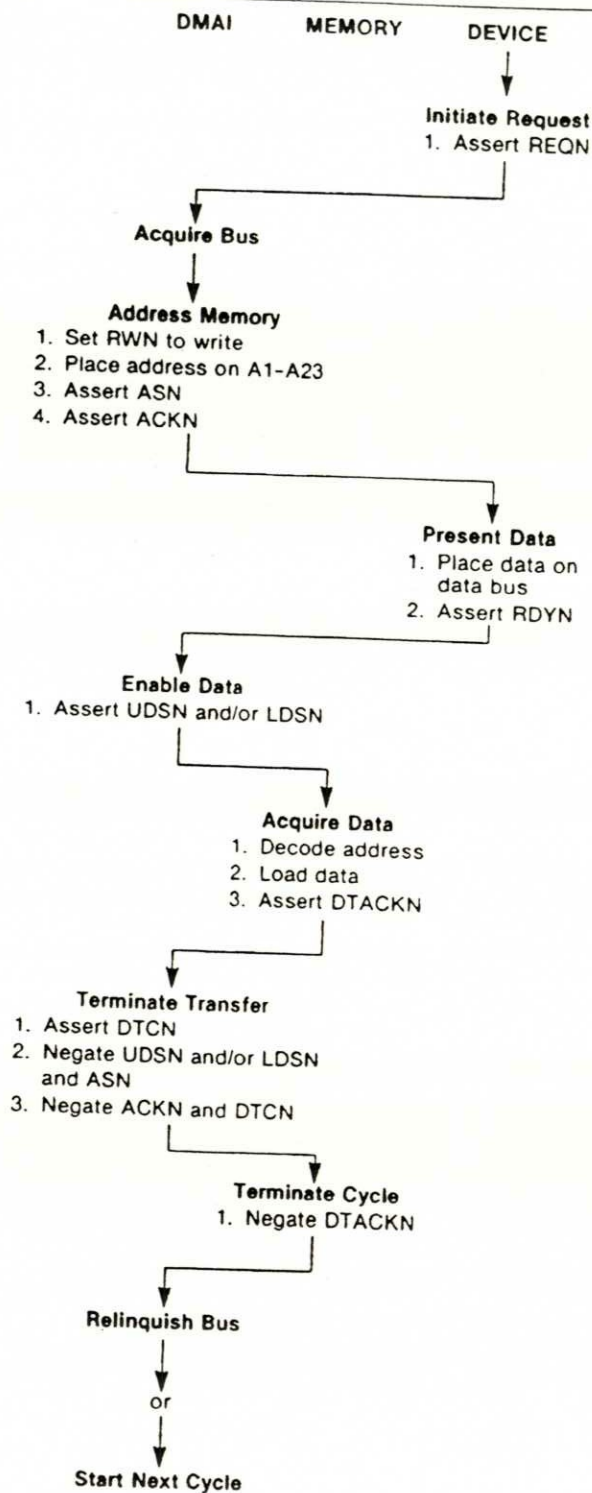


Figure 2. Transfer from Device to Memory Flowchart

PF004705

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normal IVR address should have a zero as its LSB, and the value written at the error IVR address should be the same but with the LSB equal to one.

DESIGN NOTE

When clearing the error bit in CSR (bit 12) after a DMAI abort due to a double RERUNN, ACKN and DTCN will both go low concurrent with CSN and DTACKN for one CLK cycle.

To prevent the possibility that the device may misinterpret these signals, it is suggested that these signals be ANDed with CSN (see figure below).

APPLICATIONS

Figure 3 illustrates a typical interconnection of the DMAI in a 68000 based system.

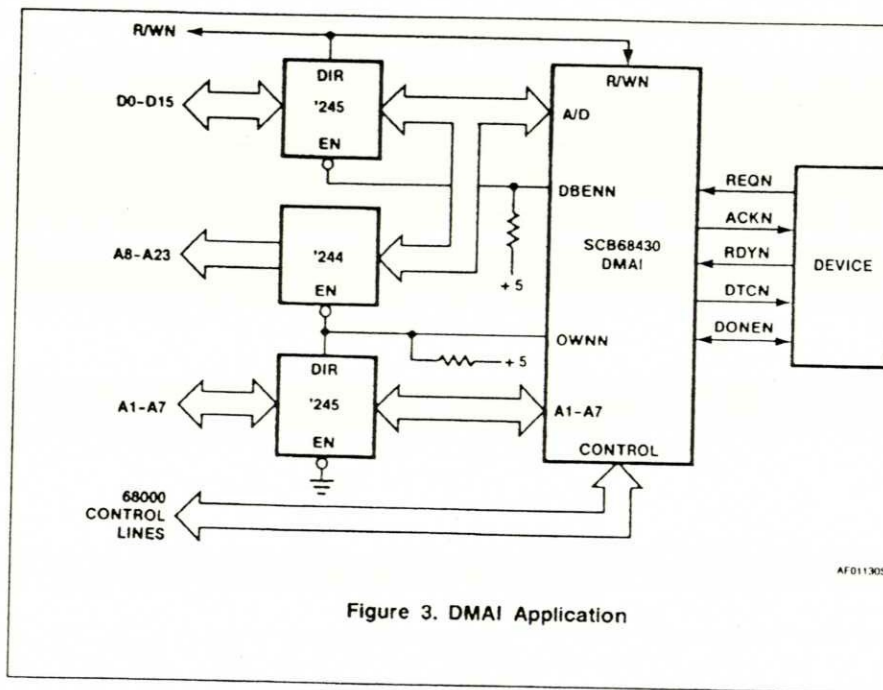
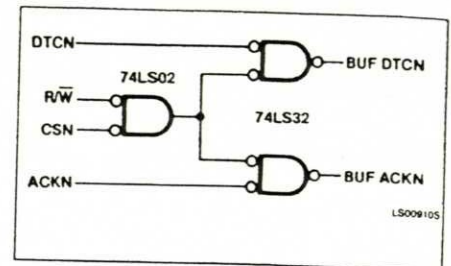
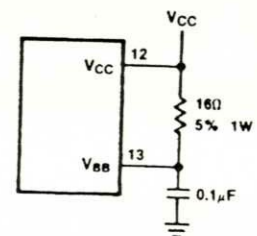


Figure 3. DMAI Application

Figure 4. Recommended V_{BB} Test Circuit

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ABSOLUTE MAXIMUM RATINGS¹

PARAMETER	RATING	UNIT
Supply voltages V_{CC} and V_{BB}	-0.5 to +7.0	V
Input voltage	-0.5 to +5.5	V
Operating temperature range ²	0 to +70	°C
Storage temperature	-65 to +150	°C

DC ELECTRICAL CHARACTERISTICS $V_{CC} = 5.0V \pm 5\%$, $V_{BB} = \text{Figure 4}$, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ ^{3,4,7}

PARAMETER	TEST CONDITIONS	LIMITS		UNIT
		Min	Max	
V_{IL} Input low voltage			0.8	V
V_{IH} Input high voltage		2.0		V
V_{OL} Output low voltage	$I_{OUT} = 5.3\text{mA}$		0.5	V
V_{OH} Output high voltage, all outputs except open collector outputs ⁵	$I_{OUT} = -400\mu\text{A}$	2.5		V
I_{IL} Input low current	$V_{IN} = 0.4\text{V}$		-400	μA
I_{IH} Input high current	$V_{IN} = 2.7\text{V}$		20	μA
I_{OC} Open collector off state current ⁵	$V_{OUT} = 2.4\text{V}$		20	μA
I_{SC} Output short circuit current ⁶	$V_{CC} = \text{max}$	-40	-100	mA
I_{CC} V_{CC} supply current	$V_{CC} = \text{max}$		130	mA
I_{BB} V_{BB} supply current	$V_{CC} = \text{max}$		275	mA

NOTES:

- Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is stress rating only and functional operation of the device at these or at any other conditions other than those indicated in the Electrical Characteristics section of this data sheet is not implied.
- For operating at elevated temperatures, the device must be derated based on $+150^\circ\text{C}$ maximum junction temperature.
- Parameters are valid over specified temperature range.
- All voltage measurements are referenced to ground (V_{SS}). For testing, all signals swing between 0.4V and 2.4V with a transition time of 20ns maximum. All time measurements are referenced at input voltages of 0.8V and 2.0V as appropriate.
- IRON, BRN, DONEN, and OWNN are open collector outputs.
- No more than one output should be connected to ground at one time.
- Capacitive test load is 100pF for all pins except DTCN which has a 35pF capacitive test load.

AC ELECTRICAL CHARACTERISTICS $V_{CC} = 5.0V \pm 5\%$, $V_{BB} = \text{Figure 4}$, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ ^{3,4,7}

NO.	FIGURE	CHARACTERISTICS	TENTATIVE LIMITS				UNIT
			10MHz		12.5MHz		
			Min	Max	Min	Max	
1	5	A1 - A7, ASN, RWN, set-up to UDSN, LDSN low	0		0		ns
2	5	D0 - D15 3-state to invalid data from ASN, CSN, and UDSN or LDSN low	10		10		ns
3	5	DTACKN 3-state to high from ASN, CSN, and UDSN or LDSN low	10		10		ns
4	5	CSN low after UDSN or LDSN low		25		25	ns
5	5, 6	DBENN low after ASN and CSN low		60		60	ns
6	5	D0 - D15 valid data from ASN, CSN, and UDSN or LDSN low		100		100	ns
7	5	DTACKN low after D0 - D15 valid data	-15	30	-15	30	ns
8	5	A1 - A7, ASN, RWN or CSN hold after UDSN and LDSN high	0		0		ns
9	5, 6	DBENN high from either ASN or CSN high		45		45	ns
10	5	D0 - D15 to 3-state from UDSN and LDSN high		80		80	ns
11	5	D0 - D15 to invalid data from UDSN and LDSN high	10		10		ns
12	5, 6	DTACKN high from UDSN and LDSN high		55		55	ns
13	5, 6	DTACK 3-state from either CSN or ASN high		85		85	ns
14	6	A1 - A7, ASN, RWN set-up to UDSN, LDSN low	50		50		ns/s
15	6	CSN set-up before UDSN or LDSN low	20		20		ns
16	6	DTACKN 3-state to high after CSN and ASN low	10		10		ns
17	6	D0 - D15 valid after UDSN or LDSN low		0		0	ns
18	6	DTACKN low from UDSN or LDSN low		100		100	ns
19	6	UDSN and LDSN low time	115		100		ns
20	6	A1 - A7 hold after UDSN and LDSN high	0		0		ns
21	6	ASN, RWN and CSN hold after UDSN and LDSN high	0		0		ns

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AC ELECTRICAL CHARACTERISTICS (Continued)

NO.	FIGURE	CHARACTERISTICS	TENTATIVE LIMITS				UNIT
			10MHz		12.5MHz		
			Min	Max	Min	Max	
22	6	D0 - D15 hold after UDSN and LDSN high	0		0		ns
23	7	DBENN low from last low of ASN, IACKN, LDSN		65		65	ns
24	7	D0 - D7 valid after last low of ASN, IACKN, LDSN		105		105	ns
25	7	DTACKN 3-state to high after last low of ASN, IACKN, LDSN		100		100	ns
26	7	DTACKN low after last low of ASN, IACKN, LDSN		110		110	ns
27	7	DBENN high after first high of ASN, IACKN, LDSN		55		55	ns
28	7	D0 - D7 hold after first high of ASN, IACKN, LDSN		60		60	ns
29	7	D0 - D7 3-state after first high of ASN, IACKN, LDSN		80		80	ns
30	7	DTACKN high after first high of ASN, IACKN, LDSN		60		60	ns
31	7	DTACKN 3-state after first high of ASN, IACKN, LDSN		95		95	ns
32	8	BRN high from CLK high		65		65	ns
33	8, 11, 12	BGACKN low from CLK low		75		75	ns
34	8, 11, 12	OWNN low from CLK high		75		75	ns
35	8	BGACKN high from CLK low		75		75	ns
36	8,11,12	OWNN high from CLK high (load dependent)		50		50	ns
37	10	REQN set-up before CLK low	30		30		ns
38	10	REQN hold after CLK high	20		20		ns
39	10	BRN low from CLK high		80		80	ns
41	11, 12	ASN, UDSN, LDSN, RWN 3-state to high from CLK low		75		75	ns
43	11, 12	A1 - A23 to valid ASN	0		0		ns
44	11, 12	ASN low from CLK high		65		65	ns
45	11, 12	LDSN, UDSN low from CLK high		90		90	ns
46	11, 12	ACKN low from CLK high		65		65	ns
47	11, 12	DTACKN set-up to CLK high	30		30		ns
48	11, 12	RDYN set-up to CLK low	30		30		ns
49	11, 12	DTCN low from CLK high		70		70	ns
50	11, 12	ASN high from CLK high		75		75	ns
51	11, 12	LDSN, UDSN, high from CLK high		90		90	ns
52	11, 12	DTACKN, RDYN hold after CLK high	0		0		ns
-	11, 12	ASN, LDSN, UDSN, high from DTCN low	-20		-20		ns
53	11, 12	ACKN high from CLK high		50		50	ns
54	11, 12	DTCN high from CLK high		50		50	ns
55	11, 12	Address valid after CLK low	10		10		ns
-	11, 12	Address valid after ASN high	0		10		ns
56	11, 12	DONEN (output) low from CLK low		120		120	ns
57	11, 12	DONEN (output) high from CLK high		50		50	ns
58	11, 12	DONEN (input) set-up low before CLK low	30		30		ns
59	11, 12	DONEN (input) hold low after CLK high	0		0		ns
60	11, 12	BGACKN, ASN, UDSN, LDSN, RWN to 3-state from CLK low		75		75	ns
62	11, 12	A1 - A23 valid to 3-state from CLK high		100		100	ns
63	12	R/WN low from CLK high		65		65	ns
64	12	R/WN high from CLK high		75		75	ns
65	13	RERUNN set-up low before CLK high	30		30		ns
66	13	RERUNN hold low from CLK high	20		20		ns
67	13	A1 - A23 to idle state from CLK low		100		100	ns
68	13	A1 - A23 to valid after CLK low		85		85	ns

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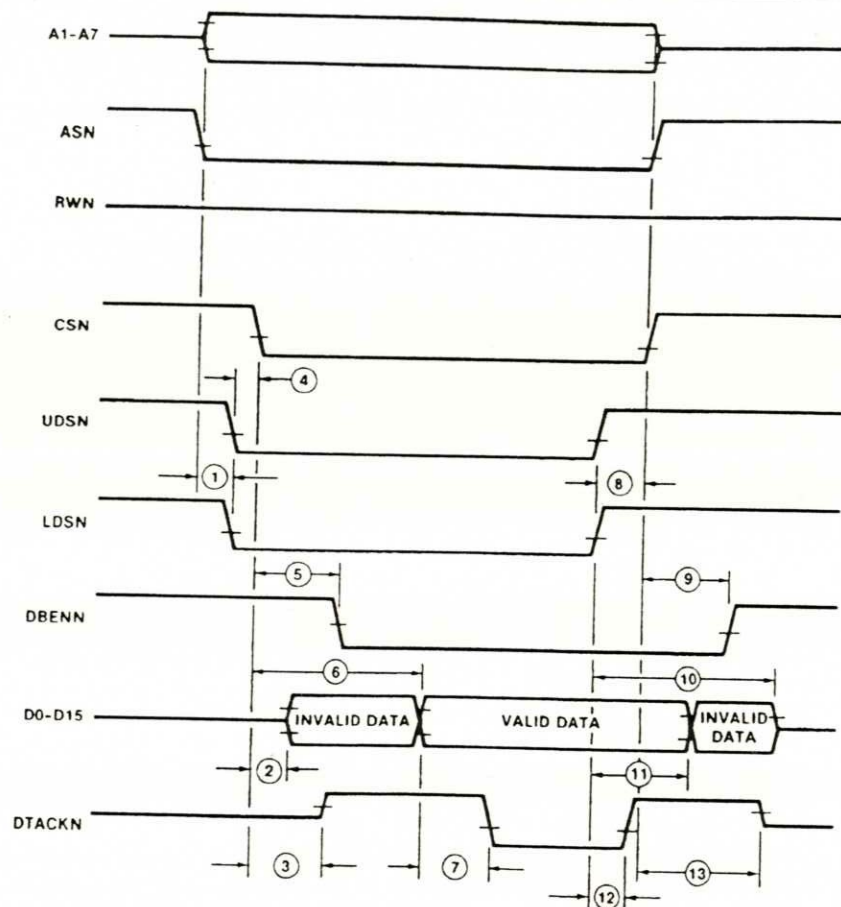
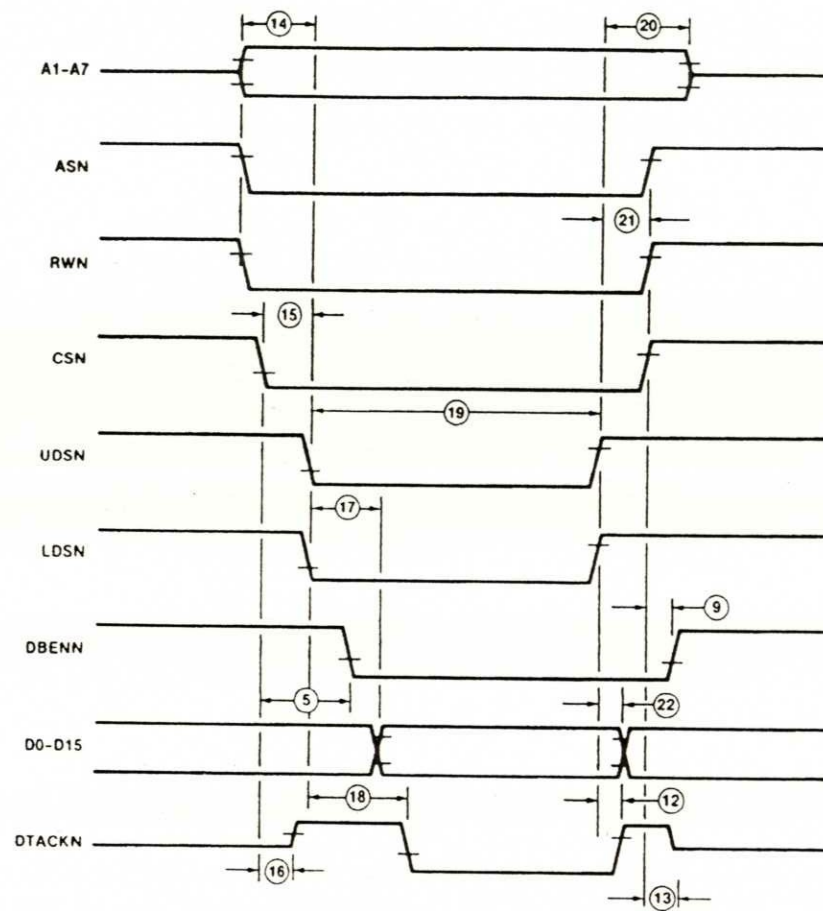


Figure 5. DMAI Read Timing

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WT030505

Figure 6. DMAI Write Timing

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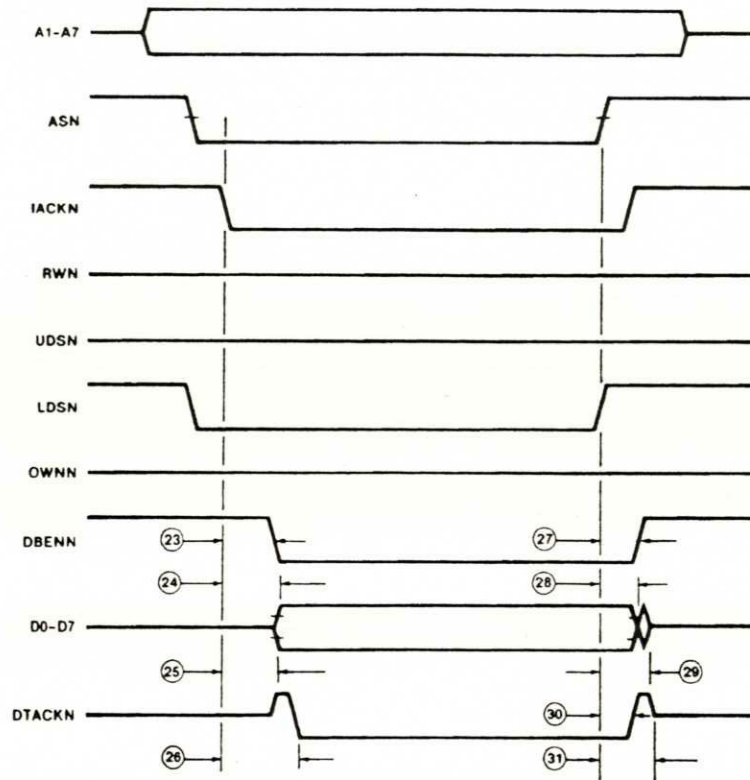
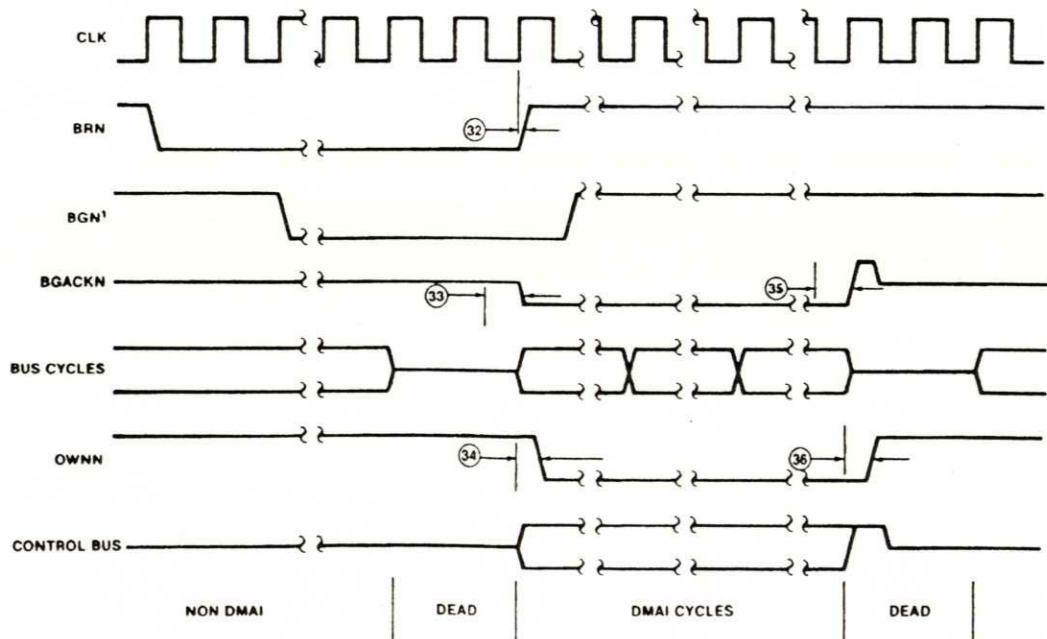


Figure 7. CPU IACK Cycle to DMAI



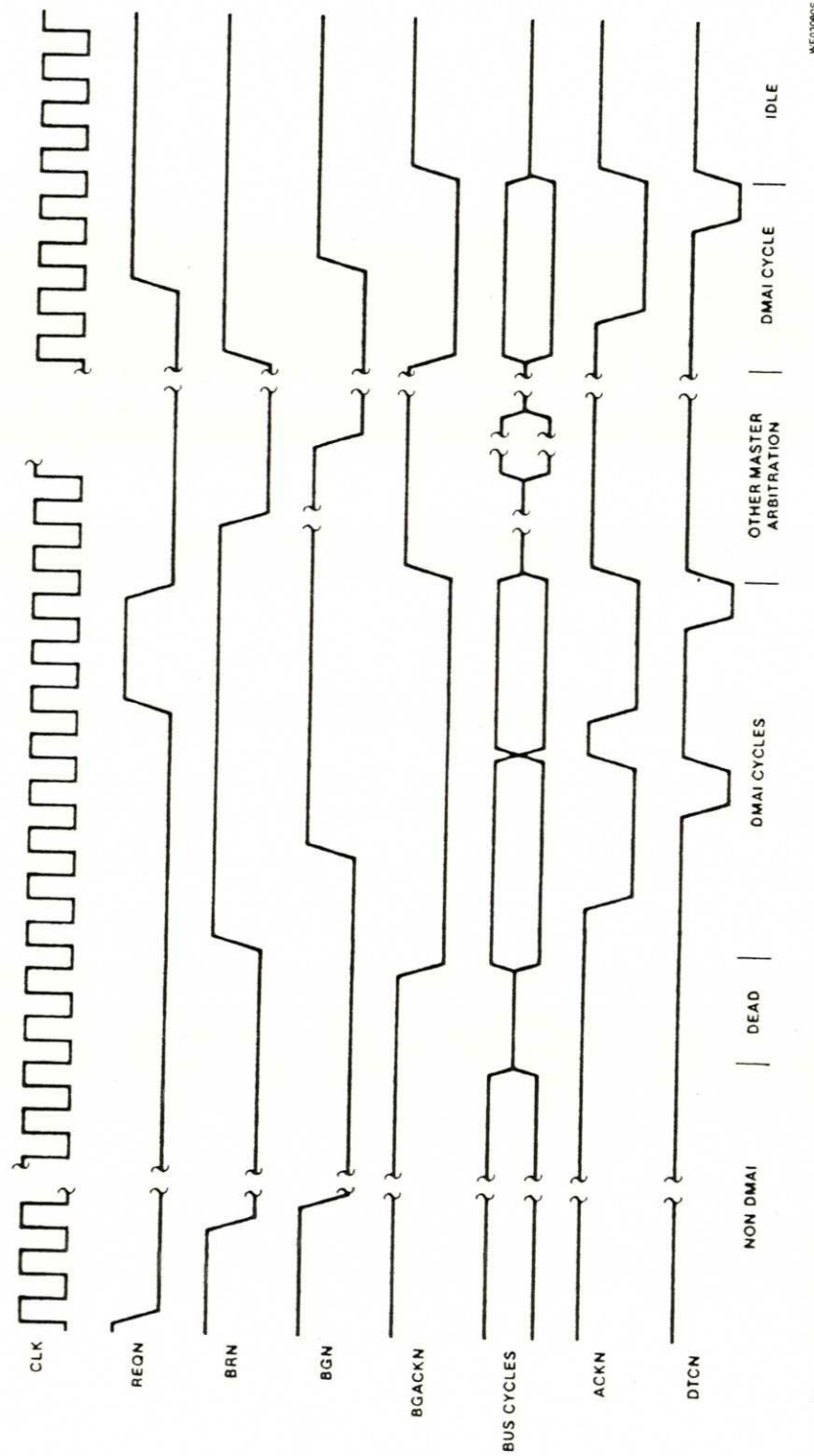
NOTES:

1. Device will become master if BGN is asserted concurrent with or later than REQN (same clock edge or later).
2. ASN, DTACKN and BGACKN must be negated in order for DMAI to become master. Timing assumes all these happen concurrent with BGN—if not, it is from the latest signal which is negated.

Figure 8. DMAI Bus Arbitration Timing

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NOTES:

1. To maintain master-ship next bus cycle, REON must remain asserted at least until 1/2 clock cycle after DTCN is asserted.
2. To guarantee that master-ship is relinquished next cycle, REON must be negated no later than 1/2 clock cycle prior to DTCN.

Figure 9. DMAI Burst Mode Request Timing

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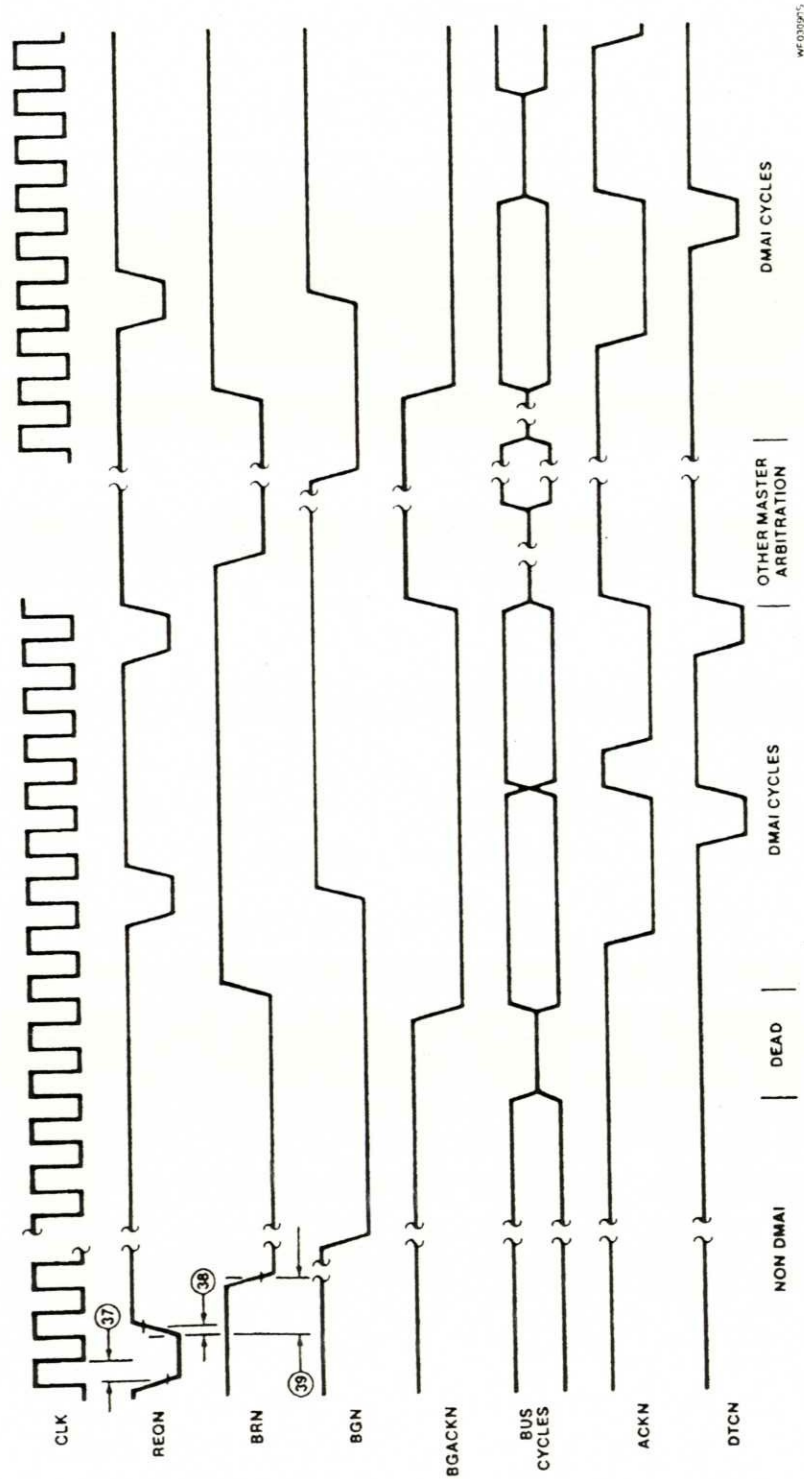
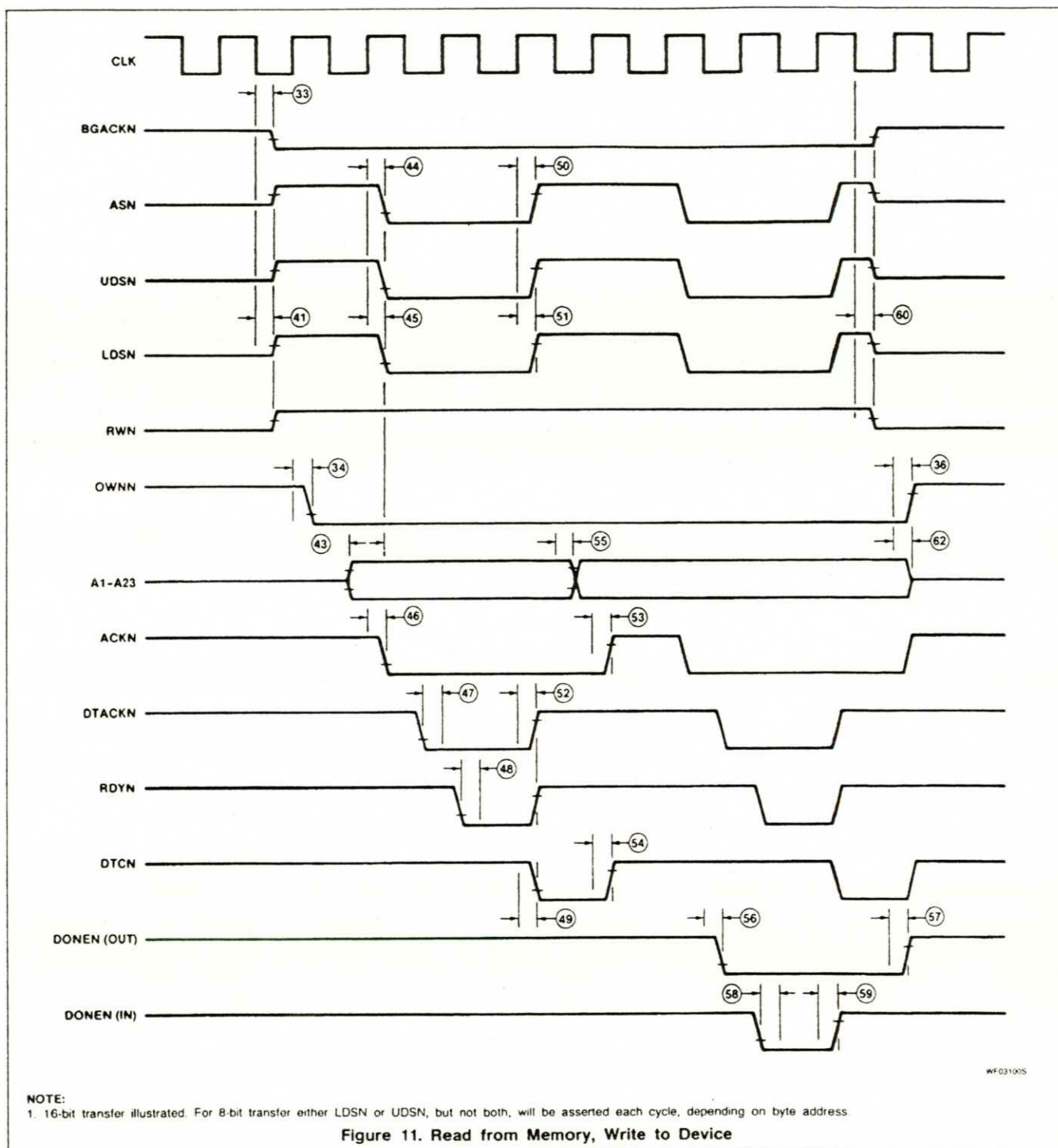


Figure 10. DMAI Cycle Steal Mode Request Timing

1. In order to keep the bus, REON must come no later than the 1/2 clock minus the set-up time (37) prior to assertion edge of DTCN.

Direct Memory Access Interface (DMAI)

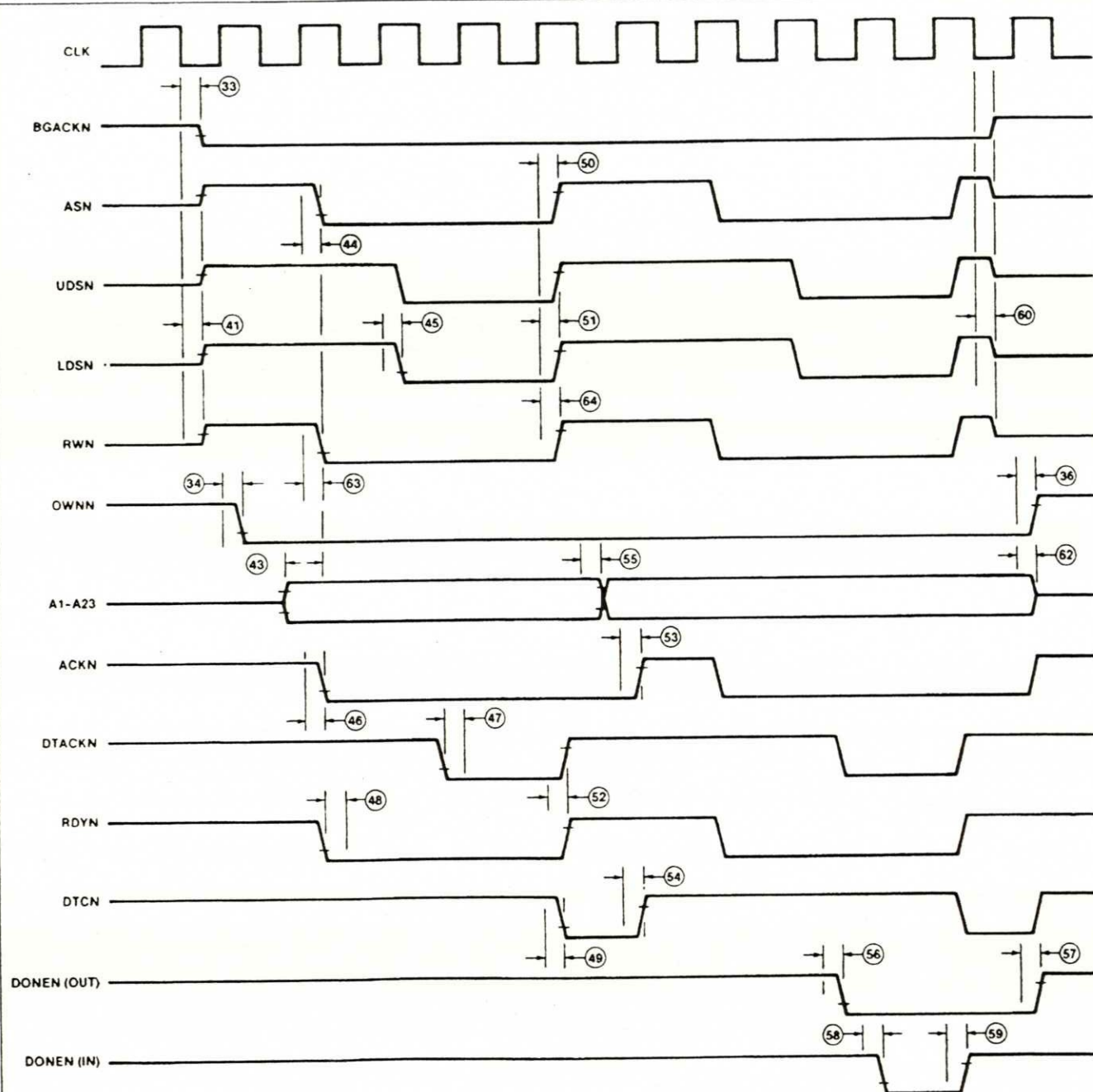
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WF031105

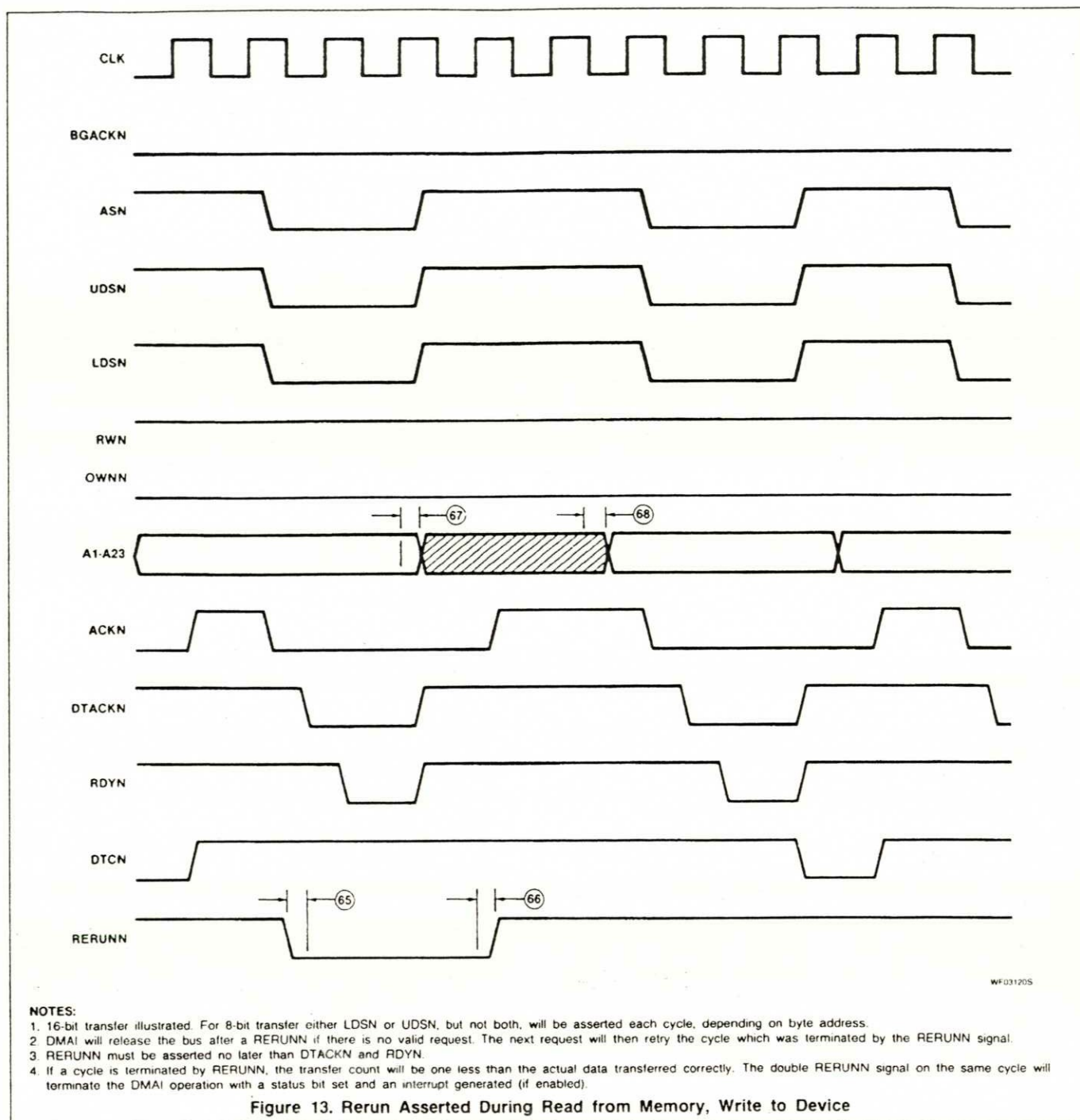
NOTE:

1. 16-bit transfer illustrated. For 8-bit transfer either LDSN or UDSN, but not both, will be asserted each cycle, depending on byte address.

Figure 12. Write to Memory, Read from Device

Direct Memory Access Interface (DMAI)

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APPENDIX C

SAMPLE SOFTWARE LISTINGS

src=drllwa4.sa

```

*****
*
*      DR11A4:  DR11WA DATA TRANSFER TESTS
*      -----
*      MODE_M:  Start test processing sequence as a master.
*      MODE_S:  Start test processing sequence as a slave.
*
*****

*      This is the main entry point to transfer tests

XDEF      DR11A4              drllWA Dma (+) transfer tests

*      These entry points are for setup modifications

XDEF      SETMTC              set the transfer counter
XDEF      SETMAC              set the address counter
XDEF      SETAMR              set the address modifier
XDEF      SETEMA              set the extended address
XDEF      SETC33              set def's for cpu33 buffers
XDEF      SETRR2              set def's for rr2 buffers
XDEF      DUMP_T              dump dma transfer tables
XDEF      TEST                transfer test enable flags
XDEF      TDATA               reference single test data

*      Reference external subroutines and variables

XREF      DSPBYTE             display byte subr
XREF      DSPWORD             display word subr
XREF      DSPLONG             display long subr
XREF      FLAGS               program (test) flags
XREF      PCOUNT              loop on test pass count
XREF      FCOUNT              loop on test fail count

INCLUDE   VMEPROM.SA

*****
*
*      VMEPROM INTERFACE SUPPORT CODE
*      =====
*      Copyright 1989 Vme Microsystems International Corp.
*      =====
*      VMEPROM.SA contains the assembler options,
*      constants and macros for assembling Development
*      Test code that is to be ran on a Force Cpu board
*      under Vmeprom/Pdos. This code is presently being
*      assembled on the motorola Vme/10 development system
*      or compatable cross-assembler on the IBM PC
*      (msdos). This code is included in the test source
*      at assembly time in each module as it is needed. It
*      is usually listed only once at the beginning in the
*      primary or 'main' module of the listing print file.
*      Recently included are parameters for four commonly
*      used terminals and the macro to install them in the
*      TCB of the current task. (this must be done before

```

```

*      changing register A6 in the test code software).      *
*      -----      *
*      Version 2.00.02.14.90   by   Clark Coe Gwathney Jr.   *
*      *      *
*****
*
*****[ TYPICAL ASSEMBLER OPTIONS ]*****
*
      OPT      P=68020      use 68020 instruction coding
      OPT      NOCEX      do not print dc.x definitions
      OPT      NOMEX      do not print macro expansions
*
*****[ ASCII CONTROL EQUATES ]*****
*
<00000000>      NUL      EQU      00      null
<00000001>      SOH      EQU      01      start of header
<00000002>      STX      EQU      02      start of text
<00000003>      ETX      EQU      03      end of text
<00000004>      EOT      EQU      04      end of transmission
<00000005>      ENQ      EQU      05      inquiry
<00000006>      ACK      EQU      06      acknowledge
<00000007>      BEL      EQU      07      bell (beep)
<00000008>      BS      EQU      08      backspace
<00000009>      HT      EQU      09      horizontal tab
<0000000A>      LF      EQU      10      line feed
<0000000B>      VT      EQU      11      vertical tab
<0000000C>      FF      EQU      12      form feed
<0000000D>      CR      EQU      13      carriage return
<0000000E>      SO      EQU      14
<0000000F>      SI      EQU      15
<00000010>      DLE      EQU      16
<00000011>      DC1      EQU      17      device control 1 (xon)
<00000012>      DC2      EQU      18      device control 2
<00000013>      DC3      EQU      19      device control 3 (xoff)
<00000014>      DC4      EQU      20      device control 4
<00000015>      NAK      EQU      21      not acknowledge
<00000016>      SYN      EQU      22
<00000017>      ETB      EQU      23      end of transmission block
<00000018>      CAN      EQU      24      cancel
<00000019>      EM      EQU      25
<0000001A>      SUB      EQU      26
<0000001B>      ESC      EQU      27      escape
<0000001C>      FS      EQU      28
<0000001D>      GS      EQU      29
<0000001E>      RS      EQU      30
<0000001F>      US      EQU      31
<0000007F>      DEL      EQU      127      delete
*
*****[ VMEPROM / PDOS SYSTEM CALL EQUATES ]*****
*
<0000A006>      X881      EQU      $A006      save 68881 flags on switch
<0000A0AA>      XAPF      EQU      $A0AA      append file to file
<0000A070>      XBCP      EQU      $A070      set baud on console port
<0000A072>      XCBC      EQU      $A072      check for break character
<0000A050>      XCBD      EQU      $A050      convert binary to decimal

```

<0000A052>	XCBH	EQU	\$A052	convert binary to hex
<0000A054>	XCBM	EQU	\$A054	convert to decimal w/message
<0000A074>	XCBP	EQU	\$A074	check for break or pause
<0000A06A>	XCBX	EQU	\$A06A	convert to decimal in buffer
<0000A056>	XCDB	EQU	\$A056	convert ascii to binary
<0000A0D0>	XCFA	EQU	\$A0D0	close file with attribute
<0000A068>	XCHX	EQU	\$A068	convert binary to hex in buffer
<0000A0D2>	XCLF	EQU	\$A0D2	close opened file
<0000A076>	XCLS	EQU	\$A076	clear screen (TCB parms)
<0000A0AE>	XCPY	EQU	\$A0AE	copy file
<0000A026>	XCTB	EQU	\$A026	create task block
<0000A032>	XDEV	EQU	\$A032	delay set/reset event
<0000A0D4>	XDFL	EQU	\$A0D4	define file
<0000A0D6>	XDLF	EQU	\$A0D6	delete file
<0000A04A>	XDMP	EQU	\$A04A	dump memory from stack
<0000A114>	XDPE	EQU	\$A114	delay physical event
<0000A024>	XDTV	EQU	\$A024	define trap vectors
<0000A00C>	XERR	EQU	\$A00C	return error to vmeprom
<0000A030>	XEXC	EQU	\$A030	execute pdos call in d7.w
<0000A00E>	XEXT	EQU	\$A00E	exit to vmeprom
<0000A0CE>	XFAC	EQU	\$A0CE	file altered check
<0000A0F8>	XFBF	EQU	\$A0F8	flush buffers
<0000A0A0>	XFFN	EQU	\$A0A0	fix file name
<0000A058>	XFTD	EQU	\$A058	fix time & date
<0000A040>	XFUM	EQU	\$A040	free user memory
<0000A048>	XGCB	EQU	\$A048	conditional get char
<0000A078>	XGCC	EQU	\$A078	get char conditional
<0000A09E>	XGCP	EQU	\$A09E	get char from port
<0000A07A>	XGCR	EQU	\$A07A	get character raw
<0000A07C>	XGLB	EQU	\$A07C	get line in buffer
<0000A07E>	XGLM	EQU	\$A07E	get line in mon. buff
<0000A080>	XGLU	EQU	\$A080	get line in user buff
<0000A010>	XGML	EQU	\$A010	get memory limits
<0000A004>	XGMP	EQU	\$A004	get message pointer
<0000A05A>	XGNP	EQU	\$A05A	get next parameter
<0000A01E>	XGTM	EQU	\$A01E	get task message
<0000A03E>	XGUM	EQU	\$A03E	get user memory
<0000A0C0>	XISE	EQU	\$A0C0	initialize sector
<0000A0FA>	XKTB	EQU	\$A0FA	kill task
<0000A028>	XKTM	EQU	\$A028	kill task message
<0000A0B0>	XLDF	EQU	\$A0B0	load file
<0000A03A>	XLER	EQU	\$A03A	load error register
<0000A0A2>	XLFN	EQU	\$A0A2	look for file name
<0000A0D8>	XLKF	EQU	\$A0D8	lock file
<0000A014>	XLKT	EQU	\$A014	lock task
<0000A02E>	XLSR	EQU	\$A02E	load status register
<0000A0DA>	XNOP	EQU	\$A0DA	open random shared file
<0000A00A>	XPAD	EQU	\$A00A	pack ascii date
<0000A084>	XPBC	EQU	\$A084	put buffer to console
<0000A086>	XPCC	EQU	\$A086	put char's to console
<0000A088>	XPCL	EQU	\$A088	put cr,lf to console
<0000A0BC>	XPCP	EQU	\$A0BC	place char in port buffer
<0000A0BA>	XPCR	EQU	\$A0BA	put character raw
<0000A096>	XPDC	EQU	\$A096	put data to console
<0000A09C>	XPEM	EQU	\$A09C	put encoded msg to console

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<0000A08A>	XPLC	EQU	\$A08A	put line to console
<0000A08C>	XPMC	EQU	\$A08C	put message to console
<0000A08E>	XPSC	EQU	\$A08E	put cursor @ row,col
<0000A0DC>	XPSF	EQU	\$A0DC	position file
<0000A098>	XPSP	EQU	\$A098	put space to console
<0000A0DE>	XRBF	EQU	\$A0DE	read bytes from file
<0000A0B2>	XRCN	EQU	\$A0B2	reset console inputs
<0000A092>	XRCP	EQU	\$A092	read port cursor position
<0000A0A6>	XRDE	EQU	\$A0A6	read next directory entry
<0000A02A>	XRDM	EQU	\$A02A	dump processor registers
<0000A0A8>	XRDN	EQU	\$A0A8	read dir entry by name
<0000A05C>	XRDT	EQU	\$A05C	read date
<0000A0E0>	XRFA	EQU	\$A0E0	read file attributes
<0000A0FE>	XRFP	EQU	\$A0FE	read file position
<0000A0E2>	XRLF	EQU	\$A0E2	read line from file
<0000A0E4>	XRNF	EQU	\$A0E4	rename file
<0000A0E6>	XROO	EQU	\$A0E6	open random read only file
<0000A0E8>	XROP	EQU	\$A0E8	open random file
<0000A094>	XRPS	EQU	\$A094	read port status
<0000A0C2>	XRSE	EQU	\$A0C2	read sector
<0000A042>	XRSR	EQU	\$A042	read status register
<0000A0B4>	XRST	EQU	\$A0B4	reset disk
<0000A0C4>	XRSZ	EQU	\$A0C4	read sector zero
<0000A044>	XRTE	EQU	\$A044	return from interrupt
<0000A05E>	XRTM	EQU	\$A05E	read time
<0000A034>	XRTP	EQU	\$A034	read time parameters
<0000A012>	XRTS	EQU	\$A012	read task status
<0000A0EA>	XRWF	EQU	\$A0EA	rewind file
<0000A018>	XSEF	EQU	\$A018	set event flag w/swap
<0000A046>	XSEV	EQU	\$A046	set event flag
<0000A002>	XSMP	EQU	\$A002	send message pointer
<0000A112>	XSOE	EQU	\$A112	suspend on physical event
<0000A0EC>	XSOP	EQU	\$A0EC	open sequential file
<0000A09A>	XSPF	EQU	\$A09A	set port flag
<0000A020>	XSTM	EQU	\$A020	send task message
<0000A03C>	XSTP	EQU	\$A03C	set/read task priority
<0000A01C>	XSUI	EQU	\$A01C	suspend until event intr
<0000A02C>	XSUP	EQU	\$A02C	enter supervisor mode
<0000A000>	XSWP	EQU	\$A000	swap to next task
<0000A0B6>	XSZF	EQU	\$A0B6	get disk size
<0000A090>	XTAB	EQU	\$A090	tab to column
<0000A01A>	XTEF	EQU	\$A01A	test event flag
<0000A110>	XTLP	EQU	\$A110	xlate logical to phys event
<0000A036>	XUAD	EQU	\$A036	unpack ascii date
<0000A060>	XUDT	EQU	\$A060	unpack date
<0000A0EE>	XULF	EQU	\$A0EE	unlock file
<0000A016>	XULT	EQU	\$A016	unlock task
<0000A008>	XUSP	EQU	\$A008	return to user mode
<0000A062>	XUTM	EQU	\$A062	unpack time
<0000A116>	XVEC	EQU	\$A116	set/read exception vector
<0000A0F0>	XWBF	EQU	\$A0F0	write bytes to file
<0000A064>	XWDT	EQU	\$A064	write date
<0000A0F2>	XWFA	EQU	\$A0F2	write file attributes
<0000A0FC>	XWFP	EQU	\$A0FC	write file parameters
<0000A0F4>	XWLF	EQU	\$A0F4	write line to file

```

<0000A0C6>    KWSE    EQU    $A0C6            write sector
<0000A066>    KWTM    EQU    $A066            write time
<0000A0F6>    XZFL    EQU    $A0F6            zero file (wipe)
*
*****[ TERMINAL SETUP PARAMETERS ]*****
*
*   Vmeprom TCB terminal setups (see ST cmd in vmeprom)
*
<C8CA9B59>    V52     EQU    $C8CA9B59        DEC V52
<1A009B3D>    ADM3A   EQU    $1A009B3D        LEER SEIGLER ADM3A
<00000000>    VT100   EQU    $00000000        DEC VT100
<1E1A9B3D>    TVI950  EQU    $1E1A9B3D        TELE VIDIO TVI 950
*
*****[ FORCE CPU DEVICE ADDRESS EQUATES ]*****
*
*   PI/T 2 Timer address equates
*
<FF800E00>    PIT2    EQU    $FF800E00        Force cpu pit2 base address
*
<FF800E10>    TCR     EQU    PIT2+$10        timer control register
<FF800E1A>    TSR     EQU    PIT2+$1A        timer status register
<FF800E12>    CPR     EQU    PIT2+$12        counter preload register
<FF800E16>    CTR     EQU    PIT2+$16        counter register
*
*****[ TEST MACRO DEFINITIONS ]*****
*
PUSH          MACRO
MOVEM.L      \1,-(A7)                Push register(s) on stack
ENDM

POP           MACRO
MOVEM.L      (A7)+,\1                pop register(s) off stack
ENDM

CLC           MACRO
ANDI.B       #$FE,CCR                clear carry flag in CCR
ENDM

STC           MACRO
ORI.B        #$1,CCR                set carry flag in CCR
ENDM

SYSCALL      MACRO
DC.W         \1                      Vmeprom line a opcode emulation
ENDM

DISPLAY      MACRO
LEA          \1,A1                  point to start of message
SYSCALL      XPLC                    put line to console
ENDM

PROMPT       MACRO
LEA          \1,A1                  point to prompt msg
SYSCALL      XPLC                    put line to console
SYSCALL      XGCR                    get char from console
SYSCALL      XPCR                    put char to console
ENDM

TERM         MACRO
MOVE.L       \1,($43A,A6)            set terminal parms in TCB
ENDM

WAIT         MACRO

```

```

                                MOVE.L    \1,D0                load do with delay value
                                BSR        DELAY                and call pit2 delay subr
                                ENDM
                                INCLUDE    DR11WA.EQ
*                                Base pointer for VME short I/O

<FBFFE000>    VMEIO    EQU        $FBFF0000                Short I/O on Force Cpu's

*                                Base Address for Vnet board registers

<FBFFE000>    DR11     EQU        VMEIO+$E000                Base address of DR11W

*                                Offset Address Equates for the Dmai module

<FBFFE000>    CHSR     EQU        DR11+$00                Channel Status Register
<FBFFE001>    CHER     EQU        DR11+$01                Channel Error Register
<FBFFE004>    DCR      EQU        DR11+$04                Device Control Register
<FBFFE005>    OCR      EQU        DR11+$05                Operation Ctrl Register
<FBFFE007>    CHCR     EQU        DR11+$07                Channel Ctrl Register
<FBFFE00A>    MTC      EQU        DR11+$0A                Mem. Transfer Count
<FBFFE00C>    MACH     EQU        DR11+$0C                Mem. Address Count High
<FBFFE00E>    MACL     EQU        DR11+$0E                Mem. Address Count Low
<FBFFE025>    DIVR     EQU        DR11+$25                Done Intr Vector Register

*                                Offset Address Equates for the Bim module

<FBFFE043>    BICR     EQU        DR11+$43                Berr Intr Ctrl Register
<FBFFE045>    AICR     EQU        DR11+$45                Attention Intr Ctrl Reg
<FBFFE047>    DICR     EQU        DR11+$47                Dma Done Intr Ctrl Reg
<FBFFE04B>    BIVR     EQU        DR11+$4B                Berr Intr Vect Register
<FBFFE04D>    AIVR     EQU        DR11+$4D                Attention Intr Vect Reg

*                                Offset Address Equates for Vnet board registers

<FBFFE060>    BSR      EQU        DR11+$60                Board Status Register
<FBFFE061>    BCR      EQU        DR11+$61                Board Control Register
<FBFFE062>    IODR     EQU        DR11+$62                I/O Data Register
<FBFFE064>    EMA      EQU        DR11+$64                Extended Mem Address Reg    <=
<FBFFE065>    AMR      EQU        DR11+$65                Address Modifier Reg
<FBFFE066>    MCR      EQU        DR11+$66                Master Control Register    <=
<FBFFE069>    BSRA     EQU        DR11+$69                Board Status Reg A (dr11wa) <=
<FBFFE06A>    LIDR     EQU        DR11+$6A                Load Input Data Register    <=
<FBFFE070>    ODP      EQU        DR11+$70                Output Data Register         <=
<FBFFE078>    IDP      EQU        DR11+$78                Input Data Register          <=

*                                DR11WA command equates

<00000000>    NULL     EQU        $0000                null (sync) cmd
<00000001>    ACKN     EQU        $0001                acknowledge cmd
<00000002>    LREQ     EQU        $0002                link request cmd
<00000003>    BYTE     EQU        $0003                set byte dma mode
<00000004>    WORD     EQU        $0004                set word dma mode
<00000005>    LONG     EQU        $0005                set long dma mode
<00000006>    SEND     EQU        $0006                Go dma Transmit
<00000007>    RCVE     EQU        $0007                Go dma receive
```



```

<00000008> BRST EQU $0008 set burst dma
<00000009> CYCL EQU $0009 set cycle dma
<0000000A> EXIT EQU $000A set exit loop flag
<0000000B> ABRT EQU $000B set abort mode flag
<0000000C> SWAP EQU $000C set swap command flag
<0000000D> BADC EQU $000D bad cmd ack to master

*****
*
* Swap to supervisor to get VBR then back ...

/00
000000 DR11A4 SYSCALL XSUP Supervisor mode on 29
000002 4E7A8801 MOVEC VBR,A0 get Vector Base pointer
000006 SYSCALL XUSP back to User mode

* Init Interrupt Vector Table (@ VBR)

000008 217C00000000+ INITS MOVE.L #DONE,($150,A0) Init Done Vector Addr ($54)
000010 217C00000000+ MOVE.L #DERR,($154,A0) Init Derr Vector Addr ($55)
000018 217C00000000+ MOVE.L #BERR,($158,A0) Init Berr Vector Addr ($56)
000020 217C00000000+ MOVE.L #ATTN,($15C,A0) Init Attn Vector Addr ($57)

* Init Interrupt vector registers

000028 13FC0054+ MOVE.B #$54,DIVR Init Done Intr vector reg
000030 13FC0056+ MOVE.B #$56,BIVR Init Berr Intr vector reg

* Init program variables

000038 23FC00000000+ MOVE.L #DTBL,DPTR init test data pointer
000042 42B900000000 CLR.L PCOUNT clear passed count
000048 42B900000000 CLR.L FCOUNT clear failed count

*****
*
* SHOW WE'RE HERE AND PROMPT FOR START AS MASTER OR SLAVE
*
*****

00004E DR11A DISPLAY DR11_M show dr11 dma testing
000056 SELECT PROMPT SLCT_M display select mode msg
000062 0C000058 CMP.B #'X',D0 select 'X' for exit this ..
000066 6718 BEQ.S DR11W_X then exit to main menu
000068 0C00004D CMP.B #'M',D0 start in Master mode?
00006C 67000056 BEQ M_MODE then start as master
000070 0C000053 CMP.B #'S',D0 start in Slave mode?
000074 670C BEQ.S S_MODE then start as slave
000076 DISPLAY ARGH_M for an invalid selection
00007E 60D6 BRA.S SELECT and repeat selection
000080 4E75 DR11W_X RTS return to main menu

*****
*
* S: START THIS NODE IN SLAVE MODE TRANSFER TESTS
*
```

```

*
*****

000082 13FC002C+  S_MODE  MOVE.B  #$2C,BCR      Fled_off,dir_in,en_attn
00008A 13FC0000+      MOVE.B  #$00,BICR      disable Berr interrupt
000092 13FC0057+      MOVE.B  #$57,AIVR      Set Attn intr vector
00009A 13FC001E+      MOVE.B  #$1E,AICR      enable Attn interrupt
0000A2 61000062      S_LOOP  BSR      SLAVE      slave/responder mode
0000A6 08390007+      BTST     #7,TEST+0      Master mode enabled ?
0000AE 6704          BEQ.S     S_ONLY      then do Slave only
0000B0 610000A0      BSR      MASTER      master/initiator mode
0000B4 08390001+  S_ONLY  BTST     #1,FLAGS      check loop on test flag
0000BC 6704          BEQ.S     S_EXIT      if not set then exit else
0000BE          SYSCALL  XGCC      check for key entry to
0000C0 67E0          BEQ.S     S_LOOP      continue or exit test
0000C2 4E75          S_EXIT  RTS      return from module

*****
*
*      M: START THIS NODE IN MASTER MODE TRANSFER TESTS
*
*****

0000C4 13FC002C+  M_MODE  MOVE.B  #$2C,BCR      Fled_off,dir_in,en_attn
0000CC 13FC0000+      MOVE.B  #$00,BICR      don't enable BERR inter
0000D4 13FC0057+      MOVE.B  #$57,AIVR      Set Attn intr vector
0000DC 13FC001E+      MOVE.B  #$1E,AICR      enable ATTN interrupt
0000E4 6100006C      M_LOOP  BSR      MASTER      master/initiator mode
0000E8 08390006+      BTST     #6,TEST+0      Slave mode enabled ?
0000F0 6704          BEQ.S     M_ONLY      then do Master only
0000F2 61000012      BSR      SLAVE      slave/responder mode
0000F6 08390001+  M_ONLY  BTST     #1,FLAGS      check loop on test flag
0000FE 6704          BEQ.S     M_EXIT      if not set then exit else
000100          SYSCALL  XGCC      check for key entry to
000102 67E0          BEQ.S     M_LOOP      continue or exit test
000104 4E75          M_EXIT  RTS      return from module

*****
*
*      SLAVE or RESPONDER Sequence
*
*****

000106          SLAVE  DISPLAY  SLAV_M      show we are in slave mode
00010E 6100044E      S0      BSR      GET_C      waiting for command input
000112 02F90000+      CMP2.W  VALID,D0      for a valid command word
00011A 651C          BCS.S     S1      ignore invalid command
00011C 41F900000000      LEA      SCMDS,A0      point to slave cmd table
000122 20700400      MOVE.L  (A0,D0.W*4),A0      get cmd handler address
000126 4E90          JSR      (A0)      jump subr to cmd handler
000128 08B90002+      BCLR     #2,FLAGS      test skip ackn flag because
000130 66DC          BNE      S0      some commands shouldn't ackn
000132 61000450      BSR      SLACK      Send SLave Cmd Acknowledge
000136 60D6          BRA      S0      and continue slave mode

```

```

*          Handle slave command errors

000138      S1      DISPLAY  CERR_M          show command error message
000140 323900000000      MOVE.W  COMMAND,D1      get bad command word
000146 61000000      BSR      DSPWORD      display bad command word
00014A      SYSCALL  XPCL      put crlf to console
00014C 61000442      BSR      SLECK      SLave Err acknowledge
000150 60BC      BRA      S0      continue slave mode

```

```

*****
*
*          MASTER or INITIATOR Sequence
*
*****

```

```

000152      MASTER  DISPLAY  MAST_M          show we are in master mode

00015A      T_LINK  DISPLAY  LREQ_M          show requesting link
000162 303C0002      MOVE.W  #LREQ,D0      link request command
000166 610003EC      BSR      PUT_C          put command to slave
00016A 0C400001      CMP.W   #ACKN,D0      did we get an acknowledge
00016E 670C      BEQ.S   T_GRNT      then continue
000170      DISPLAY  NACK_M          get not_ackn (refused)
000178 60000250      BRA      T_EXIT      then exit
00017C      T_GRNT  DISPLAY  LACK_M          show Granted

```

```

*-----*
*          Test Burst and Cycle in main test loop
*-----*

```

* I. Execute all dma tests in BURST mode

```

000184 08390005+      T_BURST  BTST      #5,TEST+0      Burst mode enabled ?
00018C 6716      BEQ.S   T_CYCLE      then goto next test
00018E 6100057C      BSR      SETBRST      set burst mode
000192 49F900000000      LEA      BRST_M,A4      burst mode msg
000198 303C0008      MOVE.W  #BRST,D0      slave burst command
00019C 610003B6      BSR      PUT_C          put command
0001A0 61000250      BSR      T_MAIN      test loop

```

* II. Execute all dma tests in CYCLE mode

```

0001A4 08390004+      T_CYCLE  BTST      #4,TEST+0      Burst mode enabled ?
0001AC 6716      BEQ.S   T_SWAP      then goto next test
0001AE 6100058E      BSR      SETCYCL      set cycle mode
0001B2 49F900000000      LEA      CYCL_M,A4      cycle mode msg
0001B8 303C0009      MOVE.W  #CYCL,D0      slave cycle command
0001BC 61000396      BSR      PUT_C          put command
0001C0 61000230      BSR      T_MAIN      test loop

```

* III. Set Burst & Long for data Swapping Tests

```

0001C4 61000546      T_SWAP  BSR      SETBRST      set burst mode
0001C8 303C0008      MOVE.W  #BRST,D0      slave burst command
0001CC 61000386      BSR      PUT_C          put command

```


0001D0 6100067A	BSR	SETLONG	set up for longs
0001D4 303C0005	MOVE.W	#LONG,D0	slave long command
0001D8 6100037A	BSR	PUT_C	put command, get ackn
* 1. Test word swap output mode			
0001DC 08390000+	T_WSO	BTST #0,TEST+0	Swap word out enabled ?
0001E4 6730	BEQ.S	T_WSI	then goto next test
0001E6 49F900000000	LEA	WSOT_M,A4	
0001EC 4BF900000000	LEA	OUTP_M,A5	
0001F2 3039FBFFE066	MOVE.W	MCR,D0	
0001F8 08C00001	BSET	#1,D0	set word swap out
0001FC 33C0FBFFE066	MOVE.W	D0,MCR	
000202 61000250	BSR	T_TEST	
000206 3039FBFFE066	MOVE.W	MCR,D0	
00020C 08800001	BCLR	#1,D0	clr word swap out
000210 33C0FBFFE066	MOVE.W	D0,MCR	
* 2. Test word swap input mode			
000216 08390007+	T_WSI	BTST #7,TEST+1	Swap word in enabled ?
00021E 6730	BEQ.S	T_BSO	then goto next test
000220 49F900000000	LEA	WSIT_M,A4	
000226 4BF900000000	LEA	INPT_M,A5	
00022C 3039FBFFE066	MOVE.W	MCR,D0	
000232 08C00003	BSET	#3,D0	set word swap in
000236 33C0FBFFE066	MOVE.W	D0,MCR	
00023C 61000216	BSR	T_TEST	
000240 3039FBFFE066	MOVE.W	MCR,D0	
000246 08800003	BCLR	#3,D0	clr word swap in
00024A 33C0FBFFE066	MOVE.W	D0,MCR	
* 3. Test byte swap ouput mode			
000250 08390006+	T_BSO	BTST #6,TEST+1	Swap byte out enabled ?
000258 6740	BEQ.S	T_BSI	then goto next test
00025A 49F900000000	LEA	BSOT_M,A4	
000260 4BF900000000	LEA	OUTP_M,A5	
000266 303C000C	MOVE.W	#SWAP,D0	slave toggle cmd swap
00026A 610002E8	BSR	PUT_C	
00026E 3039FBFFE066	MOVE.W	MCR,D0	
000274 08C00000	BSET	#0,D0	set byte swap out
000278 33C0FBFFE066	MOVE.W	D0,MCR	
00027E 610001D4	BSR	T_TEST	
000282 303C000C	MOVE.W	#SWAP,D0	slave toggle cmd swap
000286 610002CC	BSR	PUT_C	
00028A 3039FBFFE066	MOVE.W	MCR,D0	
000290 08800000	BCLR	#0,D0	clr byte swap out
000294 33C0FBFFE066	MOVE.W	D0,MCR	
* 4. Test byte swap input mode			
00029A 08390005+	T_BSI	BTST #5,TEST+1	Swap byte in enabled ?
0002A2 6730	BEQ.S	T_WBO	then goto next test
0002A4 49F900000000	LEA	BSIT_M,A4	

0002AA	4BF900000000	LEA	INPT_M,A5	
0002B0	3039FBFFE066	MOVE.W	MCR,D0	
0002B6	08C00002	BSET	#2,D0	set byte swap in
0002BA	33C0FBFFE066	MOVE.W	D0,MCR	
0002C0	61000192	BSR	T_TEST	
0002C4	3039FBFFE066	MOVE.W	MCR,D0	clr byte swap in
0002CA	08800002	BCLR	#2,D0	
0002CE	33C0FBFFE066	MOVE.W	D0,MCR	

* 5. Test word/byte swap output mode

0002D4	08390004+	T_WBO	BTST	#4,TEST+1	Swap word/byte out enabled ?
0002DC	6748		BEQ.S	T_WBI	then goto next test
0002DE	49F900000000		LEA	WBOT_M,A4	
0002E4	4BF900000000		LEA	SWPO_M,A5	
0002EA	303C000C		MOVE.W	#SWAP,D0	slave toggle cmd swap
0002EE	61000264		BSR	PUT_C	
0002F2	3039FBFFE066		MOVE.W	MCR,D0	
0002F8	08C00001		BSET	#1,D0	set word swap out
0002FC	08C00000		BSET	#0,D0	set byte swap out
000300	33C0FBFFE066		MOVE.W	D0,MCR	
000306	6100014C		BSR	T_TEST	
00030A	303C000C		MOVE.W	#SWAP,D0	slave toggle cmd swap
00030E	61000244		BSR	PUT_C	
000312	3039FBFFE066		MOVE.W	MCR,D0	
000318	08800001		BCLR	#1,D0	clr word swap out
00031C	08800000		BCLR	#0,D0	clr byte swap out
000320	33C0FBFFE066		MOVE.W	D0,MCR	

* 6. Test word/byte swap input mode

000326	08390003+	T_WBI	BTST	#3,TEST+1	Swap word/byte in enabled ?
00032E	6738		BEQ.S	T_WBIO	then goto next test
000330	49F900000000		LEA	WBIT_M,A4	
000336	4BF900000000		LEA	SWPI_M,A5	
00033C	3039FBFFE066		MOVE.W	MCR,D0	
000342	08C00003		BSET	#3,D0	set word swap in
000346	08C00002		BSET	#2,D0	set byte swap in
00034A	33C0FBFFE066		MOVE.W	D0,MCR	
000350	61000102		BSR	T_TEST	
000354	3039FBFFE066		MOVE.W	MCR,D0	
00035A	08800003		BCLR	#3,D0	clr word swap in
00035E	08800002		BCLR	#2,D0	clr byte swap in
000362	33C0FBFFE066		MOVE.W	D0,MCR	

* 7. Test word/byte swap output/input mode

000368	08390002+	T_WBIO	BTST	#2,TEST+1	Swap word/byte out/in enabled ?
000370	6758		BEQ.S	T_EXIT	then goto next test
000372	49F900000000		LEA	WBIO_M,A4	
000378	4BF900000000		LEA	SWIO_M,A5	
00037E	303C000C		MOVE.W	#SWAP,D0	slave toggle cmd swap
000382	610001D0		BSR	PUT_C	
000386	3039FBFFE066		MOVE.W	MCR,D0	
00038C	08C00003		BSET	#3,D0	set word swap in

000390	08C00002	BSET	#2,D0	set byte swap in
000394	08C00001	BSET	#1,D0	set word swap out
000398	08C00000	BSET	#0,D0	set byte swap out
00039C	33C0FBFFE066	MOVE.W	D0,MCR	
0003A2	610000B0	BSR	T_TEST	
0003A6	303C000C	MOVE.W	#SWAP,D0	slave toggle cmd swap
0003AA	610001A8	BSR	PUT_C	
0003AE	3039FBFFE066	MOVE.W	MCR,D0	
0003B4	08800003	BCLR	#3,D0	clr word swap in
0003B8	08800002	BCLR	#2,D0	clr byte swap in
0003BC	08800001	BCLR	#1,D0	clr word swap out
0003C0	08800000	BCLR	#0,D0	clr byte swap out
0003C4	33C0FBFFE066	MOVE.W	D0,MCR	

* IV. Send EXIT loop command to slave

0003CA	T_EXIT	DISPLAY	RELL_M	show releasing link
0003D2	02390003+	AND.B	#\$03,FLAGS	clr flags-(loop,break)
0003DA	08390001+	BTST	#1,FLAGS	loop on test flag
0003E2	6704	BEQ.S	T_LESS	then skip loop info
0003E4	61000582	BSR	L_INFO	else display loop info
0003E8	303C000A	T_LESS	MOVE.W	#EXIT,D0
0003EC	61000166	BSR	PUT_C	slave exit command
0003F0	4E75	RTS		put command wait ackn
				return from master mode

* Main Test loop (longs words and bytes) *

<0003F2/00> T_MAIN EQU * main test loop entry point

* A. Test Long Dma Transfers (32 bits)

0003F2	08390003+	T_LONG	BTST	#3,TEST+0	Long data enabled ?
0003FA	6716		BEQ.S	T_WORD	then goto next test
0003FC	6100044E		BSR	SETLONG	set up for longs
000400	4BF900000000		LEA	LONG_M,A5	long message
000406	303C0005		MOVE.W	#LONG,D0	slave long command
00040A	61000148		BSR	PUT_C	put command, get ackn
00040E	61000044		BSR	T_TEST	data test loop

* B. Test Word Dma Transfers (16 bits)

000412	08390002+	T_WORD	BTST	#2,TEST+0	Word data enabled ?
00041A	6716		BEQ.S	T_BYTE	then goto next test
00041C	61000458		BSR	SETWORD	set up for words
000420	4BF900000000		LEA	WORD_M,A5	word message
000426	303C0004		MOVE.W	#WORD,D0	slave word command
00042A	61000128		BSR	PUT_C	put command, get ackn
00042E	61000024		BSR	T_TEST	data test loop

* C. Test Byte Dma Transfers (8 bits)

000432	08390001+	T_BYTE	BTST	#1,TEST+0	Byte data enabled ?
00043A	6716		BEQ.S	X_MAIN	then goto next test


```
00043C 61000462      BSR      SETBYTE      set up for bytes
000440 4BF900000000    LEA      BYTE_M,A5      byte message
000446 303C0003      MOVE.W   #BYTE,D0      slave byte command
00044A 61000108      BSR      PUT_C        put command, get ackn
00044E 61000004      BSR      T_TEST       data test loop
```

* D. Then we return for cycle or exit testing

```
000452 4E75      X_MAIN  RTS              return to caller
```

```
*-----*
*      Main Dma I/O output,input compare test data loop      *
*-----*
```

* 1. Display Test mode (Burst/Cycle/Swap) and (B/W/I/O)

```
T_TEST  MOVE.L   A4,A1      get mode message
        SYSCALL  XPLC      put line to console
000458 224D      MOVE.L   A5,A1      get data size or IO message
00045A      SYSCALL  XPLC      put line to console
```

* 2. Fill test buffer with TDATA (test data var)

```
T_FILL  LEA      FILLBUFF,A0      w/TDATA update data ptr
000462 08390001+  BTST     #1,TEST+1      Data tables enabled
00046A 6606      BNE.S    T_F0      then use fill buffer
00046C 41F900000000  LEA      FILLMEM,A0      w/o TDATA update data ptr
000472 4E90      JSR      (A0)      do fill whatever
```

* 3. Transmit the buffer to the Slave board

```
T_TX    MOVE.W   #RCVE,D0      slave Rx command
000478 610000DA      BSR      PUT_C        put cmd wait ackn
00047C 610001B6      BSR      TRANSMIT     to slave board
000480 08B90007+  BCLR     #7,FLAGS      tx error
000488 66000054      BNE      D_FAIL      then dma error
```

* 4. Receive the buffer from the Slave board

```
T_RX    MOVE.W   #SEND,D0      Slave Tx command
000490 610000C2      BSR      PUT_C        put cmd wait ackn
000494 610001F8      BSR      RECEIVE     from slave board
000498 08B90007+  BCLR     #7,FLAGS      test error flag
0004A0 6600003C      BNE      D_FAIL      then dma error
```

* 5. Test the buffer for correct TDATA

```
T_BUFF  BSR      TESTBUFF      for t_data
0004A8 08B90007+  BCLR     #7,FLAGS      buffer err?
0004B0 6600003E      BNE      X_FAIL      then fail
```

* 6. Test for last data in test data table

```
T_NEXT  BTST     #1,TEST+1      data tables enabled
0004BC 670C      BEQ.S    T_PASS      then skip last data test
```

```

0004BE 0CB900000000+      CMPI.L    #0,TDATA      last data ?
0004C8 6692               BNE        T_FILL      then refill & test

*   7.   Show passed and exit

0004CA                   T_PASS   DISPLAY    PASS_M      else show passed
0004D2 06B900000001+      ADDI.L    #1,PCOUNT      increment pass count
0004DC 4E75               RTS

*   8.   Handle dmai error from slave board

0004DE                   D_FAIL   DISPLAY    BADD_M      bad dma from slave
0004E6 6008               BRA.S     X_FAIL      common exit

*   9.   Handle acknowledge error from slave board

0004E8                   A_FAIL   DISPLAY    BADA_M      bad ackn from slave

*   Common exit for transfer tests

0004F0 06B900000001+      X_FAIL   ADDI.L    #1,FCOUNT      increment fail count
0004FA                   DISPLAY    CHSR_M      Common exit
000502 1239FBFFE000      MOVE.B     CHSR,D1
000508 61000000          BSR        DSPBYTE
00050C                   DISPLAY    STAT_M
000514 12390000000000      MOVE.B     STATS,D1
00051A 61000000          BSR        DSPBYTE
00051E                   DISPLAY    FLAG_M
000526 12390000000000      MOVE.B     FLAGS,D1
00052C 61000000          BSR        DSPBYTE
000530 23FC00000000+      MOVE.L     #DTBL,DPTR
00053A                   SYSCALL    XPCL
00053C 08390000+         BTST       #0,FLAGS      set this in MAIN
000544 670C               BEQ.S     NO_BR        break flag not set
000546                   DO_BR    PROMPT    ANYK_M      break flag set
000552 4E75               NO_BR    RTS           return errors

```

```

*****
***
**                               DR11W Board Subroutines
***
*****

```

```

*-----*
*   PUT/GET commands to/from other board (master & slave)   *
*-----*

```

```

000554 33C0FBFFE062      PUT_C    MOVE.W     D0,IODR      write command via IODR
00055A 6100003C          BSR        ATTN          set attn to other board
00055E 08B900006+       GET_C    BCLR        #6,FLAGS      clear and test attn flag
000566 67F6               BEQ.S     GET_C        wait for attn from other brd
000568 30390000000000      MOVE.W     COMMAND,D0      and get command from buffer
00056E 083900004+       BTST       #4,FLAGS      test swap command bytes flag
000576 6702               BEQ.S     GCX          skip swapping command bytes
000578 E058               ROR.W     #8,D0          else swap command bytes

```

00057A 13FC001E+ GCX MOVE.B #\$1E,AICR re-enable attn interrupt
000582 4E75 RTS

* SLave ACKn to other board with Atten (fall thru) *

000584 33FC0001+ SLACK MOVE.W #ACKN,IODR put acknowledge in IODR
00058C 6000000A BRA ATTEN else to ackn attn to Master

* SLave ERR ACKn to other board with Atten *

000590 33FC000D+ SLECK MOVE.W #BADC,IODR put bac cmd ackn in IODR

* Toggle attn input to other board (both) *

000598 1039FBFFE061 ATTEN MOVE.B BCR,D0 get board control status
00059E 020000FC AND.B #\$FC,D0 mask cycle and go bits
0005A2 08C00006 BSET #6,D0 set attention bit high
0005A6 13C0FBFFE061 MOVE.B D0,BCR write to other board
0005AC 08800006 BCLR #6,D0 set attention bit low
0005B0 13C0FBFFE061 MOVE.B D0,BCR write to other board
0005B6 4E75 RTS return

* NULL command handler (slave) *

0005B8 NULLCMD DISPLAY NULL_M show doing null command
0005C0 4E75 RTS

* LINK request command handler (slave) *

0005C2 LINKCMD DISPLAY LINK_M show link request from other
0005CA DISPLAY GRNT_M show doing grant to other
0005D2 4E75 RTS

* ACKN command handler (slave) (if he should get one) *

0005D4 ACKNCMD DISPLAY ACKN_M show doing ackn command
0005DC 4E75 RTS

* BADC command handler (slave) (if he should get one) *

0005DE BADCMD DISPLAY BCMD_M show doing BADC command

0005E6 4E75

RTS

```

*-----*
*      Set Exit current loop flag (slave)      *
*-----*

```

0005E8

EXITCMD DISPLAY EXIT_M

show exit message

0005F0 02390003+

ANDI.B #\$03,FLAGS

clr flags except loop & break

0005F8 618A

BSR SLACK

and acknowledge exit

0005FA DFFC00000004

ADDA.L #4,A7

return two levels from here

000600 4E75

RTS

& return

```

*-----*
*      Abort Program handler (quit) (slave)    *
*-----*

```

000602

ABRTCMD DISPLAY ABRT_M

show aborting message

00060A 02390003+

ANDI.B #\$03,FLAGS

clr flags except loop & break

000612 6100FF70

BSR SLACK

and acknowledge exit

000616 DFFC00000008

ADDA.L #8,A7

return three levels from here

00061C 4E75

RTS

all the way back to main menu!

```

*-----*
*      Swap command bytes (slave)              *
*-----*

```

00061E 08790004+

SWAPCMD BCHG #4,FLAGS

toggle swap command flag

000626 4E75

RTS

```

*-----*
*      Init Dmai and BCR to Transmit data (both)
*-----*

```

```

*
*      slave transmit entry point, fall thru ...
*

```

000628 33FC0001+

SLAVE_TX MOVE.W #ACKN,IODR

tell master we got the cmd

000630 6100FF66

BSR ATTN

via attention interrupt

```

*
*      master transmit entry point
*

```

000634 08F90002+

TRANSMIT BSET #2,FLAGS

set skip cmd ackn for slave

00063C 1039FBFFE061

MOVE.B BCR,D0

Get BCR status

000642 020000FC

AND.B #\$FC,D0

mask cycle and go bits

000646 08800005

BCLR #5,D0

set direction to out

00064A 13C0FBFFE061

MOVE.B D0,BCR

set direction in BCR

000650 08800003

BCLR #3,D0

set FLED on for effect

000654 08C00000

BSET #0,D0

set go bit in BCR image

000658 08C00001

BSET #1,D0

set cycle bit in image

00065C 207900000000

MOVE.L TXS,A0

get pointer to setup

000662 6100006A

BSR SETDMA

do dmai module setup

000666 08390004+

TX_RDY BTST #4,BSRA

read board status reg

00066E 67F6

BEQ.S TX_RDY

if not ready then wait

000670 13C0FBFFE061

MOVE.B D0,BCR

set go and cycle to DMA

000676 08B90005+

TX_DONE BCLR #5,FLAGS

test done in flags

00067E 67F6

BEQ.S TX_DONE

wait for done flag

000680 4E75

RTS

return to caller

```
*-----*
*      Init Dmai and BCR to Receive data (both)      *
*-----*
```

```
*
*  slave receive entry point, fall thru ...
*
```

```
000682 33FC0001+  SLAVE_RX MOVE.W    #ACKN,IODR    tell master we got the command
00068A 6100FF0C      BSR          ATTN      via attention interrupt
```

```
*
*  master receive entry point
*
```

```
00068E 08F90002+  RECEIVE BSET      #2,FLAGS    set skip cmd ackn for slave
000696 1039FBFFE061      MOVE.B    BCR,D0      Get BCR status
00069C 020000FC      AND.B      #$FC,D0      mask cycle and go bits
0006A0 08C00005      BSET      #5,D0      set direction to in
0006A4 13C0FBFFE061      MOVE.B    D0,BCR      set direction in BCR
0006AA 08800003      BCLR      #3,D0      set FLED on for effect
0006AE 08C00000      BSET      #0,D0      set go bit in BCR image
0006B2 207900000000      MOVE.L    RXS,A0      point to Rx setup table
0006B8 61000014      BSR          SETDMA      and go set the dmai
0006BC 13C0FBFFE061      MOVE.B    D0,BCR      set go in BCR to DMA
0006C2 08B900005+  RX_DONE BCLR      #5,FLAGS    test done in flags
0006CA 67F6          BEQ.S      RX_DONE    wait for done flag
0006CC 4E75          RTS          return to caller
```

```
*-----*
*      Setup Dmai for transfers from table @ (A0) (both)      *
*-----*
```

```
* registers:  csr|dcr|ocr|amr|ema|ccr| mtc.w | mac.h | mac.l | dicr
*              0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C
```

```
0006CE 13D8FBFFE000  SETDMA MOVE.B    (A0)+,CHSR    Channel Status Register
0006D4 13D8FBFFE004      MOVE.B    (A0)+,DCR      Device Control Registr
0006DA 13D8FBFFE005      MOVE.B    (A0)+,OCR      Operation Control Reg
0006E0 13D8FBFFE065      MOVE.B    (A0)+,AMR      Address Modifier reg
0006E6 13D8FBFFE064      MOVE.B    (A0)+,EMA      Extended Memory Address
0006EC 13D8FBFFE007      MOVE.B    (A0)+,CHCR      Enable dma starts & intrs
0006F2 33D8FBFFE00A      MOVE.W    (A0)+,MTC      Mem Transfer Count
0006F8 33D8FBFFE00C      MOVE.W    (A0)+,MACH      Mem Address Count (hi)
0006FE 33D8FBFFE00E      MOVE.W    (A0)+,MACL      Mem Address Count (lo)
000704 13D8FBFFE047      MOVE.B    (A0)+,DICR      Done Intr Control Reg
00070A 4E75          RTS          return to caller
```

```
*-----*
*      Set BURST mode in Transfers tables (both)      *
*-----*
```

```
00070C 08B900007+  SETBRST BCLR      #7,TX.L+1    set Burst mode in tables (dcr)
000714 08B900007+      BCLR      #7,RX.L+1
00071C 08B900007+      BCLR      #7,TX.W+1
000724 08B900007+      BCLR      #7,RX.W+1
00072C 08B900007+      BCLR      #7,TX.B+1
000734 08B900007+      BCLR      #7,RX.B+1
```

00073C 4E75

RTS

* Set CYCLE mode in Transfer tables (both) *

00073E 08F90007+	SETCYCL	BSET	#7,TX.L+1	set Cycle mode in tables (dcr)
000746 08F90007+		BSET	#7,RX.L+1	
00074E 08F90007+		BSET	#7,TX.W+1	
000756 08F90007+		BSET	#7,RX.W+1	
00075E 08F90007+		BSET	#7,TX.B+1	
000766 08F90007+		BSET	#7,RX.B+1	
00076E 4E75		RTS		

* Set Address Modifier in Transfer tables (both) *

000770 13C100000000	SETAMR	MOVE.B	D1,TX.L+3	set AMR in tables for long
000776 13C100000000		MOVE.B	D1,RX.L+3	
00077C 08C10006		BSET	#6,D1	set not longword bit in AMR &
000780 13C100000000		MOVE.B	D1,TX.W+3	set AMR in tables for word/byte
000786 13C100000000		MOVE.B	D1,RX.W+3	
00078C 13C100000000		MOVE.B	D1,TX.B+3	
000792 13C100000000		MOVE.B	D1,RX.B+3	
000798 4E75		RTS		

* Set Extended Memory Address in Transfer tables (both) *

00079A 13C100000000	SETEMA	MOVE.B	D1,TX.L+4	set EMA in tables
0007A0 13C100000000		MOVE.B	D1,RX.L+4	
0007A6 13C100000000		MOVE.B	D1,TX.W+4	
0007AC 13C100000000		MOVE.B	D1,RX.W+4	
0007B2 13C100000000		MOVE.B	D1,TX.B+4	
0007B8 13C100000000		MOVE.B	D1,RX.B+4	
0007BE 4E75		RTS		

* Set Memory Transfer Count in tables (MTC.W) (both) *

0007C0 33C100000000	SETMTC	MOVE.W	D1,TX.L+6	set MTC in tables
0007C6 33C100000000		MOVE.W	D1,RX.L+6	
0007CC 33C100000000		MOVE.W	D1,TX.W+6	
0007D2 33C100000000		MOVE.W	D1,RX.W+6	
0007D8 33C100000000		MOVE.W	D1,TX.B+6	
0007DE 33C100000000		MOVE.W	D1,RX.B+6	
0007E4 4E75		RTS		

* Set Memory Address Counter in Transfer tables (both) *

0007E6	23C100000000	SETMAC	MOVE.L	D1,TX.L+8	set Mac in tables
0007EC	23C100000000		MOVE.L	D1,RX.L+8	
0007F2	23C100000000		MOVE.L	D1,TX.W+8	
0007F8	23C100000000		MOVE.L	D1,RX.W+8	
0007FE	23C100000000		MOVE.L	D1,TX.B+8	
000804	23C100000000		MOVE.L	D1,RX.B+8	
00080A	4E75		RTS		

* Set Transfer defaults for MTC, MAC, AMR, EMA (menu) *

00080C	223CFB000000	SETRR2	MOVE.L	#\$FB000000,D1	default transfer buffer
000812	61D2		BSR	SETMAC	set MAC
000814	323CFFFF		MOVE.W	#\$FFFF,D1	default transfer count
000818	61A6		BSR	SETMTC	set MTC
00081A	123C0039		MOVE.B	#\$39,D1	default address modifier
00081E	6100FF50		BSR	SETAMR	set AMR
000822	123C00FB		MOVE.B	#\$FB,D1	default extended address
000826	6100FF72		BSR	SETEMA	set EMA
00082A	4E75		RTS		return

00082C	223C000B0000	SETC33	MOVE.L	#\$000B0000,D1	default transfer buffer
000832	61B2		BSR	SETMAC	set MAC
000834	323CFFFF		MOVE.W	#\$FFFF,D1	default transfer count
000838	6186		BSR	SETMTC	set MTC
00083A	123C0009		MOVE.B	#\$09,D1	default address modifier
00083E	6100FF30		BSR	SETAMR	set AMR
000842	123C00FF		MOVE.B	#\$FF,D1	default extended address
000846	6100FF52		BSR	SETEMA	set EMA
00084A	4E75		RTS		return

* Set Transfer mode pointers to LONG mode (both) *

00084C	23FC00000000+	SETLONG	MOVE.L	#FILL_L,FBS	setup fill buffer subr
000856	23FC00000000+		MOVE.L	#TEST_L,TBS	setup test buffer subr
000860	23FC00000000+		MOVE.L	#TX.L,TXS	setup word xfer table
00086A	23FC00000000+		MOVE.L	#RX.L,RXS	setup word xfer table
000874	4E75		RTS		and return

* Set Transfer mode pointers to WORD mode (both) *

000876	23FC00000000+	SETWORD	MOVE.L	#FILL_W,FBS	setup fill buffer subr
000880	23FC00000000+		MOVE.L	#TEST_W,TBS	setup test buffer subr
00088A	23FC00000000+		MOVE.L	#TX.W,TXS	setup word xfer table
000894	23FC00000000+		MOVE.L	#RX.W,RXS	setup word xfer table
00089E	4E75		RTS		and return

* Set Transfer mode pointers to BYTE mode (both) *

0008A0	23FC00000000+	SETBYTE	MOVE.L	#FILL_B,FBS	setup fill buffer subr
0008AA	23FC00000000+		MOVE.L	#TEST_B,TBS	setup test buffer subr
0008B4	23FC00000000+		MOVE.L	#TX.B,TXS	setup byte xfer table
0008BE	23FC00000000+		MOVE.L	#RX.B,RXS	setup byte xfer table
0008C8	4E75		RTS		and return

* Dump transfer tables to console *

* (*) Note To the unwary: This routine is not straight forward.

0008CA		DUMP_T	DISPLAY	DT0	show table breakout
0008D2			DISPLAY	DT1	show tx long
0008DA	41F900000000		LEA	TX.L,A0	
0008E0	303C000C		MOVE.W	#SC,D0	
0008E4	61000076		BSR	ST02	
0008E8			DISPLAY	DT2	show tx word
0008F0	41F900000000		LEA	TX.W,A0	
0008F6	303C000C		MOVE.W	#SC,D0	
0008FA	61000060		BSR	ST02	
0008FE			DISPLAY	DT3	
000906	41F900000000		LEA	TX.B,A0	show tx byte
00090C	303C000C		MOVE.W	#SC,D0	
000910	6100004A		BSR	ST02	
000914			DISPLAY	DT4	show rx long
00091C	41F900000000		LEA	TX.L,A0	
000922	303C000C		MOVE.W	#SC,D0	
000926	61000034		BSR	ST02	
00092A			DISPLAY	DT5	show rx word
000932	41F900000000		LEA	TX.W,A0	
000938	303C000C		MOVE.W	#SC,D0	
00093C	6100001E		BSR	ST02	
000940			DISPLAY	DT6	show rx byte
000948	41F900000000		LEA	TX.B,A0	
00094E	303C000C		MOVE.W	#SC,D0	
000952	6008		BRA.S	ST02	fall thru to rts main (*)
000954		ST01	DISPLAY	DTL	Delimiter for loop
00095C	1218	ST02	MOVE.B	(A0)+,D1	get table byte
00095E	61000000		BSR	DSPBYTE	show it
000962	51C8FFF0		DBF	D0,ST01	do loop count
000966	4E75		RTS		return to caller

* Display loop on test information *

000968		L_INFO	DISPLAY	PCNT_M	show pass message
000970	223900000000		MOVE.L	PCOUNT,D1	get passed count and
000976	61000000		BSR	DSPLONG	show it as hex longword
00097A			DISPLAY	FCNT_M	show fail message
000982	223900000000		MOVE.L	FCOUNT,D1	get failed count and
000988	61000000		BSR	DSPLONG	show it as hex longword
00098C	4E75		RTS		and return

```

*-----*
*          Fill Buffer with Test DATA & incr pointer (master)          *
*-----*
*          Fill with TDATA update
*
00098E 2079000000000    FILLBUFF MOVE.L    DPTR,A0          get test data pointer
000994 23D8000000000          MOVE.L    (A0)+,TDATA        get test data from table
00099A 6606              BNE.S      F0          if data <> 0 then set pointer
00099C 41F9000000000          LEA      DTBL,A0          else point to start of table
0009A2 23C8000000000    F0      MOVE.L    A0,DPTR          and set test data pointer

*          Fill only (no tdata update)
*
0009A8 2079000000000    FILLMEM MOVE.L    TX.L+8,A0        point to transfer buffer
0009AE 3239000000000          MOVE.W    TX.L+6,D1        Get buffer length in D1
0009B4 5341              SUB.W      #1,D1          Less 1 for DBF instruction
0009B6 2039000000000          MOVE.L    TDATA,D0        get current test data
0009BC 2279000000000          MOVE.L    FBS,A1          pointer to fill block subr
0009C2 4ED1              JMP      (A1)          use B/W/L subr & return

*          Byte buffer fill subroutine
*
0009C4 10C0              FILL_B  MOVE.B    D0,(A0)+        put data into buffer
0009C6 4600              NOT.B      D0          invert every other data
0009C8 51C9FFFA          DBF      D1,FILL_B          do the whole buffer
0009CC 4E75              RTS                      return to caller

*          Word Buffer fill subroutine
*
0009CE 30C0              FILL_W  MOVE.W    D0,(A0)+        put data into buffer
0009D0 4640              NOT.W      D0          invert every other data
0009D2 51C9FFFA          DBF      D1,FILL_W          do the whole buffer
0009D6 4E75              RTS                      return to caller

*          Long Buffer fill subroutine
*
0009D8 20C0              FILL_L  MOVE.L    D0,(A0)+        put data into buffer
0009DA 4680              NOT.L      D0          invert every other data
0009DC 51C9FFFA          DBF      D1,FILL_L          do the whole buffer
0009E0 4E75              RTS                      return to caller

*-----*
*          Test buffer Data to current test data: TDATA (master)          *
*-----*
*
0009E2 2079000000000    TESTBUFF MOVE.L    TX.L+8,A0        point to transfer buffer
0009E8 3239000000000          MOVE.W    TX.L+6,D1        get buffer length in D1
0009EE 5341              SUB.W      #1,D1          Less 1 for DBF instruction
0009F0 2039000000000          MOVE.L    TDATA,D0        get current test data and

*          handle word and byte swapping capability
*
0009F6 3439FBFFE066      T0      MOVE.W    MCR,D2        read master control register
0009FC 08020003          BTST      #3,D2          input word swapping set
000A00 6702              BEQ.S      T1          then skip it

```


000A02 4840		SWAP	D0	else swap words in tdata
000A04 08020002	T1	BTST	#2,D2	input byte swapping set
000A08 6708		BEQ.S	T2	then skip it
000A0A E058		ROR.W	#8,D0	else swap bytes 0,1
000A0C 4840		SWAP	D0	swap words
000A0E E058		ROR.W	#8,D0	then swap bytes 2,3
000A10 4840		SWAP	D0	restore words
000A12 08020001	T2	BTST	#1,D2	output word swapping set
000A16 6702		BEQ.S	T3	then skip it
000A18 4840		SWAP	D0	else swap words in tdata
000A1A 08020000	T3	BTST	#0,D2	output byte swapping set
000A1E 6708		BEQ.S	T4	then skip it
000A20 E058		ROR.W	#8,D0	else swap bytes 0,1
000A22 4840		SWAP	D0	swap words
000A24 E058		ROR.W	#8,D0	then swap bytes 2,3
000A26 4840		SWAP	D0	restore words
	*	now get test by size pointer		
000A28 227900000000	T4	MOVE.L	TBS,A1	pointer to test buffer subr
000A2E 4ED1		JMP	(A1)	use B/W/L subr & return
	*	Byte Buffer Test subroutine		
000A30 B018	TEST_B	CMP.B	(A0)+,D0	comp with data in buffer
000A32 6608		BNE.S	BBX	Error if not equal
000A34 4600		NOT.B	D0	invert for testing
000A36 51C9FFF8		DBF	D1,TEST_B	test the whole buffer
000A3A 4E75		RTS		return passing
000A3C 91FC00000001	BBX	SUBA.L	#1,A0	calc error address
000A42 61000076		BSR	BUFF_E	common buff err sub
000A46 1210		MOVE.B	(A0),D1	get error byte
000A48 61000000		BSR	DSPBYTE	show it
000A4C		DISPLAY	WROT_M	show write msg
000A54 1200		MOVE.B	D0,D1	get wrote byte
000A56 61000000		BSR	DSPBYTE	show it
000A5A		SYSCALL	XPCL	new line
000A5C 4E75		RTS		
	*	Word Buffer Test subroutine		
000A5E B058	TEST_W	CMP.W	(A0)+,D0	comp with data in buffer
000A60 6608		BNE.S	BWX	Error if not equal
000A62 4640		NOT.W	D0	invert for testing
000A64 51C9FFF8		DBF	D1,TEST_W	test the whole buffer
000A68 4E75		RTS		return passing
000A6A 91FC00000002	BWX	SUBA.L	#2,A0	calc error address
000A70 61000048		BSR	BUFF_E	common buff err sub
000A74 3210		MOVE.W	(A0),D1	get error word
000A76 61000000		BSR	DSPWORD	show it
000A7A		DISPLAY	WROT_M	show wrote msg
000A82 3200		MOVE.W	D0,D1	get wrote word
000A84 61000000		BSR	DSPWORD	show it
000A88		SYSCALL	XPCL	new line
000A8A 4E75		RTS		

```
* Long Buffer Test subroutine

000A8C B098      TEST_L  CMP.L    (A0)+,D0      comp with data in buffer
000A8E 6608      BNE.S    BLX              Error if not equal
000A90 4680      NOT.L    D0              invert for testing
000A92 51C9FFF8  DBF      D1,TEST_L      test the whole buffer
000A96 4E75      RTS                      return passing
000A98 91FC00000004 BLX      SUBA.L    #4,A0      calc error addresss
000A9E 6100001A  BSR      BUFF_E      common buff err sub
000AA2 2210      MOVE.L    (A0),D1      get error long
000AA4 61000000  BSR      DSPLONG     show it
000AA8           DISPLAY   WROT_M      show wrote msg
000AB0 2200      MOVE.L    D0,D1      get wrote long
000AB2 61000000  BSR      DSPLONG     show it
000AB6           SYSCALL   XPCL       new line
000AB8 4E75      RTS

* Test buffer subroutine error subroutine (sub sub)

000ABA          BUFF_E  DISPLAY  BADB_M      bad data from slave
000AC2 08F90007+ BSET      #7,FLAGS     set error bit in flags
000ACA 2208      MOVE.L    A0,D1      get fixed addr
000ACC 61000000  BSR      DSPLONG     show it
000AD0          DISPLAY   READ_M      show read data msg
000AD8 4E75      RTS                      and return

*****
***
**                               DR11WA Interrupt Handlers
***
*****

*-----*
* Attention Handler (Command input interrupt) (both)
*-----*

000ADA 08F90006+ ATTN      BSET      #6,FLAGS     set attn flag for cmd ready
000AE2 33F9FBFFE062+ MOVE.W    IODR,COMMAND  read command via IODR
000AEC 4E73      RTE                      return from exception

*-----*
* Dma DONE & DERR handler (both)
*-----*

000AEE 08F90007+ DERR      BSET      #7,FLAGS     Set error bit in flags
000AF6 13FC0054+ MOVE.B    #$54,DIVR     restore vector ls_bit
000AFE 08F90005+ DONE      BSET      #5,FLAGS     Set done bit in flags
000B06 13FC002C+ MOVE.B    #$2C,BCR     clean up the BCR
000B0E 13F9FBFFE060+ MOVE.B    BSR,STATS     read bsr into stats
000B18 13F900000000+ MOVE.B    TX.W+3,AMR     AMR must always be not lword
000B22 4E73      RTE                      Return from Exception

*-----*
* BUS Error (board) Handler (both)
*-----*
```

```

*-----*

000B24 08F90007+ BERR BSET #7,FLAGS set error bit in flags
000B2C 4E73 RTE and return from exception

*****
***
** DR11WA Test messages **
***
*****

000B2E DR11_M
000B2E 0D0A0A DC.B CR,LF,LF
000B31 2A2A2A2A2A2A+ DC.B '*****',CR,LF
000B6F 2A2020202020+ DC.B '*' CR,LF
000BAD 2A2020202020+ DC.B '*' (((((( VMIVME DR11WA TRANSFER TESTS ))))) '*' CR,LF
000BEB 2A2020202020+ DC.B '*' CR,LF
000C29 2A2A2A2A2A2A+ DC.B '*****',CR,LF,NUL
000C68 SLCT_M
000C68 53656C65637420+ DC.B 'Select Transfer Test Startup mode M=Master, S=Slave (M/S): ',NUL
000CA4 203F0D0700 ARGH_M DC.B ' ',CR,BEL,NUL
000CA9 0D0A MMOD_M DC.B CR,LF
000CAB 4D415354455220+ DC.B 'MASTER selected. Enter X to abort, any other key to start: ',NUL
000CE7 0D0A SMOD_M DC.B CR,LF
000CE9 534C4156452020+ DC.B 'SLAVE Selected. Enter X to abort, any other key to start: ',NUL

000D25 0D0A5072657373+ ANYK_M DC.B CR,LF,'Press any key to continue: ',nul

000D43 0D0A0A203C204D+ MAST_M DC.B CR,LF,LF,' < MASTER MODE >',CR,LF,NUL
000D59 52657175657374+ LREQ_M DC.B 'Requesting Link Mastership .... ',NUL
000D7B 52656675736564+ NACK_M DC.B 'Refused',CR,LF,NUL
000D85 4772616E746564+ LACK_M DC.B 'Granted',CR,LF,NUL
000D8F 52656C65617369+ RELM_M DC.B 'Releasing Link Mastership to other board',CR,LF,NUL

000DBA 0D0A0A203C2053+ SLAV_M DC.B CR,LF,LF,' < SLAVE MODE >',CR,LF,NUL
000DD0 52656365697665+ LINK_M DC.B 'Received Link Request from other board',CR,LF,NUL
000DF9 4772616E74696E+ GRNT_M DC.B 'Granting Link Mastership to other board',CR,LF,NUL
000E23 52656365697665+ EXIT_M DC.B 'Received Exit command from link Master',CR,LF,NUL
000E4C 52656365697665+ BCMD_M DC.B 'Received BADC command from link Master',CR,LF,NUL
000E75 52656365697665+ ABRT_M DC.B 'Received Abort command from link Master',CR,LF,NUL
000E9F 52656365697665+ CERR_M DC.B 'Received Bad command from Master = ',nul

000EC3 54657374696E67+ BRST_M DC.B 'Testing Burst Dma ',NUL
000ED6 54657374696E67+ CYCL_M DC.B 'Testing Cycle Dma ',NUL

000EE9 4C6F6E67206461+ LONG_M DC.B 'Long data .... ',nul
000EFA 576F7264206461+ WORD_M DC.B 'Word data .... ',nul
000F0B 42797465206461+ BYTE_M DC.B 'Byte data .... ',nul

000F1C 54657374696E67+ WSOT_M DC.B 'Testing word swap ',nul
000F2F 54657374696E67+ WSIT_M DC.B 'Testing word swap ',nul
000F42 54657374696E67+ BSOT_M DC.B 'Testing byte swap ',nul
000F55 54657374696E67+ BSIT_M DC.B 'Testing byte swap ',nul
000F68 54657374696E67+ WBOT_M DC.B 'Testing word/byte ',nul
000F7B 54657374696E67+ WBIT_M DC.B 'Testing word/byte ',nul

```



```

000F8E 54657374696E67+ WBIO_M DC.B 'Testing word/byte ',nul
000FA1 6F757470757473+ OUTP_M DC.B 'outputs ..... ',nul
000FB2 696E7075747320+ INPT_M DC.B 'inputs ..... ',nul
000FC3 73776170206F75+ SWPO_M DC.B 'swap out ..... ',nul
000FD4 7377617020696E+ SWPI_M DC.B 'swap in ..... ',nul
000FE5 7377617020492F+ SWIO_M DC.B 'swap I/O ..... ',nul

000FF6 5061737365640D+ PASS_M DC.B 'Passed',CR,LF,nul
000FFF 4661696C65640D+ FAIL_M DC.B 'Failed',CR,LF,NUL

001008 0D0A0A50617373+ PCNT_M DC.B CR,LF,LF,'Passed ',NUL
001013 2C204661696C65+ FCNT_M DC.B ', Failed ',NUL

00101D 0D0A5265636569+ NULL_M DC.B CR,LF,'Received NULL command.',NUL
001036 0D0A5265636569+ ACKN_M DC.B CR,LF,'Received ACKN command.',NUL

00104F 4661696C656420+ BADB_M DC.B 'Failed ==> Bad DATA from "slave"!',CR,LF,NUL
001073 4661696C656420+ BADA_M DC.B 'Failed ==> Bad ACKN from "slave"!',CR,LF,NUL
001097 4661696C656420+ BADD_M DC.B 'Failed ==> Bad DMax from "slave"!',CR,LF,NUL

0010BB 204164643A00 ADDR_M DC.B ' Add:',NUL
0010C1 2057723A00 WROT_M DC.B ' Wr:',NUL
0010C6 2052643A00 READ_M DC.B ' Rd:',NUL
0010CB 204353523A00 CHSR_M DC.B ' CSR:',NUL
0010D1 204253523A00 BSR_M DC.B ' BSR:',NUL
0010D7 205354533A00 STAT_M DC.B ' STS:',NUL
0010DD 20464C473A00 FLAG_M DC.B ' FLG:',NUL

```

* dump tables to console messages

```

0010E3 0D0A0A72656769+ DT0 DC.B CR,LF,LF,'registers: csr|dcr|ocr|amr|ema|ccr| mtc.w | mac.h | mac.l |dicr'
001126 0D0A2020202020+ DC.B CR,LF,' 0 | 1 | 2 | 3 | 4 | 5 | 6 7 | 8 9 | A B | C ',NUL
001169 0D0A545820204C+ DT1 DC.B CR,LF,'TX Long $',nul
001179 0D0A5458202057+ DT2 DC.B CR,LF,'TX Word $',nul
001189 0D0A5458202042+ DT3 DC.B CR,LF,'TX Byte $',nul
001199 0D0A525820204C+ DT4 DC.B CR,LF,'RX Long $',nul
0011A9 0D0A5258202057+ DT5 DC.B CR,LF,'RX Word $',nul
0011B9 0D0A5258202042+ DT6 DC.B CR,LF,'RX Byte $',nul
0011C9 2C2400 DTL DC.B ',,$',NUL

```

```

*****
***
**          DR11WA Test Constants, Variables, & Storage          **
***
*****

```

```

0011CC 00 STATS DC.B 0 board status register stg
0011CE 0000 COMMAND DC.W 0 attn command word storage

```

* Test Enables for individual tests (Enabled = 1, Disabled = 0)

```

0011D0 FFFF
TEST DC.W $FFFF Enable Flags (all default)
* bit 15 Master mode
* bit 14 Slave mode
* bit 13 Burst mode
* bit 12 Cycle mode

```

```
*      bit      11      Long data
*      bit      10      Word data
*      bit      9       Byte data
*      bit      8       Swap word out
*      bit      7       Swap word in
*      bit      6       Swap byte out
*      bit      5       Swap byte in
*      bit      4       Swap word/byte out
*      bit      3       Swap word/byte in
*      bit      2       Swap word/byte out/in
*      bit      1       enable test data tables
*      bit      0       undf
*
*-----*
* Slave mode command table
*
SCMDS   DC.L      NULLCMD      0      slave
        DC.L      ACKNCMD     1      master/slave
        DC.L      LINKCMD     2      slave
        DC.L      SETBYTE     3      slave
        DC.L      SETWORD     4      both
        DC.L      SETLONG     5      both
        DC.L      SLAVE_TX    6      slave
        DC.L      SLAVE_RX    7      slave
        DC.L      SETBRST     8      both
        DC.L      SETCYCL     9      both
        DC.L      EXITCMD     A      slave
        DC.L      ABRTCMD     B      slave
        DC.L      SWAPCMD     C      slave
        DC.L      BADCMD      D      master/slave
VALID   DC.W      $0000,$000D
*-----*
* registers:  csr|dcr|ocr|amr|ema|ccr| mtc.w | mac.h | mac.l | dicr
*              0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C
00120E FF383239FB88FF+ TX.L DC.B $FF,$38,$32,$39,$FB,$88,$FF,$FF,$FB,$00,$00,$00,$3E
00121B FF381279FB88FF+ TX.W DC.B $FF,$38,$12,$79,$FB,$88,$FF,$FF,$FB,$00,$00,$00,$3E
001228 FF300279FB88FF+ TX.B DC.B $FF,$30,$02,$79,$FB,$88,$FF,$FF,$FB,$00,$00,$00,$3E
*              |   |   |   |   |   |   |   |   |   |   |   |   |
001235 FF38B239FB88FF+ RX.L DC.B $FF,$38,$B2,$39,$FB,$88,$FF,$FF,$FB,$00,$00,$00,$3E
001242 FF389279FB88FF+ RX.W DC.B $FF,$38,$92,$79,$FB,$88,$FF,$FF,$FB,$00,$00,$00,$3E
00124F FF308279FB88FF+ RX.B DC.B $FF,$30,$82,$79,$FB,$88,$FF,$FF,$FB,$00,$00,$00,$3E
*-----*
* Transfer mode pointers
*
TXS      DC.L      TX.L      default is long tx table
RXS      DC.L      RX.L      default is long rx table
FBS      DC.L      FILL_L    def is long fill buff subr
TBS      DC.L      TEST_L    def is long test buff subr
*-----*
* DR11WA Test Date Table (TDATA)
*
DTBL     DC.L      $AAAAAAA,$55555555,$CCCCCCCC,$33333333
        DC.L      $0F0F0F0F,$F0F0F0F0,$00FF00FF,$FF00FF00
        DC.L      $0000FFFF,$FFFF0000,$FFFFFFF,$00000000
DPTR     DC.L      DTBL      test data table pointer
```

0012A0 00000000	TDATA	DC.L	0	current test data variable
0012A4 00	DSIZE	DC.B	0	current test data size

END DR11A4

0x12A8 bytes code/data, 0x0 uninitialized